### **Application of Plasma Phenomena**



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Institute of Space and Plasma Sciences, National Cheng Kung University

Lecture 12

2025 fall semester

Thursday 9:00-12:00

**Materials:** 

https://capst.ncku.edu.tw/PGS/index.php/teaching/

Online courses:

https://reurl.cc/ZIG6k6

## **Grading**



- Quizzes 50 % (2-min Q&A at the beginning of each class)
- Presentations 50 % (10-min presentation on any plasma applications or phenomena)
- One more in-class Quiz on 12/11.
- Final presentation on 12/25. ← Rescheduled needed.
- Prerecorded classes:
  - 1/8: International workshop on multiscale laboratory astrophysics with the aid of data science

## Energetic charged particles losses most of its energy right before it stops



Momentum transfer:

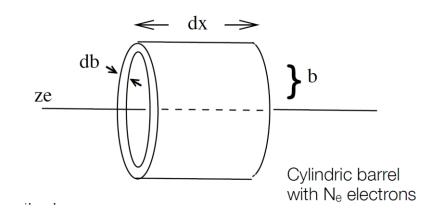
$$= \int_{-\infty}^{\infty} \frac{ze^2}{(x^2 + b^2)} \cdot \frac{b}{\sqrt{x^2 + b^2}} \cdot \frac{1}{v} \, dx = \frac{ze^2b}{v} \left[ \frac{x}{b^2 \sqrt{x^2 + b^2}} \right]_{-\infty}^{\infty} = \frac{2ze^2}{bv}$$

 $\Delta p_{\parallel}$ : averages to zero

$$\Delta E(b) = \frac{\Delta p^2}{2m_e}$$
 N<sub>e</sub> = n·(2πb)·dbdx

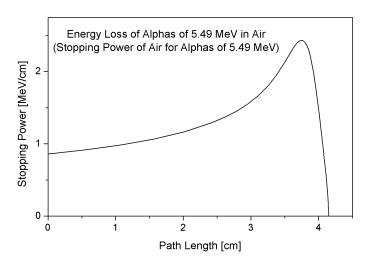
$$-dE(b) = \frac{\Delta p^2}{2m_e} \cdot 2\pi nb \, db \, dx$$

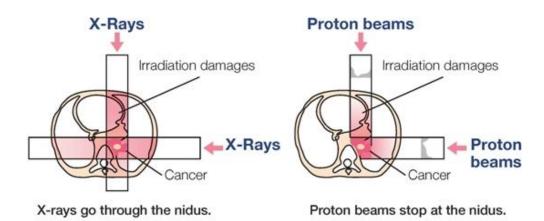
$$-\frac{dE}{dx} = \frac{4\pi \, n \, z^2 e^4}{m_{\rm e} v^2} \cdot \int_{b_{\rm min}}^{b_{\rm max}} \frac{db}{b} = \frac{4\pi \, n \, z^2 e^4}{m_{\rm e} v^2} \, \ln \frac{b_{\rm max}}{b_{\rm min}}$$



### Proton therapy takes the advantage of using Bragg peak





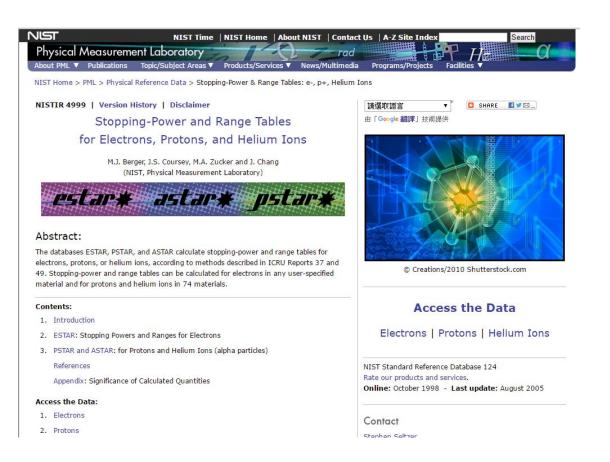


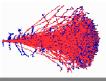


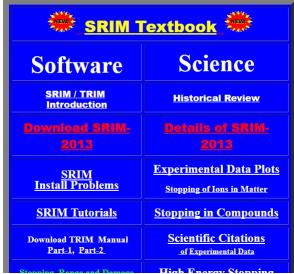
## There are two suggested website for getting the information of proton stopping power in different materials

## http://www.srim.org/



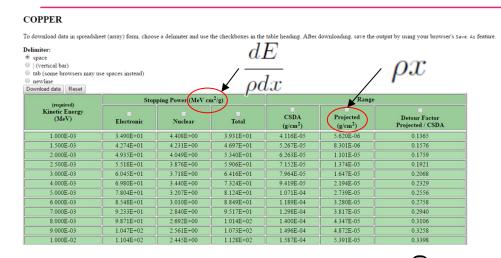


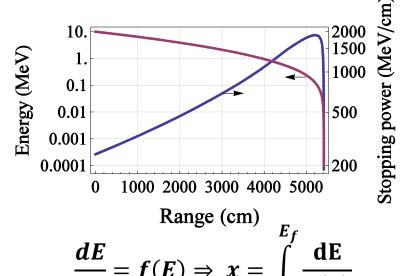


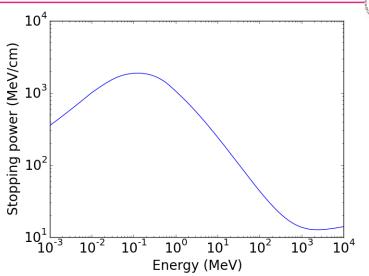


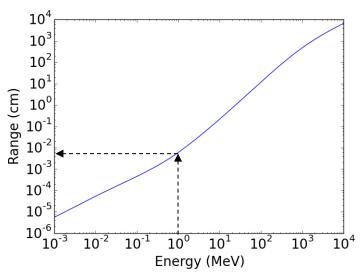


## The thickness of a filter can be decided from the range data from NIST website





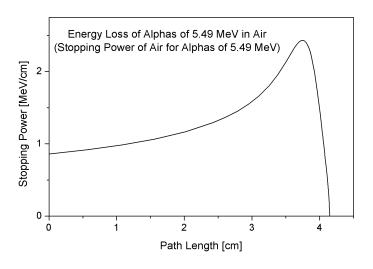


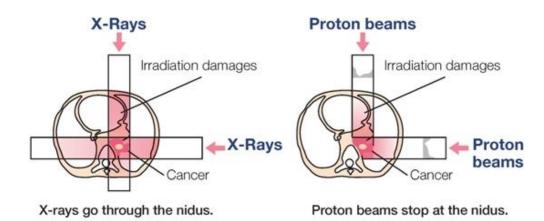




### Proton therapy takes the advantage of using Bragg peak



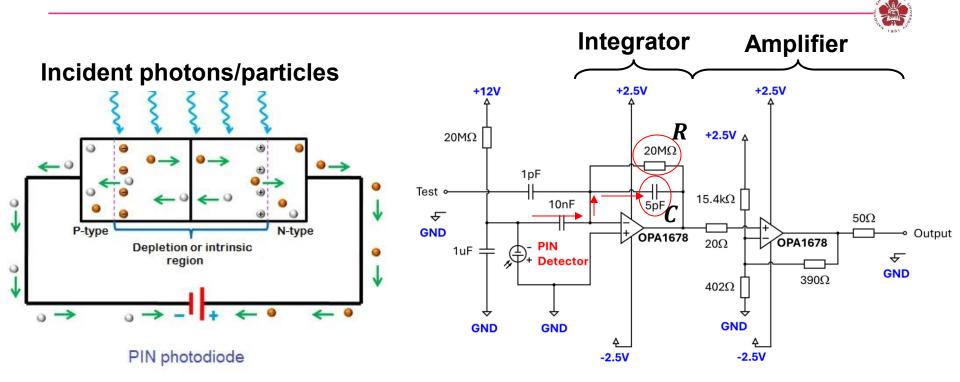




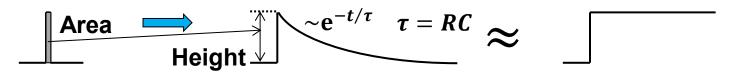


### Pulse shaping

## A pulse signal is converted to a voltage signal using an integrator



- The 5-pF capacitor is charged by the current from the PIN detector.
- The 5-pF capacitor is discharged by the 20-MΩ resistor.





## Pulse Shaping is commonly used in nuclear and particle physics electronics

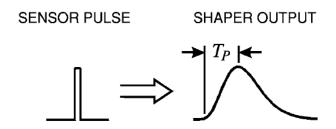


- Improve Signal-to-noise ratio S/N

   Restrict bandwidth to match measurement time.
  - => Increase pulse width.

Improve pulse-pair resolution

=> Decrease pulse width.



**FIGURE 13.** A pulse shaper transforms a short sensor pulse into a longer pulse with a rounded cusp and peaking time  $T_P$ .

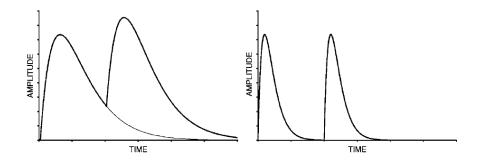
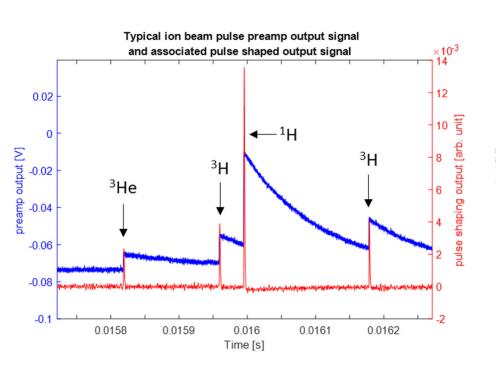
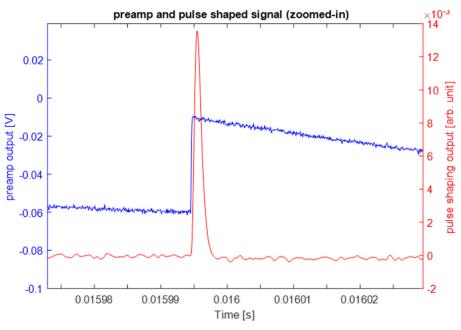


FIGURE 14. Amplitude pileup when two successive pulses overlap (left). Reducing the shaping time allows the first pulse to return to the baseline before the second arrives.

## **Expected data profile**



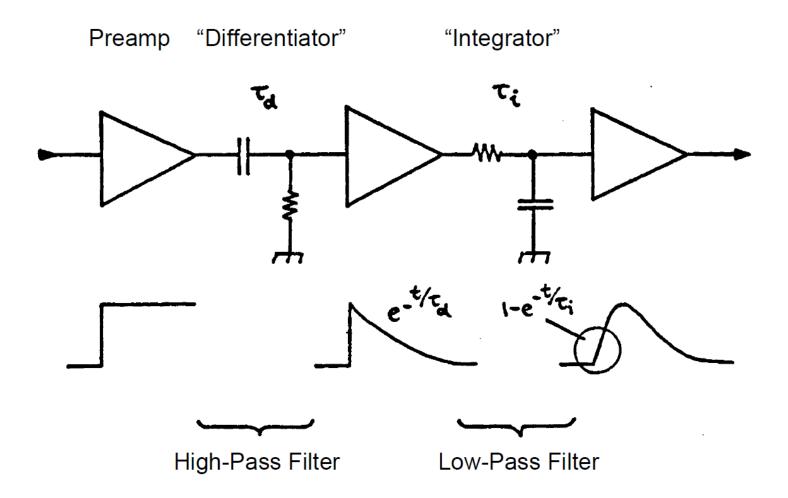






## CR-RC<sup>n</sup> pulse shaping combines a high-pass filter and n low-pass filter



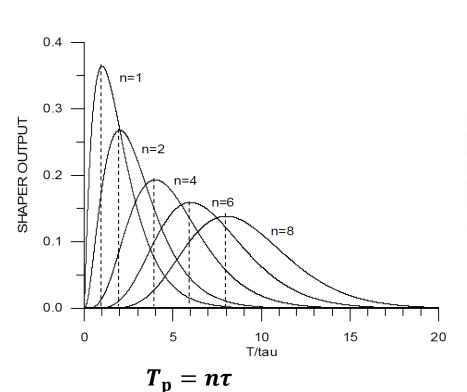




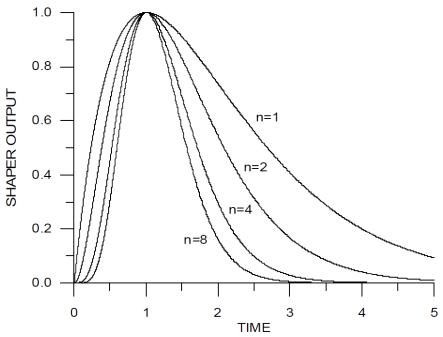
## Pulses become gaussian-like after multiple integrators



• Integrating with the same time constant  $\tau$ 



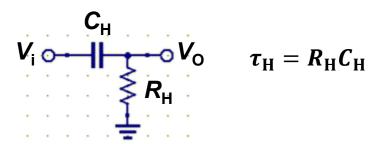
• Integrating with the reduced time constant  $\tau_n = \frac{\tau_1}{m}$ 



## CR is the high pass filter while RC is the low pass filter



#### CR circuit:



$$V_{o} = V_{i} \frac{R_{H}}{\frac{1}{j\omega C_{H}} + R_{H}} = V_{i} \frac{1}{\frac{1}{j\omega R_{H}C_{H}} + 1}$$
$$= V_{i} \frac{1}{\frac{1}{j\omega \tau_{H}} + 1}$$

For  $\omega \tau_{\rm H} \gg 1$ , i. e.,

$$\frac{2\pi f}{f_{
m H}} \gg 1 \ {
m or} \ f \gg f_{
m H} \ {
m or} \ \tau_{
m H} \gg t$$

 $V_{\rm o} \approx V_{\rm i}$  • High-pass filter!

#### RC circuit:

$$V_{l} \circ V_{o} \circ V_{o} \qquad \tau_{L} = R_{L}C_{L}$$

$$V_{o} = V_{i} \frac{\frac{1}{j\omega C_{L}}}{\frac{1}{j\omega C_{L}} + R_{L}} = V_{i} \frac{\frac{1}{j\omega R_{L}C_{L}}}{\frac{1}{j\omega R_{L}C_{L}} + 1}$$

$$= V_{i} \frac{\frac{1}{j\omega \tau_{L}}}{\frac{1}{j\omega \tau_{L}} + 1}$$

For 
$$\omega \tau_{\rm L} \ll 1$$
, i. e.,

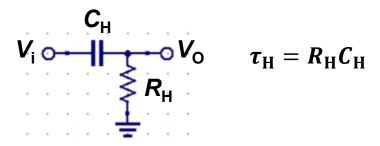
$$rac{2\pi f}{f_{
m L}} \ll 1 \ {
m or} \ f \ll f_{
m L} \ \ {
m or} \ \ t \ll au_{
m L}$$

 $V_{\rm o} \approx V_{\rm i}$  • Low-pass filter!

## CR is the high pass filter while RC is the low pass filter



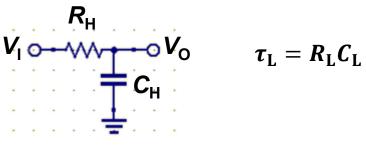
#### CR circuit:



$$egin{aligned} V_{\mathrm{i}} - V_{\mathrm{c}} - V_{\mathrm{o}} &= 0 & V_{\mathrm{o}} &= iR_{\mathrm{H}} \ V_{\mathrm{c}} &= rac{1}{C_{\mathrm{H}}} \int idt &= rac{1}{C_{\mathrm{H}}} \int rac{V_{\mathrm{o}}}{R_{\mathrm{H}}} dt \ \dot{V}_{\mathrm{i}} &= rac{V_{\mathrm{o}}}{ au_{\mathrm{H}}} + \dot{V}_{\mathrm{o}} \end{aligned}$$

$$V_o(t) = e^{-t/ au_{
m H}} \int_0^t \dot{V}_{
m i}(t') e^{t'/ au_{
m H}} dt'$$

#### RC circuit:

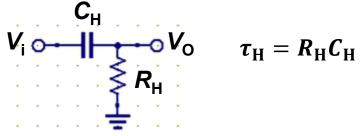


$$V_{\mathrm{i}} - V_{\mathrm{R}} - V_{\mathrm{o}} = 0$$
  $i = C_{\mathrm{L}}\dot{V}_{\mathrm{o}}$   $V_{\mathrm{R}} = iR_{\mathrm{L}} = R_{\mathrm{L}}C_{\mathrm{L}}\dot{V}_{\mathrm{o}}$   $V_{\mathrm{i}} = \tau_{\mathrm{L}}\dot{V}_{\mathrm{o}} + V_{\mathrm{o}}$ 

$$V_{0}(t) = e^{-t/\tau_{\mathrm{L}}} \frac{1}{\tau_{\mathrm{L}}} \int_{0}^{t} V_{\mathrm{i}}(t') e^{t'/\tau_{\mathrm{L}}} dt'$$

## A step function becomes an exponential decay after the high-pass filter

#### CR circuit:



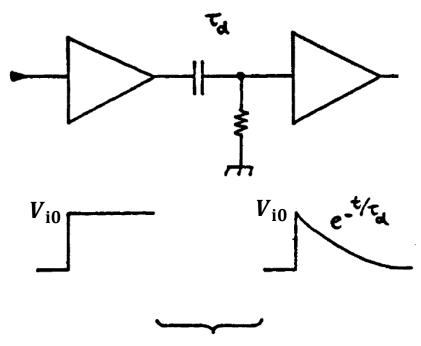
$$V_{0}(t) = e^{-t/\tau_{\mathrm{H}}} \int_{0}^{t} \dot{V}_{\mathrm{i}}(t') e^{t'/\tau_{\mathrm{H}}} dt'$$

$$V_{i}(t) = \begin{cases} 0 & t < 0 \\ V_{i0} & t \ge 0 \end{cases}$$

$$\dot{V}_{\rm i}(t) = V_{\rm i0}\delta(t)$$

$$V_{0}(t) = e^{-t/\tau_{H}} \int_{0}^{t} V_{i0} \delta(t') e^{t'/\tau_{H}} dt'$$

$$= V_{i0} e^{-t/\tau_{H}} e^{t'/\tau_{H}} \Big|_{t'=0} = V_{i0} e^{-t/\tau_{H}}$$

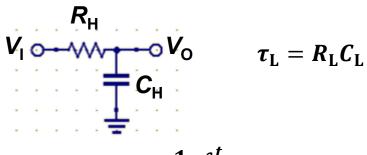


High-Pass Filter

## CR is the high pass filter while RC is the low pass filter



#### RC circuit:



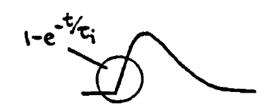
$$V_{0}(t) = e^{-t/\tau_{L}} \frac{1}{\tau_{L}} \int_{0}^{t} V_{i}(t') e^{t'/\tau_{L}} dt'$$

$$V_{\rm i}(t) = V_{\rm i0}e^{-t/\tau_{\rm H}}$$

For 
$$t \ll au_L$$
  $e^{-t/ au_L} \sim e^{t/ au_L} \sim 1$ 

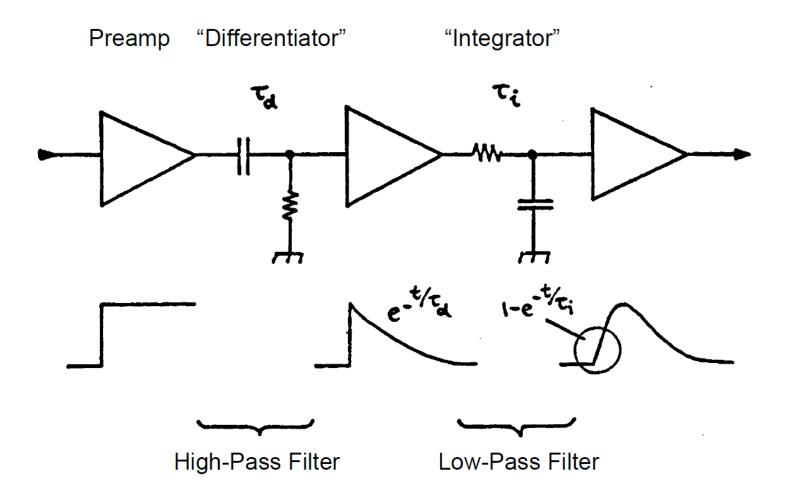
$$V_{0}(t) \sim \frac{1}{\tau_{L}} \int_{0}^{t} V_{i}(t') dt' = \frac{1}{\tau_{L}} \int_{0}^{t} V_{i0} e^{-t'/\tau_{H}} dt'$$
$$= \frac{\tau_{H}}{\tau_{I}} V_{i0} (1 - e^{-t/\tau_{H}})$$

$$egin{aligned} V_{0}(t) &= e^{-t/ au_{L}} rac{1}{ au_{L}} \int_{0}^{t} V_{i0} e^{-t'/ au_{H}} e^{t'/ au_{L}} dt' \ &= e^{-t/ au_{L}} rac{1}{ au_{L}} \int_{0}^{t} V_{i0} e^{t'/ au_{eff}} dt' \ &= e^{-t/ au_{L}} rac{ au_{eff}}{ au_{L}} V_{i0} ig( e^{t/ au_{H}} - 1 ig) \ &rac{1}{ au_{eff}} = rac{1}{ au_{L}} - rac{1}{ au_{H}} < rac{1}{ au_{L}} \end{aligned}$$



## CR-RC<sup>n</sup> pulse shaping combines a high-pass filter and n low-pass filter



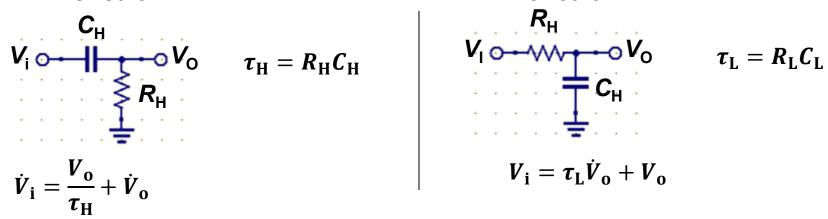




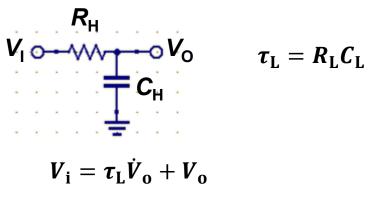
## Finite difference method is used to numerically applying the CR-RC pulse shaping



#### CR circuit:



#### RC circuit:



$$\begin{split} \frac{V_{i}(t_{j}) - V_{i}(t_{j-1})}{\Delta t} &\approx \frac{V_{o}(t_{j-1})}{\tau_{H}} + \frac{V_{o}(t_{j}) - V_{o}(t_{j-1})}{\Delta t} \\ &\approx \frac{V_{o}(t_{j})}{\tau_{H}} + \frac{V_{o}(t_{j}) - V_{o}(t_{j-1})}{\Delta t} \\ V_{o}(t_{j}) &= \alpha_{CR}V_{o}(t_{j-1}) + \alpha_{CR}[V_{i}(t_{j}) - V_{i}(t_{j-1})] \end{split}$$

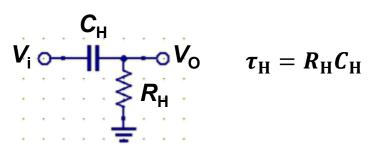
$$lpha_{\mathrm{CR}} \equiv rac{rac{ au_{\mathrm{H}}}{\Delta t}}{rac{ au_{\mathrm{H}}}{\Delta t} + 1} = rac{rac{R_{\mathrm{H}}C_{\mathrm{H}}}{\Delta t}}{rac{R_{\mathrm{H}}C_{\mathrm{H}}}{\Delta t} + 1}$$

$$rac{dV}{dt} = \lim_{\Delta t o 0} rac{V(t_{
m j}) - V(t_{
m j-1})}{\Delta t}$$
 $pprox rac{V(t_{
m j}) - V(t_{
m j-1})}{\Delta t}$ 
 $t_{
m i-1} \ t_{
m i} \ t_{
m i+1} \ ext{time}$ 

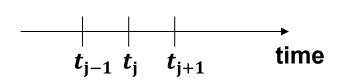
# Finite difference method is used to numerically applying the CR-RC pulse shaping



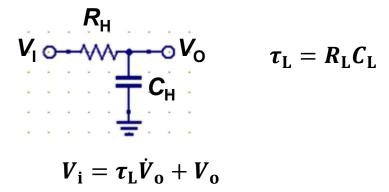
#### CR circuit:



$$\dot{V}_{i} = \frac{V_{o}}{\tau_{H}} + \dot{V}_{o}$$

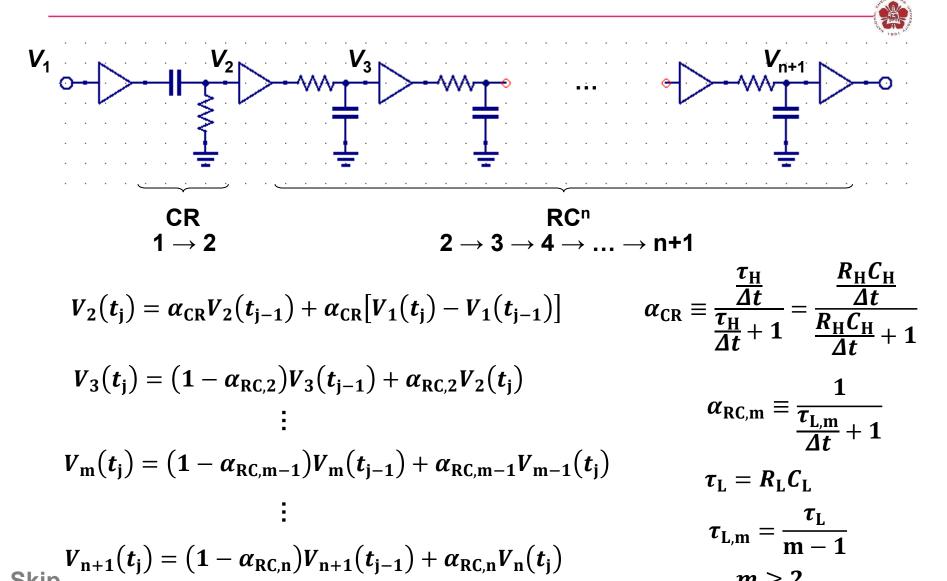


#### RC circuit:



$$\begin{split} V_{i}(t_{j}) \approx \tau_{L} \frac{V_{o}(t_{j}) - V_{o}(t_{j-1})}{\Delta t} + V_{o}(t_{j-1}) \\ \approx \tau_{L} \frac{V_{o}(t_{j}) - V_{o}(t_{j-1})}{\Delta t} + V_{o}(t_{j}) \\ V_{o}(t_{j}) = (1 - \alpha_{RC})V_{o}(t_{j-1}) + \alpha_{RC}V_{i}(t_{j}) \\ \alpha_{RC} \equiv \frac{1}{\frac{\tau_{L}}{\Delta t} + 1} = \frac{1}{\frac{R_{L}C_{L}}{\Delta t} + 1} \end{split}$$

## Iteration can be used to have more orders of CR-RC<sup>n</sup> pulse shaping



m > 2

## Let's try using excel first



$$lpha_{\mathrm{CR}} \equiv 0.85$$
 $lpha_{\mathrm{RC,2}} \equiv 0.15$ 
 $\Delta t = 64 \ \mathrm{ns}$ 

$$lpha_{\mathrm{CR}} \equiv rac{rac{ au_{\mathrm{H}}}{\Delta t}}{rac{ au_{\mathrm{H}}}{\Delta t} + 1} = 0.85$$

$$lpha_{RC,m}\equiv rac{1}{rac{ au_{L,m}}{arDelta t}+1}=0.\,15$$

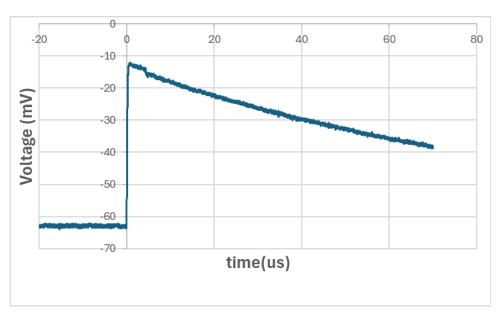
$$au_{ extsf{L}, ext{m}} = rac{ au_{ extsf{L}}}{m-1}$$

$$\tau_{\rm H} = 362.7 \ \rm ns$$

$$\tau_{\rm L.m} = 362.7/(m-1) \text{ ns}$$

$$\frac{\tau_{\rm L}}{\Lambda t} = \frac{0.85}{0.15}$$

$$lpha_{
m RC,m}\equivrac{1}{rac{0.85}{0.15}rac{1}{m-1}+1}$$



$$V_2(t_j) = \alpha_{CR}V_2(t_{j-1}) + \alpha_{CR}[V_1(t_j) - V_1(t_{j-1})]$$

$$\tau_{L,m} = 362.7/(m-1) \text{ ns} \quad V_3(t_j) = (1 - \alpha_{RC,2})V_3(t_{j-1}) + \alpha_{RC,2}V_2(t_j)$$

$$V_{\rm m}(t_{\rm j}) = (1 - \alpha_{\rm RC,m-1})V_{\rm m}(t_{\rm j-1}) + \alpha_{\rm RC,m-1}V_{\rm m-1}(t_{\rm j})$$

1 
$$V_{n+1}(t_j) = (1 - \alpha_{RC,n})V_{n+1}(t_{j-1}) + \alpha_{RC,n}V_n(t_j)$$

### Let's try using excel first

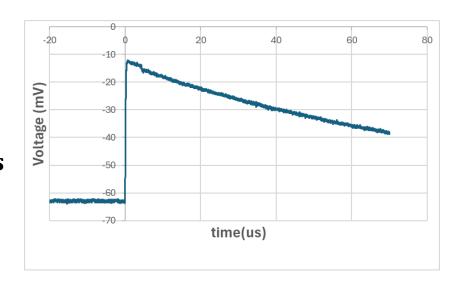


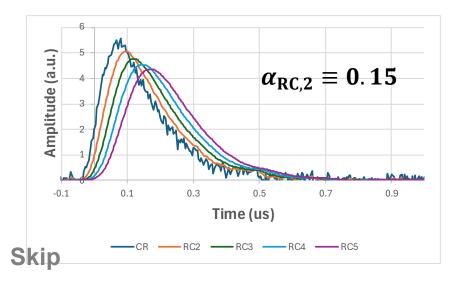
$$\Delta t = 64 \text{ ns}$$

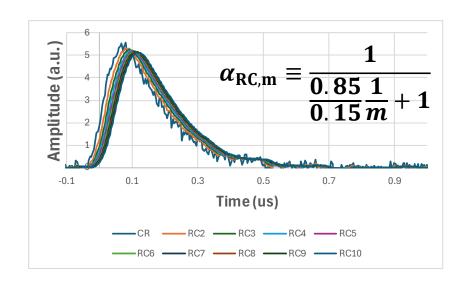
$$\alpha_{\rm CR} \equiv 0.85$$

$$\tau_{\rm H} = 362.7 \ \rm ns$$

$$\tau_{\rm L,m} = 362.7/(m-1)~{\rm ns}$$







## When the pulse is not sharp enough, no significant gaussian feature is observed

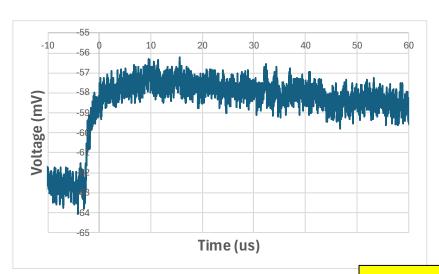


$$\Delta t = 64 \text{ ns}$$

$$\alpha_{\rm CR} \equiv 0.85$$

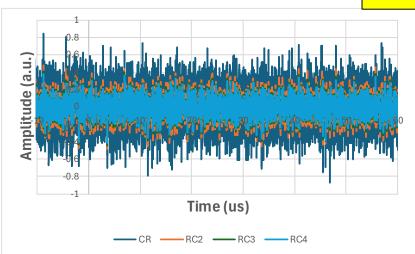
$$\tau_{\rm H} = 362.7 \ \rm ns$$

$$\tau_{\rm L,m} = 362.7/(m-1)~{\rm ns}$$



#### What's the source?

$$\alpha_{\text{RC,m}} \equiv \frac{1}{\frac{0.85}{0.15} \frac{1}{m-1} + 1}$$



#### Saha equation

## Saha equation gives the relative proportions of atoms of a certain species that are in two different states of ionization in thermal equilibrium



$$\frac{n_{r+1}n_e}{n_r} = \frac{G_{r+1}g_e}{G_r} \frac{(2\pi m_e KT)^{3/2}}{h^3} \exp\left(-\frac{\chi_r}{KT}\right)$$

- n<sub>r+1</sub>, n<sub>r</sub>: Density of atoms in ionization state r+1, r (m<sup>-3</sup>)
- n<sub>e</sub>: Density of electrons (m<sup>-3</sup>)
- G<sub>r+1</sub>, G<sub>r</sub>: Partition function of ionization state r+1, r
- g<sub>o</sub>=2: Statistical weight of the electron
- m<sub>e</sub>: Mass of the electron
- χ<sub>r</sub>: Ionization potential of ground level of state r to reach to the ground level of state r+1
- T: Temperature
- h: Planck's constant
- K: Boltzmann constant



## Some backgrounds of quantum mechanics



Planck blackbody function:

$$u(\nu, T) = \frac{8\pi h \nu^3}{c^3} \frac{1}{e^{h\nu/KT} - 1} (W/m^3 Hz)$$

- Boltzmann formula:
  - g<sub>i</sub>, g<sub>i</sub>: statistical weight

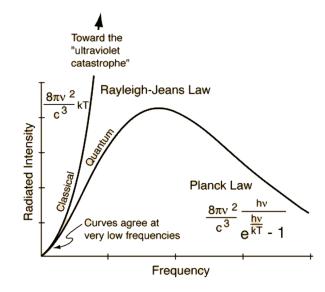
$$\frac{n_i}{n_j} = \frac{g_i e^{-\epsilon_i/\text{KT}}}{g_j e^{-\epsilon_j/\text{KT}}} = \frac{g_i}{g_j} e^{-h\nu_{ij}/\text{KT}} \qquad \frac{g_i}{g_j} = \frac{2J_i + 1}{2J_j + 1}$$

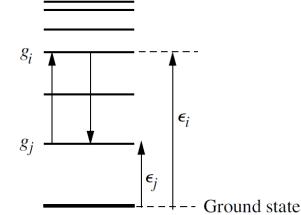
(J: angular momenta quantum number)

– Number in the i<sup>th</sup> state to the total atom:

$$\frac{n_i}{n} = \frac{n_i}{\Sigma n_i} \equiv \frac{g_i e^{-\epsilon_i/\text{KT}}}{G} \qquad G \equiv \Sigma g_j e^{-\epsilon_j/\text{KT}}$$

G: partition function of statistical weight for the atom, taking into account all its excited states.







### Einstein coefficient



- Probability of electron energy transition:
  - Excitation ( $\uparrow$ ):  $P_{ji} = B_{ji}u(\nu, T)$
  - De-excitation ( $\downarrow$ ):  $P_{ij} = A_{ij} + B_{ij}u(\nu, T)$
- In thermal equilibrium:

$$n_{i}(A_{ij} + B_{ij}u) = n_{j}B_{ji}u$$

$$\frac{g_{i}}{g_{j}}e^{-x}(A_{ij} + B_{ij}u) = B_{ji}u$$

$$x \equiv \frac{h\nu}{KT}$$

$$u = a(e^{x} - 1)^{-1}$$

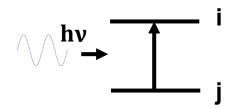
$$a \equiv \frac{8\pi h\nu^{3}}{c^{3}}$$

$$a\left(e^{x}B_{ji} - \frac{g_{i}}{g_{i}}B_{ij}\right) = (e^{x} - 1)\frac{g_{i}}{g_{i}}A_{ij}$$

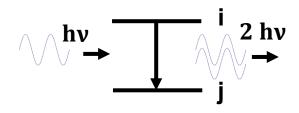
• The Einstein coefficients are independent of T or  $\nu$ .

$$x \to 0, e^x \to 1$$
  $x \to \infty, e^x \to \infty$  
$$\frac{B_{ij}}{B_{ij}} = \frac{g_j}{a_i}$$
 
$$aB_{ji} = \frac{g_i}{a_i} A_{ij} \quad \frac{A_{ij}}{B_{ij}} = \frac{8\pi h v^3}{c^3}$$

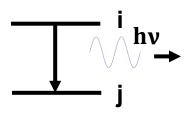
Photoexcitation:



Induced radiation:



Spontaneous radiation:



## Saha equation is derived using the transition between different ionization states

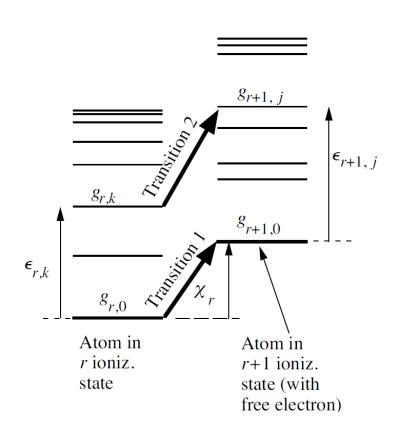


 Required photon energy for transition 1 from the ground state of r ionization state to the ground state of r+1 ionization state:

$$hv = \chi_r + \frac{p^2}{2m}$$
 Energy of the free electron

 Required photon energy for transition 2 from the energy level k of r ionization state to the energy level j of r+1 ionization state:

$$hv = \chi_r + \epsilon_{r+1,j} - \epsilon_{r,k} + \frac{p^2}{2m}$$



## Saha equation is derived using the transition between different ionization states



#### Photoionization:

$$R_{\mathrm{pi}} = n_{r,k} u(\nu) B_{r,k \to r+1,j}$$

Induced radiation:

$$R_{ir} = n_{r+1,j} n_{e,p}(p) u(\nu) B_{r+1,j \to r,k}$$

Spontaneous emission:

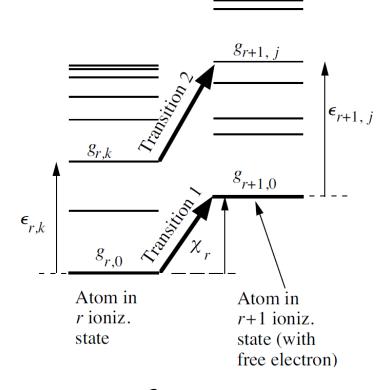
$$R_{\rm sr} = n_{r+1,j} n_{e,p}(p) A_{r+1,j\to r,k}$$

In thermal equilibrium:

$$n_{r+1,j}n_{e,p}A_{r+1,j\to r,k} + n_{r+1,j}n_{e,p}uB_{r+1,j\to r,k}$$
  
=  $n_{r,k}uB_{r,k\to r+1,j}$ 

Einstein coefficients:

$$\frac{B_{r,k\to r+1,j}}{B_{r+1,j\to r,k}} = \frac{g_{r+1,j}}{g_{r,k}} \frac{g_e 4\pi p^2}{h^3}$$



$$\frac{A_{r+1,j\to r,k}}{B_{r+1,j\to r,k}} = \frac{8\pi h \nu^3}{c^3}$$

## Saha equation - continued



 $\frac{B_{r,k\to r+1,j}}{B_{r+1,j\to r,k}} = \frac{g_{r+1,j}}{g_{r,k}} \frac{g_e 4\pi p^2}{h^3}$ 

$$n_{r+1,j}n_{e,p}A_{r+1,j\to r,k} + n_{r+1,j}n_{e,p}uB_{r+1,j\to r,k} = n_{r,k}uB_{r,k\to r+1,j}$$

$$n_{r+1,j}n_{e,p}rac{A_{r+1,j o r,k}}{B_{r+1,j o r,k}}+n_{r+1,j}n_{e,p}u=n_{r,k}urac{B_{r,k o r+1,j}}{B_{r+1,j o r,k}}$$

$$\frac{n_{r+1,j}n_{e,p}}{n_{r,k}} = \left(\frac{A_{r+1,j\to r,k}}{uB_{r+1,j\to r,k}} + 1\right)^{-1} \frac{B_{r,k\to r+1,j}}{B_{r+1,j\to r,k}}$$

$$n_{e,p}(p) = \frac{n_e 4\pi p^2}{(2\pi m KT)^{3/2}} \exp\left(-\frac{p^2}{2m KT}\right)$$
  $\frac{A_{r+1,j\to r,k}}{B_{r+1,j\to r,k}} = \frac{8\pi h \nu^3}{c^3}$ 

$$\frac{n_{r+1,j}n_e}{n_{r,k}} = \frac{(2\pi m KT)^{3/2}}{4\pi p^2} \exp\left(\frac{p^2}{2m KT}\right) \left[\frac{c^3}{8\pi h \nu^3} \left(e^{h\nu/KT} - 1\right) \frac{8\pi h \nu^3}{c^3} + 1\right]^{-1} \frac{g_{r+1,j}}{g_{r,k}} \frac{g_e 4\pi p^2}{h^3}$$

$$\frac{n_{r+1,j}n_e}{n_{r,k}} = \frac{(2\pi m KT)^{3/2}}{h^3} \frac{g_{r+1,j}g_e}{g_{r,k}} \exp\left[\frac{1}{KT} \left(\frac{p^2}{2m} - h\nu\right)\right]$$



## Saha equation - continued



$$\frac{n_{r+1,j}n_e}{n_{r,k}} = \frac{(2\pi m KT)^{3/2}}{h^3} \frac{g_{r+1,j}g_e}{g_{r,k}} \exp\left[\frac{1}{KT} \left(\frac{p^2}{2m} - h\nu\right)\right]$$

$$\frac{n_{r+1,j}n_e}{n_{r,k}} = \frac{(2\pi m KT)^{3/2}}{h^3} \frac{g_{r+1,j}g_e}{g_{r,k}} \exp\left[\frac{1}{KT} \left(\frac{p^2}{2m} - \chi_r - \epsilon_{r+1,j} + \epsilon_{r,k} - \frac{p^2}{2m}\right)\right]$$

$$\frac{n_{r+1,j}n_e}{n_{r,k}} = \frac{(2\pi m KT)^{3/2}}{h^3} \frac{g_{r+1,j} exp\left(\frac{\epsilon_{r+1,j}}{KT}\right)g_e}{g_{r,k} exp\left(\frac{\epsilon_{r,k}}{KT}\right)} exp\left(-\frac{\chi_r}{KT}\right)$$

$$rac{n_{r,k}}{n_r} = rac{g_{r,k}e^{-\epsilon_{r,k}/\mathrm{KT}}}{G_r}$$
  $G_r = \Sigma g_{r,k}e^{-\epsilon_{r,k}/\mathrm{KT}}$ 

$$\frac{n_{r+1,j}}{n_{r+1}} = \frac{g_{r+1,j}e^{-\epsilon_{r+1,j}/KT}}{G_{r+1}} \qquad G_{r+1} = \sum g_{r+1,j}e^{-\epsilon_{r+1,j}/KT}$$

$$\frac{n_{r+1}n_e}{n_r} = \frac{G_{r+1}g_e}{G_r} \frac{(2\pi m_e KT)^{3/2}}{h^3} \exp\left(-\frac{\chi_r}{KT}\right)$$



### Saha equation – example: hydrogen plasma of the sun



- Photosphere of the sun hydrogen atoms in an optically thick gas in thermal equilibrium at temperature T=6400 K.
  - Neutral hydrogen (r state / ground state)

$$G_r = \Sigma g_{r,k} = g_{r,0} + g_{r,1} \exp\left(-\frac{\epsilon_{r,1}}{KT}\right) + \dots = 2 + 8 \exp\left(-\frac{10.2 \text{ eV}}{0.56 \text{ eV}}\right) + \dots$$
  
= 2 + 9.8 × 10<sup>-8</sup> + \dots \approx 2

lonized state (r+1 state)

$$G_{r+1} = \Sigma g_{r+1,j} = g_{r+1,0} + g_{r+1,1} \exp\left(-\frac{\epsilon_{r+1,1}}{KT}\right) + \cdots \approx 1$$

– Other information:  $g_e=2$   $\chi_r=13.6 \,\mathrm{eV}; \ \mathrm{kT}=0.56 \,\mathrm{eV}$   $n_{r+1}=n_e$ 

$$\frac{n_{r+1}^2}{n_r} = 2.41 \times 10^{21} \frac{1 \times 2}{2} (6400)^{3/2} \exp\left(-\frac{13.6}{0.56}\right) = 3.5 \times 10^{16} m^{-3}$$

### It is mostly neutral in the photosphere of the sun



Assuming 50 % ionization:

$$n_{r+1} = n_r = 3.5 \times 10^{16} m^{-3}$$
  $n = n_{r+1} + n_r = 7 \times 10^{16} m^{-3}$ 

In the photosphere of the sun:

$$ho \sim 3 \times 10^{-4} \, \mathrm{kg}/m^3 \rightarrow n = 2 \times 10^{23} m^{-3} \gg 7 \times 10^{16} m^{-3}$$

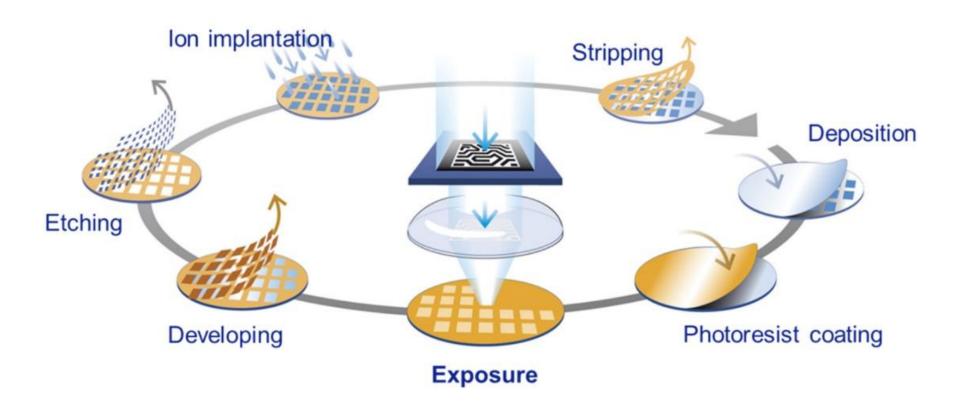
- At higher densities n at the same temperature, there should be more collisions leading to higher recombination rate and thus the plasma is less than 50 % ionization.
  - ⇒ Less than 50 % ionization
- Use the total number density to estimate the ionization percentage:

$$n_{r+1} + n_r = 2 \times 10^{23}$$

$$\frac{n_{r+1}}{n_r} = 4 \times 10^{-4} @6400K$$

## A semiconductor device is fabricated by many repetitive production process

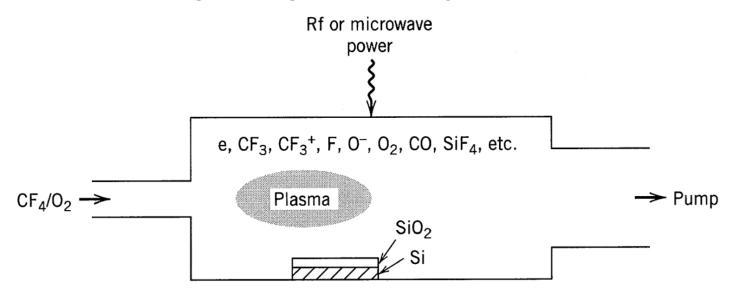




### Reference for material processing



- Principles of plasma discharges and materials processing, 2<sup>nd</sup> edition, by Michael A. Lieberman and Allan J. Lichtenberg
- http://www.eecs.berkeley.edu/~lieber/
- Materials science of thin films, 2<sup>nd</sup> edition, by Milton Ohring
- Plasma etching, by Dennis M. Manos and Daniel L. Flamm
- Industrial plasma engineering, volume 1, by J. Reece Roth

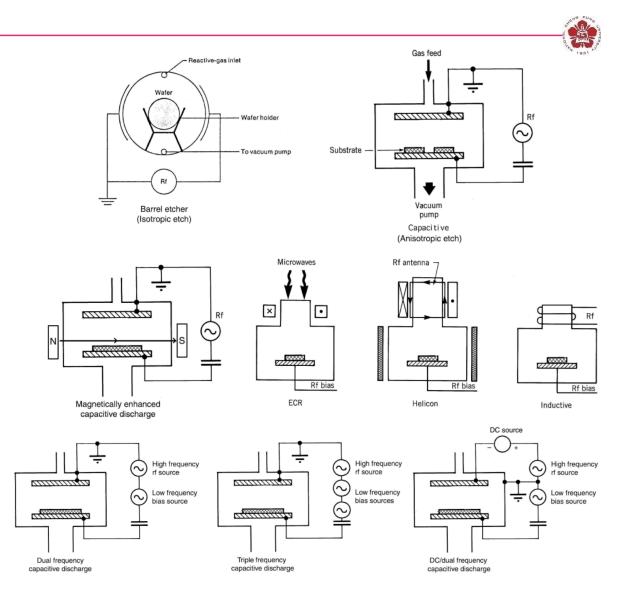


### **Evolution of etching discharges**

1<sup>st</sup> generation (1 source, multi-wafer, low density)

2<sup>nd</sup> generation (2 sources, single-wafer, high density)

3<sup>rd</sup> generation (multi-sources, singlewafer, moderate density)

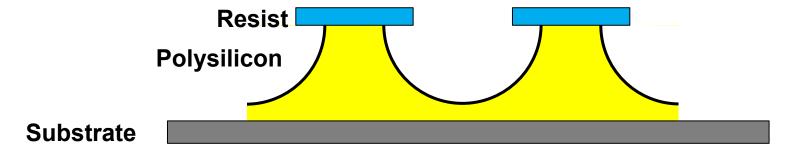




### There are two types of etching: isotropic vs anistropic



Isotropic etching



• Anisotropic etching

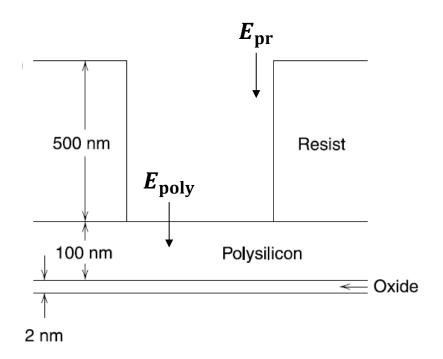
Resist

Polysilicon

Substrate

### Plasma etch requirements – etch rate





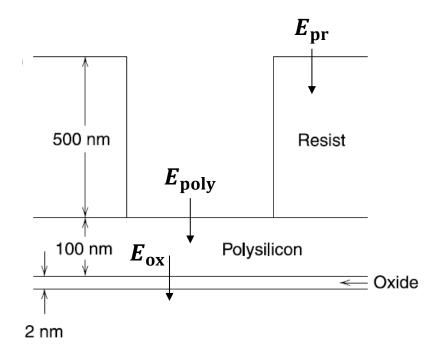
 Etch time needs to be within a few minutes:

$$E_{\rm pr} \ge 250\,{\rm nm/min}$$

$$E_{\text{poly}} \geq 50 \, \text{nm/min}$$

### Plasma etch requirements - selectivity





 Selectivity between polysilicon and resist:

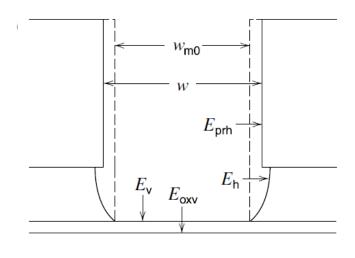
$$s = \frac{E_{\text{poly}} \triangle t}{E_{\text{pr}} \triangle t} >> \frac{100 \text{nm}}{500 \text{nm}} = 0.2$$

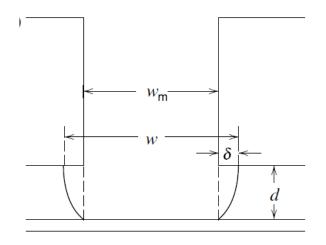
 Assuming 20% nonuniformity on the wafer:

$$s = \frac{E_{\text{poly}} \triangle t}{E_{\text{ox}} \triangle t} >> \frac{20\% \times 100 \text{nm}}{2 \text{nm}} = 10$$

### Plasma etch requirements – Anisotropy







### Anisotropy

$$a_{h} = \frac{E_{v}}{E_{h}} = \frac{d}{\delta}$$

$$w = w_{m} + 2\delta$$

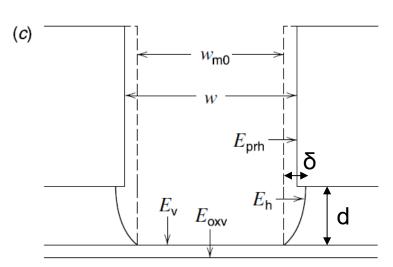
$$a_{h} \ge \frac{2d}{w - w_{m}}$$

 The smallest feature size where w<sub>m</sub>=0:

$$w \approx \frac{2d}{a_{\rm h}}$$

# Plasma etch requirements – Anisotropy including etching on photoresist



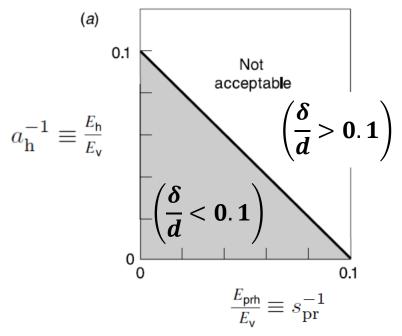


$$\delta \approx (E_{\rm h} + E_{\rm prh}) t$$

$$t = \frac{d}{E_{\rm v}}$$

$$\delta \approx d \frac{E_{\rm h} + E_{\rm prh}}{E_{\rm v}}$$

$$\frac{E_{\rm h} + E_{\rm prh}}{E_{\rm v}} \approx \frac{\delta}{d}$$



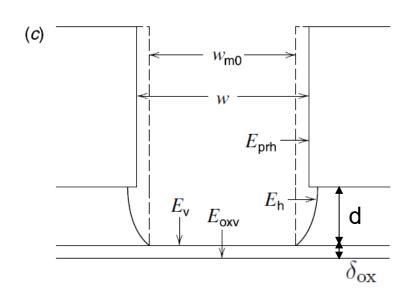
$$\frac{E_h}{E_V} + \frac{E_{\text{prh}}}{E_V} = a_h^{-1} + s_{\text{pr}}^{-1} \approx \frac{\delta}{d} \equiv 0.1$$

 The contribution of the horizontal etching is from both E<sub>h</sub> and E<sub>prh</sub>.

Principles of plasma discharges and materials processing, 2<sup>nd</sup> edition, by Michael A. Lieberman and Allan J. Lichtenberg

# Plasma etch requirements – Uniformity on selectivity and anisotropy



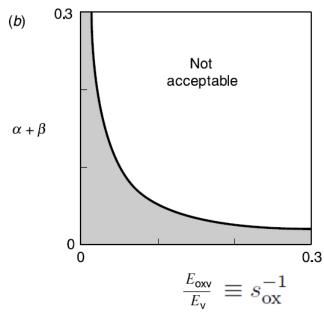


$$d \rightarrow d(1 \pm \alpha)$$
  $E_{v} \rightarrow E_{v}(1 \pm \beta)$ 

where  $\alpha$ ,  $\beta$  are variations.

$$t_{\text{max}} = \frac{d(1+\alpha)}{E_{\text{v}}(1-\beta)} \approx \frac{d}{E_{\text{v}}}(1+\alpha+\beta)$$

$$t_{\min} = \frac{d(1-\alpha)}{E_{\nu}(1+\beta)} \approx \frac{d}{E_{\nu}}(1-\alpha-\beta)$$



$$\delta_{\text{ox}} = (t_{\text{max}} - t_{\text{min}}) E_{\text{oxv}}$$
$$= \frac{d}{E_{\text{v}}} 2(\alpha + \beta) E_{\text{oxv}}$$
$$F \qquad \delta$$

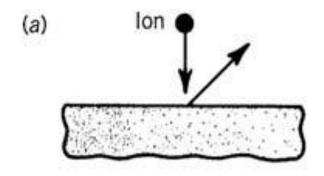
$$2(\alpha + \beta) \frac{E_{\text{oxv}}}{E_{\text{v}}} = \frac{\delta_{\text{ox}}}{d}$$

Principles of plasma discharges and materials processing, 2<sup>nd</sup> edition, by Michael A. Lieberman and Allan J. Lichtenberg

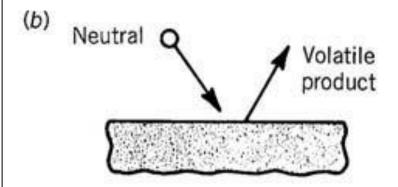
### There are four major plasma etching mechanisms

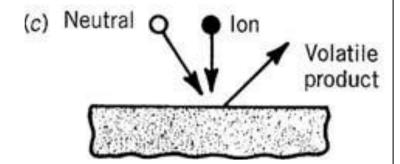


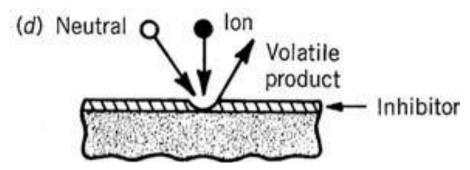












Ion energy-driven etching

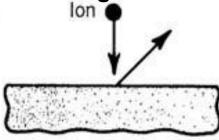
lon-enhanced inhibitor etching

### Sputtering etching

### Sputtering is an unselective but anisotropic process

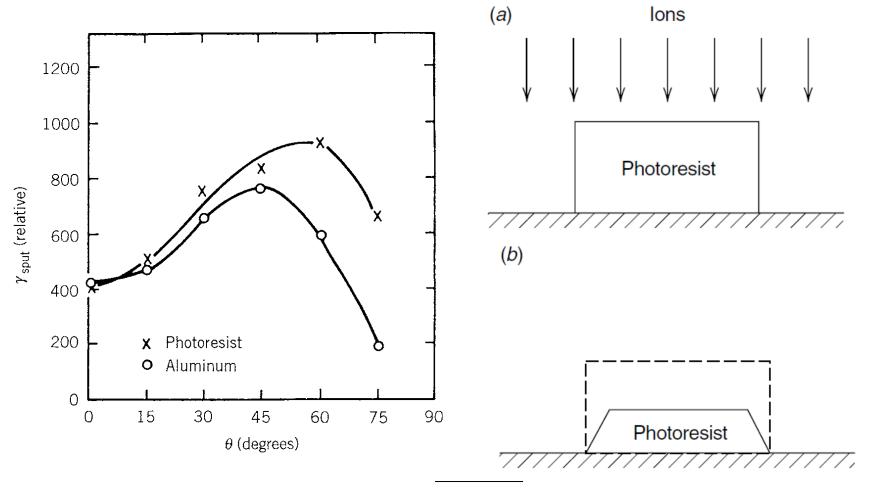


- Unselective process.
- Anisotropic process, strongly sensitive to the angle of incidence of the ion.
- Sputtering rates of different materials are roughly the same.
- Sputtering rates are generally low because the yield is typically of order one atom per incident ion.
- Sputtering is the only one of the four etch processes that can remove nonvolatile products from a surface.
- The process is generally under low pressure since the mean free path of the sputtered atoms must be large enough to prevent redeposition on the substrate or target.



# Topographical patterns might not be faithfully transferred during sputter etching





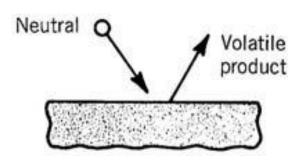
Principles of plasma discharges and materials processing, 2<sup>nd</sup> edition, by Michael A. Lieberman and Allan J. Lichtenberg

### **Pure chemical etching**

## Atoms or molecules chemically react with the surface to form gas-phase products

Highly chemically selective, e.g.,

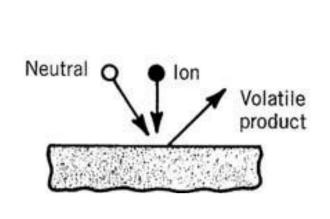
$$Si(s) + 4F \longrightarrow SiF_4(g)$$
  
photoresist + O(g)  $\longrightarrow CO_2(g) + H_2O(g)$ 

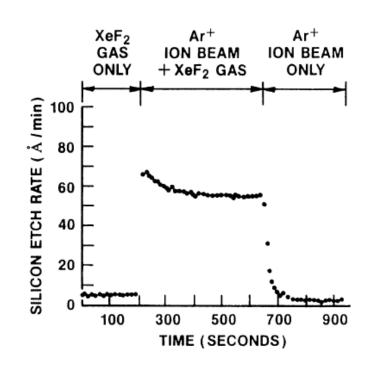


- Almost invariably isotropic.
- Etch products must be volatile.
- The etch rate can be quite large.
- Etch rate are generally not limited by the rate of arrival of etchant atoms, but by one of a complex set of reactions at the surface leading to formation of etch products.

### Ion-enhanced energy-driven etching

# The discharge supplies both etchants and energetic ions to the surface





- Low chemical etch rate of silicon substrate in XeF2 etchant gas.
- Tenfold increase in etch rate with XeF<sub>2</sub> + 500 V argon ions, simulating ionenhanced plasma etching.
- Very low "etch rate" due to the physical sputtering of silicon by ion bombardment alone.

  Plasma etching, by Daniel L. Flamm and G. Kenneth Herb

# Ion-enhanced energy-driven etching has the characteristic of both sputtering and pure chemical etching

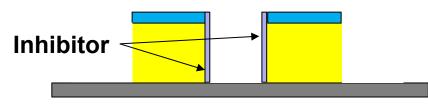
- Chemical in nature but with a reaction rate determined by the energetic ion bombardment.
- Product must be volatile.
- Highly anisotropic.

### Ion-enhanced inhibitor etching

### An inhibitor species is used



- Inhibitor precursor molecules that absorb or deposit on the substrate form a protective layer or polymer film.
- Etchant is chosen to produce a high chemical etch rate of the substrate in the absence of either ion bombardment or the inhibitor.
- Ion bombardment flux prevents the inhibitor layer from forming or clears it as it forms.
- Where the ion flux does not fall, the inhibitor protects the surface (side wall) from the etchant.
- May not be as selective as pure chemical etching.
- A volatile etch product must be formed.
- Contamination of the substrate and final removal of the protective inhibitor film are other issues.



→ Inhibitor

## **Comparison of different processes**



	Sputtering etching	Pure chemical etching		Ion-enhanced Inhibitor etching
Selectivity	X	0	0	0
Anisotropic	0	X	0	0
Volatile product	X	0	0	0

**TABLE 15.1. Etch Chemistries Based on Product Volatility** 

Material	Etchant Atoms
Si, Ge	F, Cl, Br
$SiO_2$	F, F + C
Si <sub>3</sub> N <sub>4</sub> , silicides	F
Al	Cl, Br
Cu	Cl $(T > 210^{\circ} \text{C})$
C, organics	O
W, Ta, Ti, Mo, Nb	F, Cl
Au	Cl
Cr	Cl, Cl + O
GaAs	Cl, Br
InP	Cl, C + H

### **Deposition and implementation**

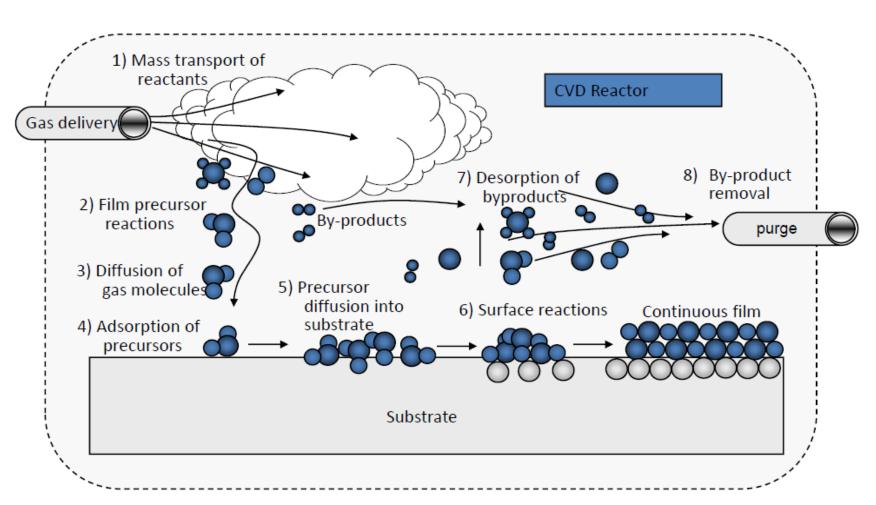


- Plasma-assisted deposition, implantation, and surface modification are important material processes for producing films on surfaces and modifying their properties
- Example processes:
  - Plasma-enhanced chemical vapor deposition (PECVD)
  - Sputter deposition / physical vapor deposition (PVD)
  - Plasma-immersion ion implantation (PIII)



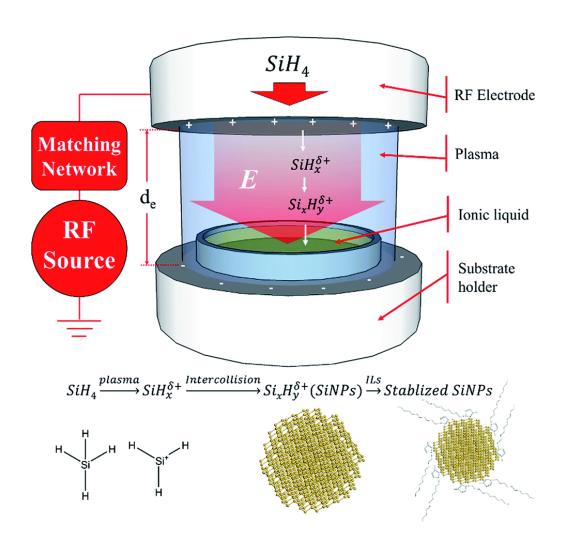
### **Chemical Vapor Deposition (CVD)**





### Plasma-enhanced chemical vapor deposition (PECVD)





## Films can be deposited in low temperatures using plasma deposition



- Device structures are sensitive to temperature, high-temperature deposition processes cannot be used in many cases.
- High-temperature films can be deposited at low temperatures.
- Unique films not found in nature can be deposited, e.g., diamond.

# Working temperature is determined by the desired film properties

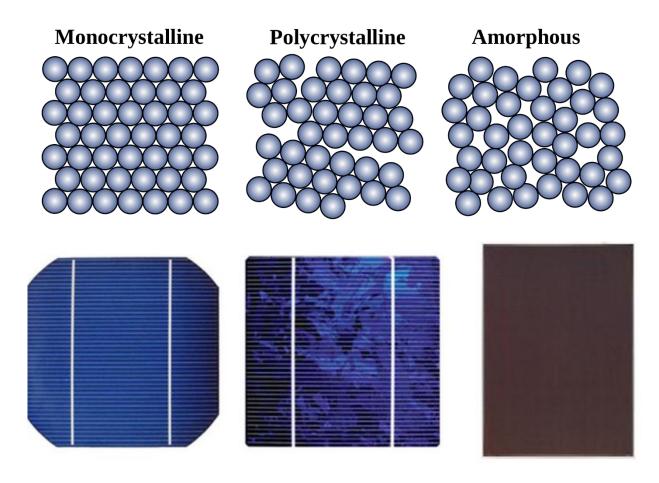


- CVD consists of a thermally activated set of gas-phase and surface reactions that produce a solid product at a surface.
- PECVD gas-phase and the surface reactions are controlled or modified by the plasma properties.
- Te~2-5 eV in PECVD is much greater than the substrate temperature, the temperature in PECVD is much less that CVD.
- Deposition rates are usually not very sensitive to the substrate temperature T.
- Film properties such as composition, stress, and morphology, are functions of T.
- Low-temperature PECVD films are amorphous, not crystalline, which can more easily be achieved with chemical vapor deposition (CVD).

### Example of using PECVD – amorphous silicon



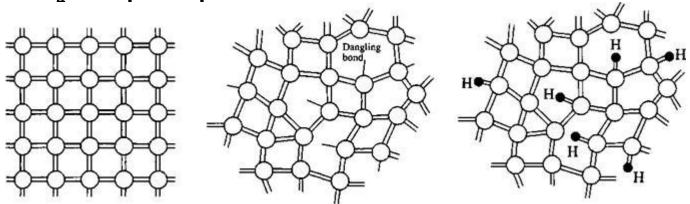
Amorphous silicon thin films are used in solar cells



### **Example of using PECVD – amorphous silicon**



- H is required so that SiH₄ is used
  - For the material to be semiconducting.
  - Terminate the dangling bonds.
  - The dangling bonds are created by ion bombardment (SiH<sub>3</sub><sup>+</sup>) which also removes hydrogen from the surface.
  - SiH<sub>3</sub> and SiH<sub>2</sub> radicals are important precursors for film growth while
     SiH<sub>4</sub> also participates in surface reactions.

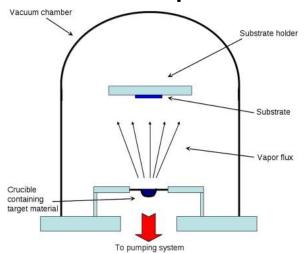


## PVD

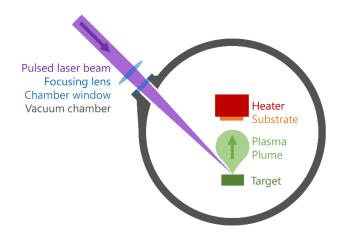
# Physical vapor deposition can be achieved by heating the deposited material



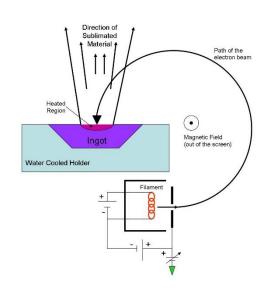
### Thermal evaporator



#### · Pulsed-laser deposition

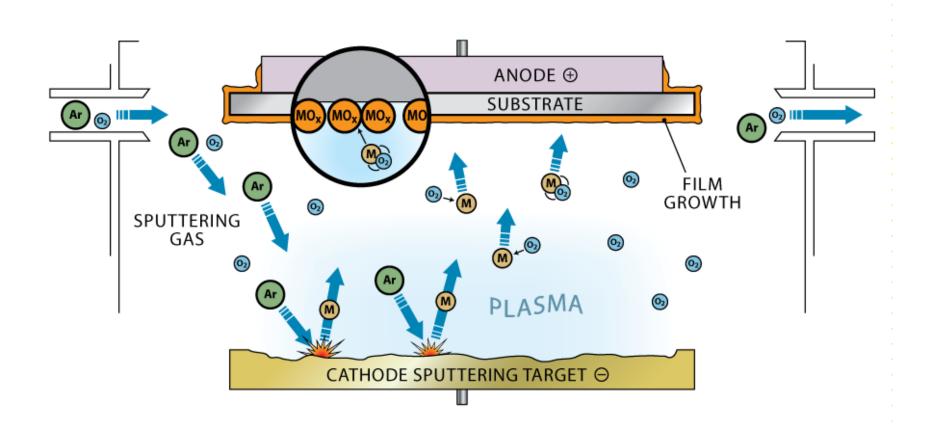


#### Electron-beam evaporator



### **Sputtering deposition**





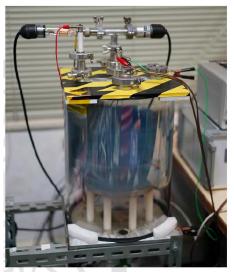
# The chamber becomes very dirty after the deposition process



Before



After

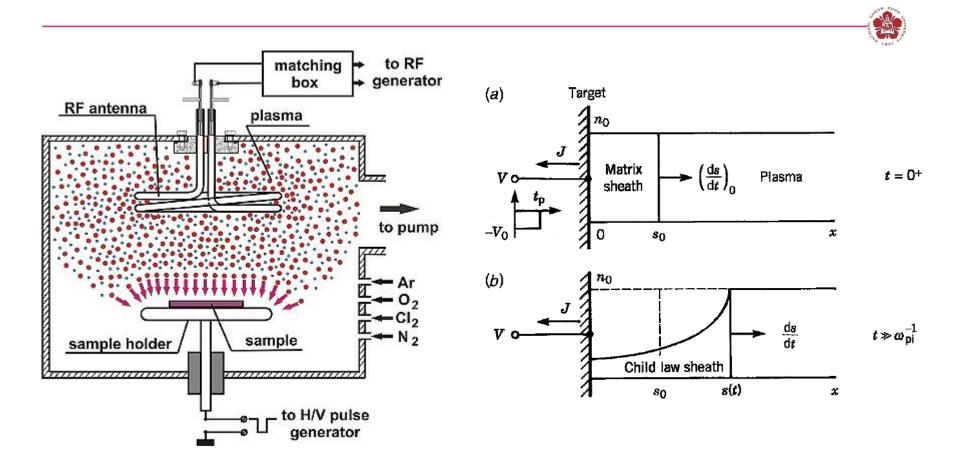


 The turbomolecular pump is also very dirty after the process.



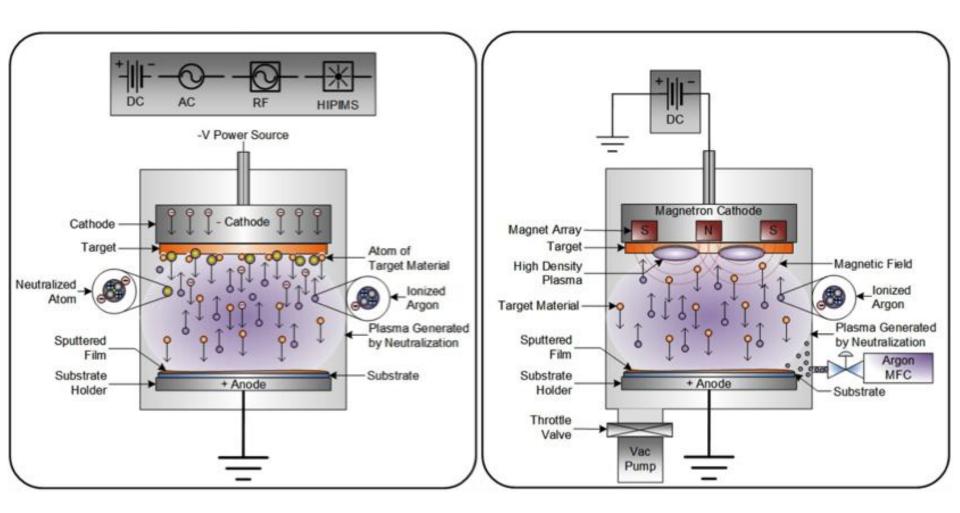


### Plasma-immersion ion implantation (PIII)



- Silicon doping ions such as B, P, As are implanted
- Surface hardening of metals N, C are implanted

# Magnetron sputtering provides higher deposition rates than conventional sputtering

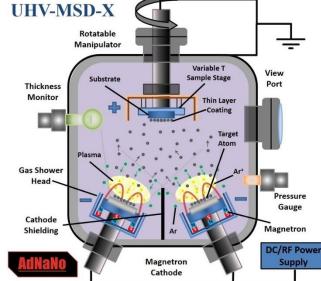


## **Examples of magnetron sputtering deposition**









https://angstromengineering.com/tech/magnetron-sputtering/pulsed-dc/https://dynavac.com/wp-content/uploads/2017/09/Confocal-Sputtering-2.jpg https://www.adnano-tek.com/magnetron-sputtering-deposition-msd.html

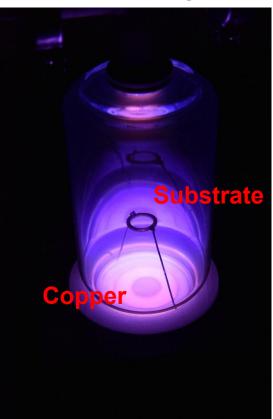
### **Demonstration experiments – magnetron sputtering**



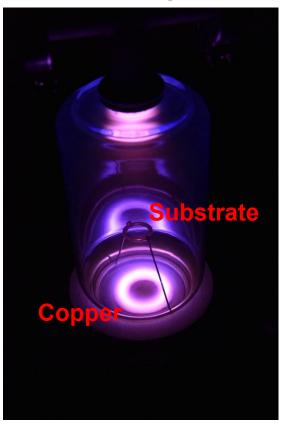
System



Without magnet

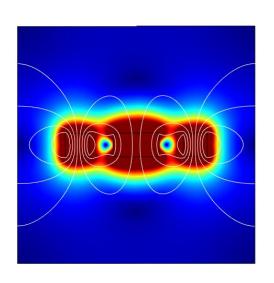


With magnet



# A bright ring occurs when the magnet is inserted into the system



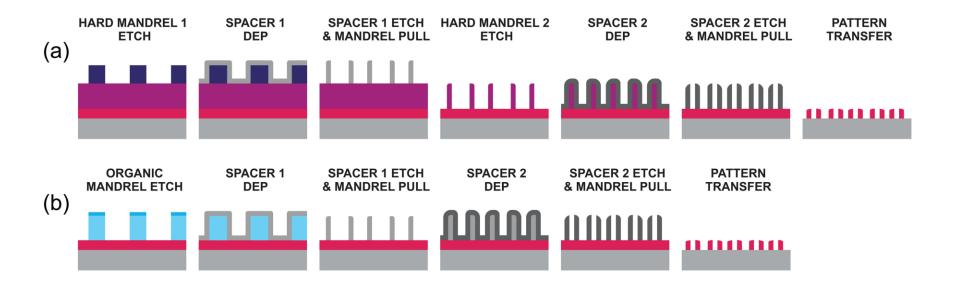




**Confined electrons** 

### self-aligned quadruple patterning

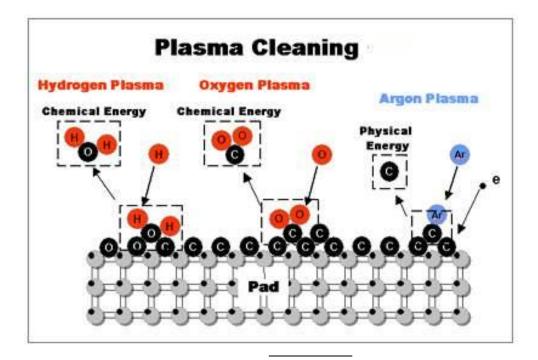




### Plasma can be used for cleaning surface



- Cleaning mechanisms:
  - Chemical reactions by free radicals
  - Physical sputtering by high energy ions



### Free radicals are generated and used in chemical reactions



$$e^- + H_2 \rightarrow 2H \bullet \qquad \qquad e^- + O_2 \rightarrow 2O \bullet \qquad \qquad O \bullet + O_2 \rightarrow O_3$$

- Highly reactive free radicals generated in plasma may react with the hydrocarbon contaminants of surface oxide.
- **Both H•** and O• can react with grease or oil on surface to form volatile hydrocarbons.

$$\begin{split} \mathbf{H} \bullet_{(g)} + C_n H_{2n+2(s)} &\to \mathbf{CH}_{4(s)} \\ \mathbf{O} \bullet_{(g)} + C_n H_{2n+2(s)} &\to \mathbf{CO}_{(s)} + \mathbf{CH}_x O_{y(g)} + H_2 O_{(g)} \end{split}$$

• O• is more reactive than H•. But O• may also react with surface metal to form oxide, deteriorating the material properties. Nevertheless, H• can make metal oxide back to metal.

$$0 \cdot +Me \rightarrow MeO$$
 $H \cdot +MeO \rightarrow Me + H_2O$ 

# The effect of chemical reactions is increased as the pressure increases



#### Advantages:

- Stable gas products are formed.
- No redeposition problem.
- High etching selectivity.

#### Disadvantages:

- Higher concentration of H<sub>2</sub> or O<sub>2</sub> is required to ensure an appropriate etching rate.
- H<sub>2</sub> safety or O<sub>2</sub> strong oxidation ability needs to be monitored.

# High energy ions are used in physical sputtering cleaning



- lons generated in plasma can be accelerated toward the substrate to physically bombard away the atoms of contaminants.
- The physical sputtering rate increases as the following quantities increase:
  - Plasma density;
  - Accelerating voltage;
  - Mass of bombardment atoms.
- The physical sputtering is also enhanced by lowering the pressure.
- High cathode bias is used.
- Ar<sup>+</sup> has strong sputtering effect.

## The physical sputtering rate increases with higher cathode bias and Ar concentration and lower pressure

#### Advantages:

- Highly efficient cleaning effect can be achieved.
- Gas consumption rate can be very low.

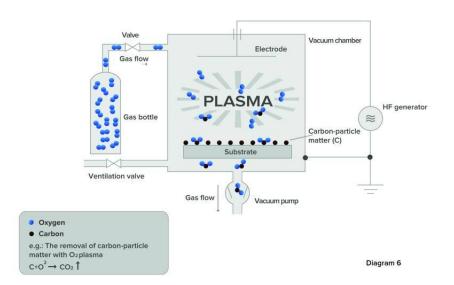
#### Disadvantages:

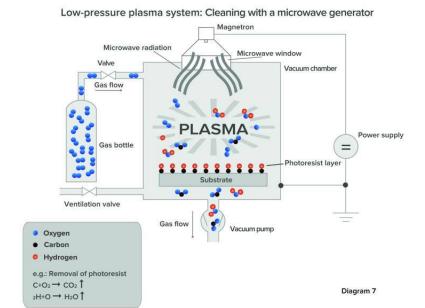
- Etching problems non-selective etching by physical sputtering.
- Redeposition problems: the products sputtered out may be highly unstable and tend to deposit again downstream.

### Plasma cleaning examples



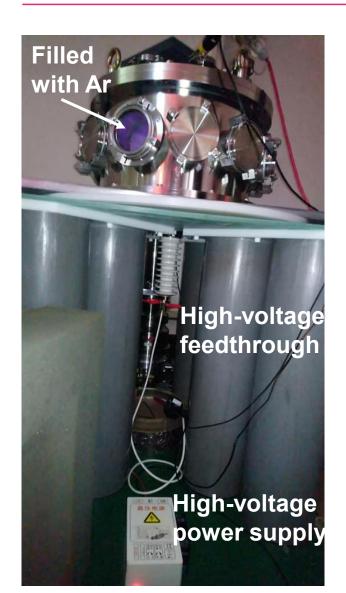
Low-pressure plasma system: Generation with a low-frequency or high-frequency generator





# Plasma cleaning needs to work in the regime of abnormal glow discharge





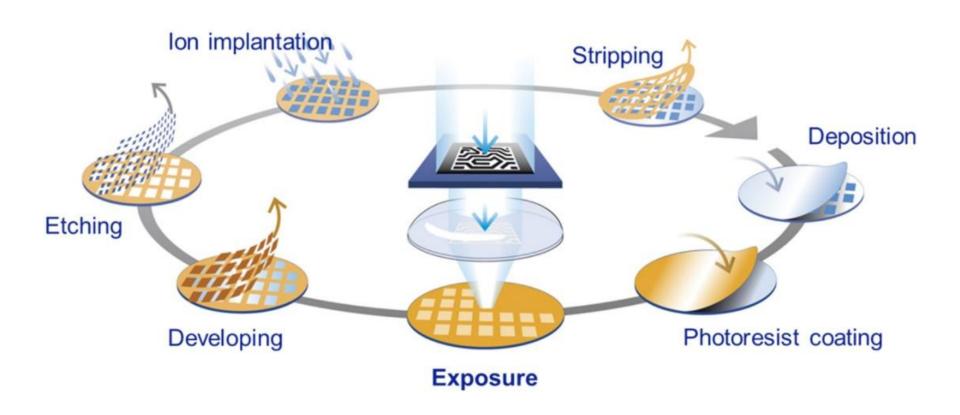




#### **EUV** light sources

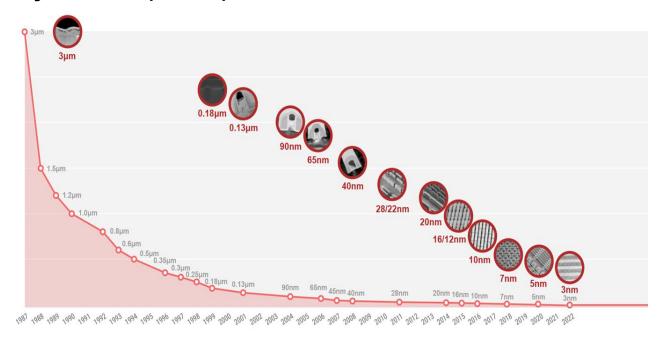
# A semiconductor device is fabricated by many repetitive production process





# Ultraviolet lithography (EUVL) is one of the key technologies in semiconductor manufacturing nowadays

 The process technology of Taiwan Semiconductor Manufacturing Company Limited (TSMC):



- Optical diffraction needs to be taken into account.
- Shorter wavelength is preferred.
  - Light source with a center wavelength of 13.5 nm is used.

## EUV lithography becomes important for semiconductor industry

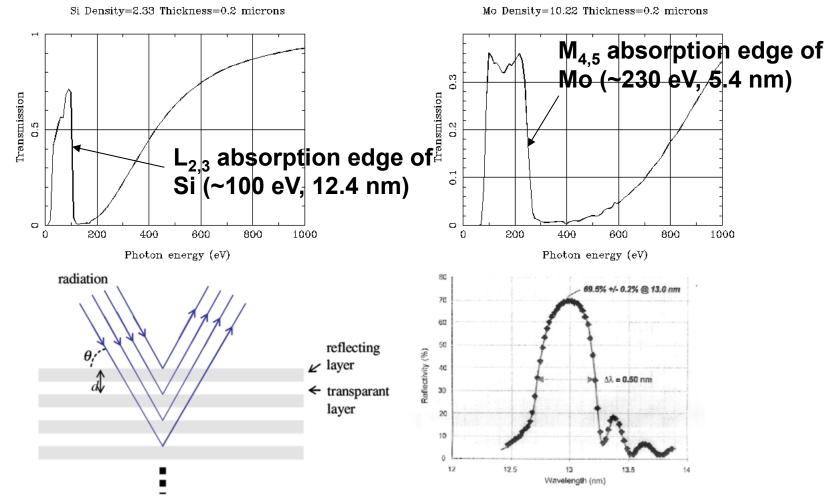


0.15 billion USD for each EUV light source.

https://www.youtube.com/watch?v=NHSR6AHNiDs

#### EUV light can only be reflected using multilayer mirrors

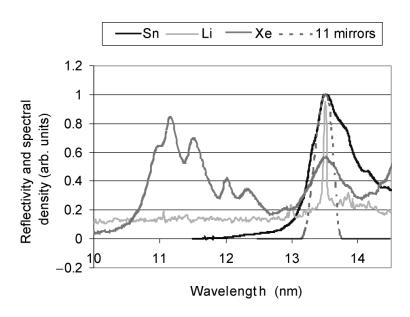




https://henke.lbl.gov/optical\_constants/ Mo/Si multilayer coating technology for EUVL, coating uniformity and time stability; E. Louis et al.; SPIE 4146-06, Soft X-ray and EUV Imaging Systems, San Diego, 2000.

#### 13.5-nm EUV light is picked for EUV lithography



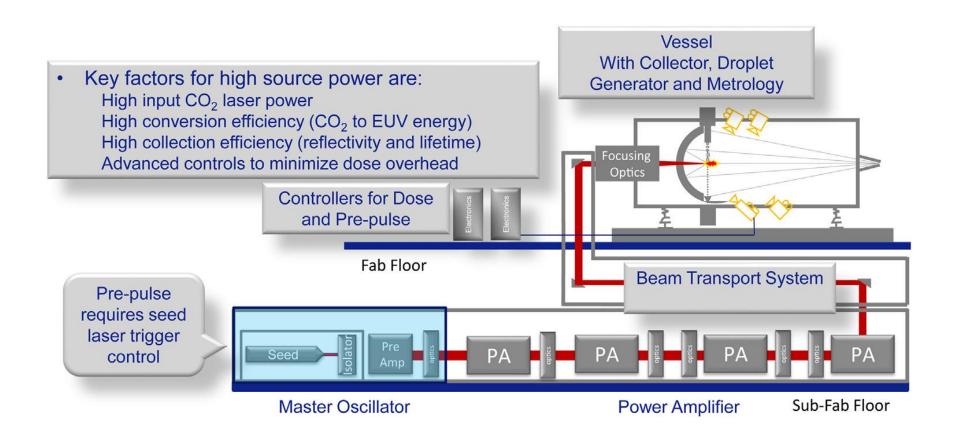


- $\lambda = 13.5 \text{ nm} \pm 1\%$  is required.
- At T=35-40 eV (~450,000 K), in-band emission occurs.
- Xenon:
  - $4p^64d^8 \rightarrow 4p^64d^75p$  from single ion stage  $Xe^{10+}$
  - UTA @ 11 nm

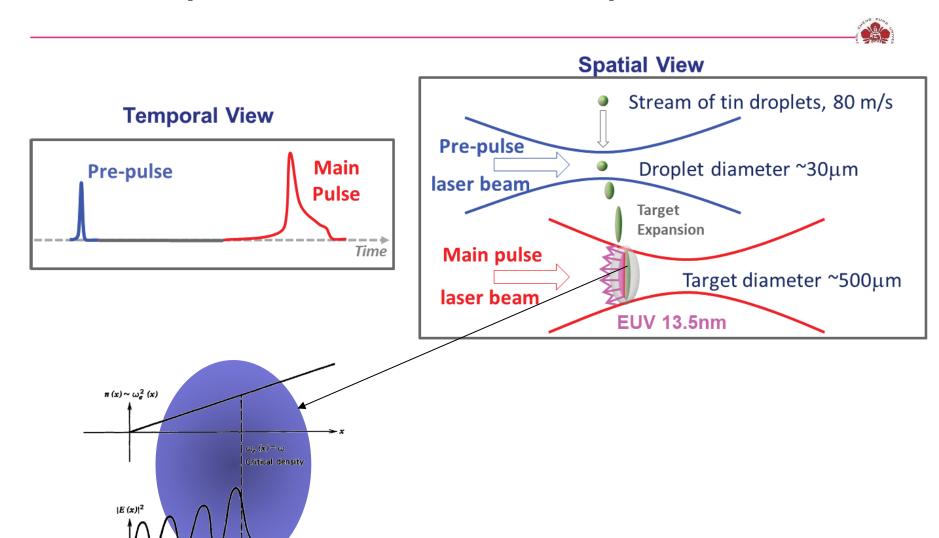
- Tin:
  - $4p^64d^N \rightarrow 4p^54d^{N+1} + 4p^64d^{N-1}4f$ (1 $\leq$ N  $\leq$  6) in ions ranging from Sn<sup>8+</sup> to Sn<sup>12+</sup>
  - UTA @ 13.5 nm
  - UTA: unresolved transition array

#### **EUV** light is generated from laser-produced plasma (LPP)



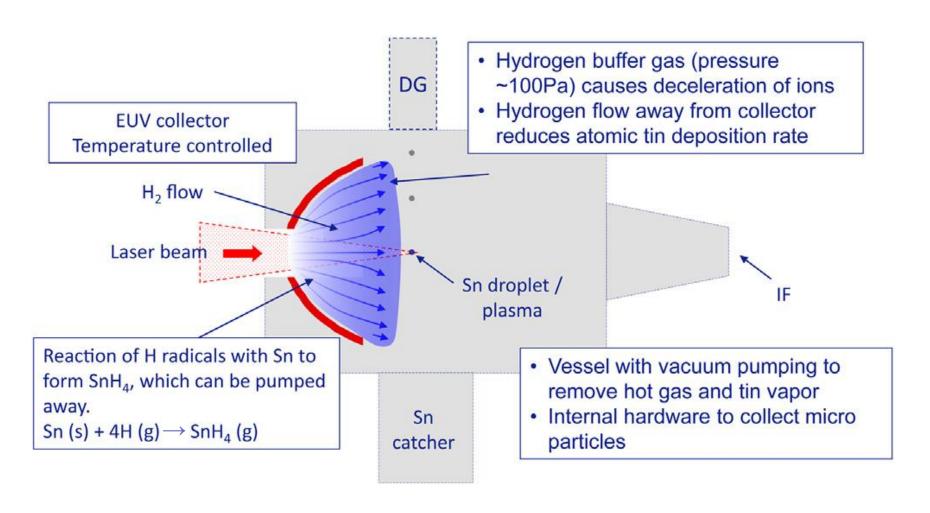


#### Two laser pulses are used to heat the plasma



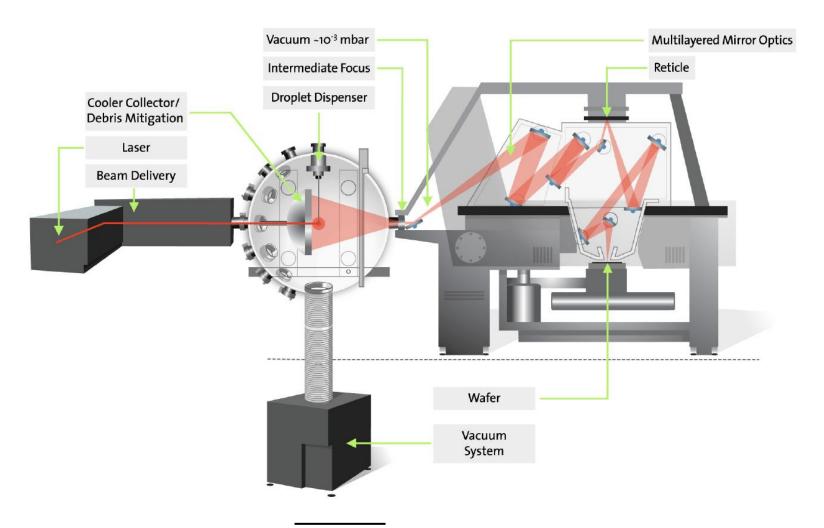
# Hydrogen buffer gas with a pressure of ~100 Pa is used to protect the collector mirror





# Laser-produced plasma (LPP) is used in the EUV lithography





#### High harmonic generation from high-power laser

Distance

For  $I < 10^{18} \text{ w/cm}^2$ Xe Source gas cell IR field a b C (a) atomic core atomic core (b) 3  $E_{rad}$ half optical period =  $\pi/\omega$ Energy  $\Lambda\Lambda\Lambda\Lambda\Lambda\Lambda\Lambda$ (c)  $S(\omega)$ twice laser frequency =  $2\omega_{L}$  $q_{\text{max}} \omega_{\text{L}}$ 

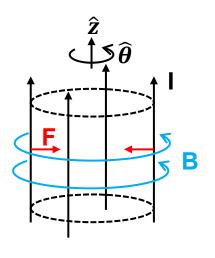
M. Krüger, etc., Appl. Sci. 9, 378 (2019)

Nonlinear Optics 3rd edition, by Robert W. Boyd

P. B. Corkum and F. Krausz, Nature Phys., 3, 381 (2007)

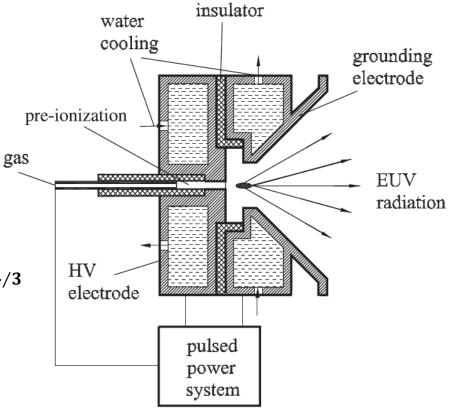
# EUV light can be generated using discharged-produced plasma





Adiabatic compression:

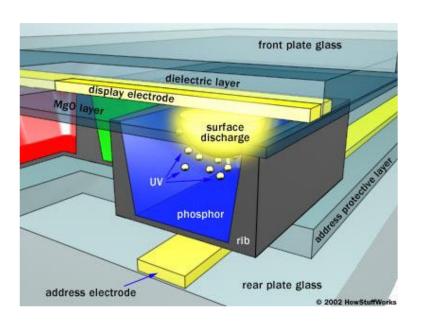
$$TV^{\gamma-1} = \text{const} \quad T_{\rm f} = T_{\rm o} \left(\frac{r_{\rm o}}{r_{\rm f}}\right)^{4/3}$$



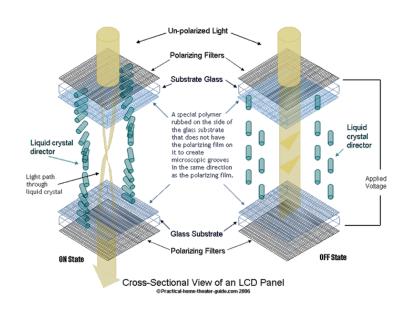
#### Light source and display systems



#### Plasma display panel (PDP)



#### **Liquid crystal display (LCD)**





#### **Outlines**

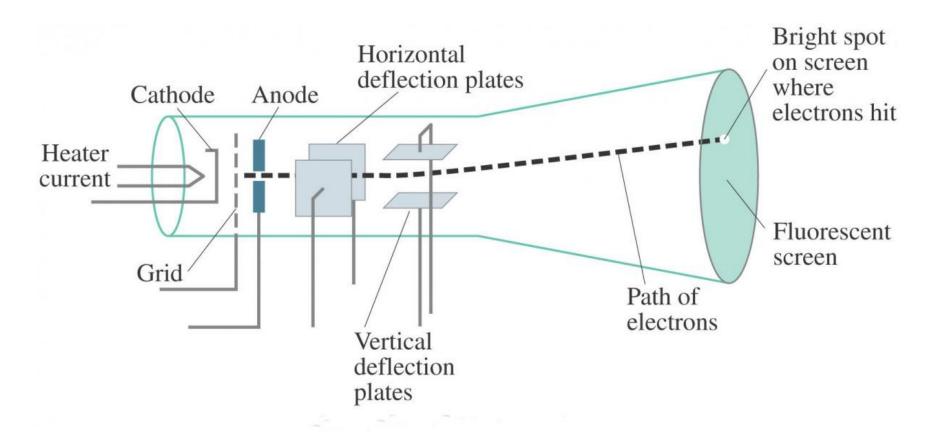


- Cathode Ray Tube
- Color space (CIE 1931 color spaces )
- History of plasma display panel (PDP)
- Design of PDP
- Liquid crystal display (LCD)
- LCD vs PDP



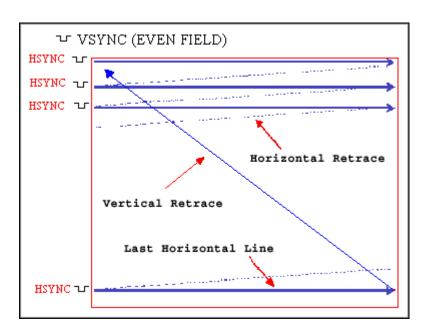
#### Cathode Ray Tube uses electron beams to light the fluorescent screen

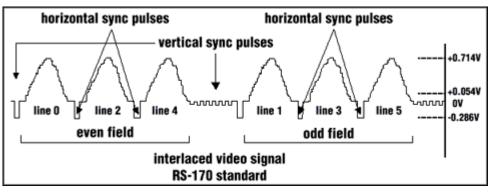


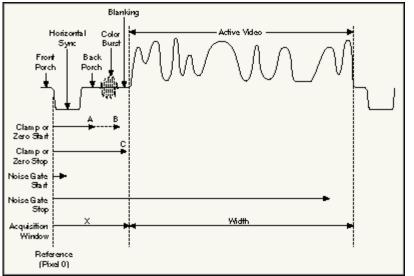


# The image is shown by scanning through the whole screen with the single electron beam





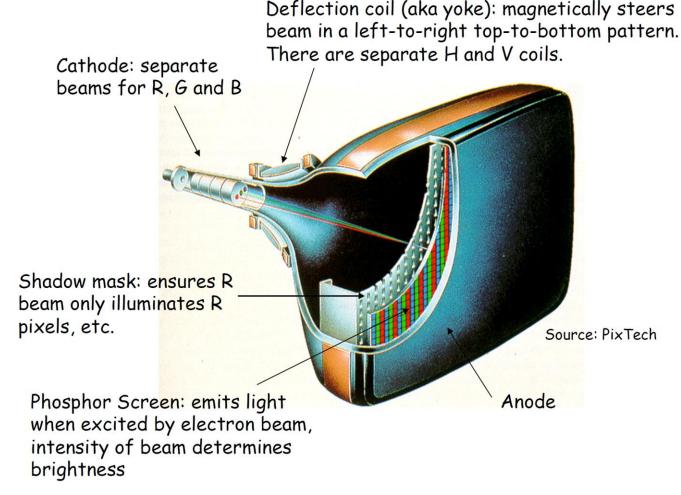






# Color image is formed by using three electron beams scanning through three different color channels





#### Color space

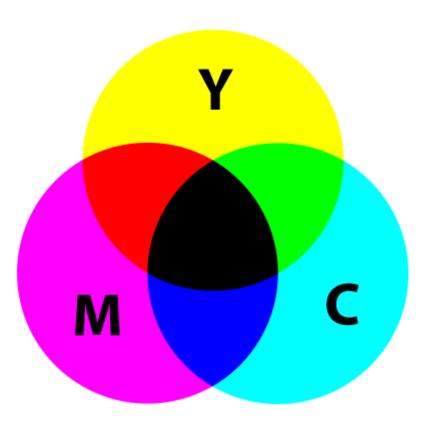
#### Color can be created using three primary colors



#### **Additive primaries**

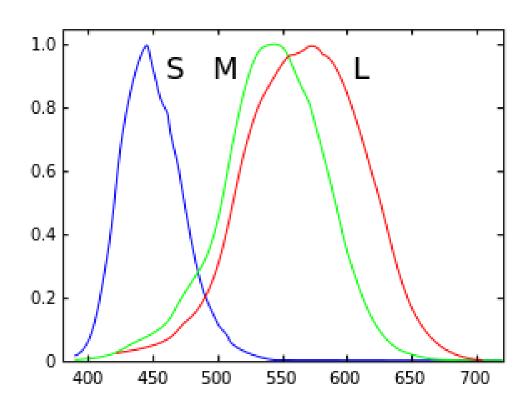
# R

#### **Subtractive primaries**



# Human retina has three kinds of "cones" that have different spectral response

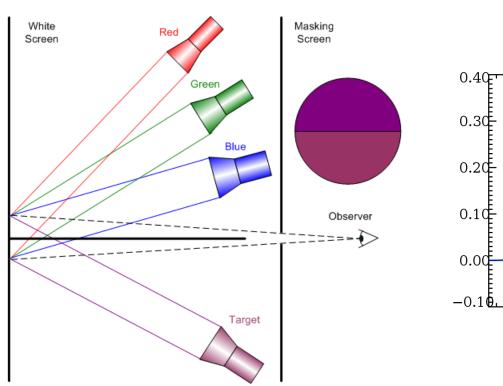


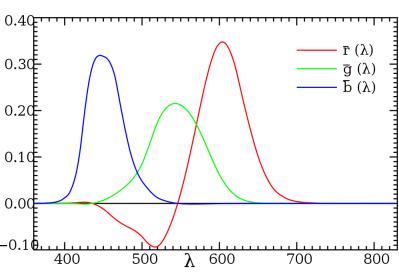




# Spectral response of retina "cones" are tested using light sources with single wavelength



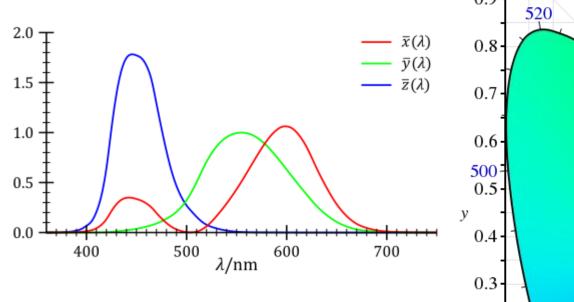


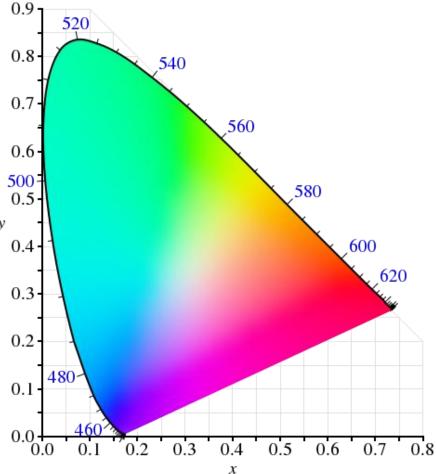




# The CIE 1931 color space chromaticity diagram is the standard color space

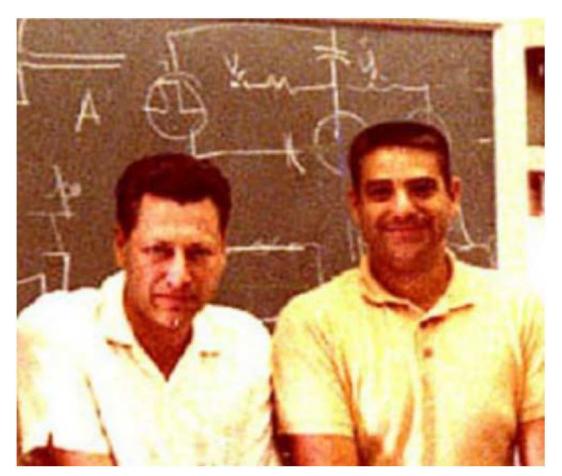






#### **History of PDP**

#### Plasma display panel was invented at the University of Illinois in 1967



**Prof. H. Gene Slottow** 

Prof. Donald L. Bitzer

## PDP was invented due to a need for Programmed Logic for Automatic Teaching Operations (PLATO) in 1960s





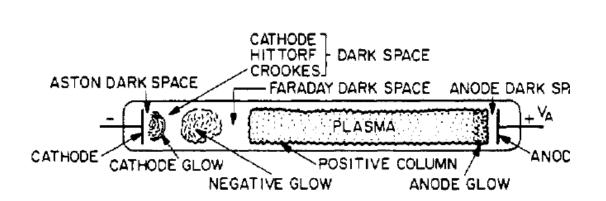


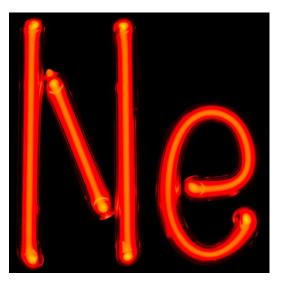


https://topwallpapers.pw/computer/keyboards-computers-history-teletype-typewriters-desktop-hd-wallpaper-1035981/https://en.wikipedia.org/wiki/Punched\_tape https://en.wikipedia.org/wiki/PLATO (computer system)

# The positive column in a glow discharge is used to excite phosphors in color PDP



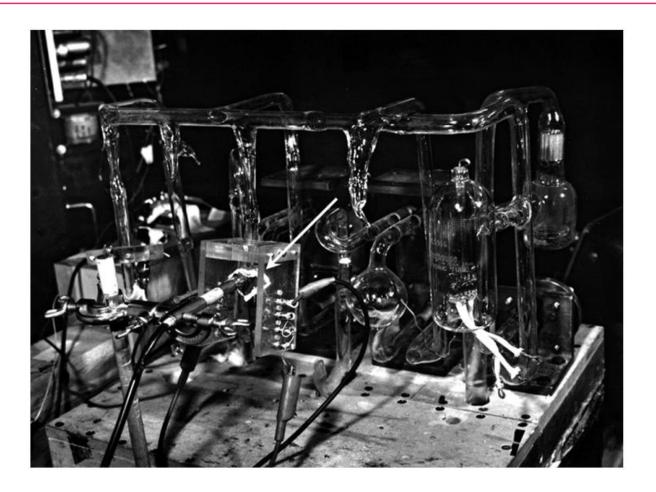




- Majority of monochrome PDPs use the negative glow as the light source
- The positive column is used to excite phosphors in fluorescent lamps and in color PDPs

# Early plasma panel (PD) attached to the glass vacuum system used for the first plasma displays at UI

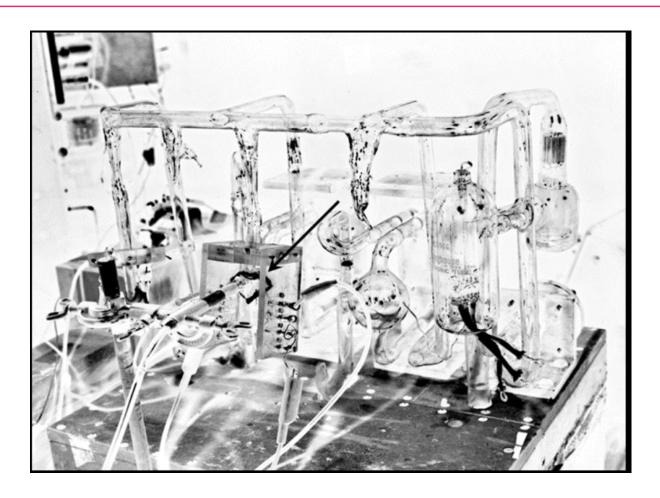




 It had the same alternating sustain voltage, neon, gas, and dielectric glass insulated electrodes that are used for plasma TVs today.

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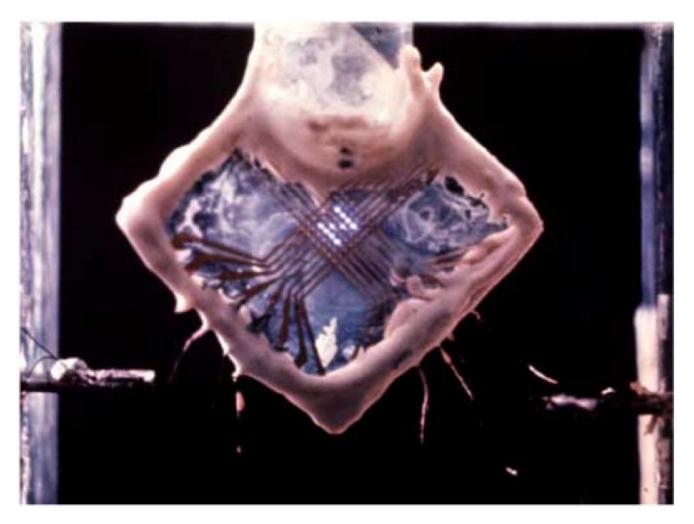




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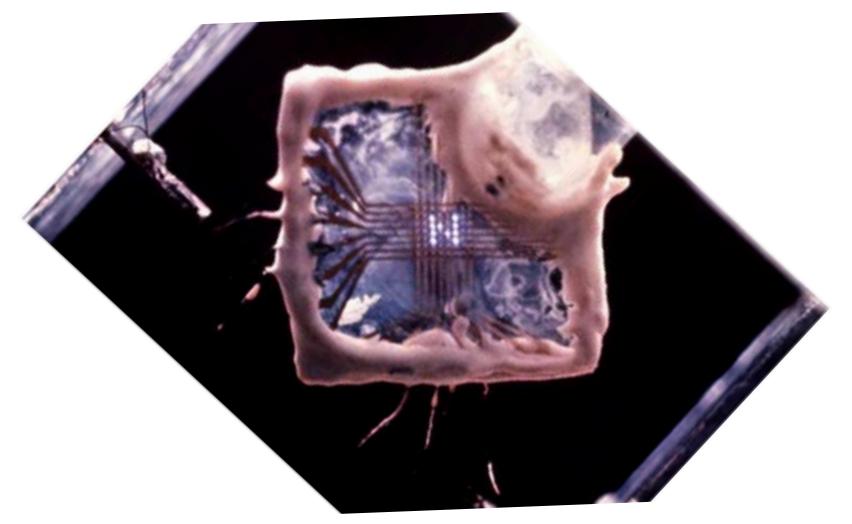
#### Early 4x4 pixel panel has achieved matrix addressability for the first time





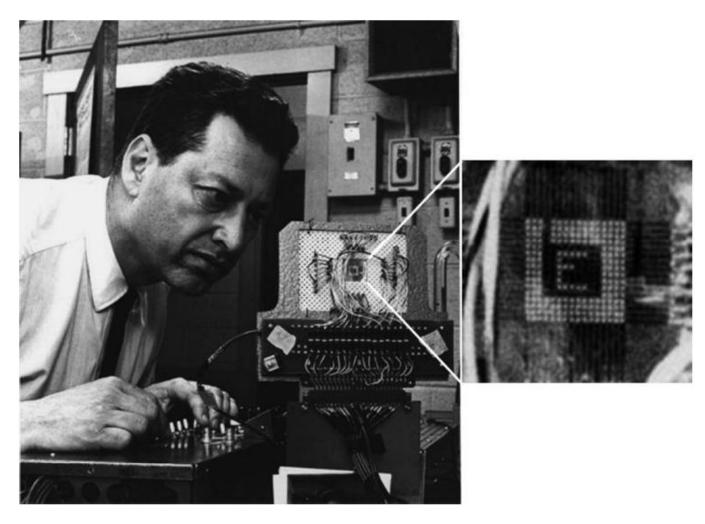
#### Early 4x4 pixel panel has achieved matrix addressability for the first time



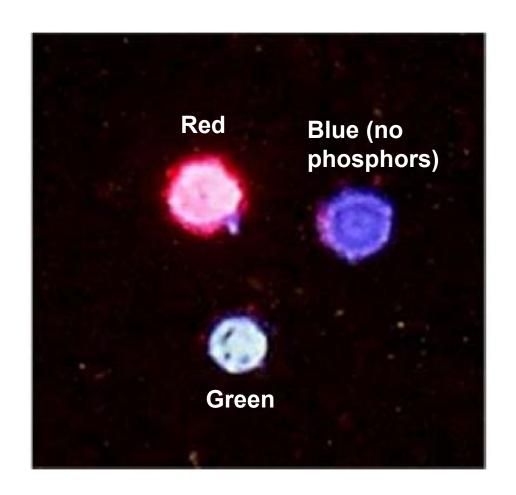


# A 16x16 pixel PD, developed in 1967, needed to be addressed manually





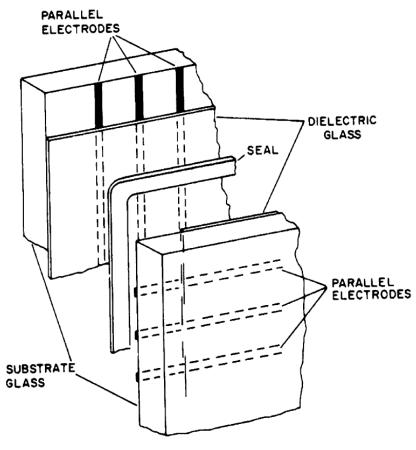
# First color PD was three cell prototype with red and green color phosphors excited by a xenon gas discharge



#### **Open-cell structure developed in 1968**







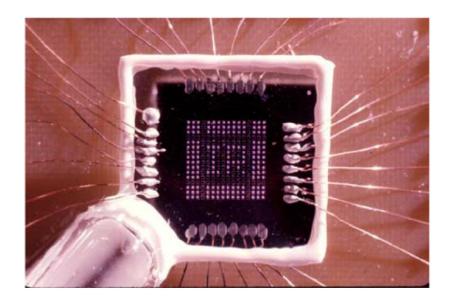
It could be baked under vacuum at 350 °C to drive out contaminants.

#### More progress



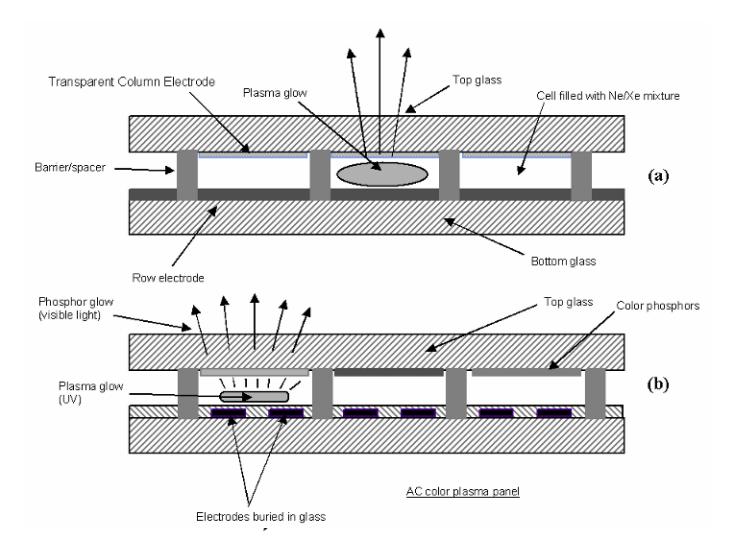
#### 1968, University of Illinois 16x16 pixels

1971, Owens-Illinois 512x512 pixels



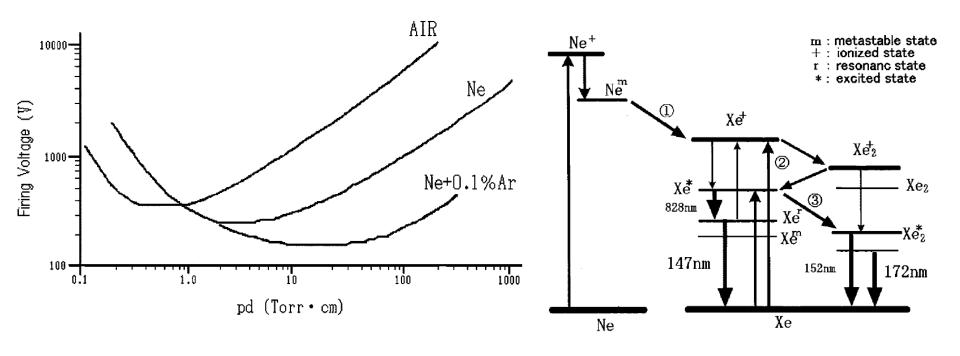


# Color PDPs had short display lifetime due to the degradation of color phosphors caused by ion sputtering



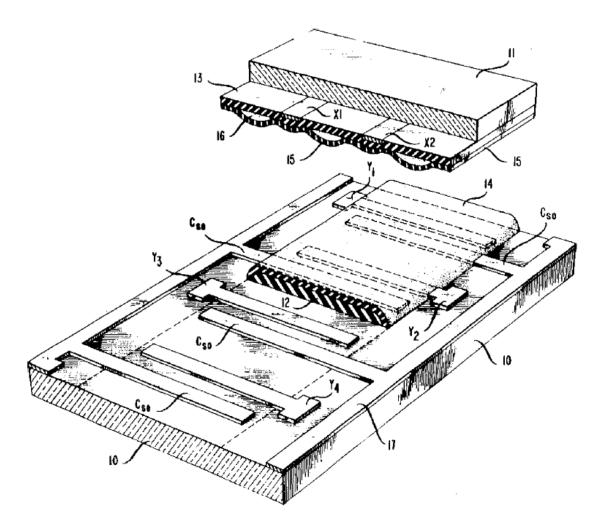
#### **Design of PDP**

## A lower breakdown voltages can be obtained with very small amounts of added gas



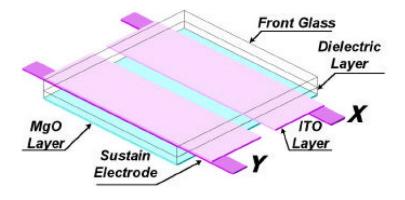
#### **AT&T** three-electrode patent

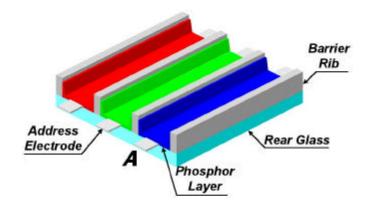


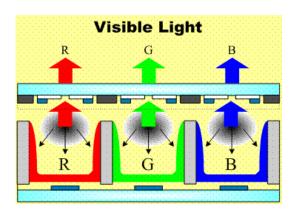


# Reflective phosphor geometry is used in most of today's plasma TVs



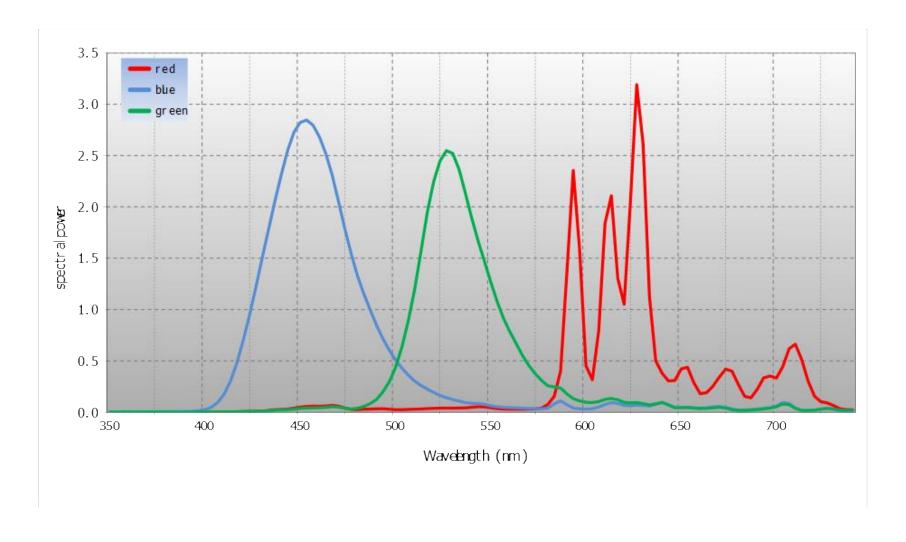






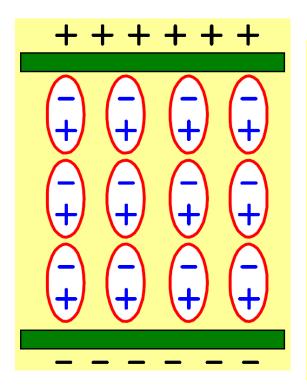
#### **Spectrum of the different phosphors**

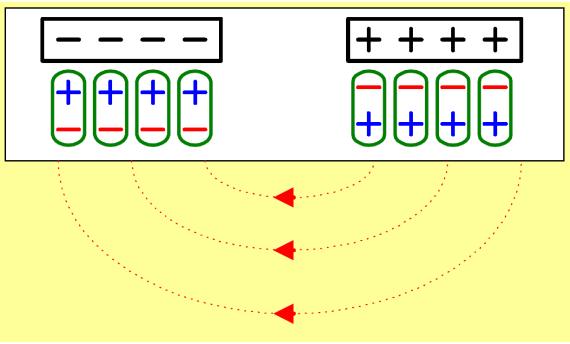




## The foundation of AC discharge

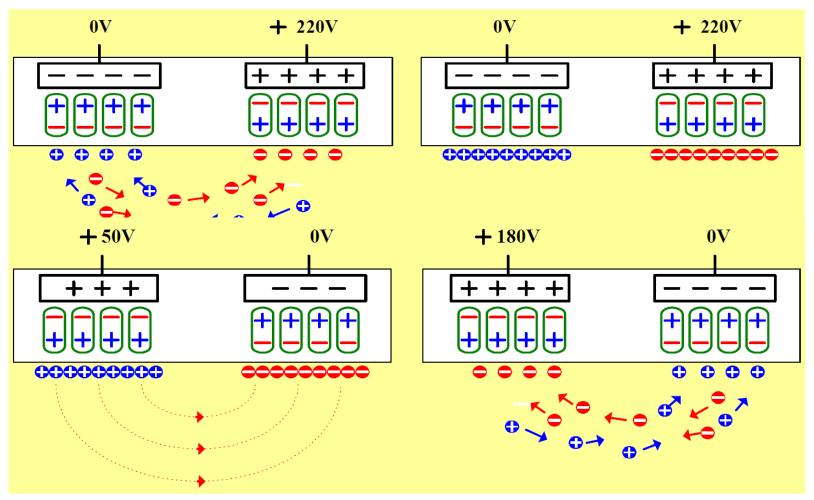






#### The plasma can be sustained using ac discharged

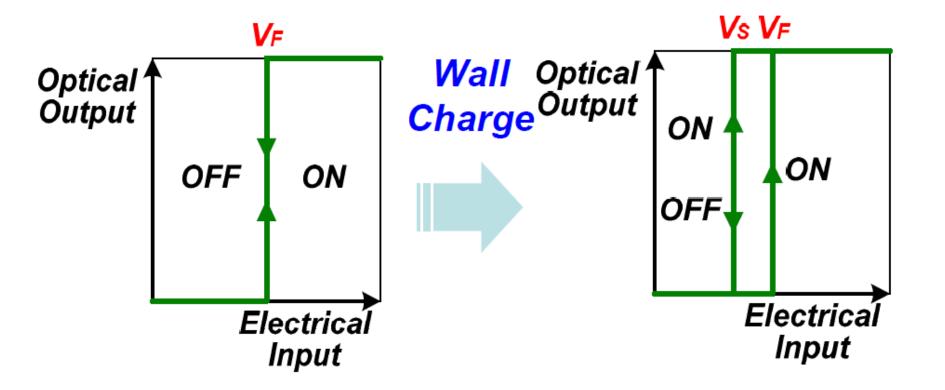




Wall discharge reduced the required discharge voltage

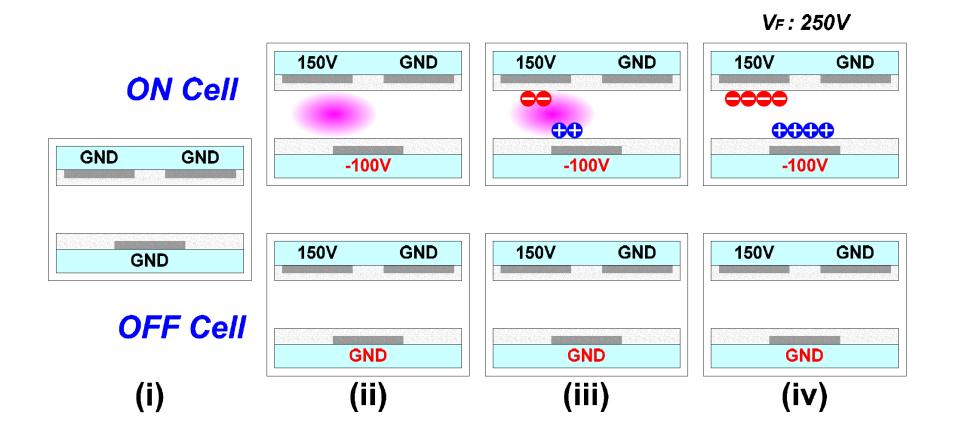
#### Wall discharge reduced the required discharge voltage





#### **ON/OFF State Selection**

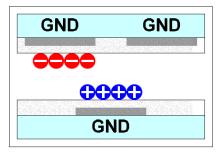


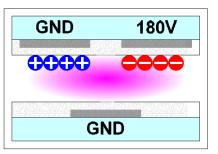


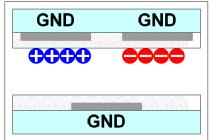
#### Sustain discharge

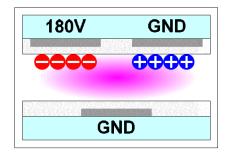


#### **ON Cell**

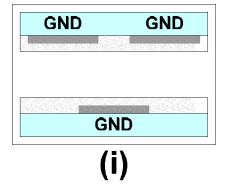


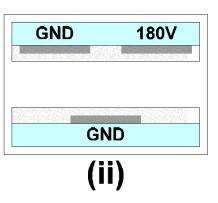


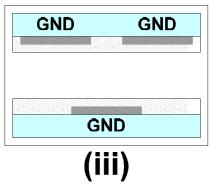


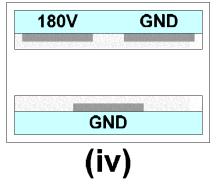


#### **OFF Cell**



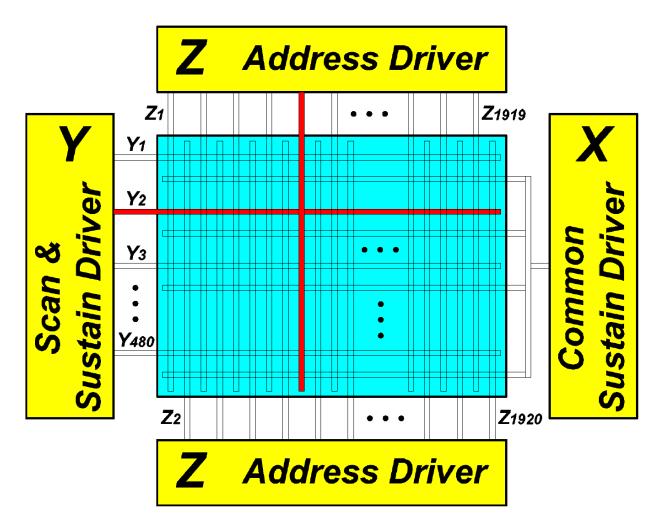






# Address and sustain electrodes are connected to different drivers

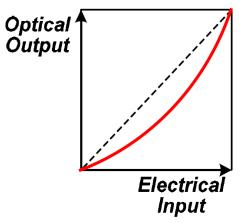




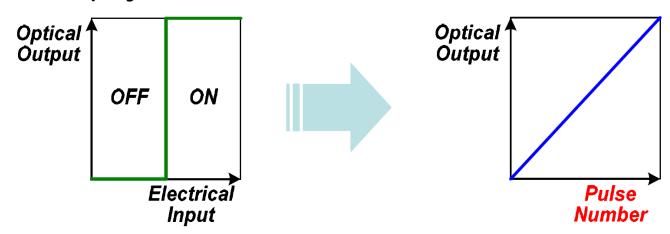
#### PDP pixel can only be either ON or OFF



Cathode Ray Tube :



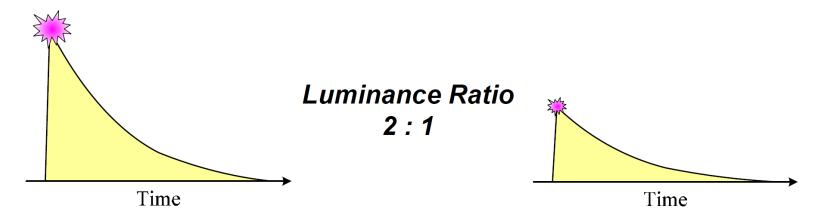
Plasma Display Panel :



# PDP luminance is controlled by using number of light pulses



CRT : Control the Luminance using Electron Beam Intensity

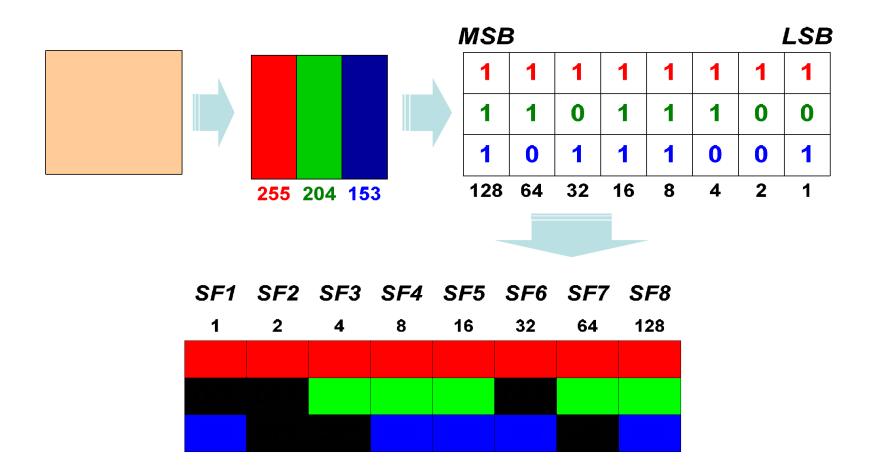


PDP : Control the Luminance using Number of Light Pulses



#### A single field is divided into 8 subfield

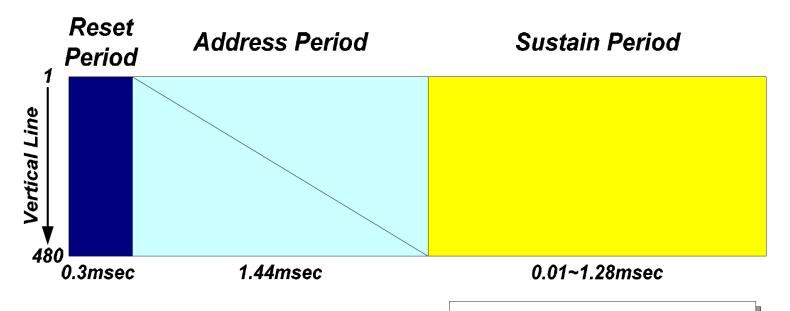






#### Composition of each subfield





Spec : VGA (640\*480)

8 Subfield

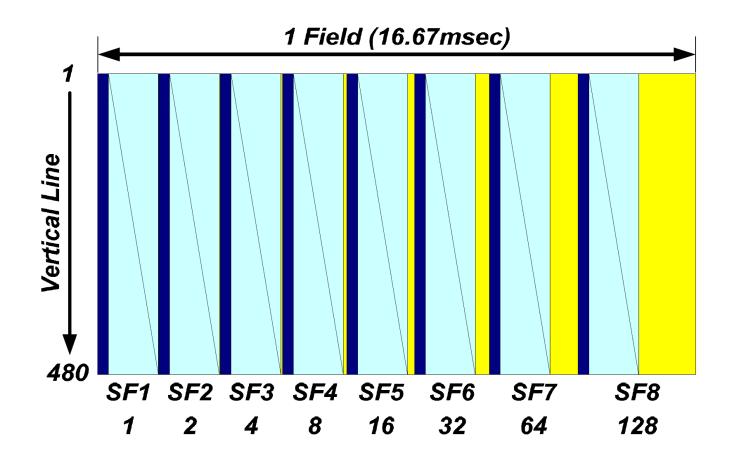
0.03msec Address Pulse

100KHz Sustain Freq.



#### 8 subfield in one TV-Field (ADS)



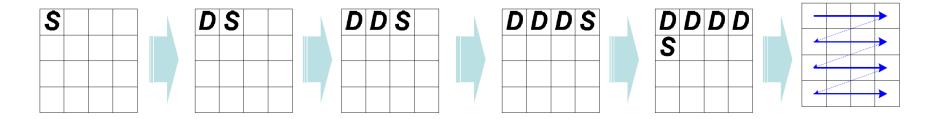




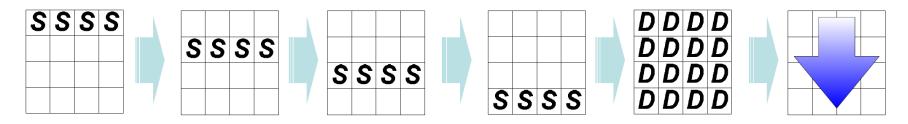
#### PDP uses line-by-line scanning



Cathode Ray Tube : Cell-by-Cell Scanning



PDP : Line-by-Line Scanning

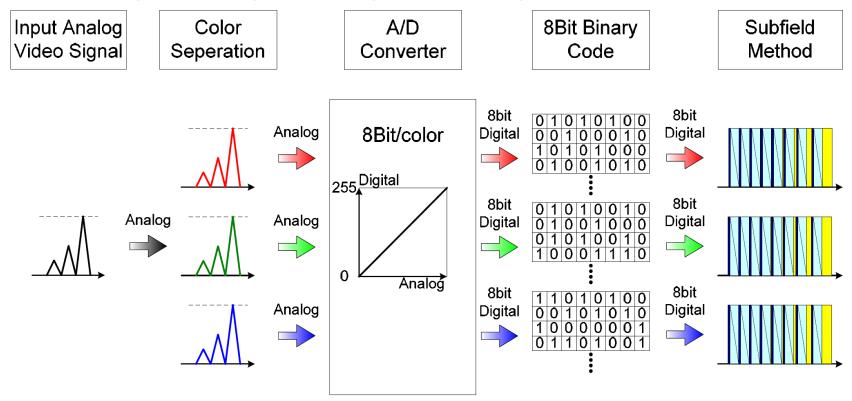




#### Video signal processing



Analog Video Signal ⇒ Digital Pulse Signal





#### **Addressing period**







## **Displaying period**



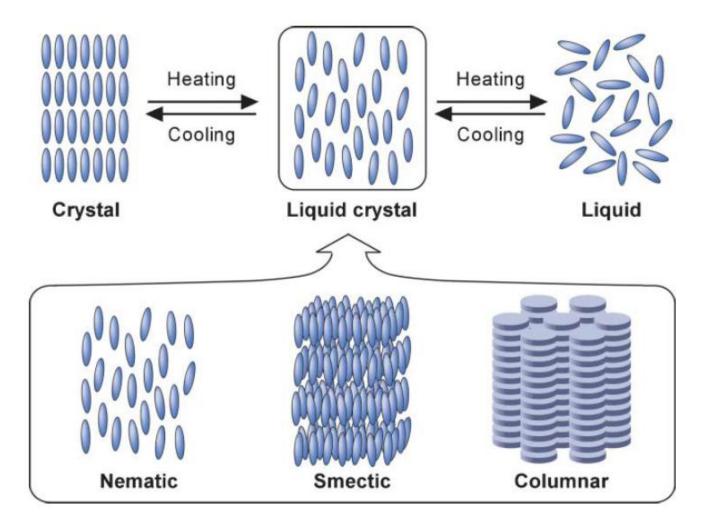






# Liquid crystal are a special state of matter between liquid and crystal

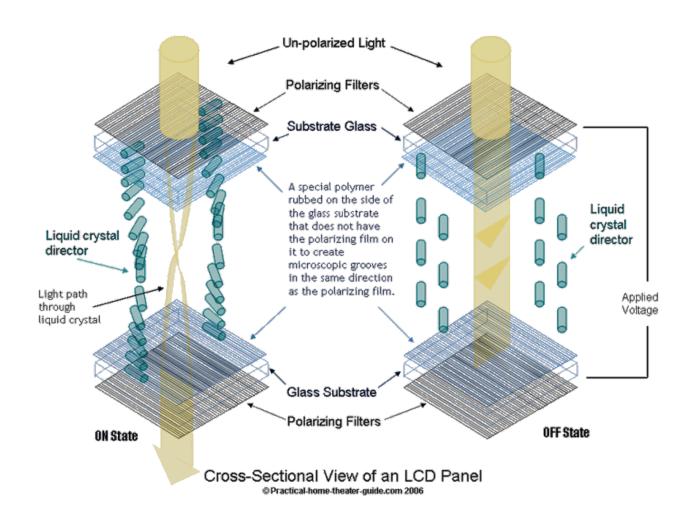






# Linear polarization of a light can be rotated by miss aligned liquid crystal

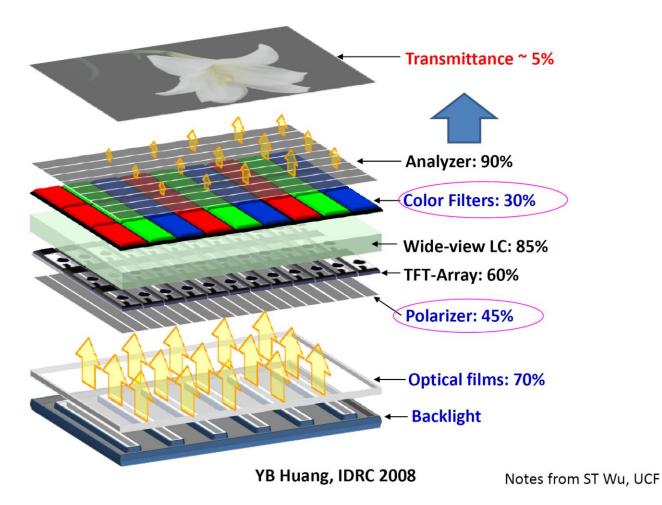






#### Structure of Liquid crystal display (LCD)

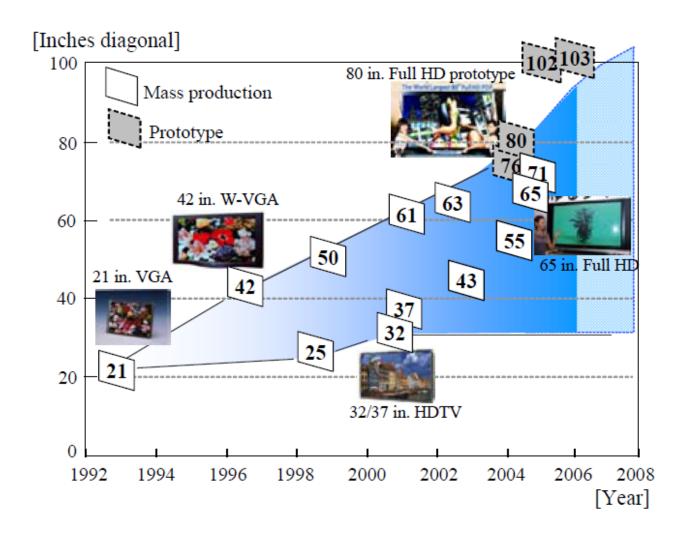






#### **Optimistic projection of PDP market**



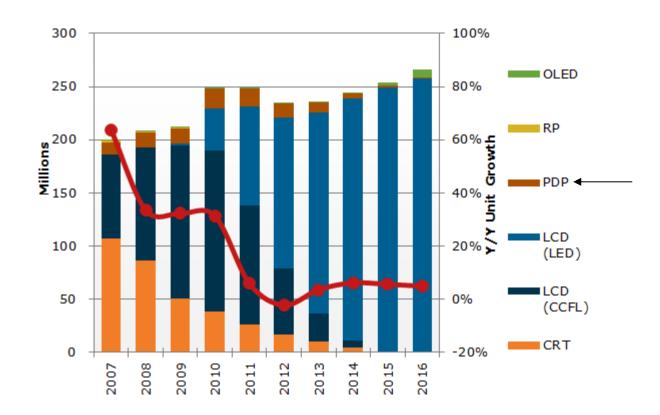




#### Reality



#### **TV Shipment Growth by Technology**





#### Too many reasons that PDP died!

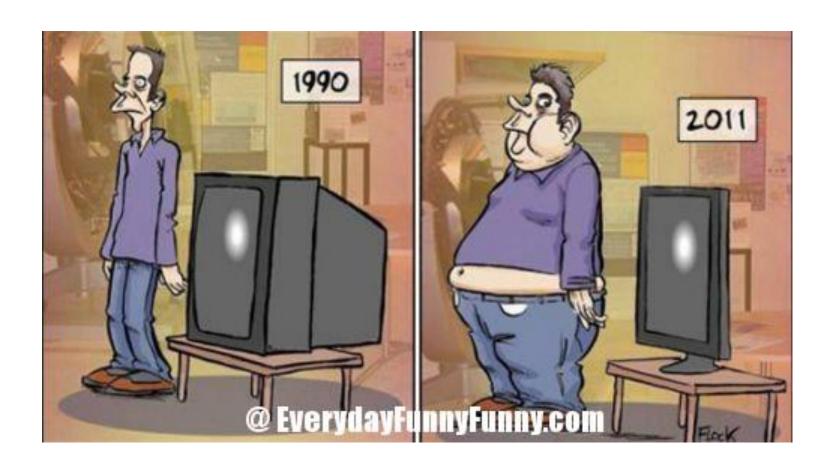


- Bright showroom conditions put plasmas at a distinct disadvantage versus LED-lit LCDs
- Aesthetics may have played a role in hastening plasma's demise
- UHD/4K caught on quickly
- Screen-size limitations also played a part in plasmas plight
- You can't bend a plasma
- Plasmas were harder to deal with than LCDs
- While OLED is still in the early stages of development, there's no question it offers greater potential than plasma
- Energy efficiency may have played a part in putting plasma out to pasture
- Plasma was the original flat-panel technology, People just thought of it as old technology.
- Projectors improved in quality and prices dropped



## Let's stand up and do exercise!!







# The hydrogen bomb

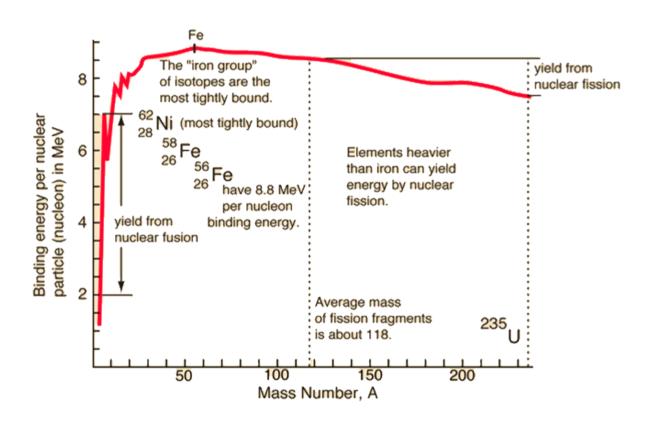






#### The "iron group" of isotopes are the most tightly bound

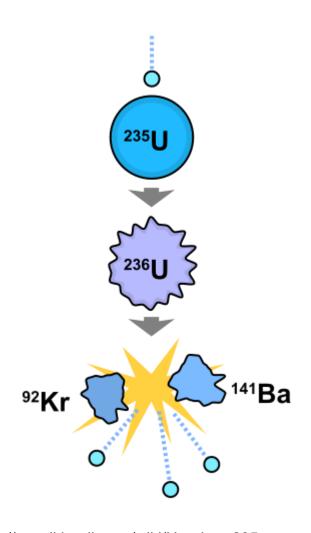






#### Chain reaction can happen in U<sup>235</sup> fission reaction

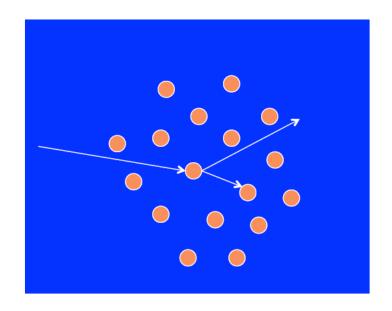




- ~ 200 million electron volts (MeV)/fission, ~million times more than chemical reactions
- Energy for bombs, or for civilian power can generate huge amounts of energy (and toxicity) in a small space with a modest amount of material
- Source of safety, security issues for nuclear power

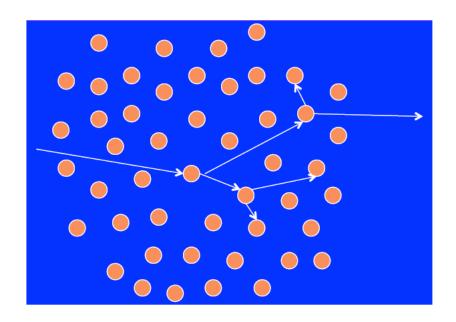
# The neutrons are leaking out and stopping the chain reaction in a sub-critical mass





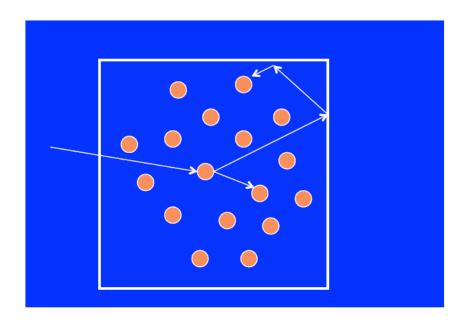
#### Solution 1: add more material





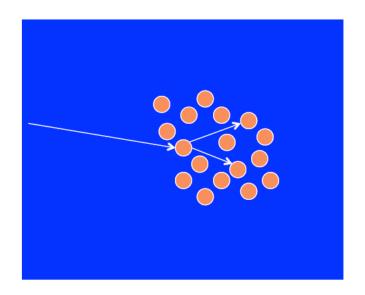
#### Solution2: reflect the neutron back in





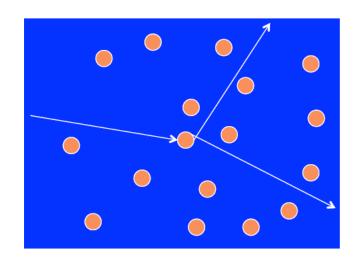
#### **Solution 3: increase the density**





#### How to get the material together before it blows apart?



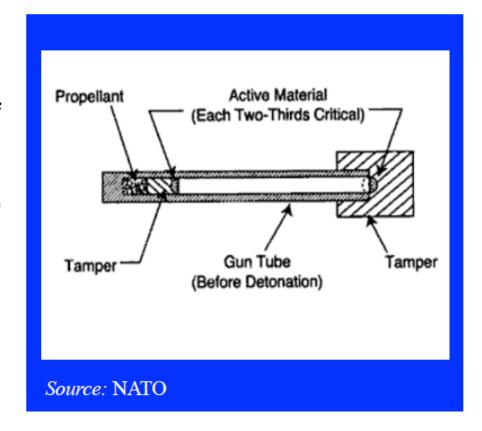


- There are always neutrons around
- Once chain reaction starts, material will heat up, expand, stop reaction
- How to get enough material together fast enough?

#### **Gun-type bomb**



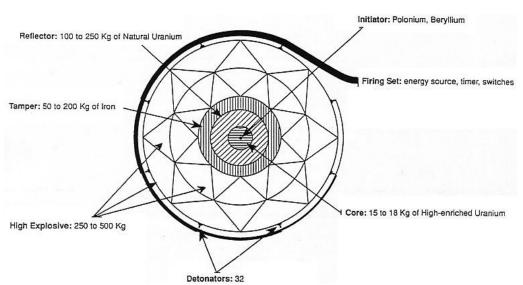
- Simple, reliable can be built without testing
- Highly inefficient require lots of nuclear material (50-60 kg of 90% enriched HEU)
- Can only get high yield with HEU, not plutonium
- Hiroshima bomb: cannon that fired HEU projectile into HEU target



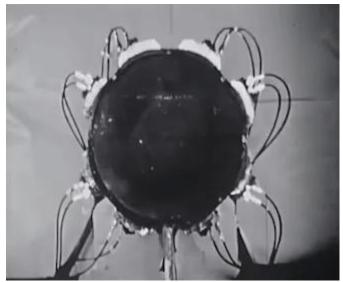
#### Implosion design



 A schematic diagram of an implosion bomb



 Small-scale slow-motion cross-section of a shaped charge implosion design

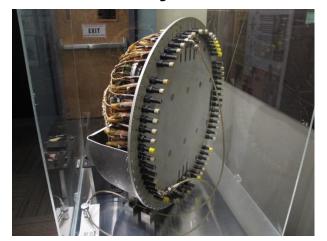


# The 1<sup>st</sup> nuclear bomb: Trinity (Bradbury Science Museum)

**Model of the Trinity Gadget** 



**Project Y Atomic Bomb Detonator System** 



**Project Y Atomic Bomb Detonator** 





**Project Y Atomic Bomb Detonator System Spark Gap Switch** 

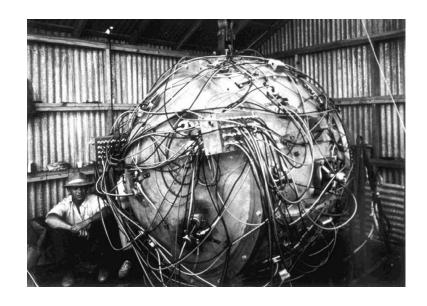


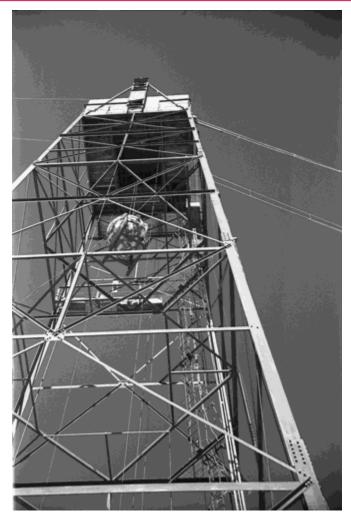


https://www.flickr.com/photos/rocbolt/with/8061684482

#### The 1<sup>st</sup> nuclear bomb: Trinity





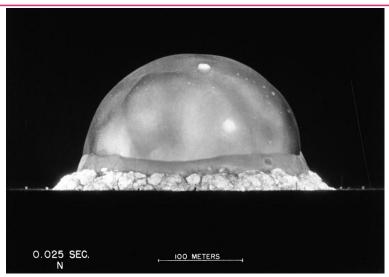




https://www.theatlantic.com/photo/2015/07/70-years-since-trinity-when-we-tested-nuclear-bombs/398735/https://saddlebagnotes.com/arts-and-leisure/tucson-seismographs-detected-first-nuclear-test-at-trinity-n-m/article b01c5b20-f6fb-11eb-a221-6327df2feaeb.html

# Trinity explosion on July 16, 1945











https://www.theatlantic.com/photo/2015/07/70-years-since-trinity-when-we-tested-nuclear-bombs/398735/https://en.wikipedia.org/wiki/Trinity\_%28nuclear\_test%29

#### **Hiroshima Bomb – "Little Boy"**





Gun Type – Easiest to design and build (Hiroshima bomb was never tested)

About 13 kiloton explosive yield



#### **Atomic bomb is very destructive**



Hiroshima: August 6, 1945

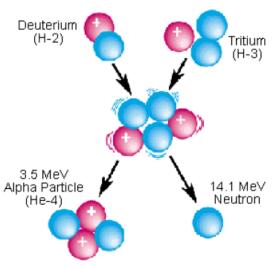


Nagasaki: August 9, 1945



#### The fusion process





$$^{2}H+^{3}H \Rightarrow ^{4}He+n+Q \equiv 17.6 \text{ MeV}$$

#### Energy release Q=17.6 MeV

#### In comparison

$${}^{2}H+{}^{2}H \Rightarrow {}^{1}H+{}^{3}H +Q \equiv 4.0 \text{ MeV}$$
 ${}^{2}H+{}^{2}H \Rightarrow {}^{3}He+n +Q \equiv 3.2 \text{ MeV}$ 
 ${}^{3}H+{}^{3}H \Rightarrow {}^{4}He+2n+Q \equiv 11.3 \text{ MeV}$ 
 ${}^{235}U+n \Rightarrow X_{A}+X_{B}+3n +Q \approx 200 \text{ MeV}$ 

**Deuterium-Tritium Fusion Reaction** 

Fusionable Material, deuterium <sup>2</sup>H (D) and tritium <sup>3</sup>H (t):

**Deuterium**: natural occurrence (heavy water) (0.015%).

**Tritium**: natural occurrence in atmosphere through cosmic ray bombardment; radioactive with  $T_{1/2}$ =12.3 y.

## "Advantages" of hydrogen bomb



Fusion of 
$${}^{2}\text{H+}{}^{3}\text{H}$$
:  $\frac{Q}{A} = \frac{17.6 \ MeV}{(3+2) \ amu} = 3.5 \frac{MeV}{amu}$ 

Fission of <sup>235</sup>U: 
$$\frac{Q}{A} = \frac{200 \ MeV}{236 \ amu} = 0.85 \frac{MeV}{amu}$$

Fusion is 4 times more powerful than fission and generates 24 times more neutrons!

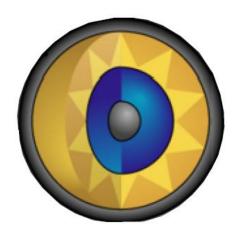
$$^{2}H + ^{3}H : \frac{n}{A} = \frac{1}{5} = 0.2$$

Neutron production:

$$^{235}U + n$$
:  $\frac{n}{A} = \frac{2}{236} = 0.0085$ 

## Hydrogen bomb uses a fission bomb to initiate the fusion reaction





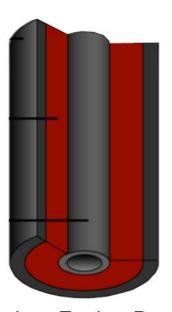
**Fuel** 

Primary Fission Device

Core: <sup>239</sup>Pu, <sup>235</sup>U, plus <sup>2</sup>H+<sup>3</sup>H booster

Shell: 238U tamper

High explosive lenses



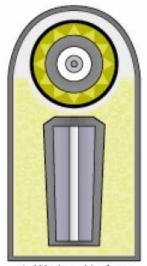
Secondary Fusion Device

Radiation channel
<sup>239</sup>Pu sparkplug
<sup>6</sup>Li, <sup>2</sup>H, <sup>3</sup>H fusion cell
<sup>238</sup>U tamper

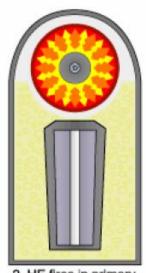


#### **Event sequence**

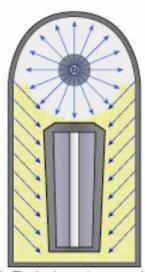




1. Warhead before firing; primary (fission bomb) at top, secondary (fusion fuel) at bottom, all suspended and beginning a fission in polystyrene foam.



2. HE fires in primary, compressing plutonium core into supercriticality reaction.



 Fissioning primary emits X-rays which reflect along the inside of the casing, irradiating the polystyrene foam.



Polystyrene foam becomes plasma, compressing secondary, and plutonium sparkplug begins to fission.

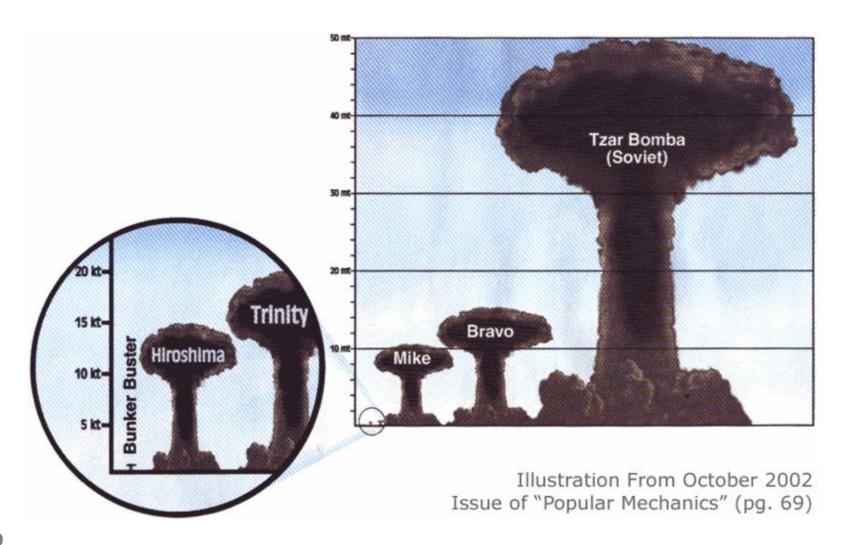


Compressed and heated, lithium-6 deuteride fuel begins fusion reaction, neutron flux causes tamper to fission. A fireball is starting to form...

Additional pressure from recoil of exploding shell (ablation)!

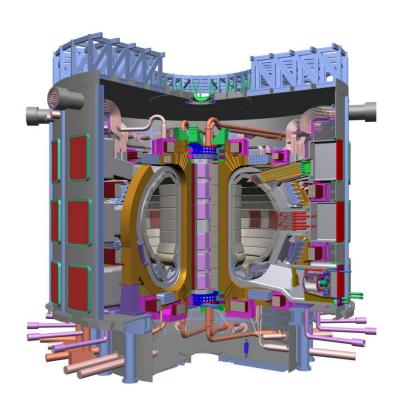
### You don't want to build a hydrogen bomb!

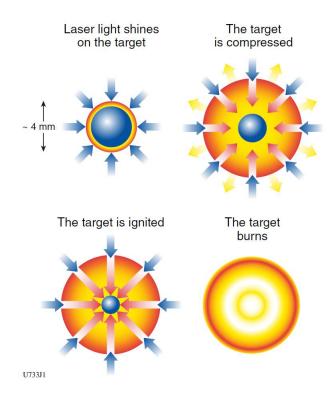




## To Fuse, or Not to Fuse...







#### **Outline**



- Introduction to nuclear fusion
- Magnetic confinement fusion (MCF)
  - Tokamak
  - Stellarator
- Inertial confinement fusion (ICF)
  - Indirection drive ICF
  - Direct drive ICF
- Innovation idea MCF + ICF
- Plasma in space
- Pulsed-power system at NCKU

#### **Outline**

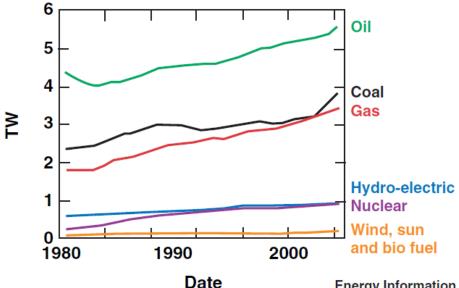


- Introduction to nuclear fusion
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# World energy consumption is dominated by the use of dwindling fossil fuels



Fossil fuel	Estimated reserve	(2005 consumption rate) Years remaining
Oil	1,277,702 million barrels	32 years
Natural gas	~6,500,000 billion cubic ft	72 years
Coal	1,081,279 million tons	252 years



E15657

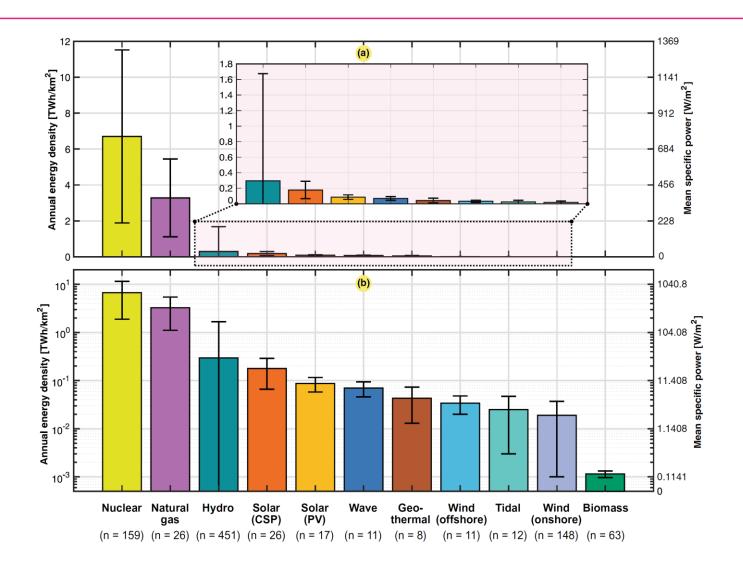
While predictions about the exact number of remaining years vary, fossil fuels will run out.

Energy Information Administration (EIA) 2006 Annual Report, U.S. Department of Energy, Washington, D.C.

<sup>\*</sup>from Laboratory for Laser Energetics, University of Rochester, Rochester, NY

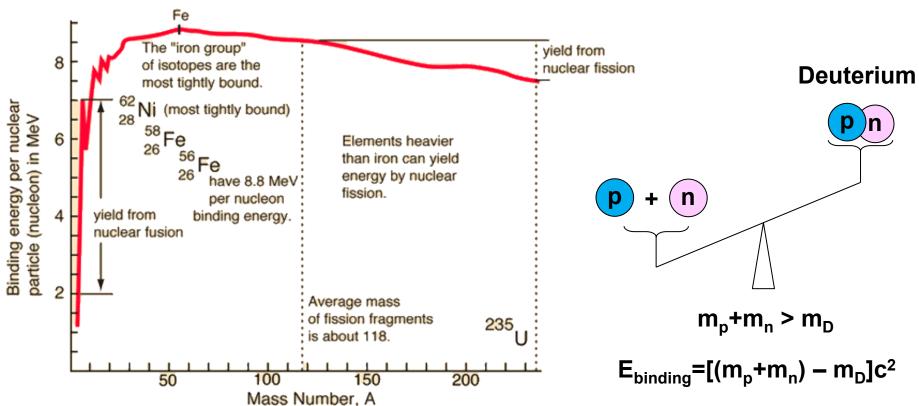
### Nuclear energy has the highest energy density





### The "iron group" of isotopes are the most tightly bound





$$Q = \left(\sum_{i} m_{i} - \sum_{f} m_{f}\right) c^{2}$$

$$\Delta m = z m_{\rm p} + (A - z) m_{\rm n} - m$$

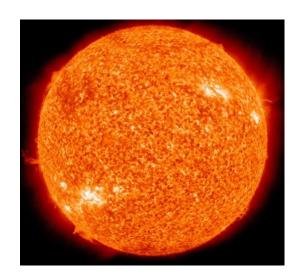
• Binding energy:  $B = \Delta mc^2$ 

Output energy:  $Q = \sum_{f} B_{f} - \sum_{i} B_{i}$ 

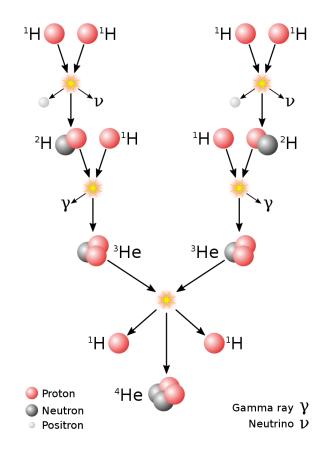
### Fusion in the sun provides the energy



Proton-proton chain in sun or smaller

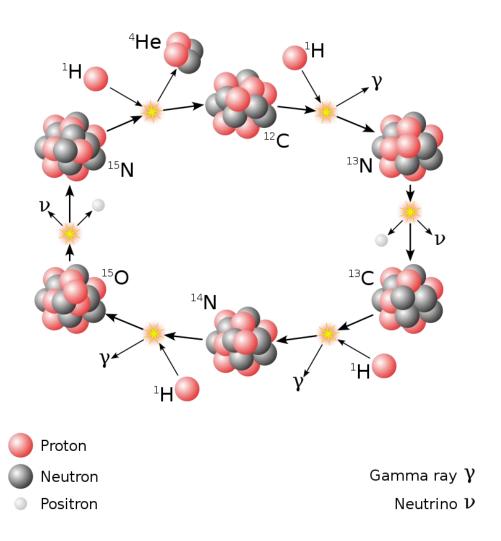


Particles are confined by the gravity.



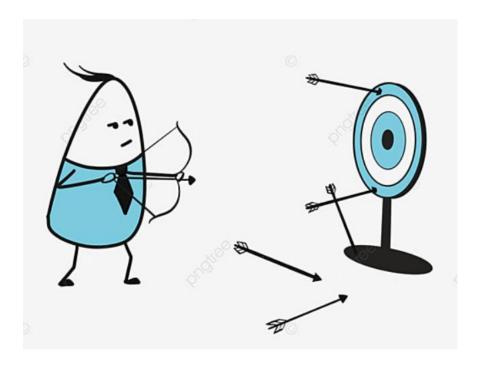
### In heavy sun, the fusion reaction is the CNO cycle

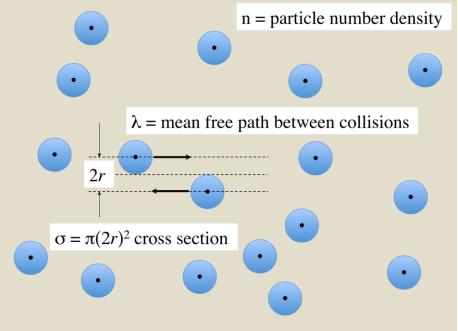




## The cross section is a measure of the probability that a specific process will take place in a collision of two particles







# Cross section measures the probability per pair of particles for the occurrence of the reaction



$$x_1 + x_2 \rightarrow x_3 + x_4$$

The hard sphere cross section:  $\sigma \approx \pi R^2$  where R  $\approx 5 \times 10^{-15}$  m is the nuclear radius, i.e.,  $\sigma = 0.8 \times 10^{-28}$  m<sup>2</sup>  $\approx 1$  barm. (barm  $\equiv 10^{-28}$  m<sup>2</sup>)



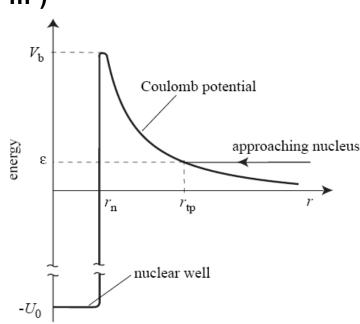
Classical cross section:

$$D \biguplus v_D \bigvee v_T$$

$$\frac{m_{\rm D}}{2}v_{\rm D}^2 + \frac{m_{\rm T}}{2}v_{\rm T}^2 \ge \frac{e^2}{4\pi\epsilon_{\rm o}R}$$

• Let 
$$v = |\overrightarrow{v}_D - \overrightarrow{v}_T|$$

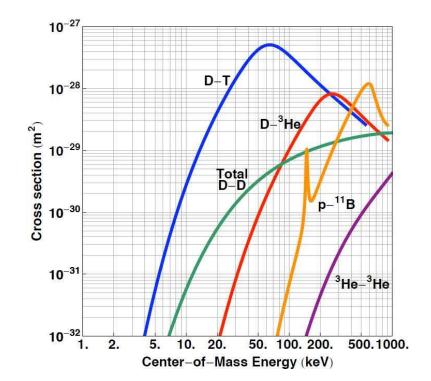
$$v_{\mathrm{D}} = \frac{m_{\mathrm{T}}}{m_{\mathrm{D}} + m_{\mathrm{T}}} v \qquad v_{\mathrm{T}} = \frac{m_{\mathrm{D}}}{m_{\mathrm{D}} + m_{\mathrm{T}}} v$$



 Classical kinetic energy required for fusion is

$$K_{\rm c.m.} > 288 \, {\rm keV} \, \parallel \parallel$$

## Cross section of fusion reaction is much larger than the classical approach

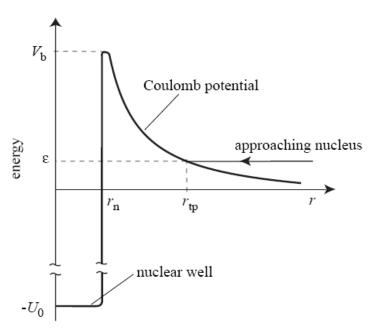


 $D + He^3 \rightarrow He^4 + p$ 

 $p + B^{11} \rightarrow 3He^4$ 

- $\begin{array}{c} D+D \rightarrow T+p \\ \rightarrow He^3+n \end{array}$
- $D + T \rightarrow He^4 + n$

- Classical kinetic energy required for fusion is  $K_{c.m.} > 288 \text{ keV } !!!$
- DT cross section has a peak of ~5 barns at 120 keV.
- $\sigma_{DT} \approx 100\sigma_{DD}$  @ 20 keV.



https://i.stack.imgur.com/wXQD5.jpg Santarius, J. F., "Fusion Space Propulsion – A Shorter Time Frame Than You Think", JANNAF, Monterey, 5-8 December 2005.

## The cross section of proton-proton chain is much smaller than D T fusion

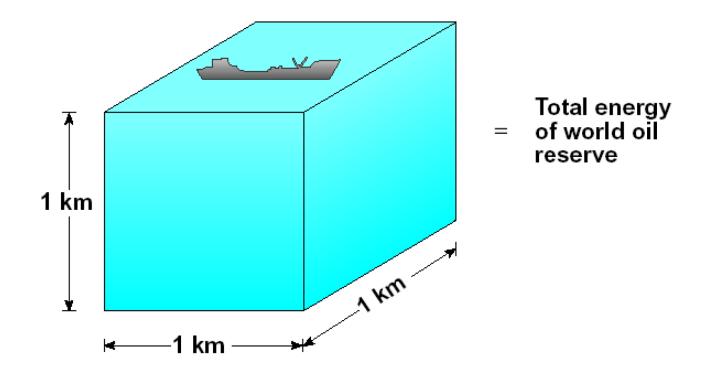


Reaction	σ <sub>10 keV</sub> (barn)	σ <sub>100 keV</sub> (barn)	σ <sub>max</sub> (barn)	ε <sub>max</sub> (keV)
D+T $\rightarrow \alpha$ +n	2.72x10 <sup>-2</sup>	3.43	5.0	64
D+D→T+p	2.81x10 <sup>-4</sup>	3.3x10 <sup>-2</sup>	0.06	1250
D+D→³He+n	2.78x10 <sup>-4</sup>	3.7x10 <sup>-2</sup>	0.11	1750
T+T→α+2n	7.90x10 <sup>-4</sup>	3.4x10 <sup>-2</sup>	0.16	1000
$D+^3He \rightarrow \alpha+p$	2.2x10 <sup>-7</sup>	0.1	0.9	250
p+ <sup>6</sup> Li→α+ <sup>3</sup> He	6x10 <sup>-10</sup>	7x10 <sup>-3</sup>	0.22	1500
$p+^{11}B\rightarrow 3\alpha$	(4.6x10 <sup>-17</sup> )	3x10 <sup>-4</sup>	1.2	550
p+p→D+e++v	(3.6x10 <sup>-26</sup> )	(4.4x10 <sup>-25</sup> )		
$p+^{12}C\rightarrow^{13}N+\gamma$	(1.9x10 <sup>-26</sup> )	2.0x10 <sup>-10</sup>	1.0x10.4	400
<sup>12</sup> C+ <sup>12</sup> C (all branches)		(5.0x10 <sup>-103</sup> )		

- Barn =  $10^{-28}$  m<sup>2</sup>. It is the hard sphere cross section of a nucleus with R  $\approx 5 \times 10^{-15}$  m.
- "()" are theoretical values while others are measured values.

### Enormous fusion fuel can be produced from sea water



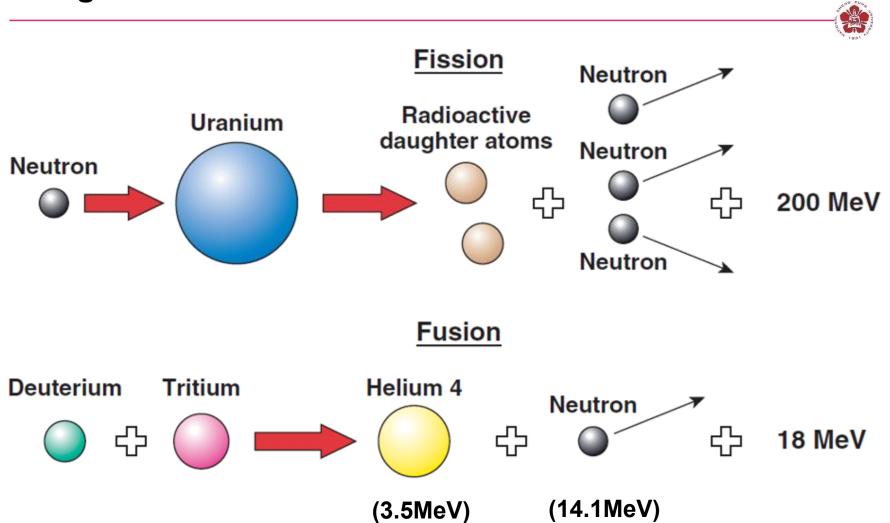


### What could you do with 1 kg DT?



- 1 kg DT -> 340 Tera joules
  - You can drive your car for ~40,000 km (back and forth between Keelung and Kaoshiung for 50 times).
  - You can keep your furnace running for 8 years.
  - You can blow things up! 1 TJ = 250 tons of TNT.

# Nuclear fusion and fission release energy through energetic neutrons



# Nuclear fusion provides more energy per atomic mass unit (amu) than nuclear fission

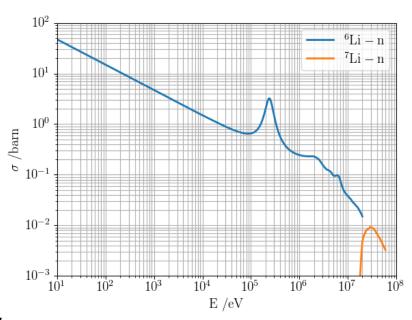


Fusion of 
$${}^{2}\text{H+}{}^{3}\text{H}$$
:  $\frac{Q}{A} = \frac{17.6 \ MeV}{(3+2) \ amu} = 3.5 \frac{MeV}{amu}$ 

Fission of <sup>235</sup>U: 
$$\frac{Q}{A} = \frac{200 MeV}{236 amu} = 0.85 \frac{MeV}{amu}$$

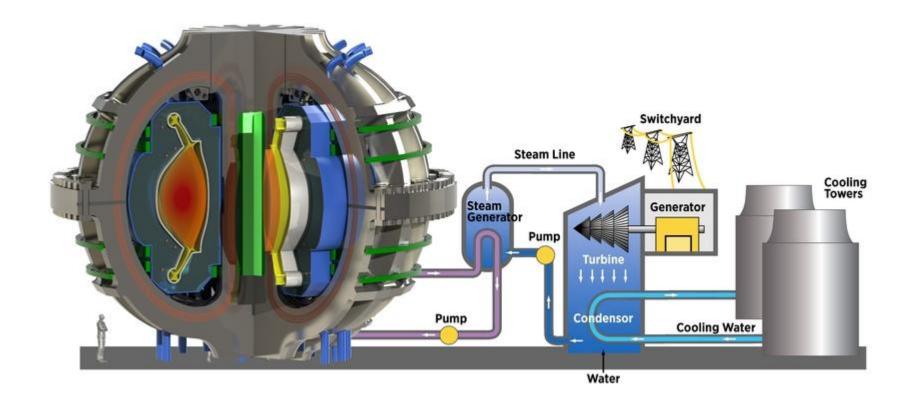
	Half-life (years)
U235	7.04x10 <sup>8</sup>
U238	4.47x10 <sup>9</sup>
•••	
Tritium	12.3

$$n + {}^{6}Li \rightarrow \alpha + T + 4.86 \text{ MeV}$$
  
 $n + {}^{7}Li \rightarrow \alpha + T + n - 2.87 \text{ MeV}$ 



# **Nuclear fusion power plant proposed by Commonwealth Fusion Systems (CFS)**

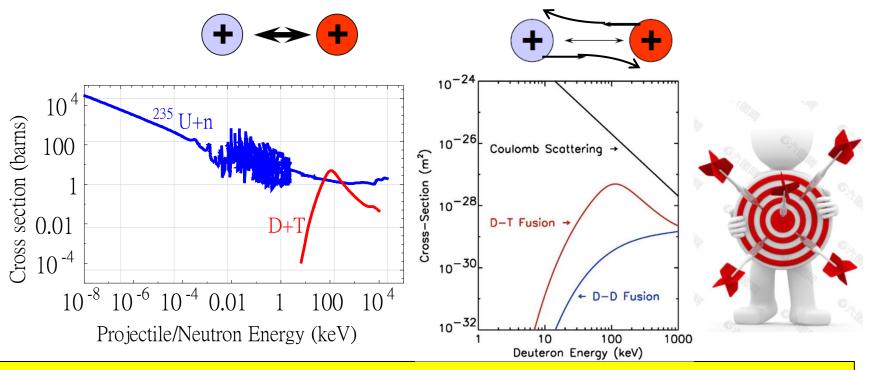




#### Fusion is much harder than fission



- Fission:  $n + {}^{235}_{92}U o {}^{236}_{92}U o {}^{144}_{56}Ba + {}^{89}_{36}Kr + 3n + 177 \text{ MeV}$
- Fusion:  $D + T \rightarrow {}_{2}^{4}He(3.5 \text{ MeV}) + n(14.1 \text{ MeV})$

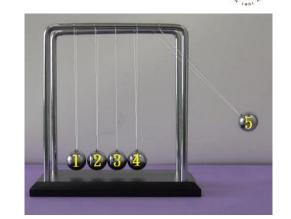


 Beam particles lose their energy before making a fusion reaction, i.e., they only thermalize the fuel. Therefore, beam fusion does NOT work!

#### Fast neutrons are slowed down due to the collisions

- A moderator is used to slow down fast neutrons but not to absorb neutrons.
- For  $m_M \sim m_N$ , the energy decrement is higher. Therefore, H slows down neutron most efficiently.

 $m_N$   $m_M$ 



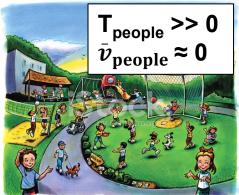
The best option is the D in the heavy water (D<sub>2</sub>O).

	Energy decrement	Neutron scattering cross section $(\sigma_s)$ (Barns)	Neutron absorption cross section $(\sigma_a)$ (Barns)
Н	1	49 (H <sub>2</sub> O)	0.66 (H <sub>2</sub> O)
D	0.7261	10.6 (D <sub>2</sub> O)	0.0013 (D <sub>2</sub> O)
С	0.1589	4.7 (Graphite)	0.0035 (Graphite)

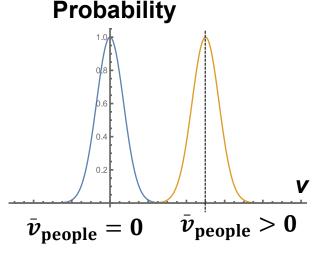
### A temperature describes the randomness of particles

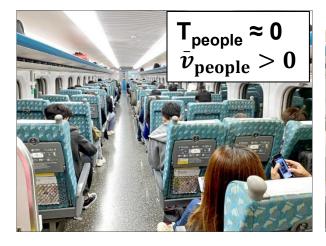














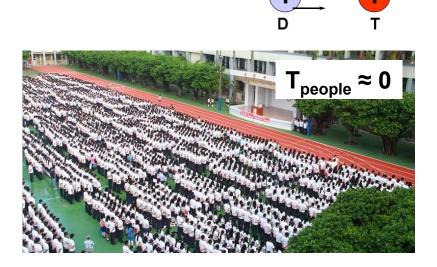
#### A "hot plasma" at 100M °C is needed



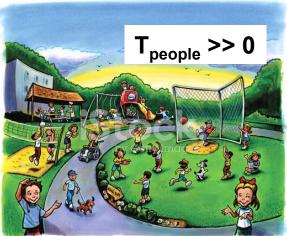
 Probability for fusion reactions to occur is low at low temperatures due to the coulomb repulsion force.

$$D + \longrightarrow T$$

 If the ions are sufficiently hot, i.e., large random velocity, they can collide by overcoming coulomb repulsion







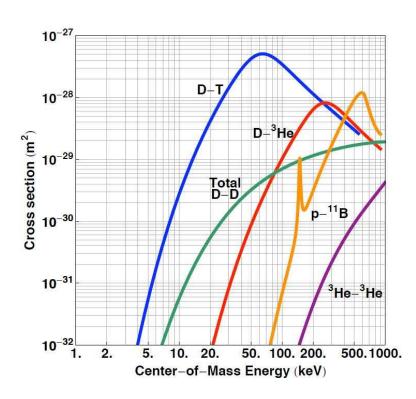
\*R. Betti, HEDSA HEDP Summer School, 2015

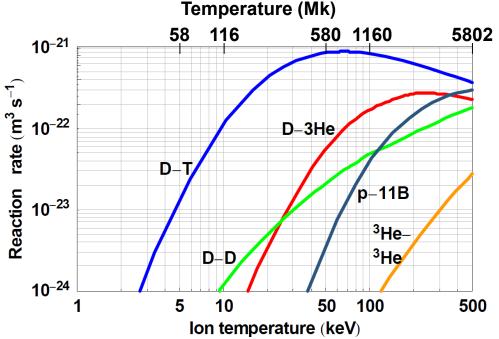
https://ydweb.yuda.tyc.edu.tw/Page/YDW/School/Home/Post?id=13286&BoardName=%E6%A1%83%E8%82%B2%E6%B4%BB%E5%8B%95%E7%85%A7%E7%89%87&Board\_PartialViewName=&Post\_PartialViewName=&Page=60&PageSize=3 https://www.freeimages.com/tw/premium/school-playground-with-children-1496555

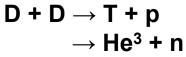
### Fusion doesn't come easy



**Probability** 



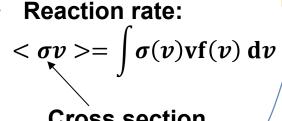




$$D + T \rightarrow He^4 + n$$

$$D + He^3 \rightarrow He^4 + p$$

$$p + B^{11} \rightarrow 3He^4$$

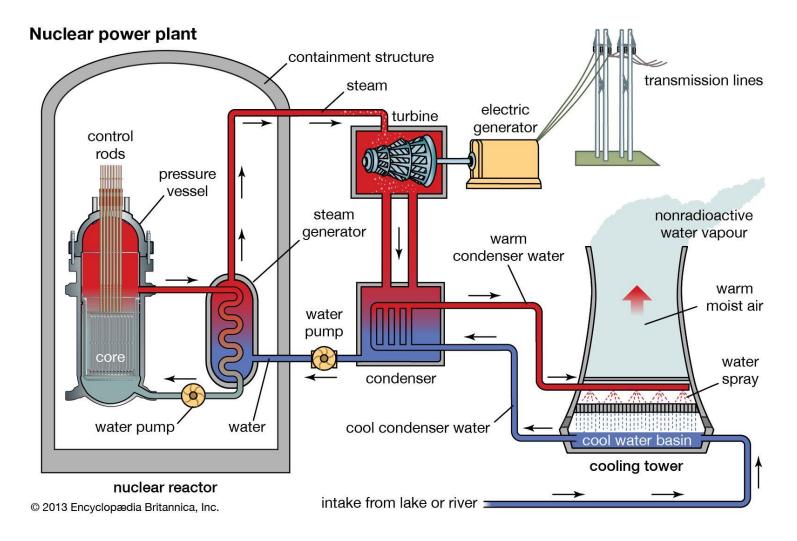


**Cross section** 

https://i.stack.imgur.com/wXQD5.jpg Santarius, J. F., "Fusion Space Propulsion - A Shorter Time Frame Than You Think", JANNAF, Monterey, 5-8 December 2005.

## **Nuclear power plant**



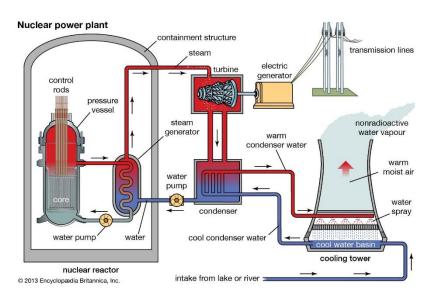


#### Comparison between nuclear fission and nuclear fusion

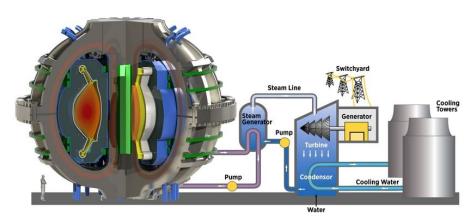


	Nuclear Fission	Nuclear Fusion
Chain reaction	Yes	No
Melt down	Possible	Impossible
Nuclear waste	High radiative	Low radiative / None

#### Nuclear fission power plant



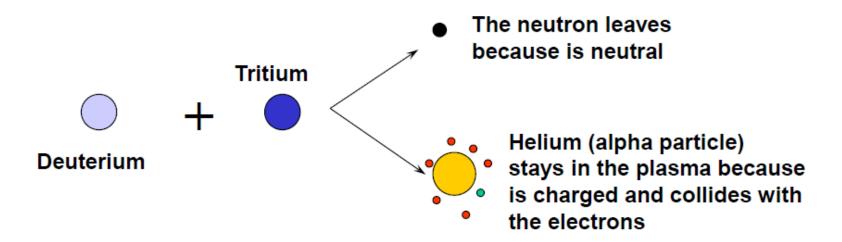
#### Nuclear fussion power plant



## It takes a lot of energy or power to keep the plasma at 100M °C



Let the plasma do it itself!



The α-particles heat the plasma.

#### Under what conditions the plasma keeps itself hot?



Steady state 0-D power balance:

$$S_{\alpha}+S_{h}=S_{B}+S_{k}$$

 $S_{\alpha}$ :  $\alpha$  particle heating

S<sub>h</sub>: external heating

**S**<sub>B</sub>: Bremsstrahlung radiation

S<sub>k</sub>: heat conduction lost

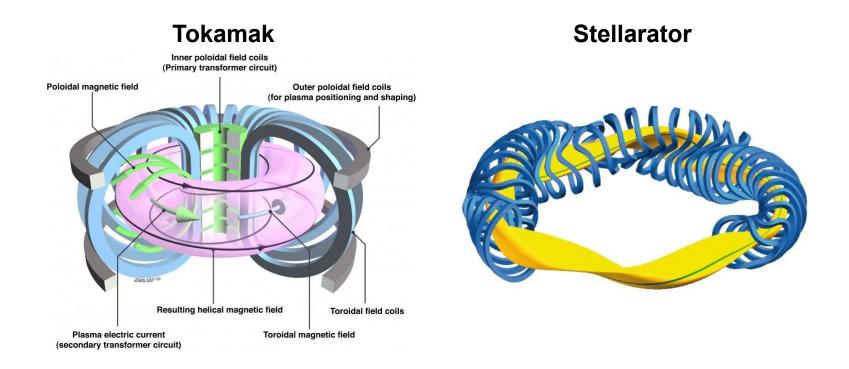
Ignition condition: PT > 10 atm-s = 10 Gbar - ns

- P: pressure, or called energy density
- т is confinement time

#### The plasma is too hot to be contained



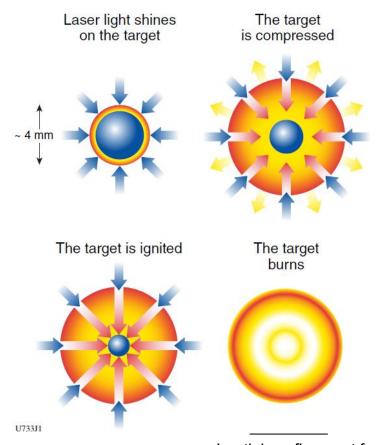
 Solution 1: Magnetic confinement fusion (MCF), use a magnetic field to contain it. P~atm, τ~sec, T~10 keV (108 °C)



#### Don't confine it!



 Solution 2: Inertial confinement fusion (ICF). Or you can say it is confined by its own inertia: P~Gigabar, τ~nsec, T~10 keV (10<sup>8</sup> °C)

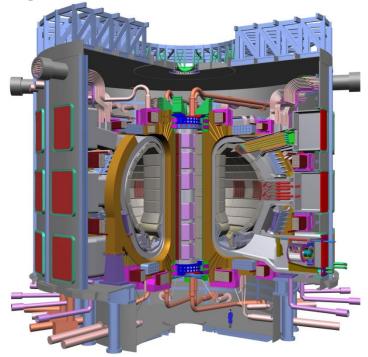


Inertial confinement fusion: an introduction, Laboratory for Laser Energetics, University of Rochester

#### To control? Or not to control?

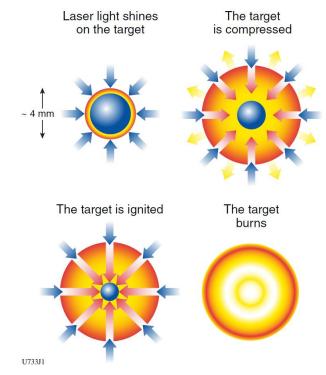


Magnetic confinement fusion (MCF)



Plasma is confined by toroidal magnetic field.

Inertial confinement fusion (ICF)



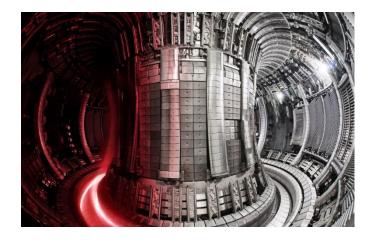
A DT ice capsule filled with DT gas is imploded by laser.

Laboratory for Laser Energetics, University of Rochester is a pioneer in laser fusion

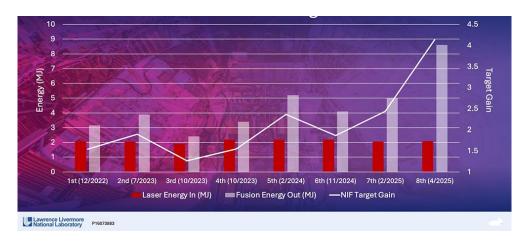
#### "Ignition" (target yield larger than one) was achieved for the first time in NIF on 2022/12/5

19:21

- Magnetic confinement fusion (MCF)
- Inertial confinement fusion (ICF)



Record-breaking 59
megajoules of sustained
fusion energy in Joint
European Torus (JET) facility
in Oxford demonstrates
powerplant potential and
strengthens case for ITER.





NIF's ignition achievement in perspective

https://ccfe.ukaea.uk/resources/#gallery https://physicstoday.scitation.org/do/10.1063/PT.6.2.20221213a/full/ https://lasers.llnl.gov/science/achieving-fusion-ignition

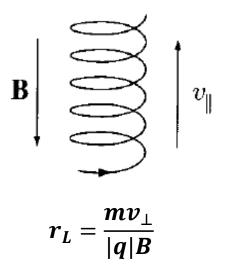
#### **Outline**

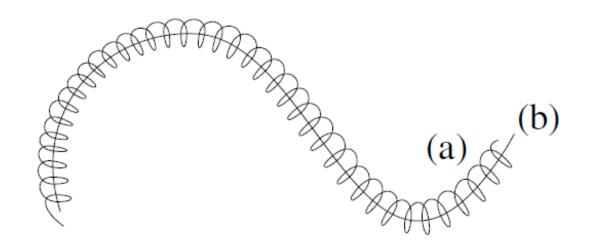


- Introduction to nuclear fusion
- Magnetic confinement fusion (MCF)
  - Tokamak
  - Stellarator
- Inertial confinement fusion (ICF)
  - Indirection drive ICF
  - Direct drive ICF
- Innovation idea MCF + ICF
- Plasma in space
- Pulsed-power system at NCKU

### Charged particles gyro around the magnetic fields



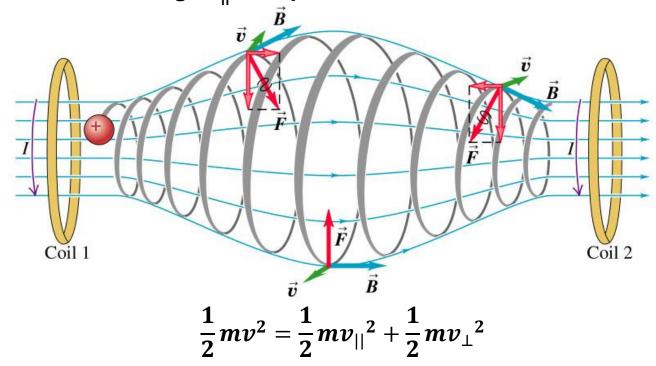




# Charged particles can be partially confined by a magnetic mirror machine



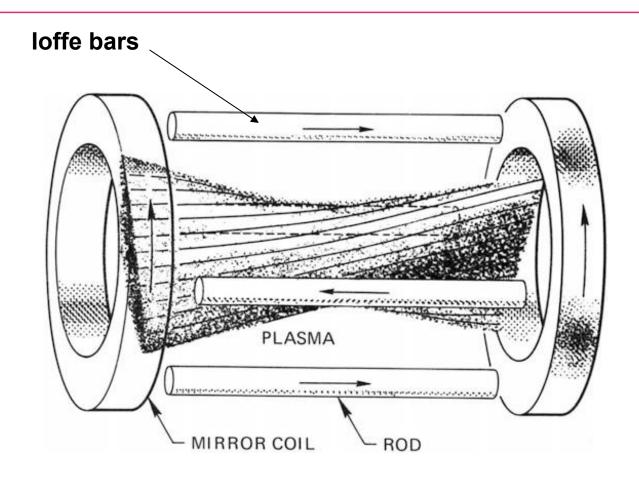
• Charged particles with small  $v_{||}$  eventually stop and are reflected while those with large  $v_{||}$  escape.



- Large v<sub>||</sub> may occur from collisions between particles.
- Those confined charged particle are eventually lost due to collisions.

## "loffe bars" are added to stabilize the Rayleigh-Taylor instabilities at the center of the mirror machine

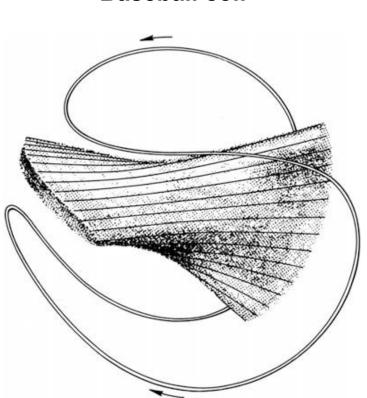




### A "baseball coil" is obtained if one links the coils and the bars into a single conductor



Baseball coil

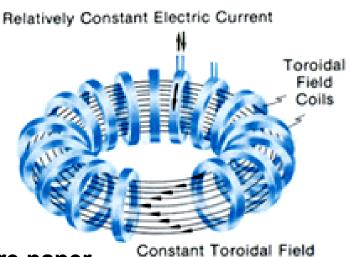


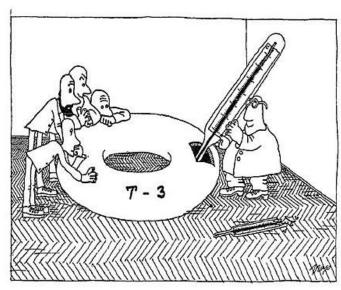
MFTF-B mirror machine



# Plasma can be confined in a doughnut-shaped chamber with toroidal magnetic field

Tokamak - "toroidal chamber with magnetic coils" (тороидальная камера с магнитными катушками)





Nature paper

Measurement of the Electron Temperature by Thomson Scattering in Tokamak T3

by

N. J. PEACOCK
D. C. ROBINSON
M. J. FORREST
P. D. WILCOCK
UKAEA Research Group,
Culham Laboratory,

Abingdon, Berkshire

V. V. SANNIKOV
I. V. Kurchatov Institute,
Moscow

Electron temperatures of 100 eV up to I keV and densities in the range  $I-3\times 10^{13}$  cm<sup>-3</sup> have been measured by Thomson scattering on Tokamak T3. These results agree with those obtained by other techniques where direct comparison has been possible.

in ring her

Te = 100 ~ 1 keV

• n=1-3 x 10<sup>13</sup> cm<sup>-3</sup>

https://www.iter.org/mach/tokamak

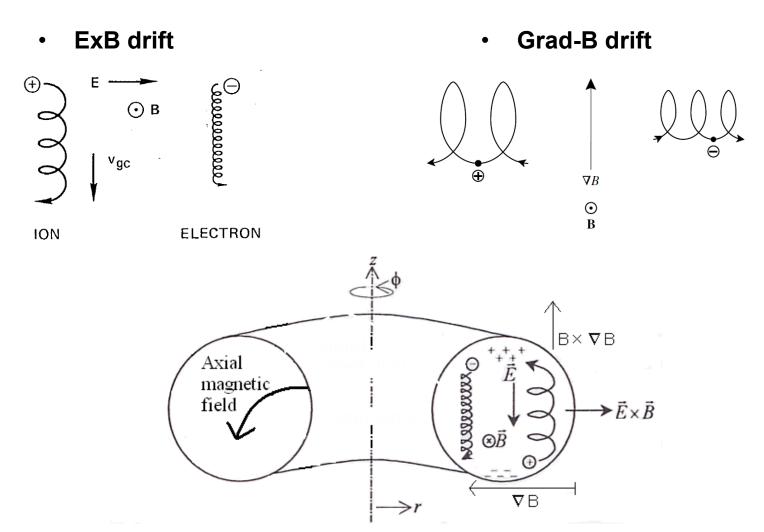
https://en.wikipedia.org/wiki/Tokamak#cite\_ref-4

N. J. Peacock, etc., Nature 224, 488 (1969)

Drawing from the talk "Evolution of the Tokamak" given in 1988 by B.B. Kadomtsev at Culham.

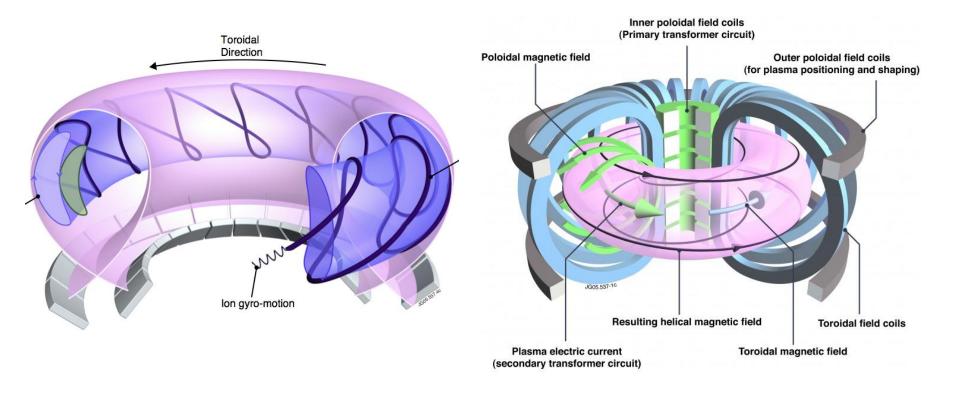
### Charged particles drift across field lines





### A poloidal magnetic field is required to reduce the drift across field lines





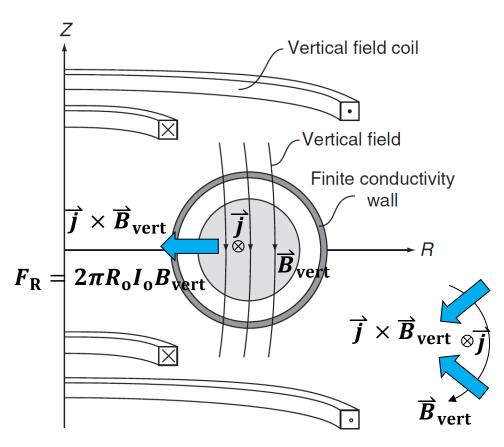
### A poloidal magnetic field is required to reduce the drift across field lines



# The outward force can be compensated by externally applied vertical fields

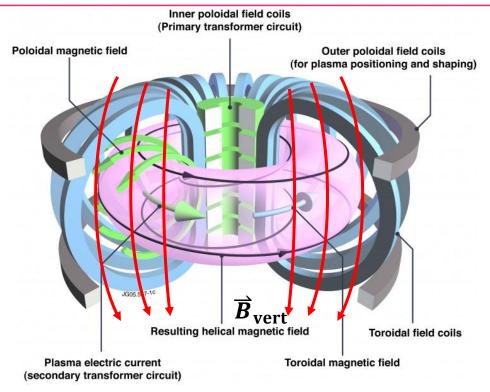


#### Externally applied vertical field



#### Coils in a tokamak

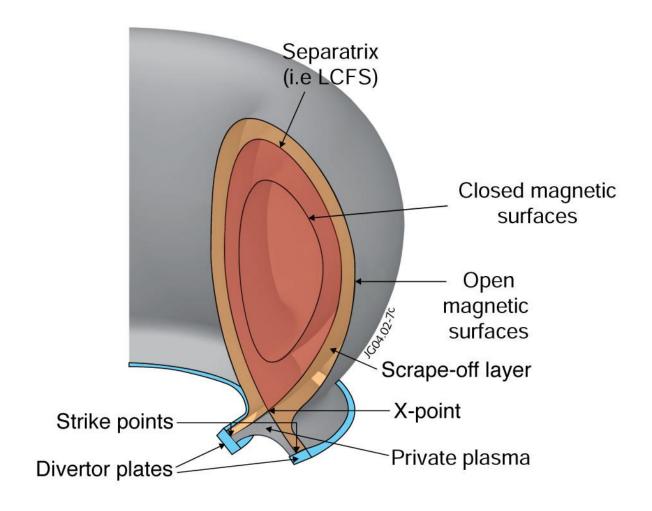




- Toroidal field coils (in poloidal direction) generate toroidal field for confinement.
- Poloidal field coils generate vertical field for plasma positioning and shaping.
- Central solenoid for breakdown and generating plasma current (in toroidal direction) and thus generating poloidal field for confinement.

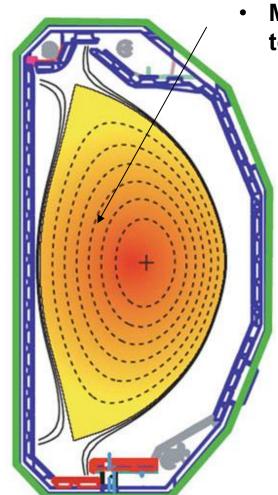
# A divertor is needed to remove impurities and the power that escapes from the plasma





# D-shaped tokamak with diverter is more preferred nowadays

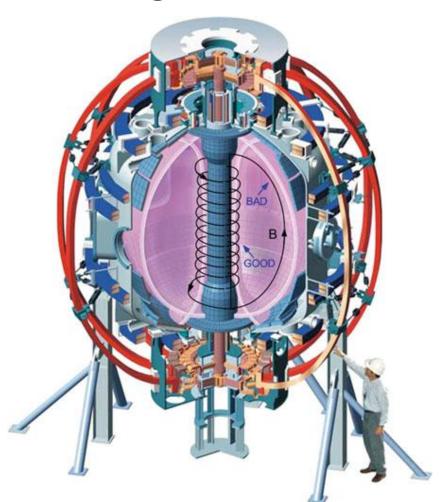




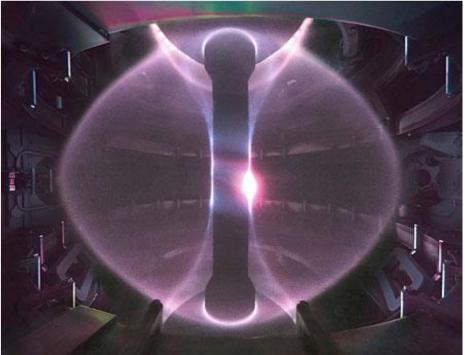
Make the plasma closer to the major axis

# Spherical tokamak is formed when the aspect ratio of a tokamak is reduced to the order of unity

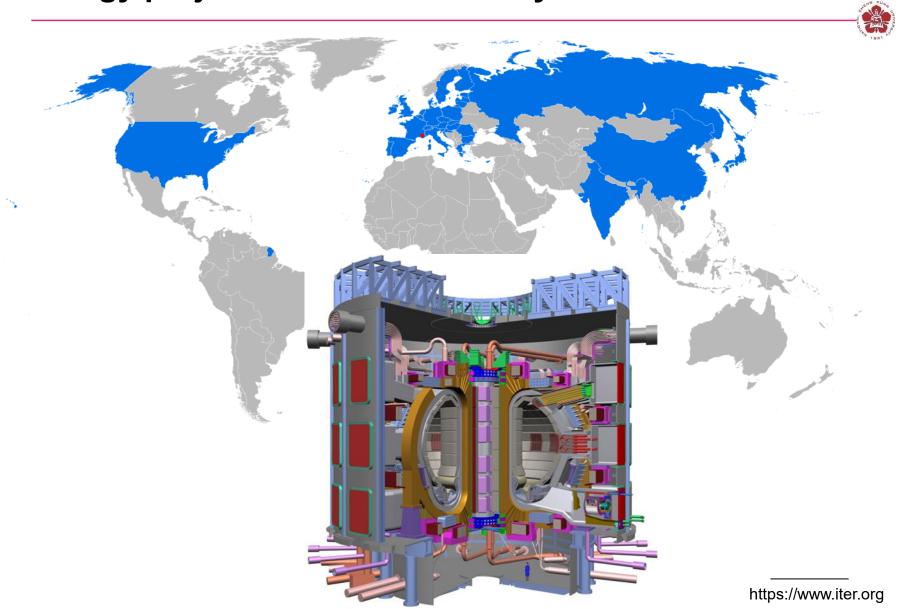
NSTX @ Princeton



 MegaAmpere Spherical Tokamak (MAST) @ Culham center for fusion energy, UK

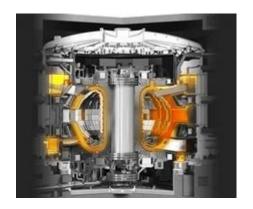


# ITER ("The Way" in Latin) is one of the most ambitious energy projects in the world today

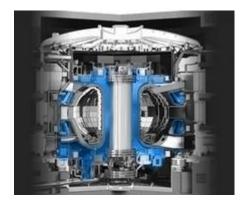


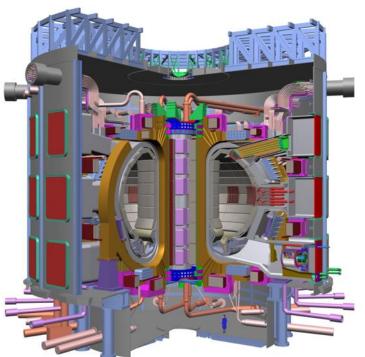
# ITER ("The Way" in Latin) is one of the most ambitious energy projects in the world today

#### Vacuum vessel

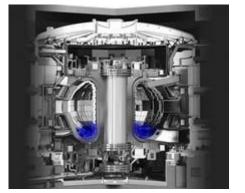


Magnets

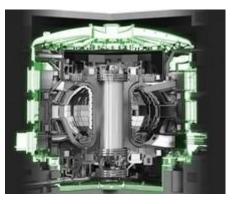




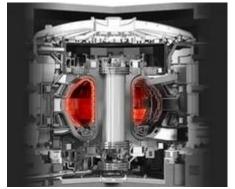
Divertor



Cryostat



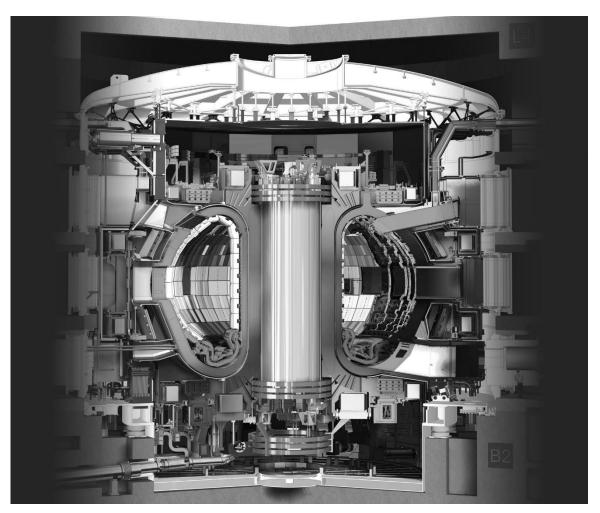
Blanket



### **ITER**



- T=150M °C
- P=500 MW



### ITER – Magnets



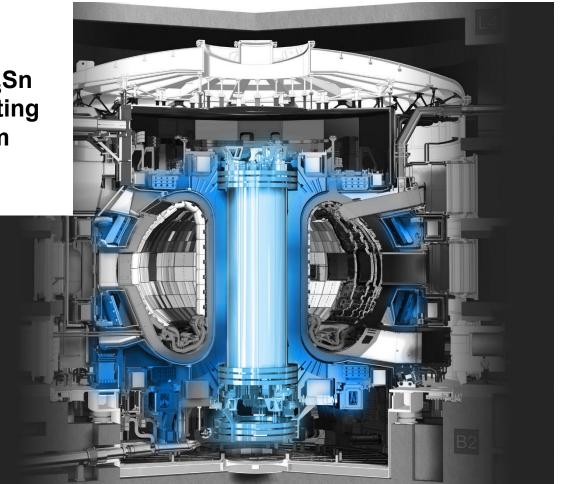
• E<sub>B</sub>=51 GJ

• T<sub>B</sub>=4 K

 Length of Nb<sub>3</sub>Sn superconducting strand: 10<sup>5</sup> km

• B<sub>T,max</sub>=11.8 T

• B<sub>P,max</sub>=6 T



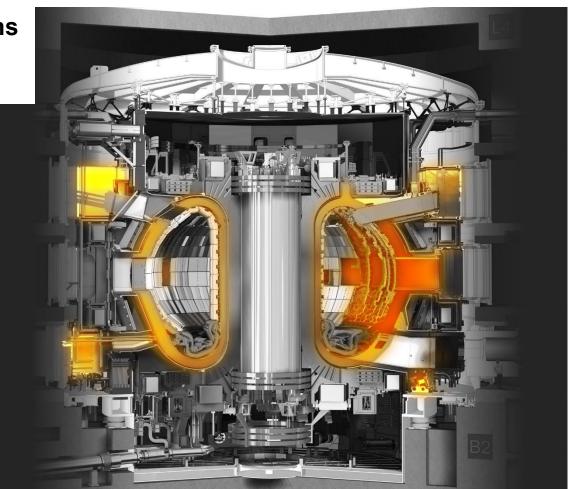
#### ITER - Vacuum vessel



• W = 8000 tons

•  $V = 840 \text{ m}^3$ 

• R = 6 m

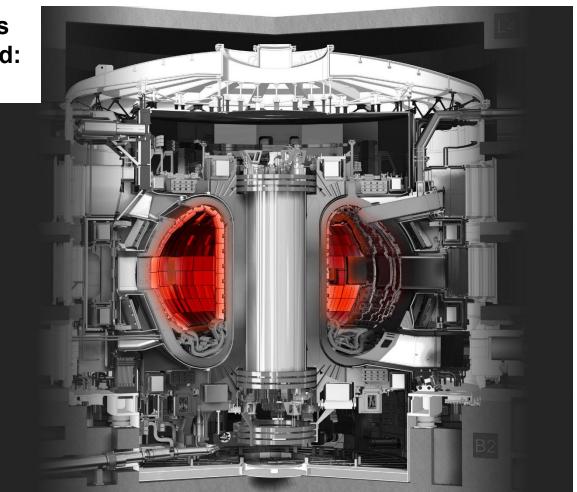


#### ITER - Blanket



440 modules

Thermal load:736 MW



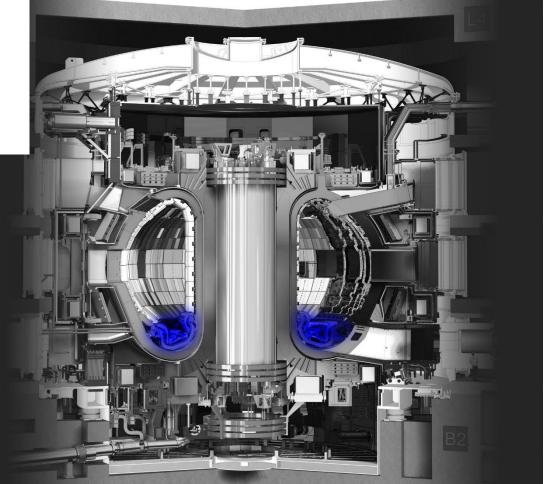
#### ITER - Divertor



54 cassettes

Thermal load:
 20 MW/m²

Each cassette:10 tons



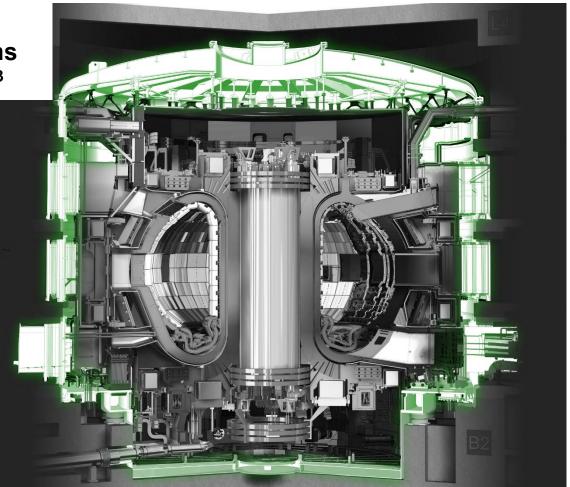
### ITER – Crystat



 $P = 10^{-6}$  atm

• W = 3800 tons

•  $V = 16000 \text{ m}^3$ 



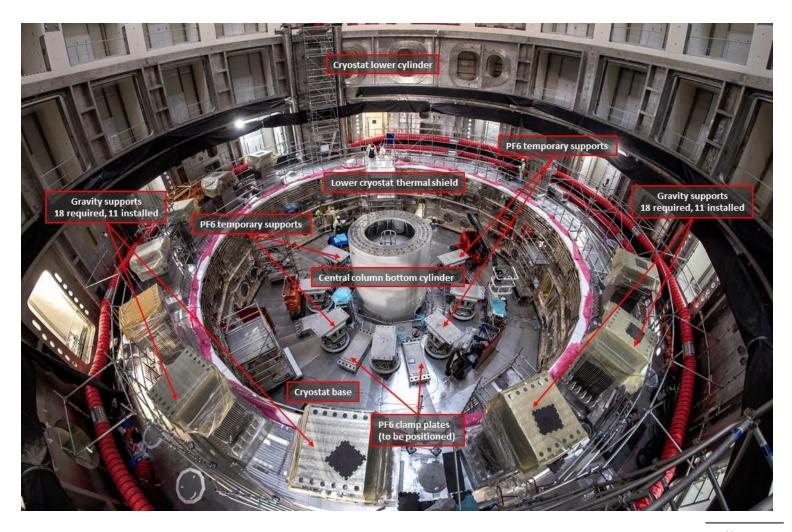
#### **Supporting systems**



- Tritium breeding
- Control, Data access and Communication (CODAC)
- Cooling water
- Cryogenics
- Diagnostics
- Fuel cycle
- Hot cell a secure environment for processing, repair or testing, etc., of components that have become activated by neutrons.
- Power supply
- Remote handling
- Heating and current drive
- Vacuum system

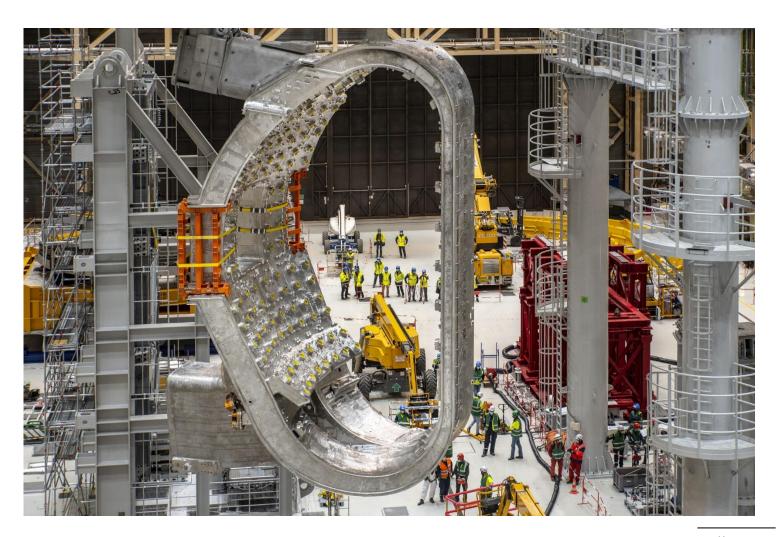
### ITER is being assembled





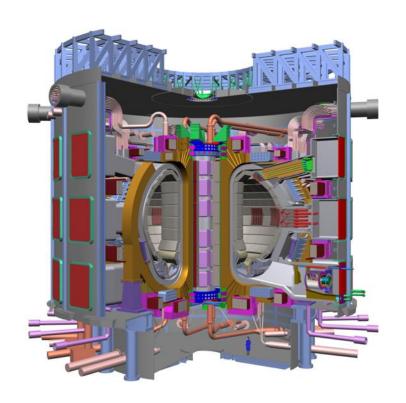
### ITER is being assembled





### There is a long way to go, but we are on the right path...





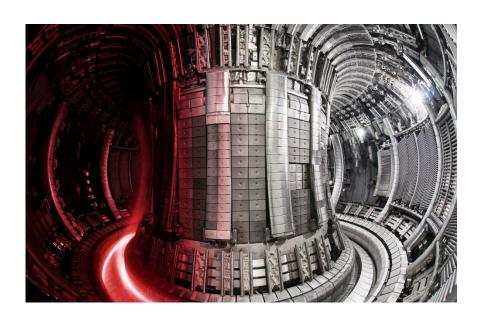
Dec 2025 First Plasma

2035

**Deuterium-Tritium Operation begins** 

### Joint European Torus (JET) facility has a recordbreaking 59 megajoules of sustained fusion energy

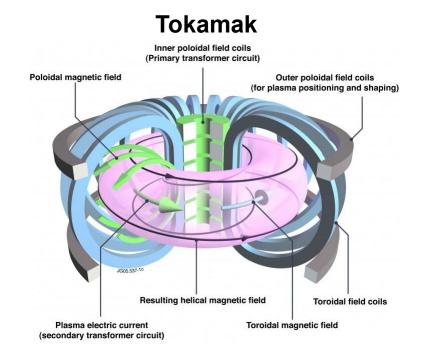




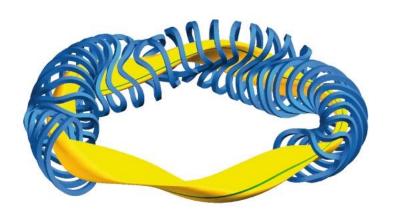
 Record-breaking 59 megajoules of sustained fusion energy in Joint European Torus (JET) facility in Oxford demonstrates powerplant potential and strengthens case for ITER.

# Stellarator uses twisted coil to generate poloidal magnetic field



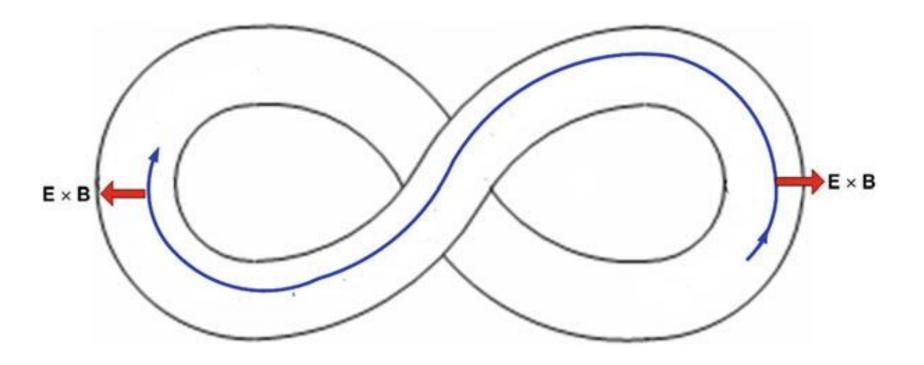


#### **Stellarator**



### A figure-8 stellarator solved the drift issues





### A figure-8 stellarator solved the drift issues



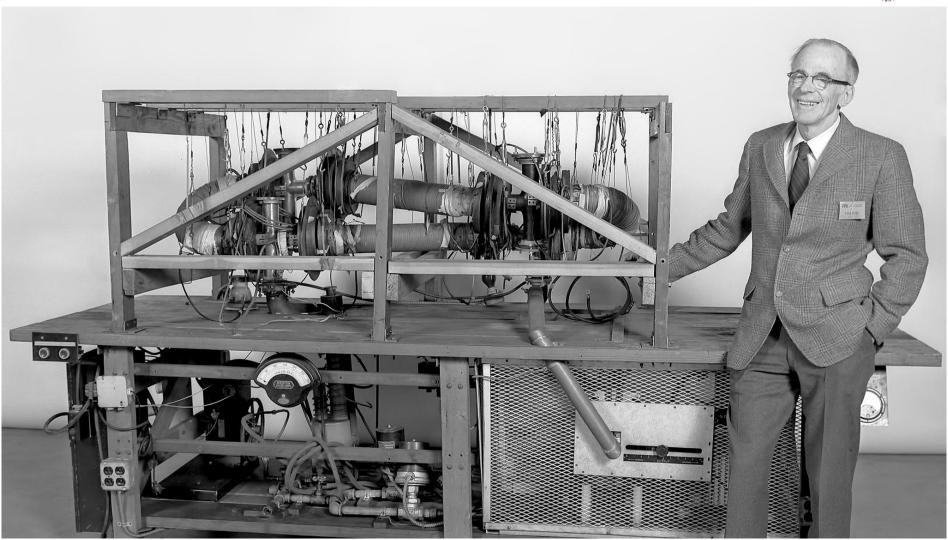
### Lyman Spitzer, Jr. came out the idea during a long ride on a ski lift at Garmisch-Partenkirchen





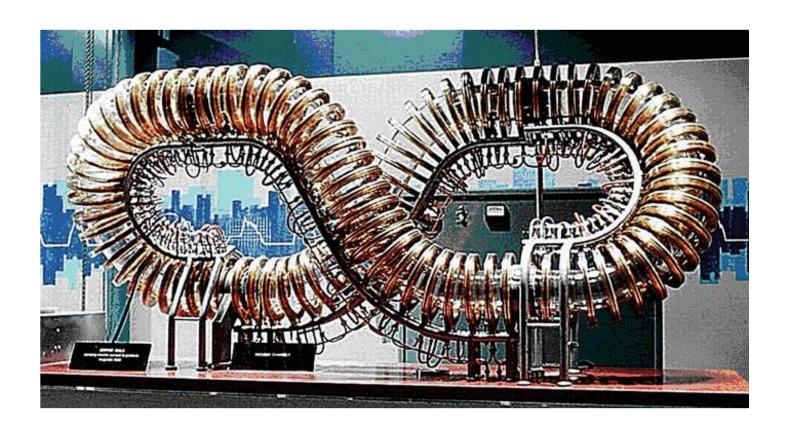
#### **Model A stellarator**





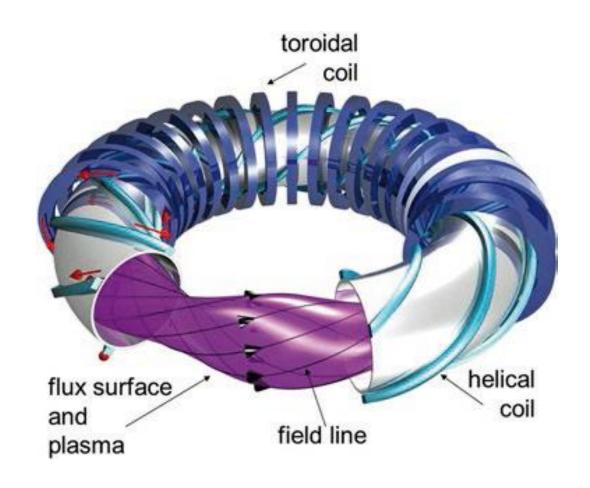
## Exhibit model of a figure-8 stellarator for the Atoms for Peace conference in Geneva in 1958





### Twisted magnetic field lines can be provided by toroidal coils with helical coils





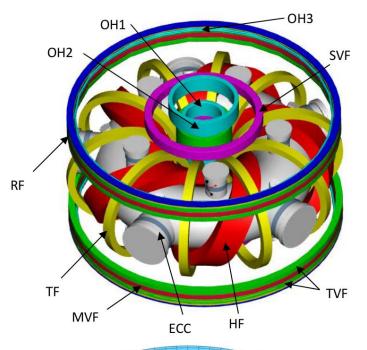
# Construction of a pair of helical magnetic coils for the Advanced Toroidal Facility torsatron

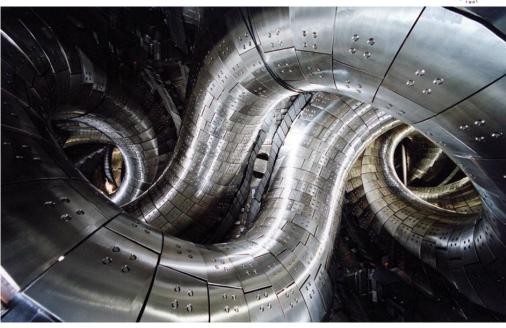


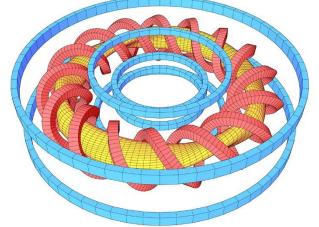


### LHD stellarator in Japan (Heliotron)



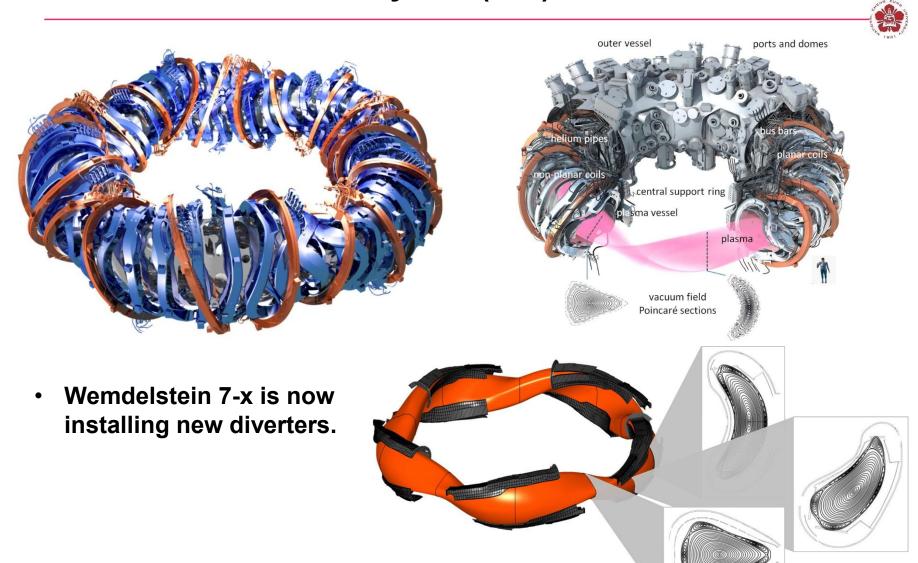






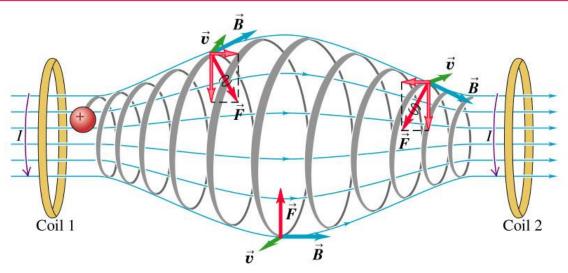
https://en.wikipedia.org/wiki/Compact\_Toroidal\_Hybrid https://www.energyencyclopedia.com/en/glossary/heliotron https://en.wikipedia.org/wiki/Large\_Helical\_Device

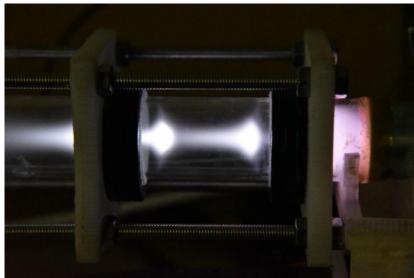
# Wendelstein 7-X is a stellarator built by Max Planck Institute for Plasma Physics (IPP)



## Demonstration of a magnetic mirror machine



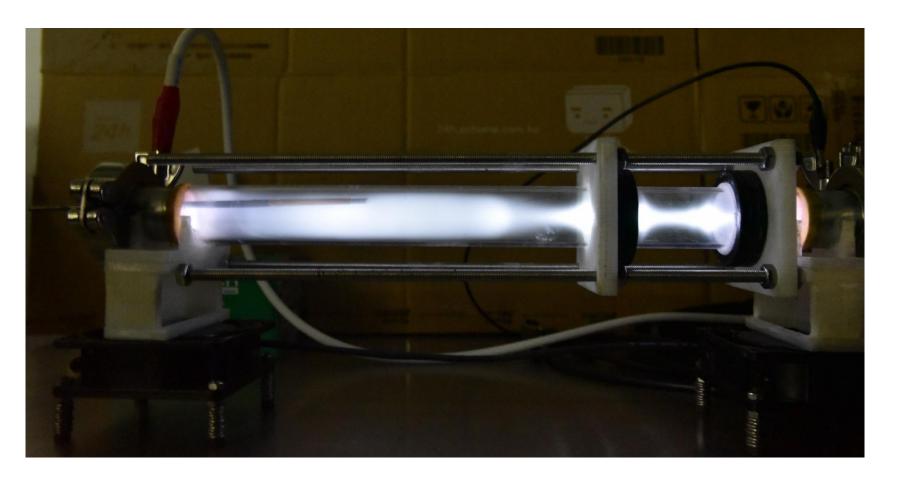




Show video.

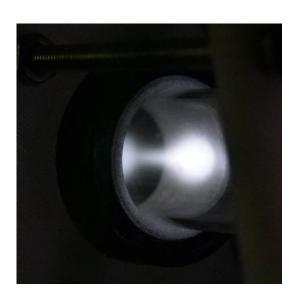
## Plasma is partially confined by the magnetic field

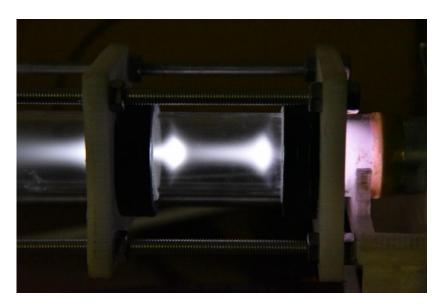


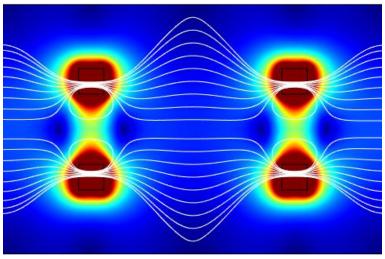


# Many mirror points are provided by a pair of ring-type magnets







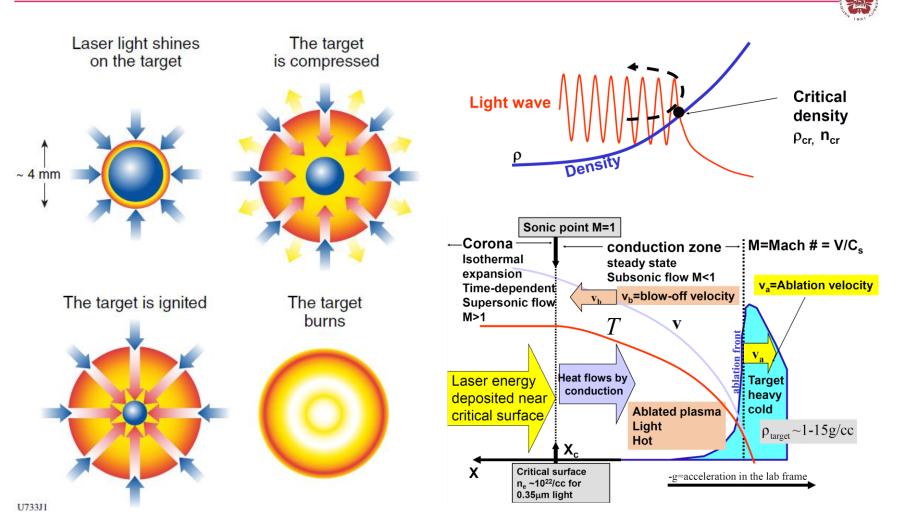


### **Outline**



- Introduction to nuclear fusion
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  - Tokamak
  - Stellarator
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  - Indirection drive ICF
  - Direct drive ICF
- Innovation idea MCF + ICF
- Plasma in space
- Pulsed-power system at NCKU

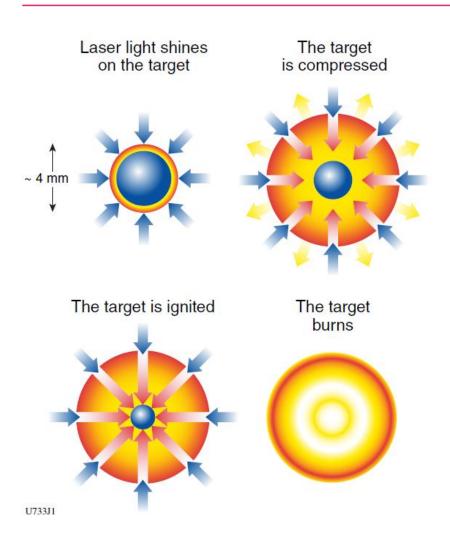
# Compression happens when outer layer of the target is heated by laser and ablated outward



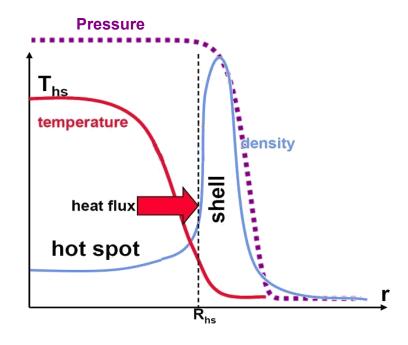
Inertial confinement fusion: an introduction, Laboratory for Laser Energetics, University of Rochester R. Betti, HEDSA HEDP Summer School, 2015

# Plasma is confined by its own inertia in inertial confinement fusion (ICF)





### **Spatial profile at stagnation**

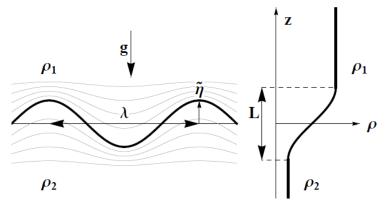


# A ball can not be compressed uniformly by being squeezed between several fingers

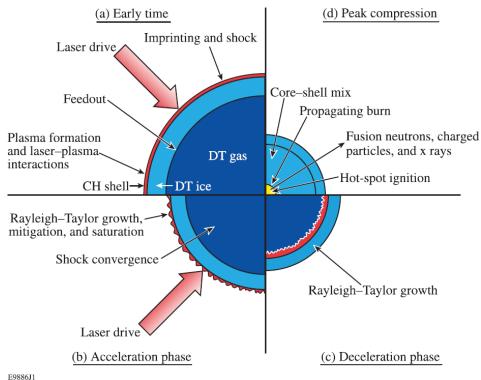




### Rayleigh-Taylor instability



### Stages of a target implosion

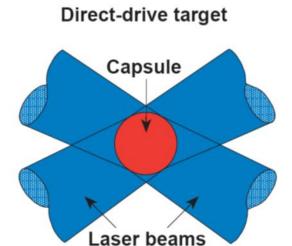


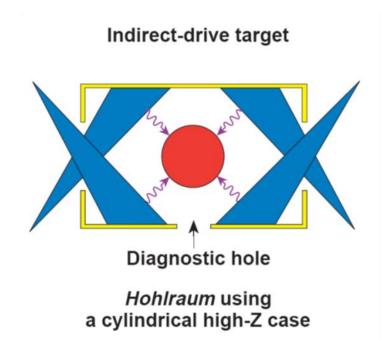
P.-Y. Chang, PhD Thesis, U of Rochester (2013)

R. S. Craxton, etc., Phys. Plasmas 22, 110501 (2015)

# A spherical capsule can be imploded through directly or indirectly laser illumination







## Rochester is known as "The World's Image Center"





### There are many famous optical companies at Rochester



## Kodak





Eastman school of music

## **BAUSCH+LOMB**

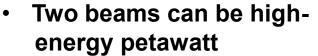


# Laboratory for Laser Energetics, University of Rochester is a pioneer in laser fusion

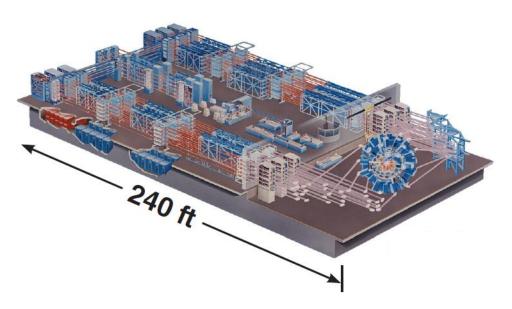
- OMEGA Laser System
  - 60 beams
  - >30 kJ UV on target
  - 1%~2% irradiation nonuniformity
  - Flexible pulse shaping

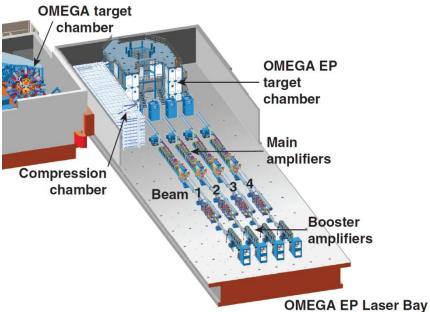






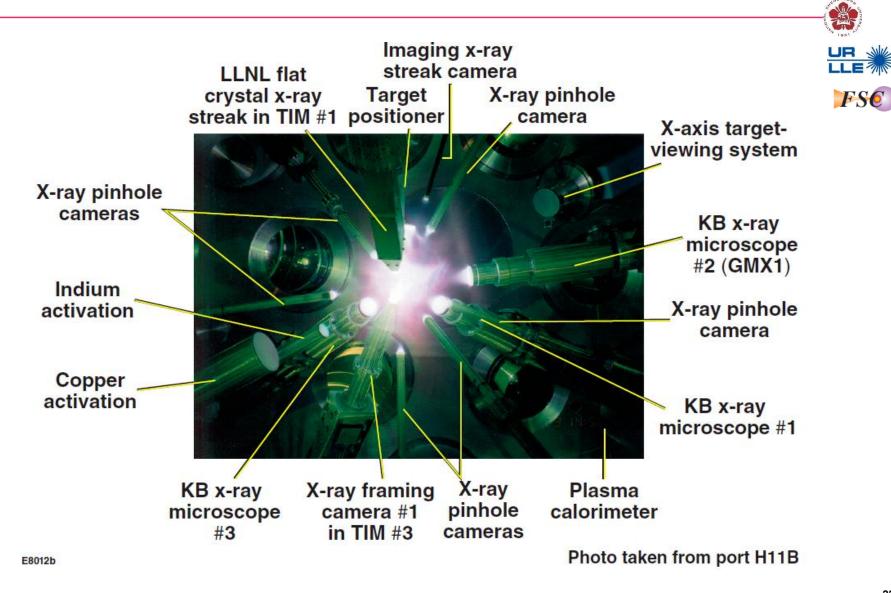
- 2.6 kJ IR in 10 ps
- Can propagate to the OMEGA or OMEGA EP target chamber





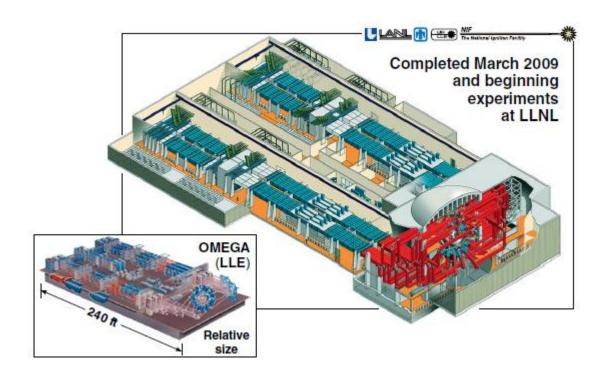
FSC

# The OMEGA Facility is carrying out ICF experiments using a full suite of target diagnostics



# The 1.8-MJ National Ignition Facility (NIF) will demonstrate ICF ignition and modest energy gain

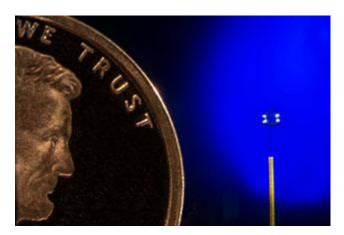




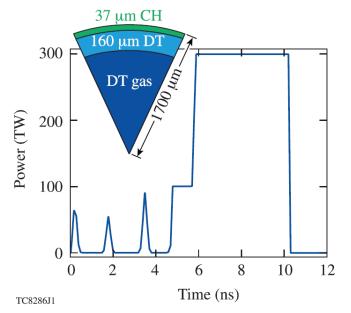
OMEGA experiments are integral to an ignition demonstration on the NIF.

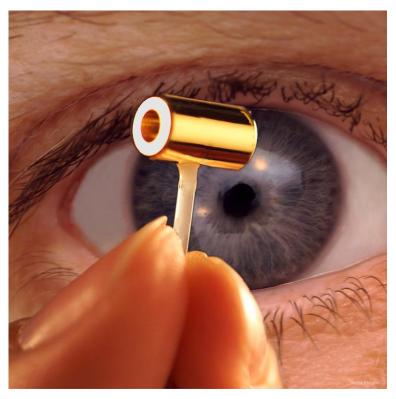
## Targets used in ICF





Triple-point temperature : 19.79 K

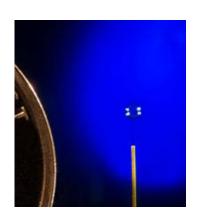




http://www.lle.rochester.ed https://en.wikipedia.org/wiki/Inertial\_confinement\_fusion R. S. Craxton, etc., *Phys. Plasmas* **22**, 110501 (2015)

## Targets used in ICF

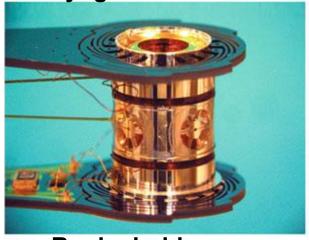




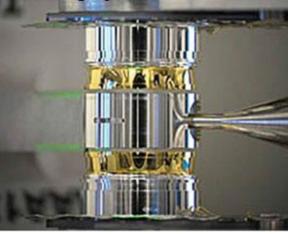
Cryogenic shroud



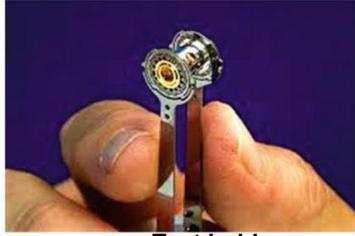
a Cryogenic hohlraum



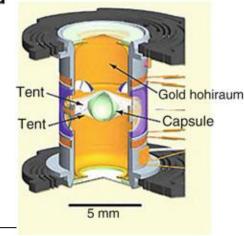
Rugby hohlraum



b



d Tent holder



https://www.lle.rochester.edu/index.php/2014/11/10/next-generation-cryo-target/ Introduction to Plasma Physics and Controlled Fusion 3<sup>rd</sup> Edition, by Francis F. Chen https://www.llnl.gov/news/nif-shot-lights-way-new-fusion-ignition-phase

## Softer material can be compressed to higher density

Compression of a baseball



Compression of a tennis ball



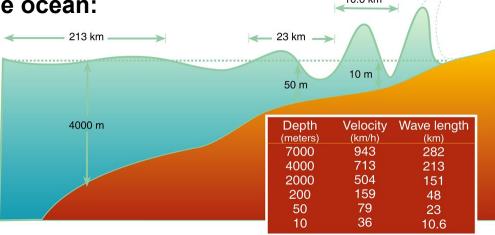




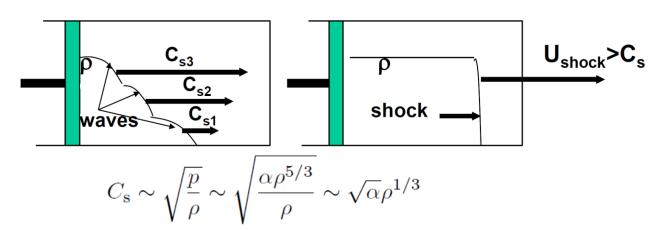
# A shock is formed due to the increasing sound speed of a compressed gas/plasma





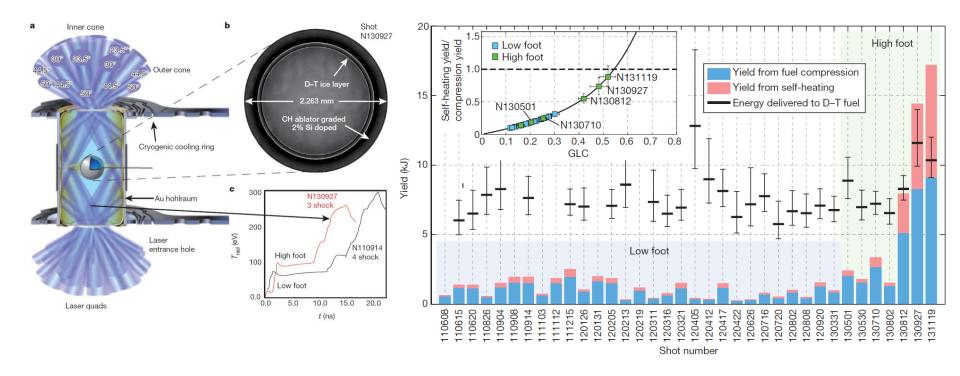


Acoustic/compression wave driven by a piston:



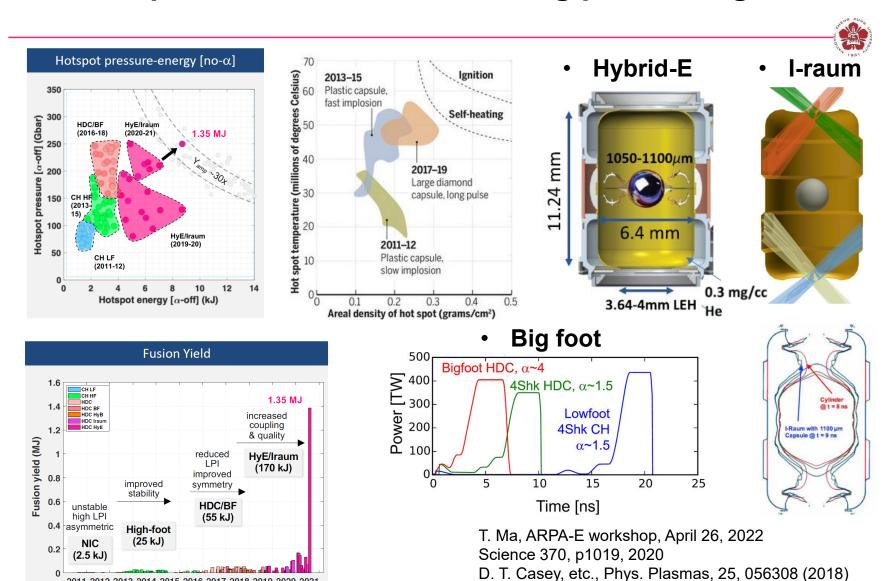
# Nature letter "Fuel gain exceeding unity in an inertially confined fusion implosion"





Fuel gain exceeding unity was demonstrated for the first time.

### The hot spot has entered the burning plasma regime



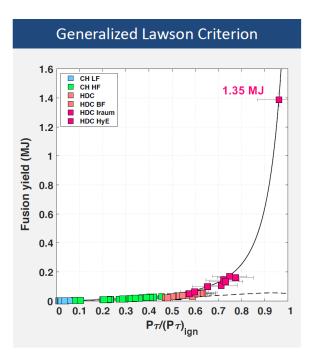
2011 2012 2013 2014 2015 2016 2017 2018 2019 2020 2021

Year

A. L. Kritcher, etc., Phys. Plasmas, 28, 072706 (2021)

H. F. Robey, etc., Phys. Plasmas, 25, 012711 (2018)

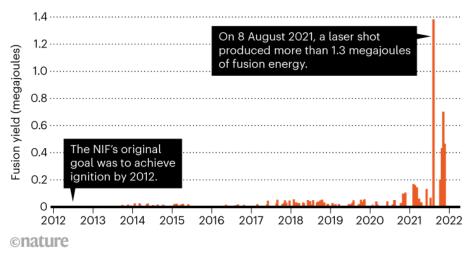
# National Ignition Facility (NIF) achieved a yield of more than 1.3 MJ from ~1.9 MJ of laser energy in 2021 (Q~0.7)



National Ignition Facility (NIF)
 achieved a yield of more than 1.3
 MJ (Q~0.7). This advancement puts
 researchers at the threshold of
 fusion ignition.

#### THE ROAD TO IGNITION

The National Ignition Facility (NIF) struggled for years before achieving a high-yield fusion reaction (considered ignition, by some measures) in 2021. Repeat experiments, however, produced less than half the energy of that result.

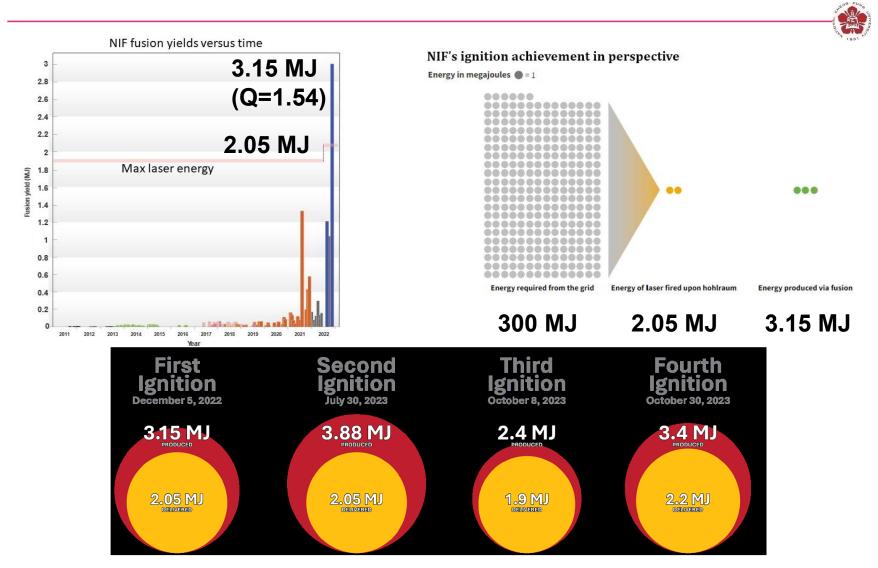


 Laser-fusion facility heads back to the drawing board.

T. Ma, ARPA-E workshop, April 26, 2022

J. Tollefson, Nature (News) 608, 20 (2022)

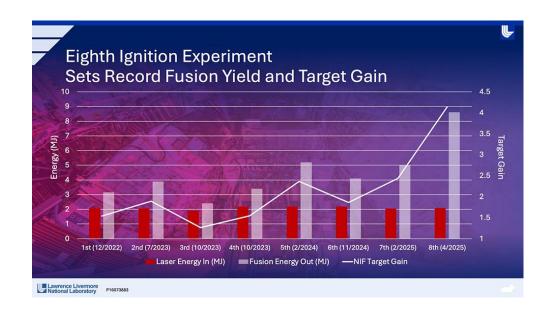
## "Ignition" (target yield larger than one) was achieved in NIF on 2022/12/5

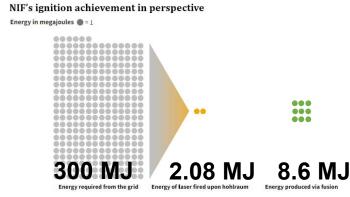


https://physicstoday.scitation.org/do/10.1063/PT.6.2.20221213a/full/ The age of ignition: anniversary edition, LLNL-BR-857901

## A gain over 4 has been achieved





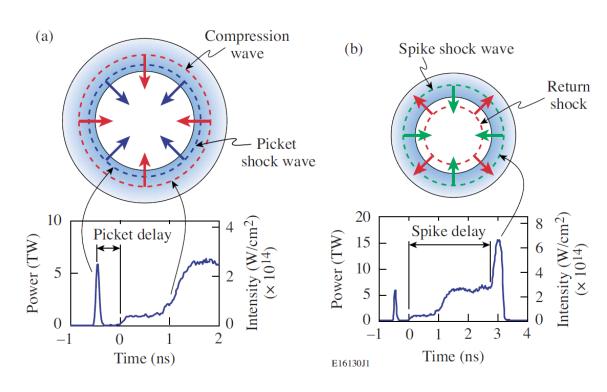


 In recent attempts, the team at NIF increased the yield of the experiment, first to 5.2 megajoules and then again to 8.6 megajoules, according to a source with knowledge of the experiment.

## External "spark" can be used for ignition

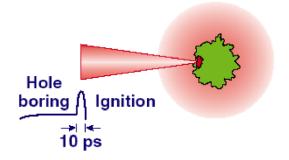


### Shock ignition

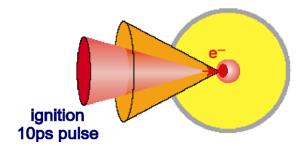


### Fast ignition

a) channeling FI concept



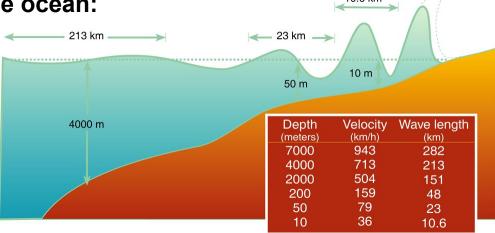
b) cone-in-shell FI concept



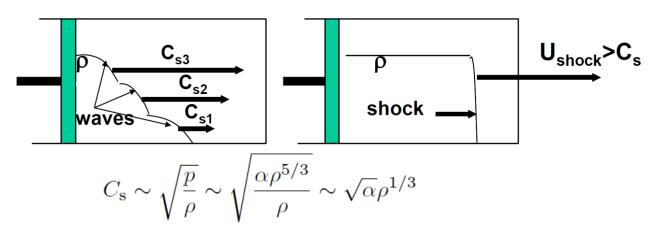
# A shock is formed due to the increasing sound speed of a compressed gas/plasma







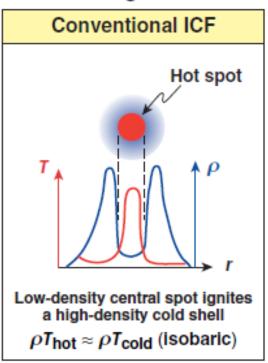
Acoustic/compression wave driven by a piston:



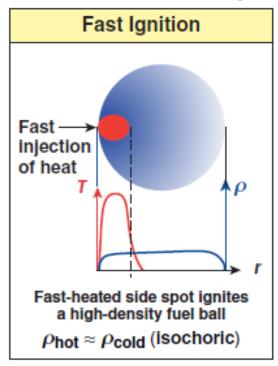
## Ignition can happen by itself or being triggered externally

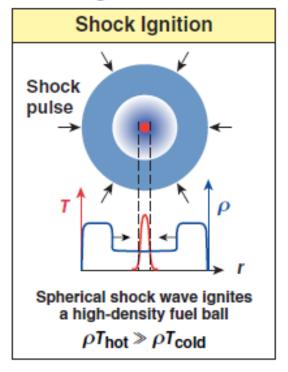


#### Self-ignition



#### External "spark" for fast ignition





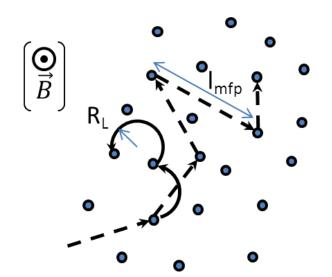
### **Outline**



- Introduction to nuclear fusion
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  - Tokamak
  - Stellarator
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  - Indirection drive ICF
  - Direct drive ICF
- Innovation idea MCF + ICF
- Plasma in space
- Pulsed-power system at NCKU

## A strong magnetic field reduces the heat flux





$$oldsymbol{q}_{ au} = -\kappa_{||} 
abla_{||} oldsymbol{T} - \kappa_{\perp} 
abla_{\perp} oldsymbol{T}$$
 $oldsymbol{\kappa}_{||} = \kappa_{0} oldsymbol{T}^{5/2}$ 

$$\kappa_{||} = \kappa_0 T^{5/2}$$

$$\kappa_{\perp} = \frac{\kappa_{||}}{\chi^2}$$
 for large Hall parameter  $\chi \propto \frac{I_{\text{mfp}}}{R_{\perp}} >> 1$ 

Typical hot spot conditions:

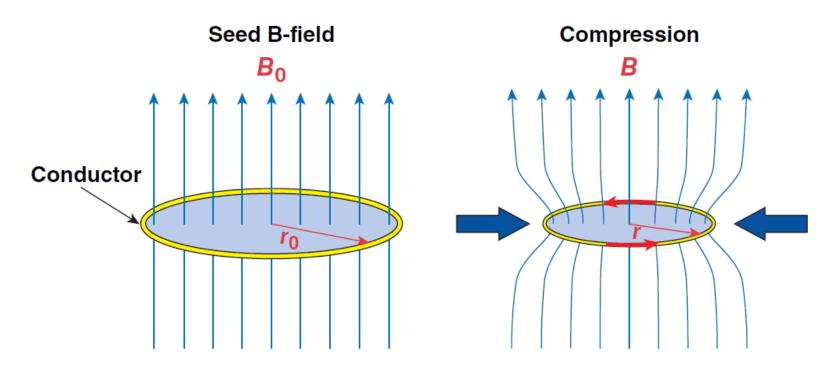
 $R_{hs} \sim 40 \ \mu m, \ \rho \sim 20 \ g/cm^3, \ T \sim 5 \ keV$ :

 $B > 10 \, \text{MG}$  is neededfor  $\chi > 1$ 

Magnetic-flux compression can be used to provide the needed magnetic field.

# Principle of frozen magnetic flux in a good conductor is used to compress fields

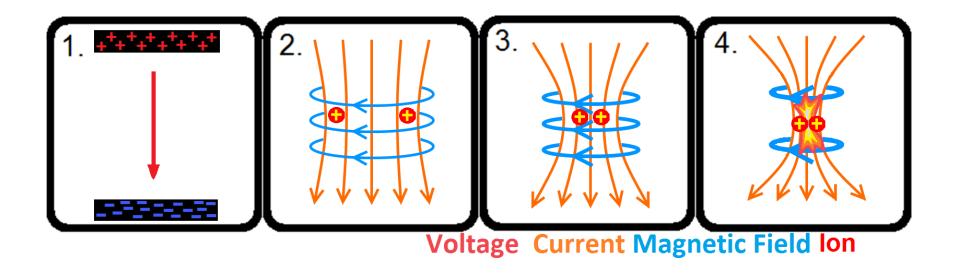




$$\Phi = \pi r_0^2 B_0 = \pi r^2 B$$

## Plasma can be pinched by parallel propagating plasmas

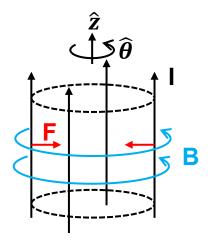




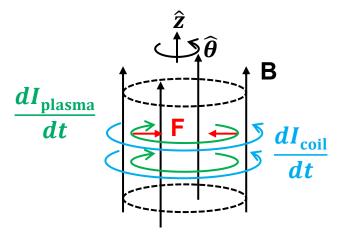
## Plasma can be heated via pinches





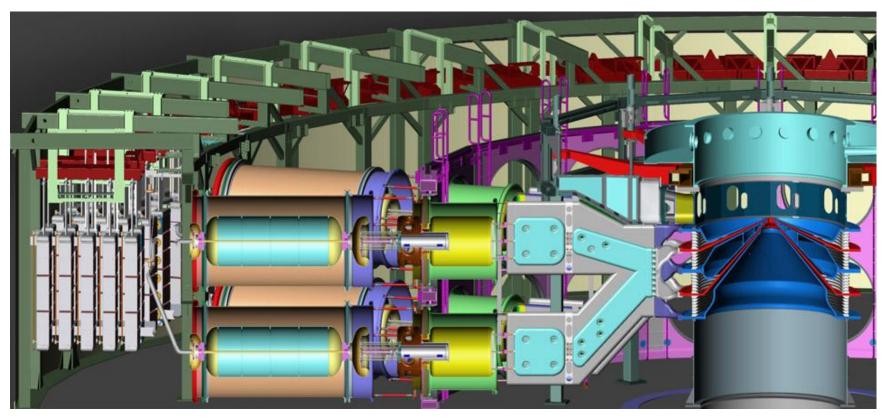


### Theta pinch



# Sandia's Z machine is the world's most powerful and efficient laboratory radiation source





Stored energy: 20 MJ

Marx charge voltage: 85 kV

Peak electrical power: 85 TW

Peak current: 26 MA

Rise time: 100 ns

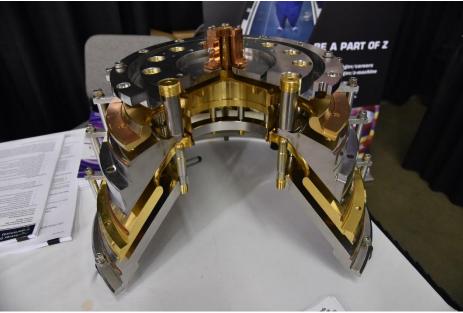
Peak X-ray emissions: 350 TW

Peak X-ray output: 2.7 MJ

## **Z** machine



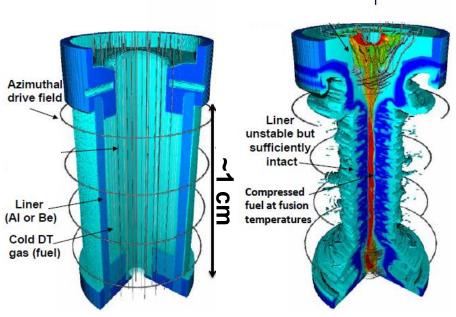




### **Z** machine







Stored energy: 20 MJ

Peak electrical power: 85 TW

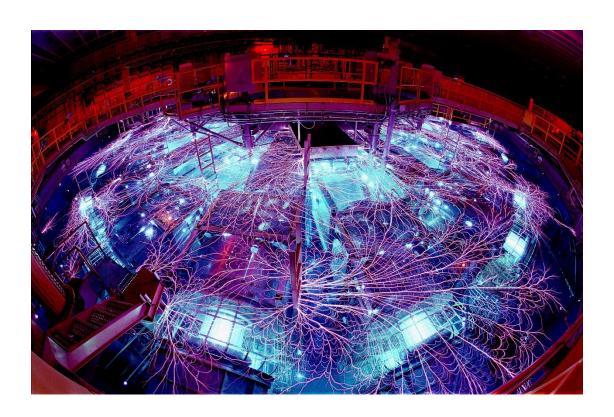
Peak current: 26 MA

Rise time: 100 ns

Peak X-ray output: 2.7 MJ

## **Z** machine discharge



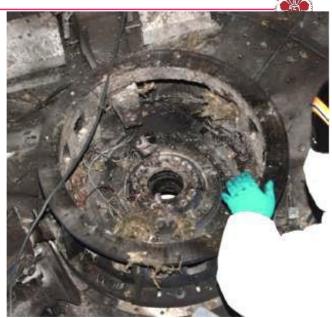


### Before and after shots

### Before shots



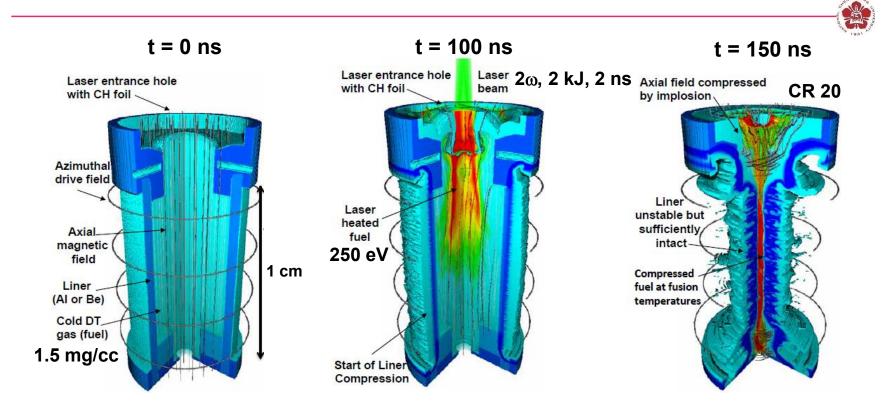
### After shots





SAND2017-0900PE\_The sandia z machine - an overview of the world's most powerful pulsed power facility.pdf

# Promising results were shown in MagLIF concept conducted at the Sandia National Laboratories

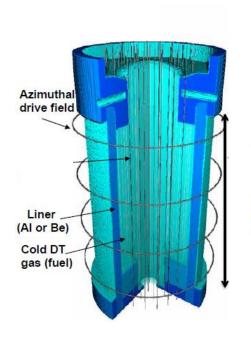


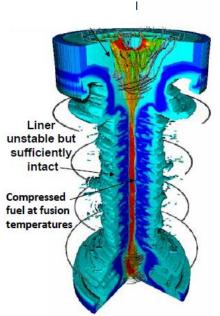
The stagnation plasma reached fusion-relevant temperatures with a 70 km/s implosion velocity

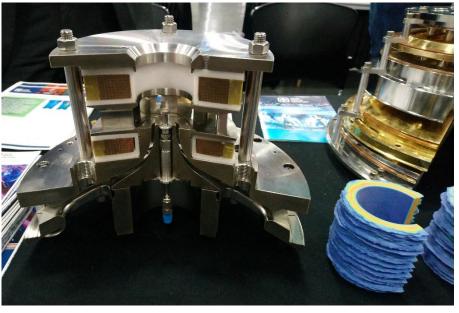
S. A. Slutz *et al* Phys. Plasmas 17 056303 (2010) M. R. Gomez *et al* Phys. Rev. Lett. 113 155003 (2014)

# **MagLIF target**



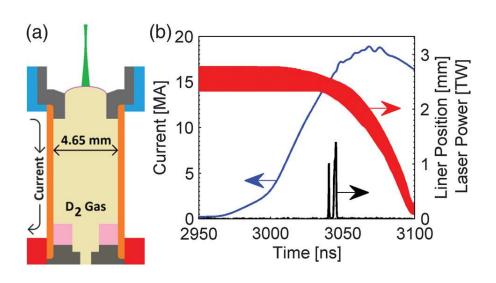


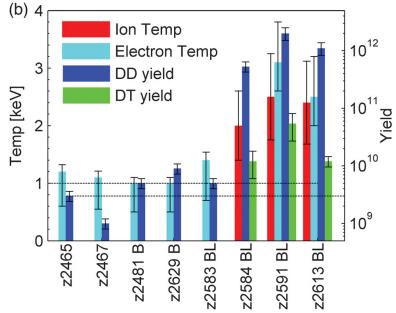




# Neutron yield increased by 100x with preheat and external magnetic field.

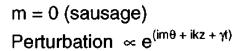


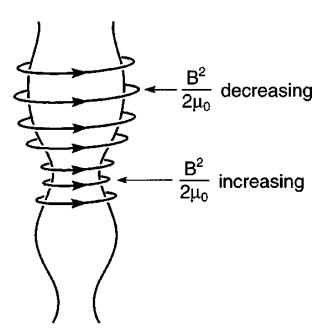




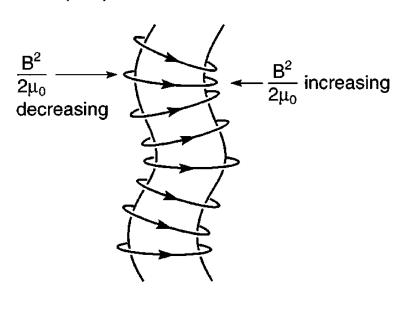
#### Sheared flow stabilizes MHD instabilities

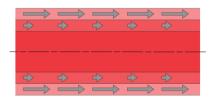


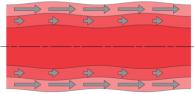


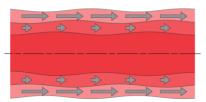


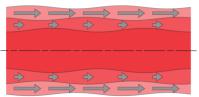
$$m = 1 (kink)$$









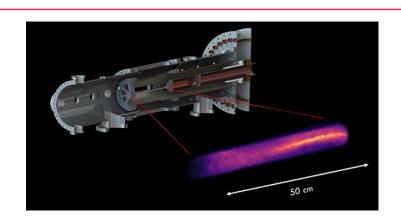


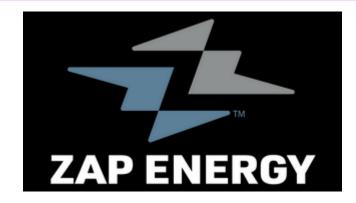
$$\frac{dV_Z}{dr}\neq 0$$

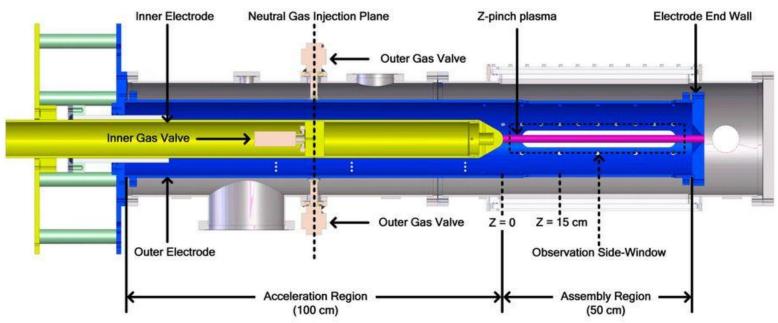
- M. G. Haines, etc., Phys. Plasmas 7, 1672 (2000)
- U. Shumlak, etc., Physical Rev. Lett. 75, 3285 (1995)
- U. Shumlak, etc., ALPHA Annual Review Meeting 2017

#### A z-pinch plasma can be stabilized by sheared flows





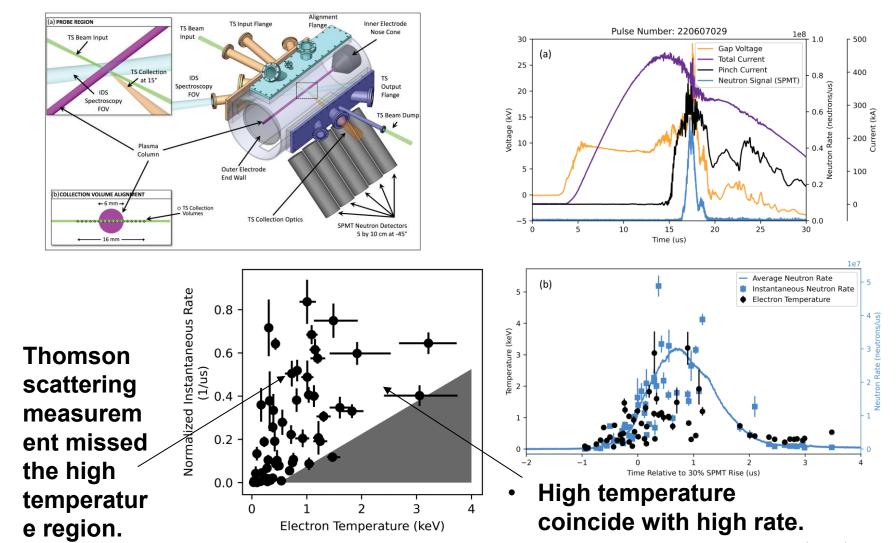




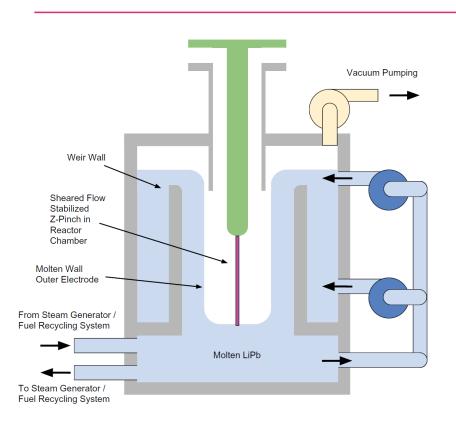
https://www.zapenergyinc.com/about

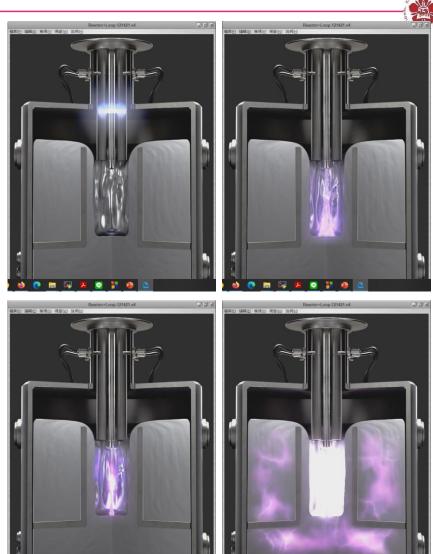
A. D. Stepanov, etc., Phys. Plasmas 27, 112503 (2020)

# Elevated electron temperature coincident with observed fusion reactions in a sheared-flow-stabilized z pinch



# Fusion reactor concept by ZAP energy

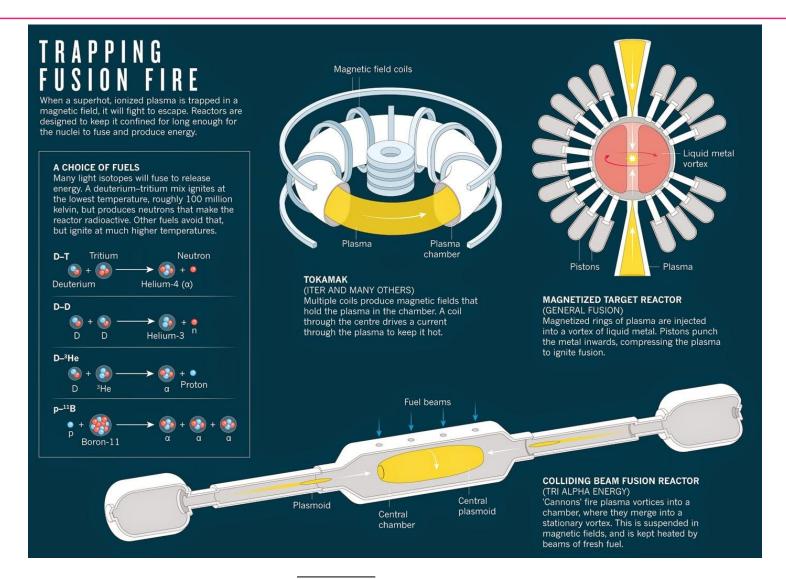




https://www.zapenergyinc.com/about E. G. Forbes, etc., Fusion Sci. Tech. 75, 599 (2019)

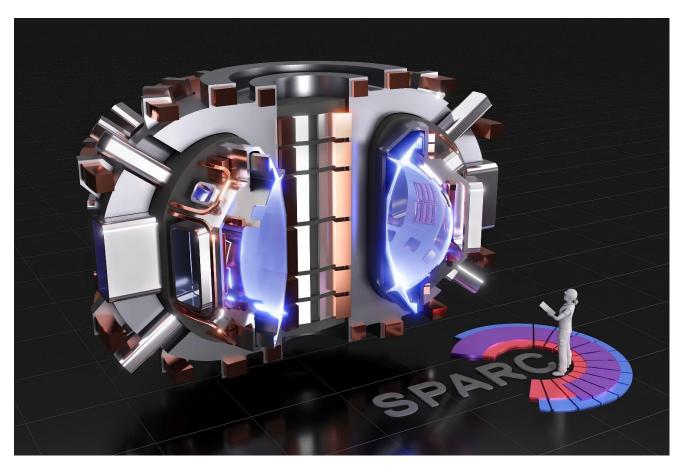
#### There are alternative





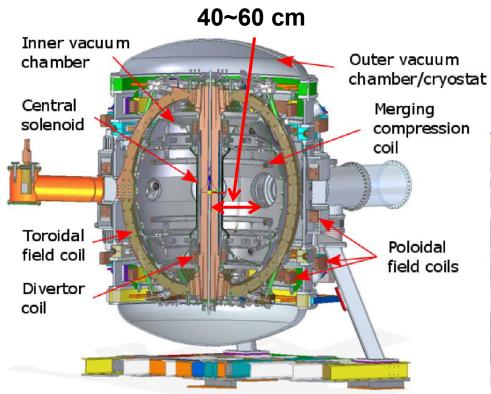
# Commonwealth Fusion Systems, a MIT spin-out company, is building a high-magnetic field tokamak





- The fusion gain Q > 2 is expected for SPARC tokamak.

# Merging compression is used to heat the tokamak at the start-up process in ST40 Tokamak at Tokamak Energy Ltd



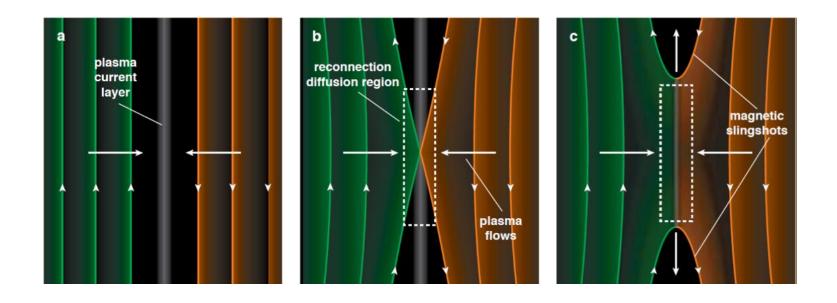
- High temperature superconductors are used.
- $B_T \sim 3 T$



M. Gryaznevich, etc., Fusion Eng. Design, **123**,177 (2017) https://www.tokamakenergy.co.uk/

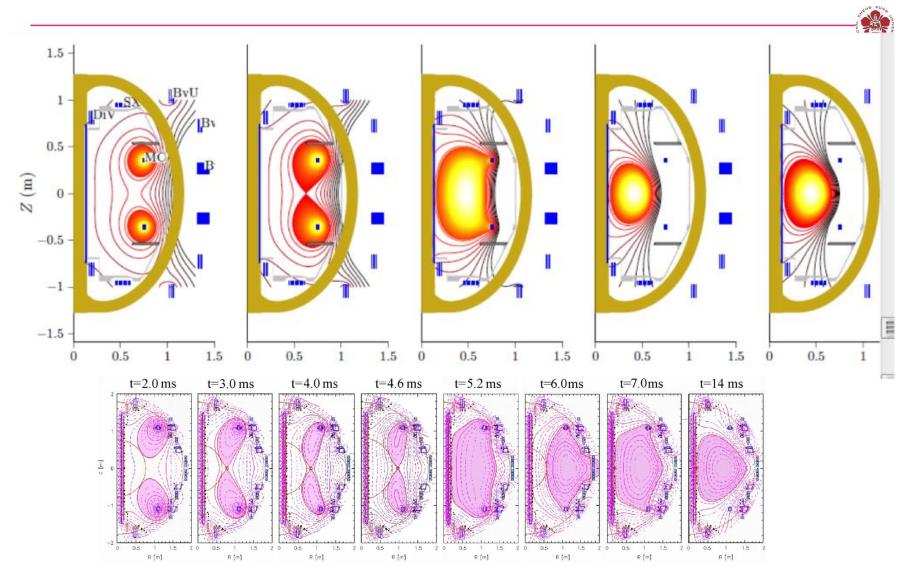
#### Reconnection





https://www.youtube.com/watch?v=7sS3Lpzh0Zw

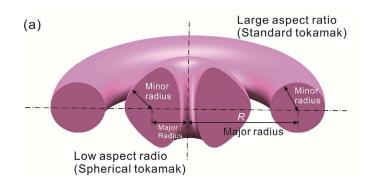
### Merging compression is used to heat the plasma



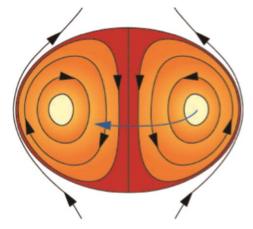
### Spherical torus (ST) and compact torus (CT)



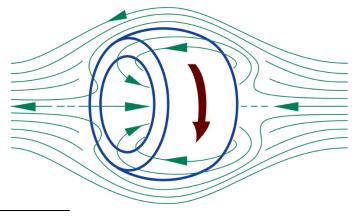
Spherical torus (ST)



- Compact torus (CT)
  - Spheromak



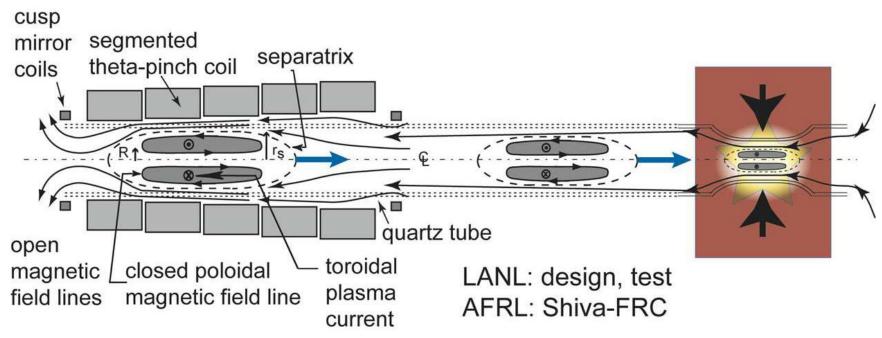
Field reversed configuration (FRC)

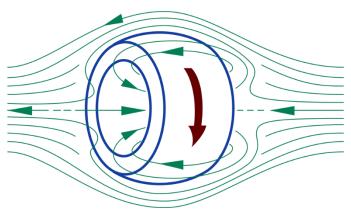


Zhe Gao, Matter Radiat. Extremes **1**, 153 (2016) https://en.wikipedia.org/wiki/Field-reversed\_configuration

#### Field reverse configuration is used in Tri-alpha energy





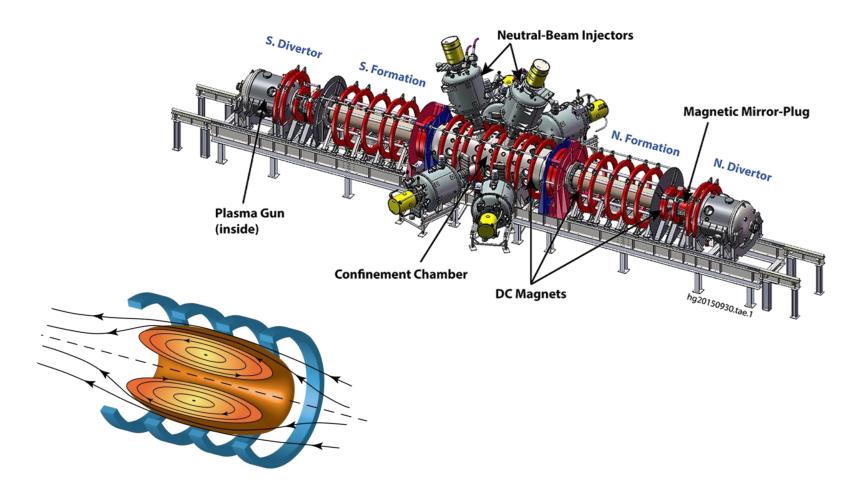


<sup>\*</sup>Magneto-Inertial Fusion & Magnetized HED Physics by Bruno S. Bauer, UNR & Magneto-Inertial Fusion Community

<sup>\*\*</sup>https://en.wikipedia.org/wiki/Field-reversed configuration

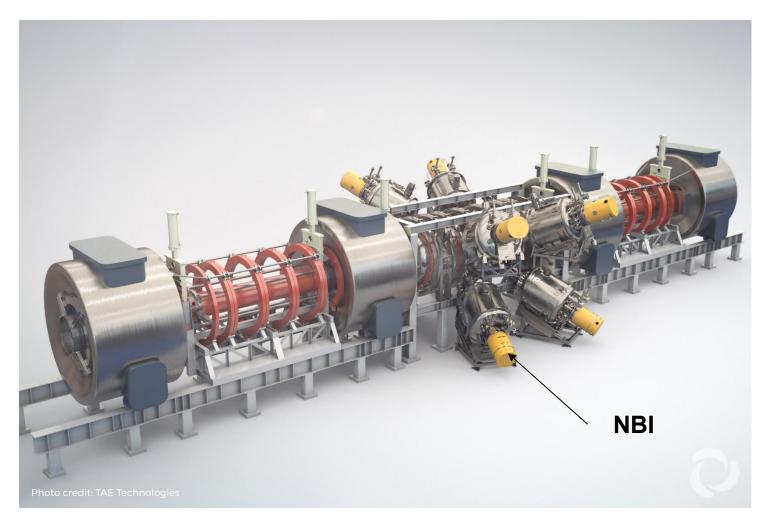
### Field reverse configuration is used in Tri-alpha energy





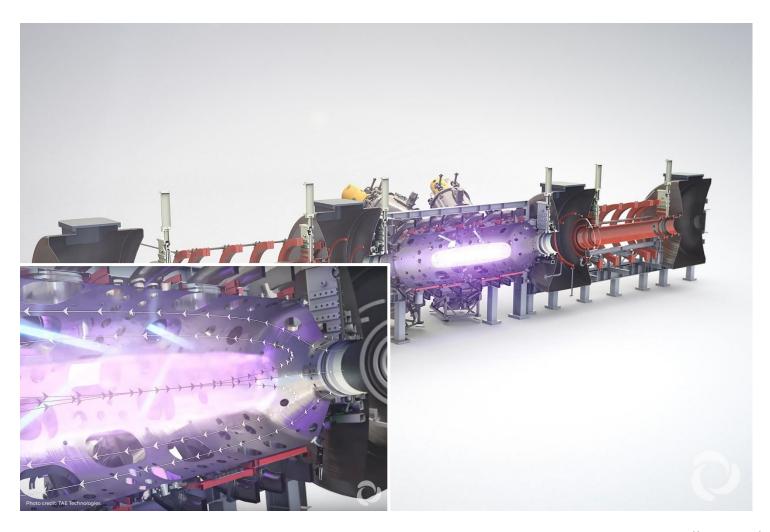
### **NBI** for Tri-Alpha Energy Technologies





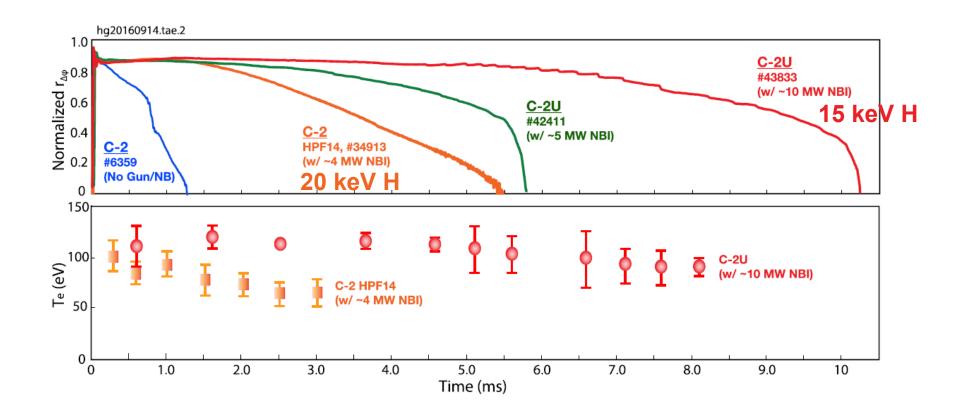
# Neutral beams are injected in to the chamber for spinning the FRC





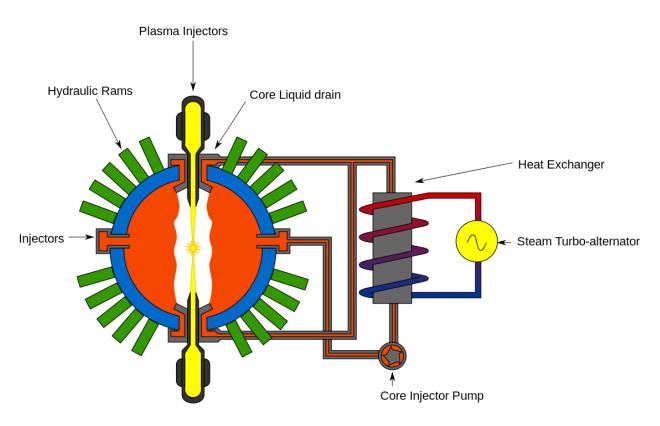
### FRC sustain longer with neutral beam injection





# General fusion is a design ready to be migrated to a power plant

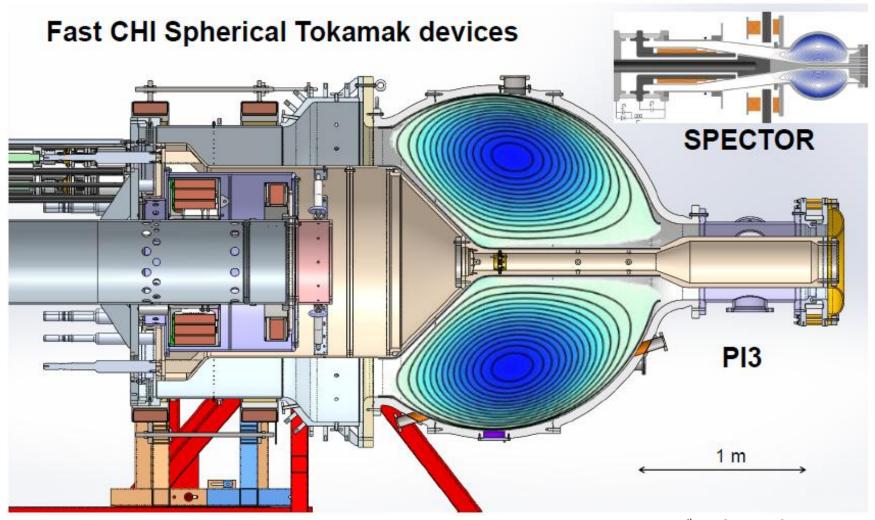






### A spherical tokamak is first generated





# Plasma injector for the spherical tokamak

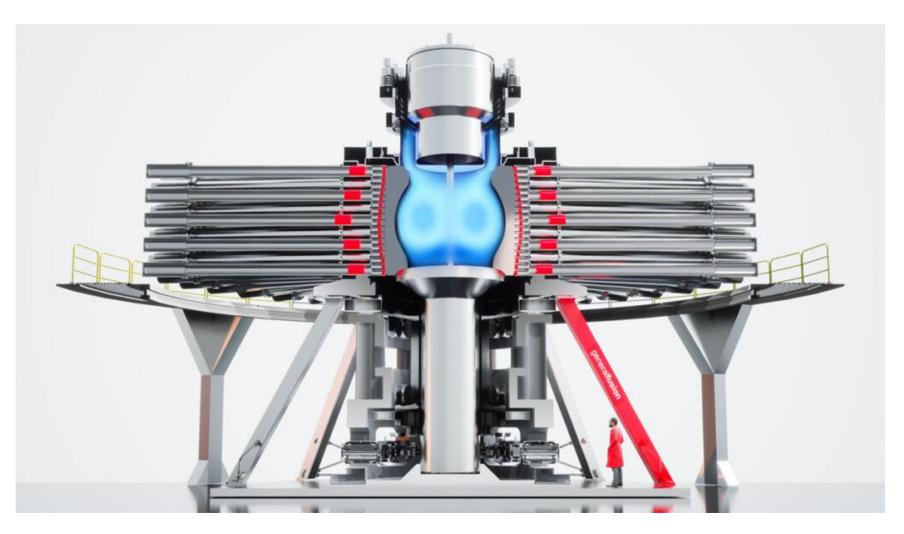






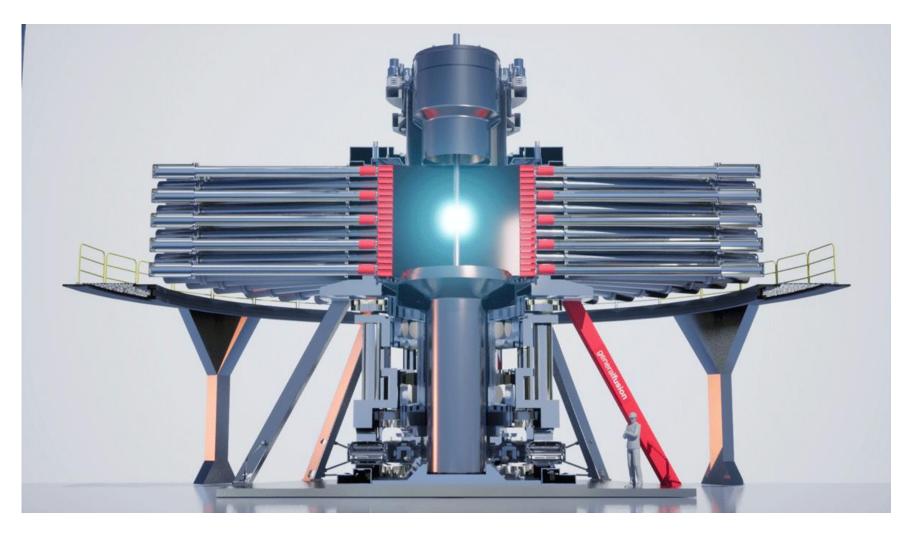
# A spherical tokamak is generated in a liquid metal vortex





# The spherical tokamak is compressed by the pressure provided by the sournding hydraulic pistons





# BBC: General Fusion to build its Fusion Demonstration Plant in the UK, at the UKAEA Culham Campus

#### Nuclear energy: Fusion plant backed by Jeff Bezos to be built in UK

By Matt McGrath Environment correspondent

(1) 17 June



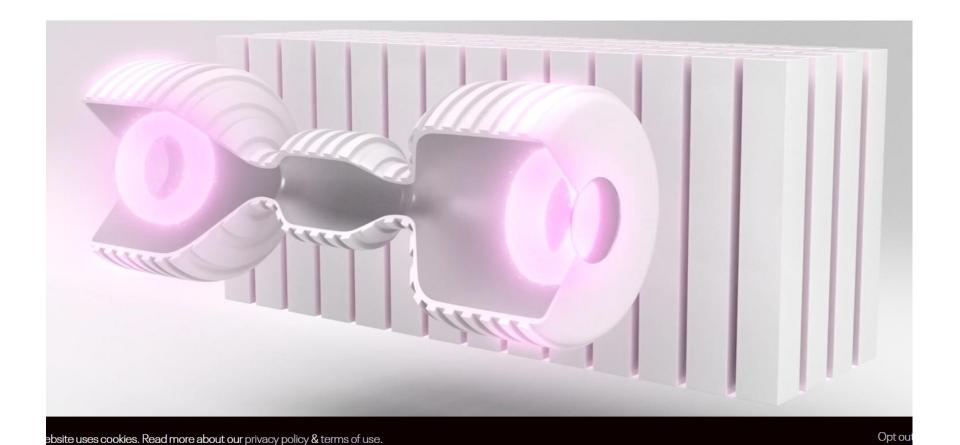


A company backed by Amazon's Jeff Bezos is set to build a large-scale nuclear fusion demonstration plant in Oxfordshire.

Canada's General Fusion is one of the leading private firms aiming to turn the

### Helion energy is compressing the two merging FRCs

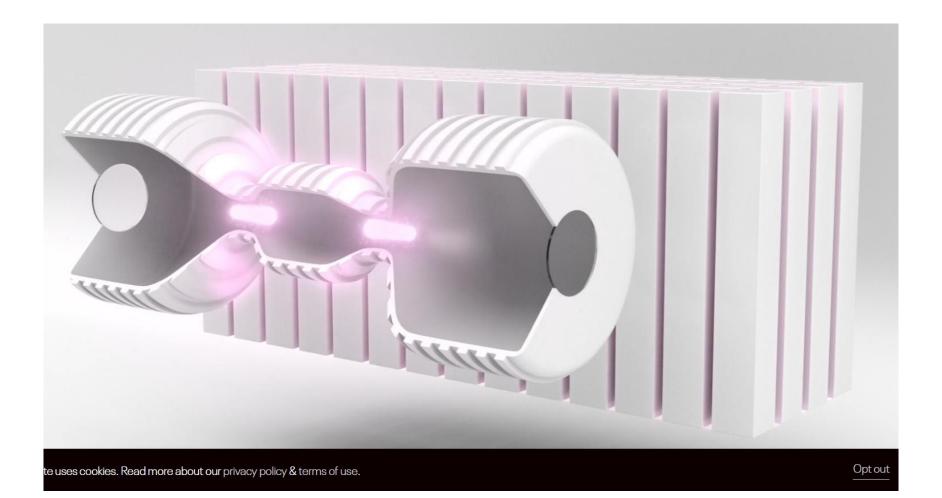




https://www.helionenergy.com/

#### Two FRCs are accelerated toward each other





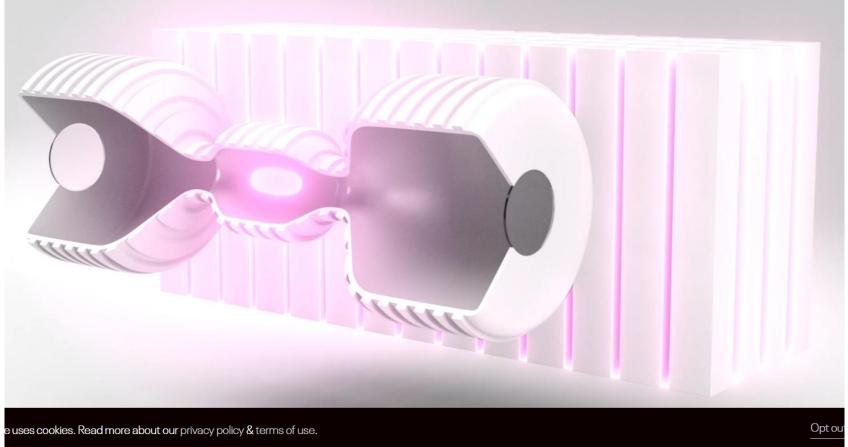
### Two FRCs merge with each other





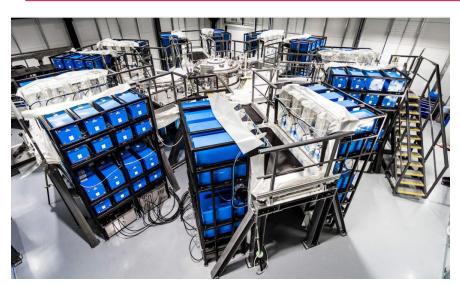
# The merged FRC is compressed electrically to high temperature

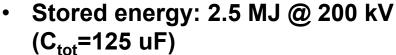




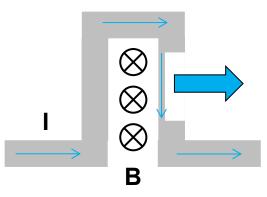
Similar concept will be studied in our laboratory.

### Projectile Fusion is being established at First Light **Fusion Ltd, UK**

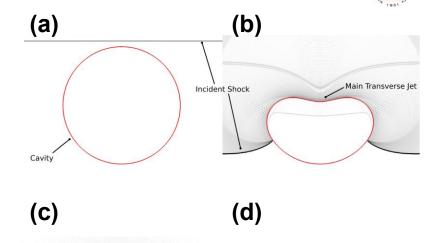


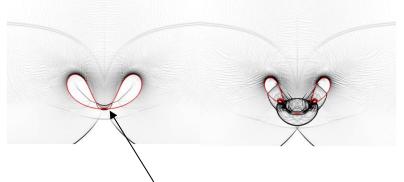


 $I_{peak}$ =14 MA w/  $T_{rise}$ ~2us.









High pressure is generated by the colliding shock.

### A gas gun is used to eject the projectile



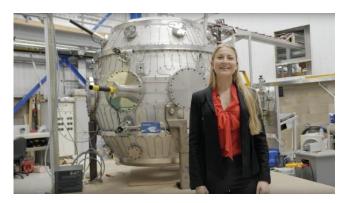




https://www.youtube.com/watch?v=JN7lyxC11n0 https://www.youtube.com/watch?v=aW4eufacf-8

# Many groups aim to achieve ignition in the MCF regime in the near future

- ITER 2025 First Plasma
   2035 D-T Exps
   2050 DEMO
- Tokamak energy, UK
  - 2025 Gain
  - 2030 to power grid



Commonwealth Fusion Systems, USA – 2025 Gain



https://www.iter.org

https://www.tokamakenergy.co.uk/ https://www.psfc.mit.edu/sparc

#### **Fusion is blooming**























































































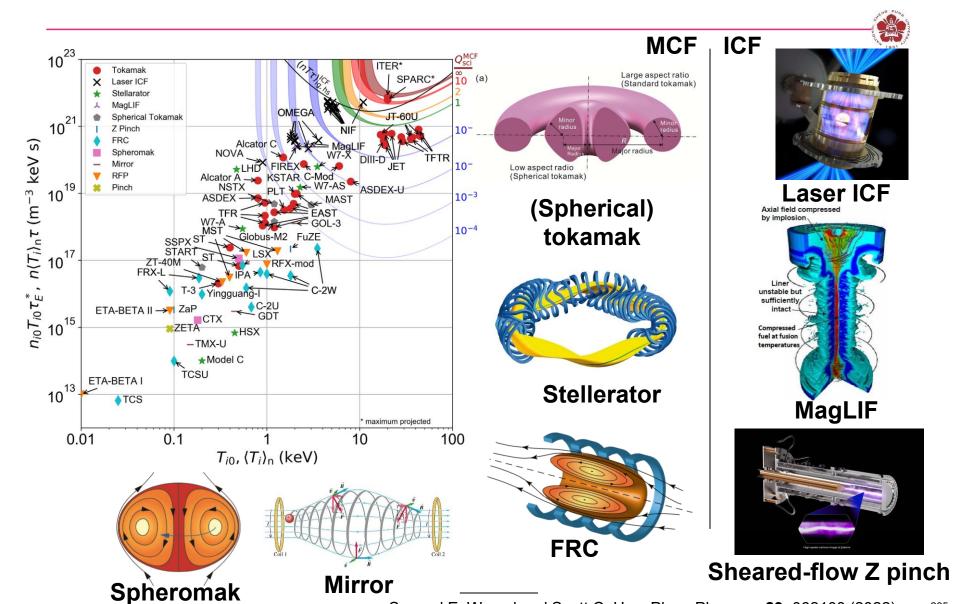




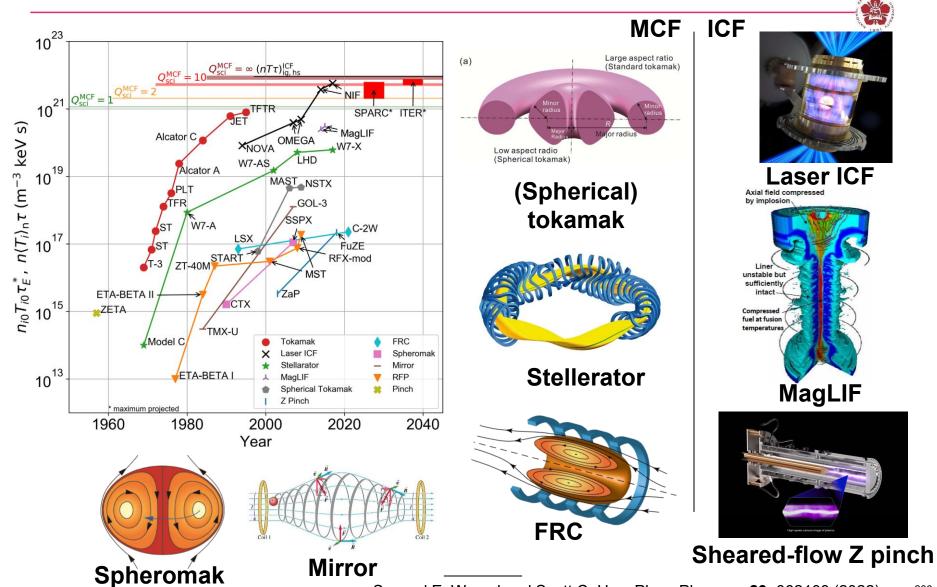




### We are closed to ignition!

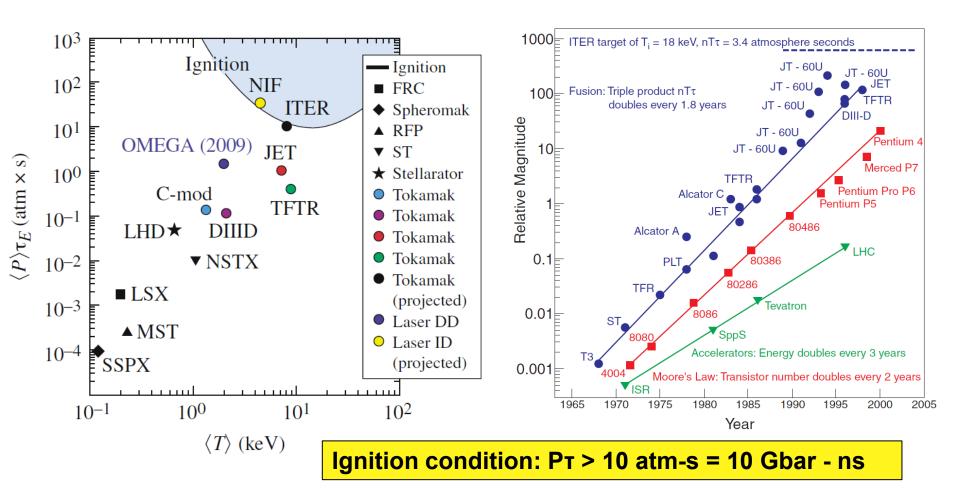


### We are closed to ignition!



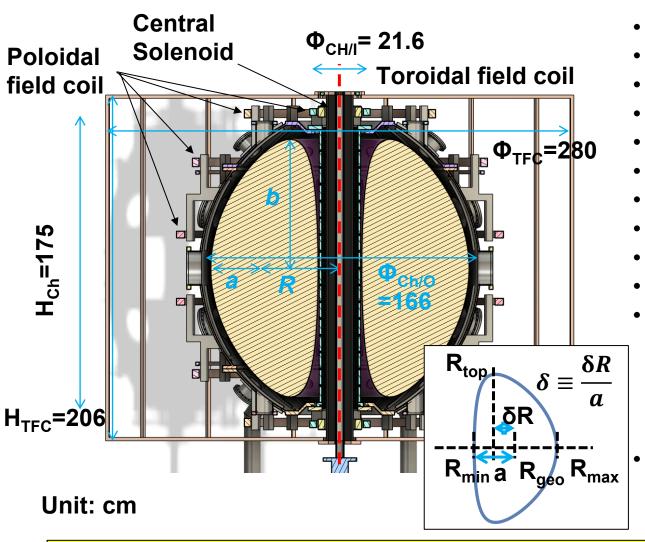
### We are closed to ignition!





A. J. Webster, Phys. Educ. **38**, 135 (2003) R. Betti, etc., Phys. Plasmas, **17**, 058102 (2010)

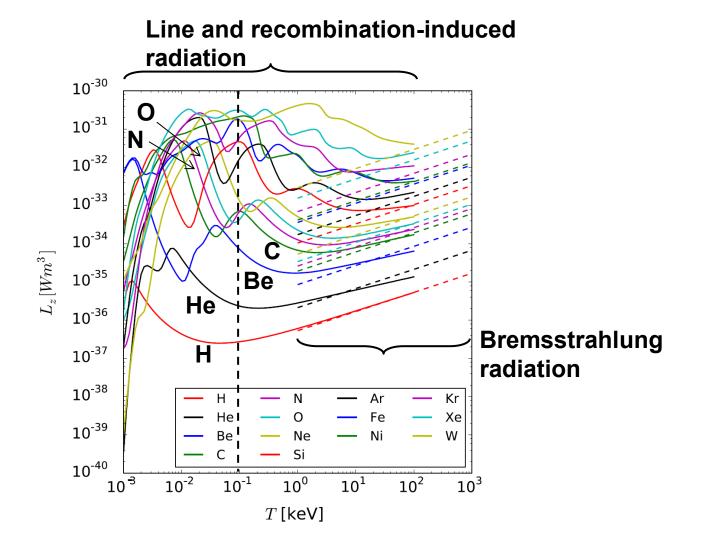
# Formosa Integrated Research Spherical Tokamak (FIRST) aiming for the first plasma in 2026



- *R/a/b*=45/32/76.8 cm
- Aspect ratio = R/a = 1.5
- k = b/a = 2.4
- $\delta = 0.5$
- $B_T = 0.1 \sim 0.5 \text{ T}$
- T≥ 100 eV
- $I_p \ge 100 \text{ kA}$
- Gas: H<sub>2</sub>
- Ohmic heating
- Duration: 100 ms
- FIRST is targeted for
  - Low aspect ratio
  - High beta
  - High bootstrap current
- Short term goal in my group study the startup mechanism.
- We welcome anyone interested in fusion research to join us!

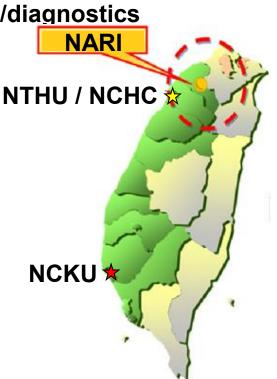
# Temperature of 100 eV is the threshold of radiation barrier by impurities





### This is a joint project including 6 groups

- 馬維揚團隊 @ 國家原子能科技研究院
  - Site
- 張博宇團隊 @ 成功大學 太空與電漿科學研究所
  - System design and development/diagnostics
- 向克強團隊 @ 成功大學 前瞻電漿中心
  - Theoretical design
- 河森榮一郎團隊 @ 成功大學 太空與電漿科學研究所
  - Diagnostics
- 柳克強團隊 @ 清華大學 工程與系統科學系
  - Diagnostics
- 蔡宗哲團隊 @ 國家高速網路與計算中心
  - Simulation
- 張存續團隊 @ 清華大學 物理系
  - RF startup
  - We welcome anyone interested in fusion research to join us!



https://www.sipa.gov.tw/home.jsp?mserno=20100 1210037&serno=201001210041&menudata=Chin eseMenu&contlink=content/introduction\_4\_1.jsp&serno3=201002010023

## Students are encouraged to study either science or engineering



- Management team @ Laboratory for Laser Energetics, University of Rochester
  - Administrative ` Engineering ` Experimental ` Omega Laser Facility ` Plasma & Ultrafast Laser Science & Engineering ` Theory division ` Laboratory Safety ` Laser and Materials Technology
- Science involved:
  - Plasma Physics ` Physics ` Material Science ` Super conductors ` Chemistry ` Mathematics...
- Engineering involved:
  - Electrical Engineering \ Mechanical Engineering \ Computer science \ Artificial intelligent \ Control \ Optics \ ...

Skip

#### **Outline**



- Introduction to nuclear fusion
- Magnetic confinement fusion (MCF)
  - Tokamak
  - Stellarator
- Inertial confinement fusion (ICF)
  - Indirection drive ICF
  - Direct drive ICF
- Innovation idea MCF + ICF
- Plasma in space
- Pulsed-power system at NCKU

### **Aurora**

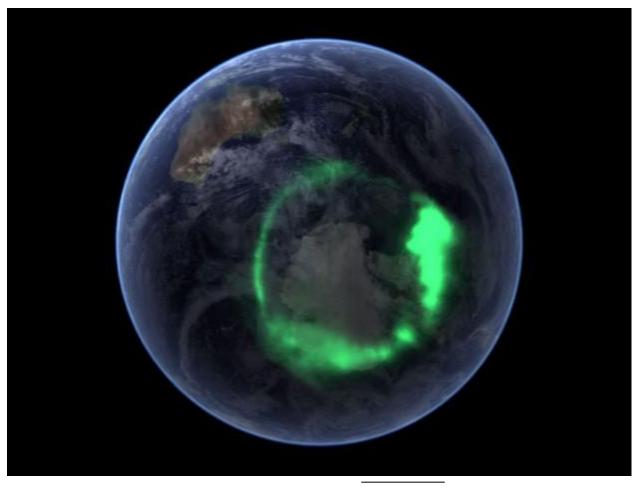




https://en.wiktionary.org/wiki/aurora

#### Aurora seen from a satellite

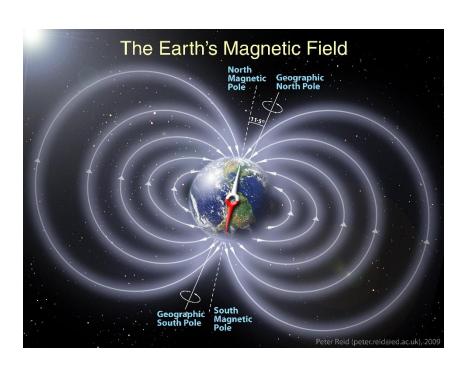


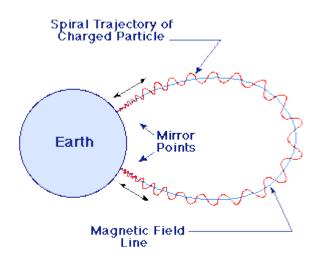


https://flashpack.com/insights/2014/11/20/aurora-australis-forget-the-northern-lights-have-you-heard-about-the-southern-lights/

### Earth's magnetic field



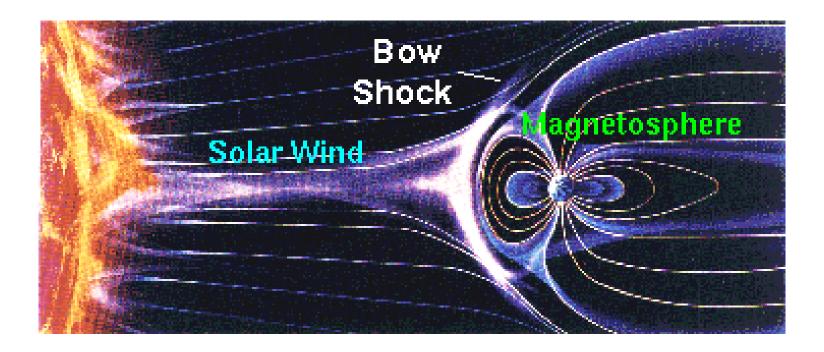




https://www.nasa.gov/mission\_pages/sunearth/news/gallery/Earths-magneticfieldlines-dipole.html

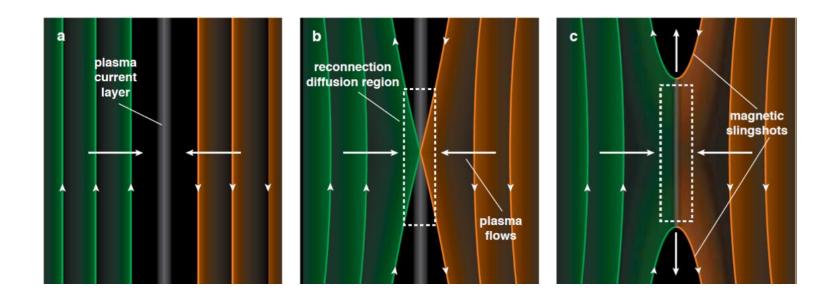
## Earth magnetic fields are strongly influenced by solar wind





#### Reconnection

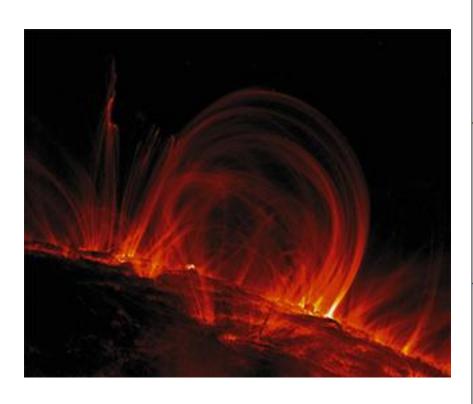


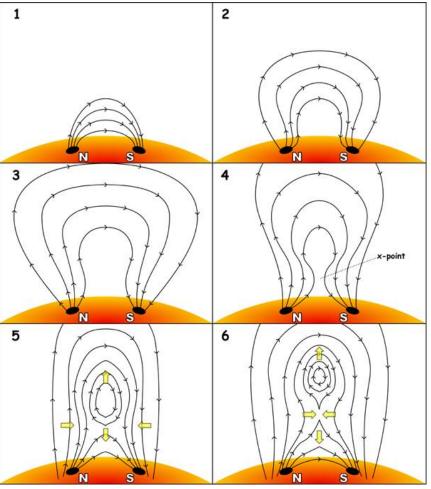


https://www.youtube.com/watch?v=7sS3Lpzh0Zw

### Corona mass ejection (CME)



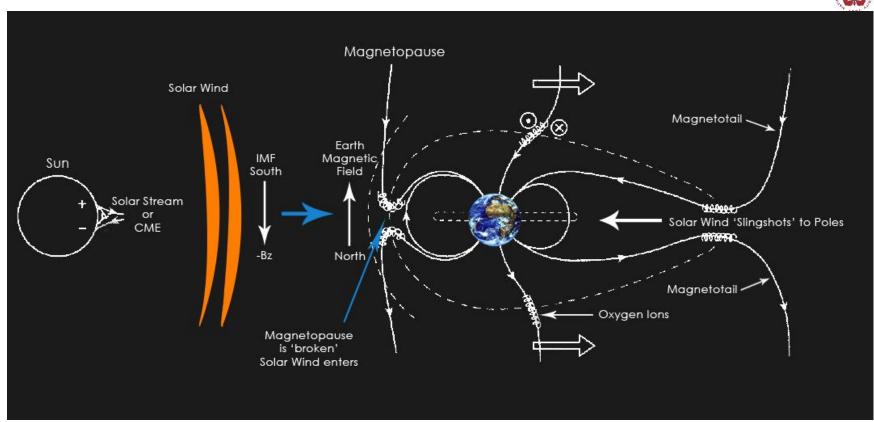




http://cse.ssl.berkeley.edu/SegwayEd/lessons/exploring\_magnetism/in\_Solar\_Flares/s4.html#sf

### Reconnections occur in many locations



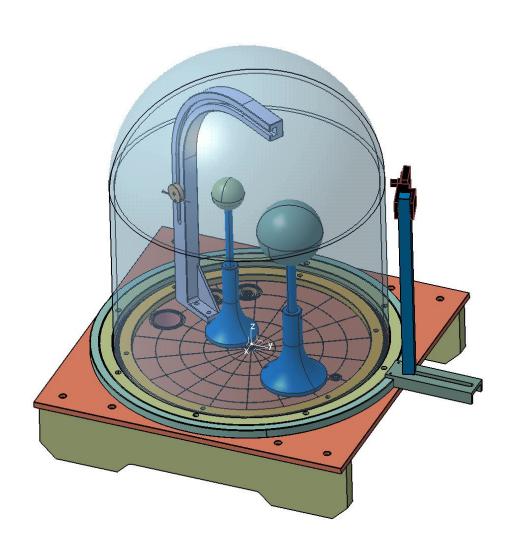


The Aurora Borealis:

https://www.youtube.com/watch?v=IT3J6a9p\_o8

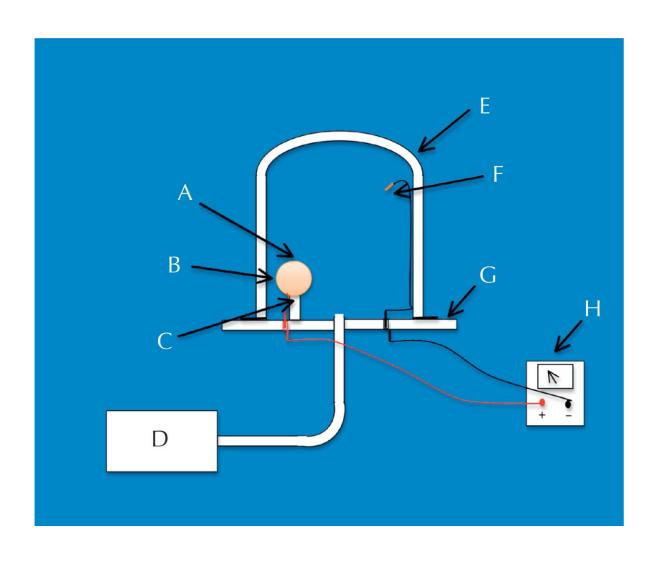
### Planeterrella is an aurora simulator





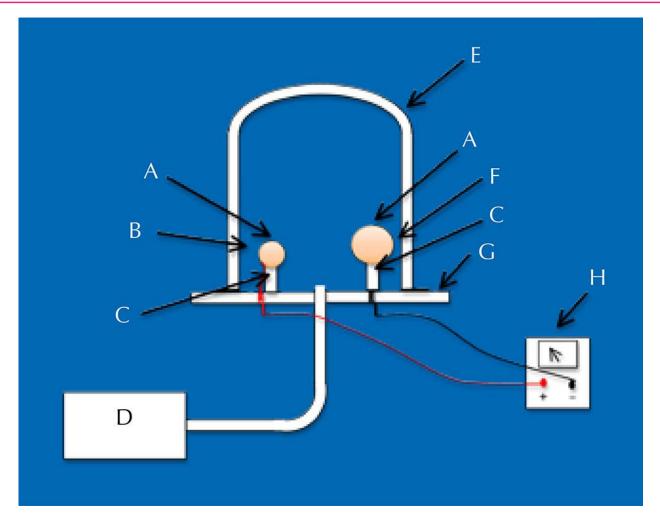
### Simple glow discharge is demonstrated





### Aurora/ring current are demonstrated

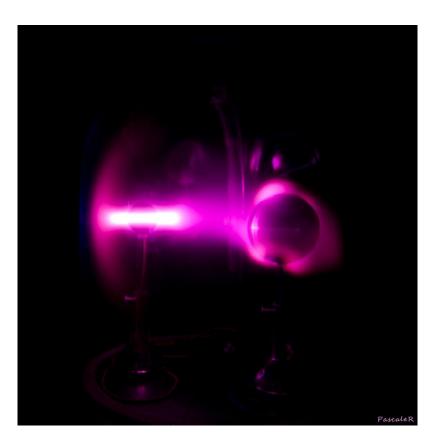




- B w/ magnet: aurora demonstration
- F w/ magnet: ring current

### Aurora and ring current are expected to be seen





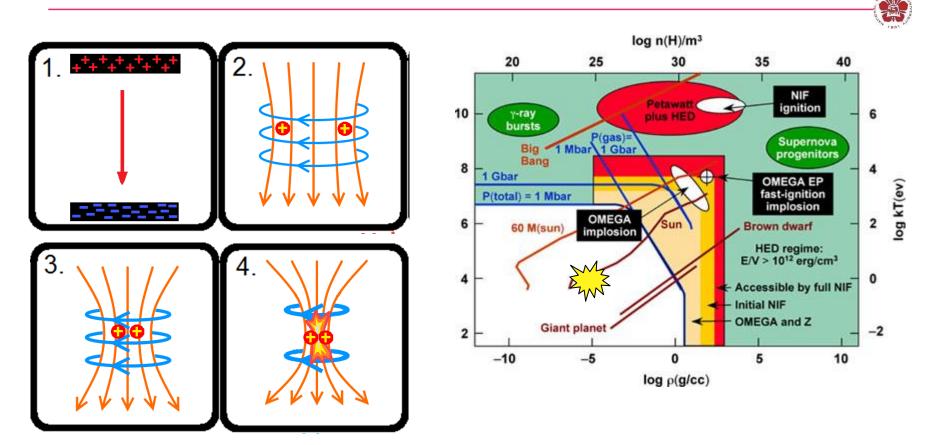


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- Plasma in space
- Pulsed-power system at NCKU
  - Extreme ultraviolet (EUV) light source
  - Studies of the rotational plasma jets

### Plasma can be compressed when parallel propagating current occurs



High energy density plasma (HEDP) regime: P > 1 Mbar

<sup>\*</sup>https://en.wikipedia.org/wiki/Pinch\_(plasma\_physics)

<sup>\*\*</sup>Frontiers in High Energy Density Physics: The X-Games of Contemporary Science © (2003) by the National Academy of Sciences, courtesy of the National Academies Press, Washington, D.C.

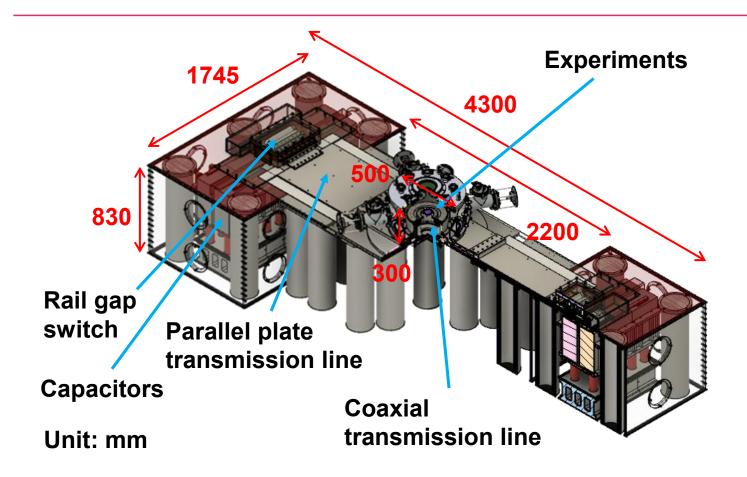
# A pulsed-power system is much cheaper than a laser facility



Facility	Budgets (NTD)
OMEGA at University of Rochester	~1.8 billion
National Ignition Facility (NIF) at Lawrence Livermore National Laboratory (LLNL)	~100 billion
Advanced Light Source (ALS) at Lawrence Berkeley National Laboratory in Berkeley (LBNL)	~3 billion
Taiwan Photon Source (TPS) at National Synchrotron Radiation Research Center (NSRRC)	~7 billion
Pulsed-power system at ISAPS, NCKU	~0.002 billion (<0.1 %)!!!

#### The pulsed-power system was built by only students

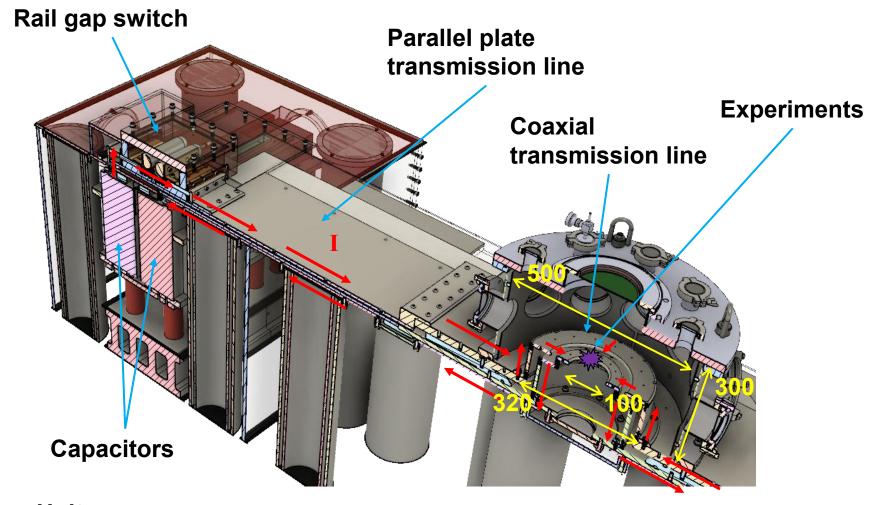




 A 1 kJ pulsed-power system at ISAPS, NCKU started being operated since September, 2019.

## Experiments will be taken placed at the center of the vacuum chamber



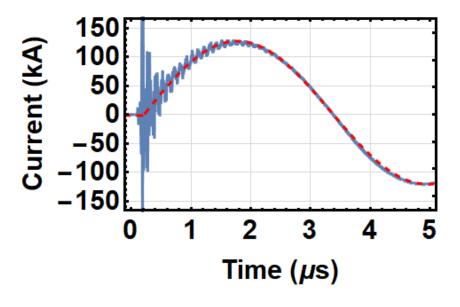


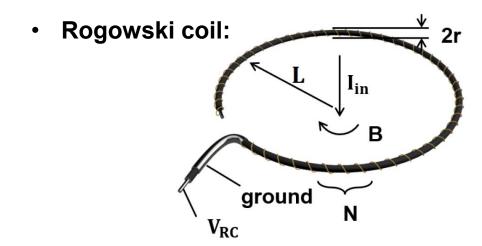
**Unit: mm** 

# A peak current of 135 kA with a rise time of 1.6 us is provided by the pulsed-power system



Capacitance (µF)	5	
V <sub>charge</sub> (kV)	20	(50)
Energy (kJ)	1	(6.25)
Inductance (nH)	204 ± 4	
Rise time (quarter period, ns)	1592 <u>+</u> 3	
I <sub>peak</sub> (kA)	135 ± 1	(~340)
Peak power (GW)	~0.6	(~4)

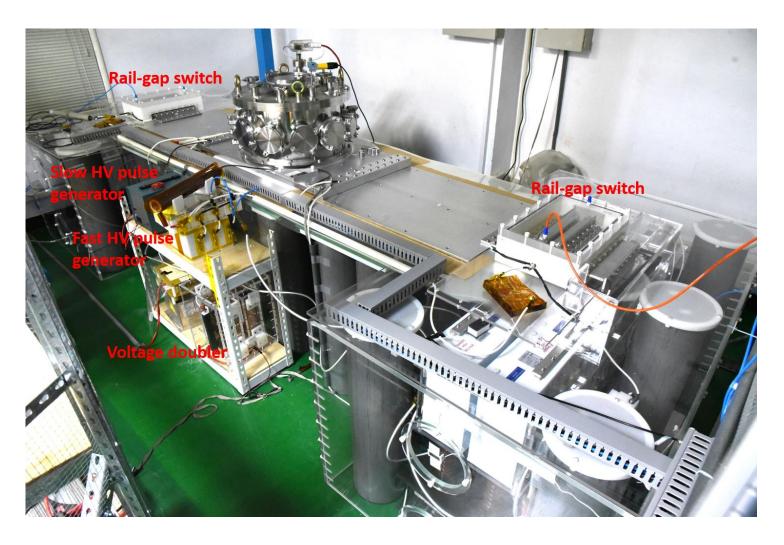






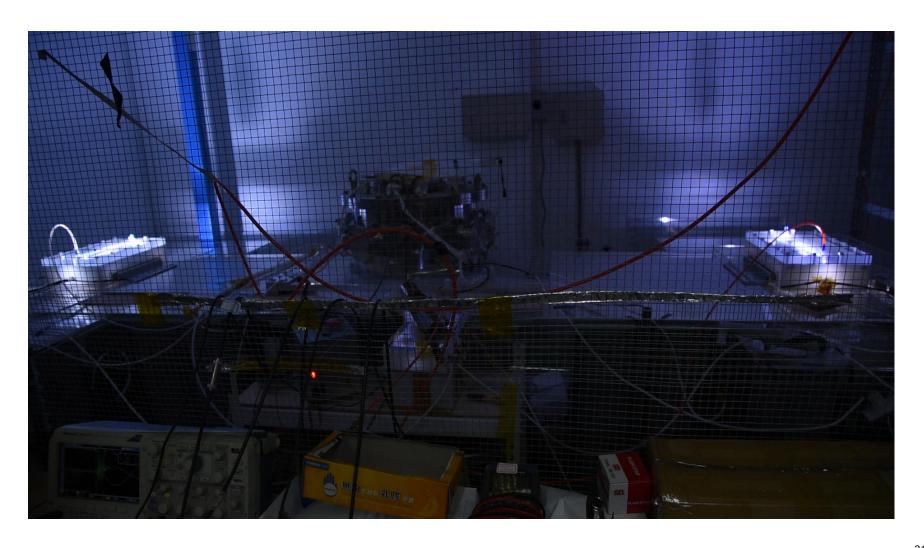
### The 1-kJ pulsed-power system





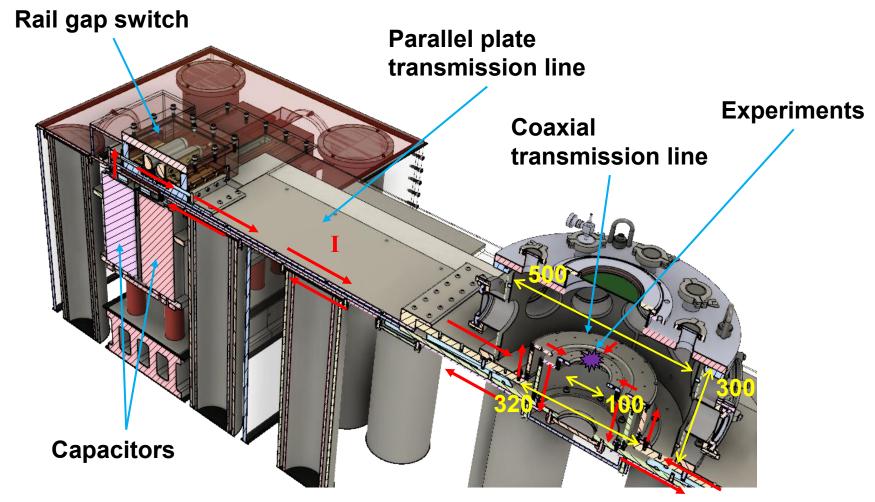
### First shot with two synchronized rail-gap switches





### Experiments will take place at the center of the vacuum chamber

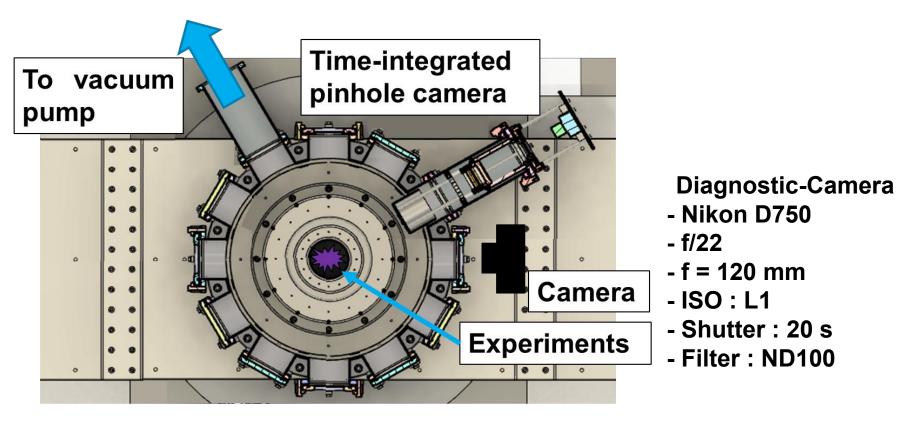




**Unit: mm** 

### System with current diagnostics

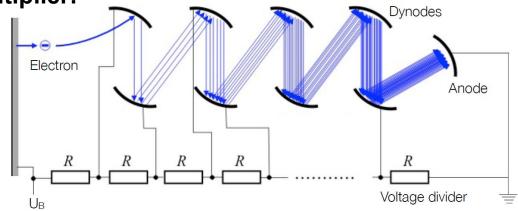




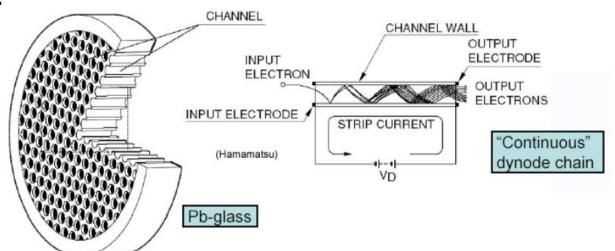
# The number of electrons can be increased through a photomultipliers or a microchannel plate (MCP)



Photomultiplier:

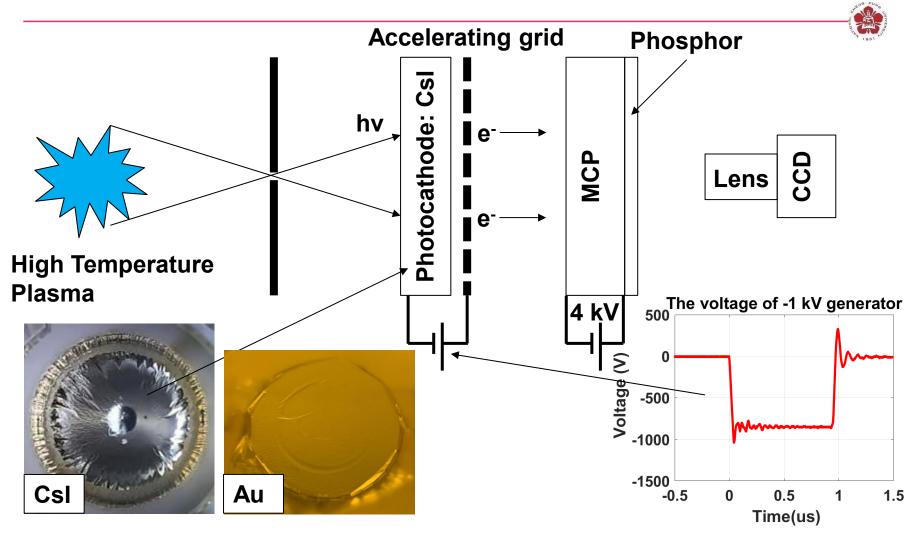


MCP:



http://www.kip.uni-heidelberg.de/~coulon/Lectures/DetectorsSoSe10/ Slides from 2013 HEDP Summer School (http://hedpschool.lle.rochester.edu/1000 proc2013.php)

### X-rays are imaged using photocathode, MCP, phosphor, and CCD

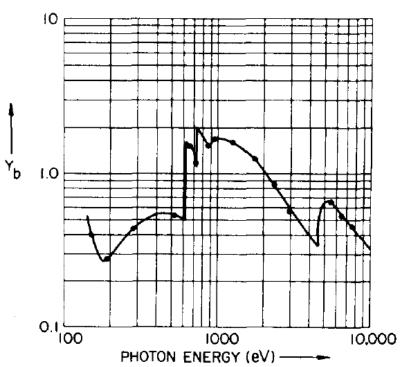


- Prof. Chou @ Photonics, NCKU is developing 50nm Au foil for us.
  - Images can be gated using fast high voltage pulses.

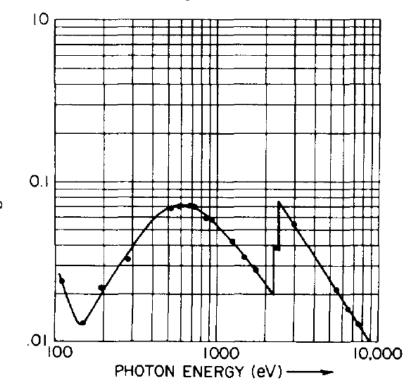
# The CsI photocathode is sensitive to photons with energy above 600 eV



 Back-surface secondary electron quantum yield for a 100 nm Csl transmission photocathode.



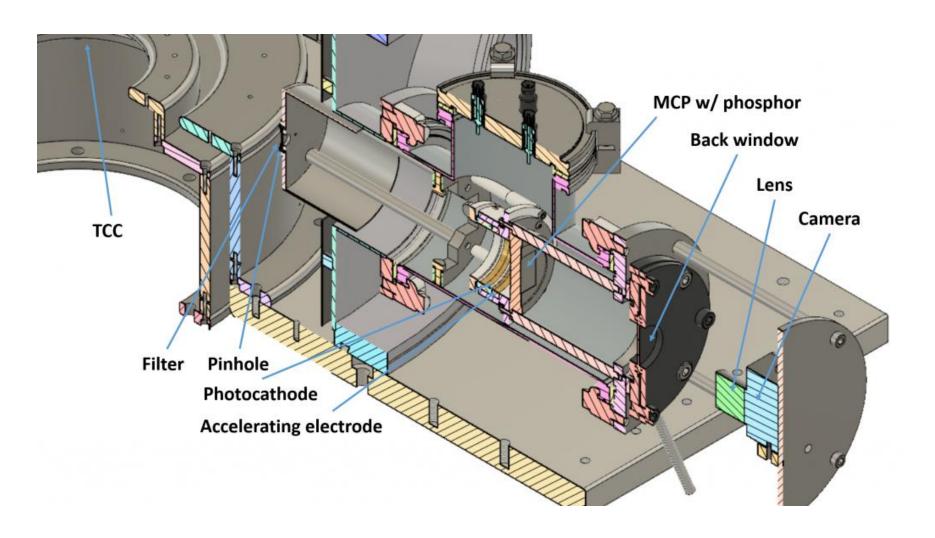
Back-surface secondary electron quantum yield for a 23 nm Au transmission photocathode.



Our photocathode: 200nm Lexan / 25nm Al / 120nm Csl.

### The pinhole camera is attached to one of the flange



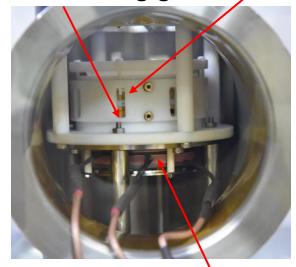


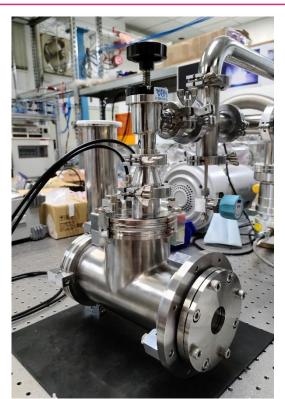
### The MCP right was tested



#### **Photocathode**

**Accelerating grid** 

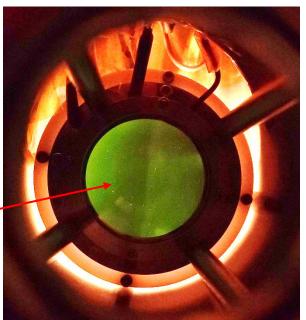






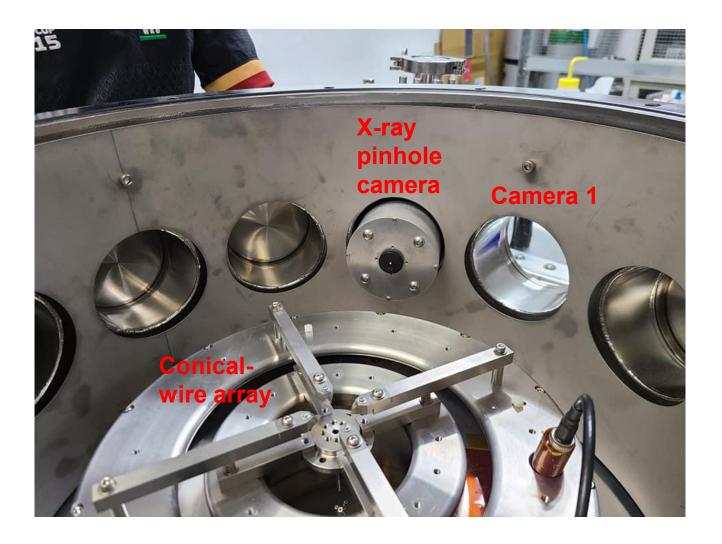
**MCP** 





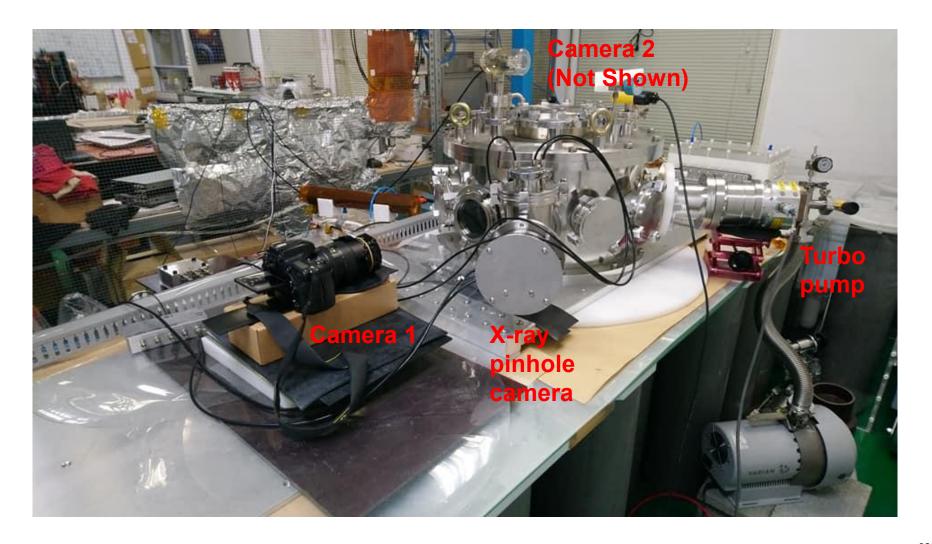
#### The view inside the vacuum chamber





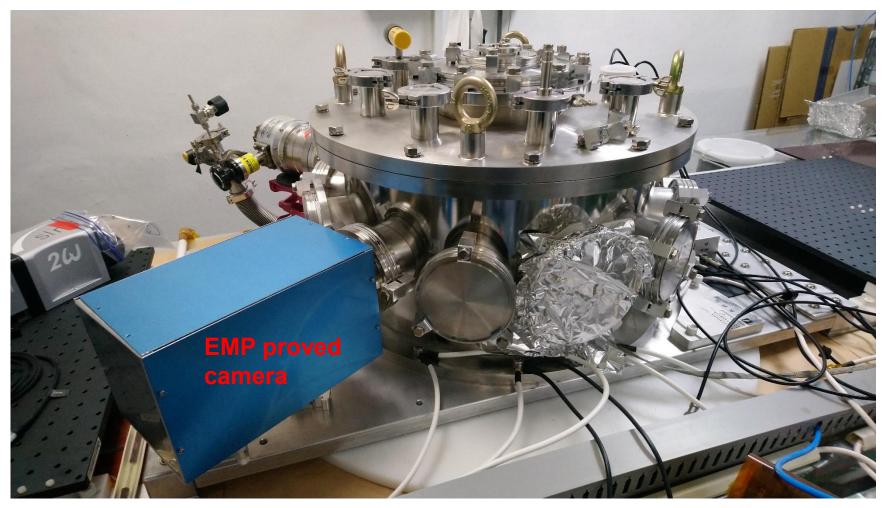
### **System with current diagnostics**





### **EMP** proved camera

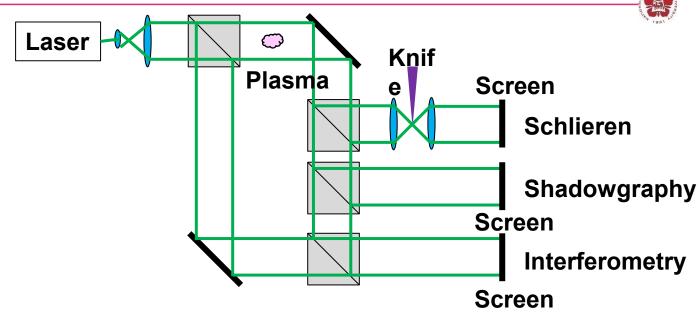




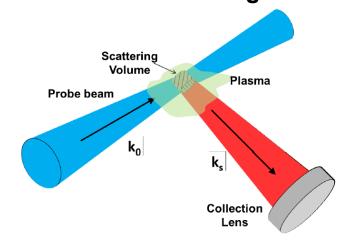
The camera is controlled via wifi and powered by batteries.

# Density and temperature can be measured using laser diagnostics

Imaging



Thomson scattering



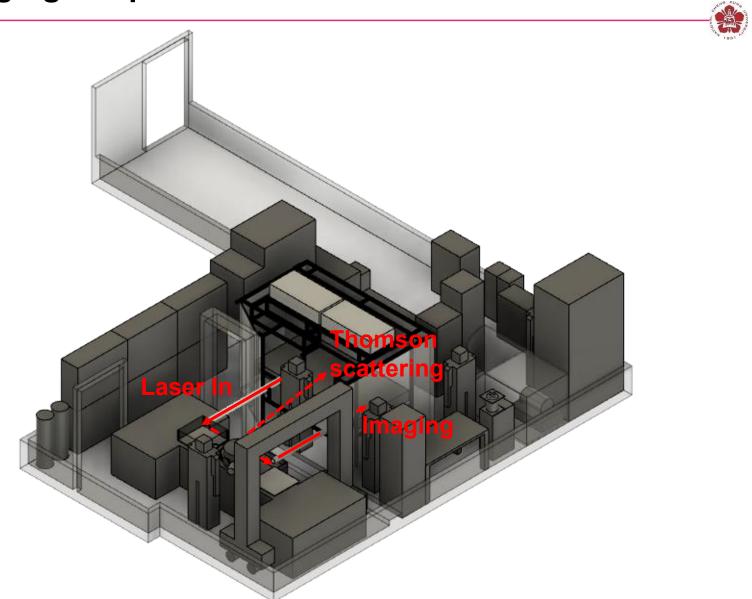
Ion-acoustic waves:

$$\omega^2 \approx k^2 \frac{ZT_e + 3T_i}{M_i}$$

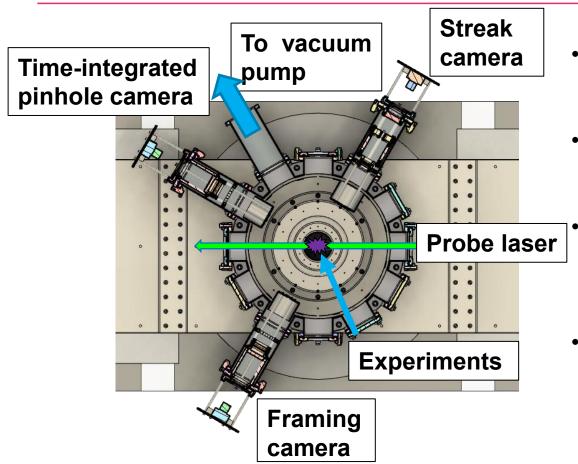
Electron-acoustic waves:

$$\omega^2 = \omega_{\rm pe}^2 + 3k^2v_{\rm Te}^2$$

# Laser alignment on three different optical tables will be challenging but possible



# A suit of diagnostics in the range of (soft) x-ray are being built



- Csl are used as the photocathode for all xray imaging system.
- Au photocathode may be used in the future.

#### Pinhole camera:

- Magnification: 1x

- Exposure time: 1 us

Streak camera:

- Magnification: 1x

- Temporal resolution: 15 ps

Framing camera:

- Magnification: 0.3x

- Temporal resolution: ~ns using 4 individual MCPs
- Laser probing:
- For interferometer, schlieren, shadowgraphy, Thomson scattering.
- Temporal resolution: ~300 ps using stimulated brillouin scattering (SBS) pulse compression in water

#### **Outline**

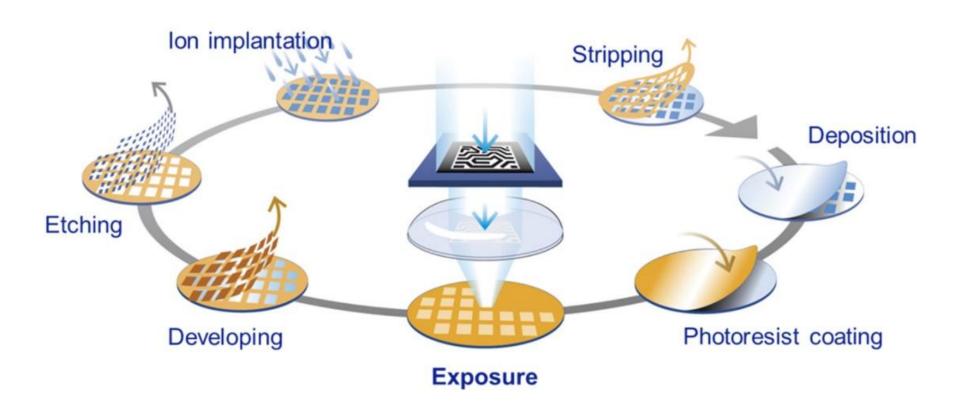


- Introduction to nuclear fusion
- Magnetic confinement fusion (MCF)
  - Tokamak
  - Stellarator
- Inertial confinement fusion (ICF)
  - Indirection drive ICF
  - Direct drive ICF
- Innovation idea MCF + ICF
- Plasma in space
- Pulsed-power system at NCKU
  - Extreme ultraviolet (EUV) light source
  - Studies of the rotational plasma jets

### **EUV** light sources

# A semiconductor device is fabricated by many repetitive production process





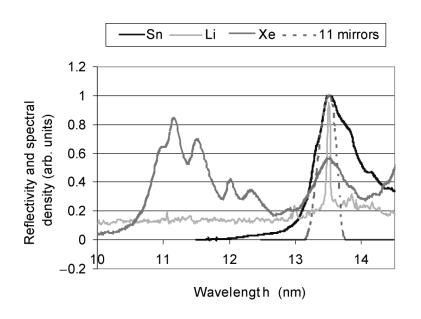
# **EUV** lithography becomes important for semiconductor industry

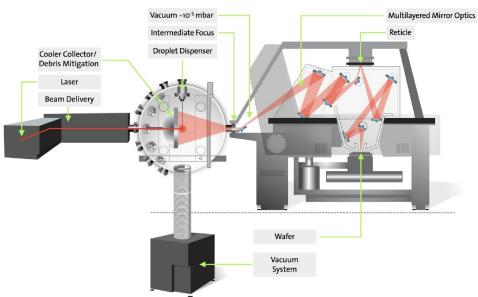




### EUV light is generated from laser-produced plasma (LPP)



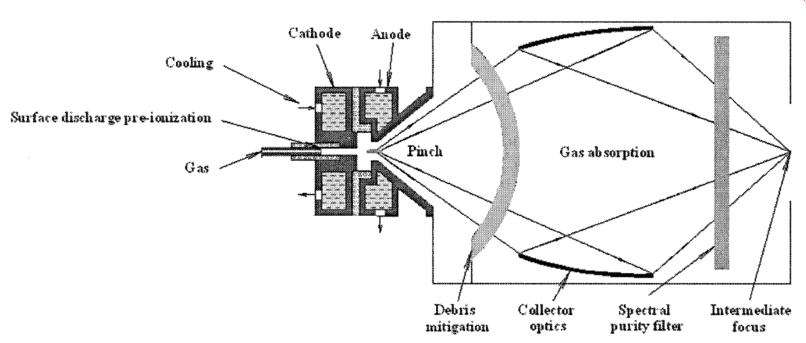




- $\lambda = 13.5 \text{ nm} \pm 1\%$  is required.
- At T=35-40 eV (~450,000 K), in-band emission occurs.
- Xenon:
  - $4p^64d^8 \rightarrow 4p^64d^75p$  from single ion stage Xe<sup>10+</sup>
  - UTA @ 11 nm

- Tin:
  - $4p^64d^N \rightarrow 4p^54d^{N+1} + 4p^64d^{N-1}4f$ (1 $\leq$ N  $\leq$  6) in ions ranging from Sn<sup>8+</sup> to Sn<sup>12+</sup>
  - UTA @ 13.5 nm
  - UTA: unresolved transition array

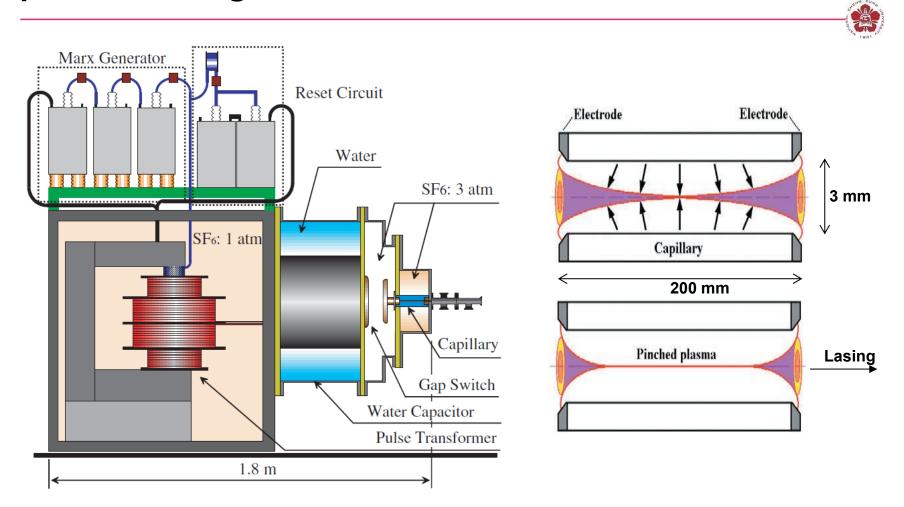
# Discharge produced plasma (DPP) can generate EUV light for EUV lithography



 Electrodes are damaged significantly due to the heat and sputtering by ions.

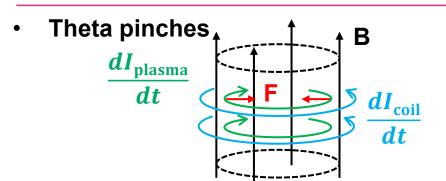
	Laser-produced plasma (LPP)	Discharge-produced plasma (DPP)
Pros	Commercial system available.	High conversion efficiency.
Cons	Low conversion efficiency.	Short system life time due to electrode erosion.

### Soft x-ray laser can be generated using a capillary zpinch discharge



• If 200  $\sim$  500 mTorr Ar is used as the filled gas, 46.9 nm (26.5 eV) Ne-like Ar laser can be built.

### EUV light can be generated using gas-puff theta pinches

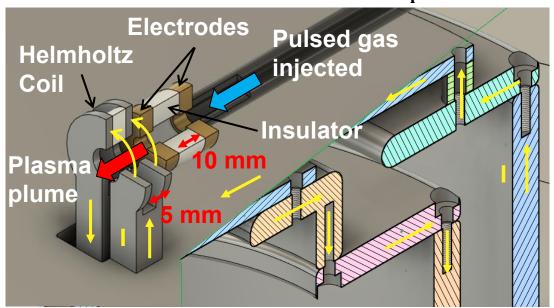




$$TV^{\gamma-1} = \text{const}$$
  $T_f = T_o \left(\frac{r_o}{r_f}\right)^{4/3}$   
 $T_o = 1 \sim 10 \text{ eV}$   $T_f = 40 \text{ eV}$ 

Compression ratio:  $\frac{r_{
m o}}{r_{
m f}}=16\sim 3$ 

- Gas-puff Theta pinches
- High voltage is applied between electrodes to generate initial plasma via arc discharge.
- Advantages:
  - Energy is directed used for generating and heating plasma.
  - Electrodes are away from hot plasma.
  - Less current is used to generate plasma.



# Simulations show that plasma with temperature higher than 30 eV can be generated on our system

Snow plow model is used\*:

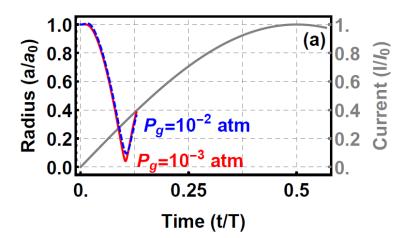
$$\frac{d}{dt}\left(M_{s}\frac{da}{dt}\right) = -2\pi a \left(\frac{B^{2}}{8\pi} - P_{0}\left(\frac{a_{0}}{a}\right)^{2\gamma}\right)$$
$$M_{s}(t) = \pi m_{i}N_{0}\left(a_{0}^{2} - a^{2}\right)\eta(t)$$

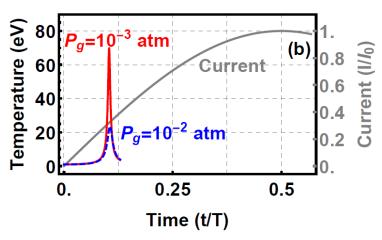
 The magnetic field provided by a Helmholtz coil with both radius and separation equal to 5 mm:

$$B = B_{\text{max}} \sin(\omega t)$$
 where  $B_{\text{max}} = 9$  T

Initial conditions:

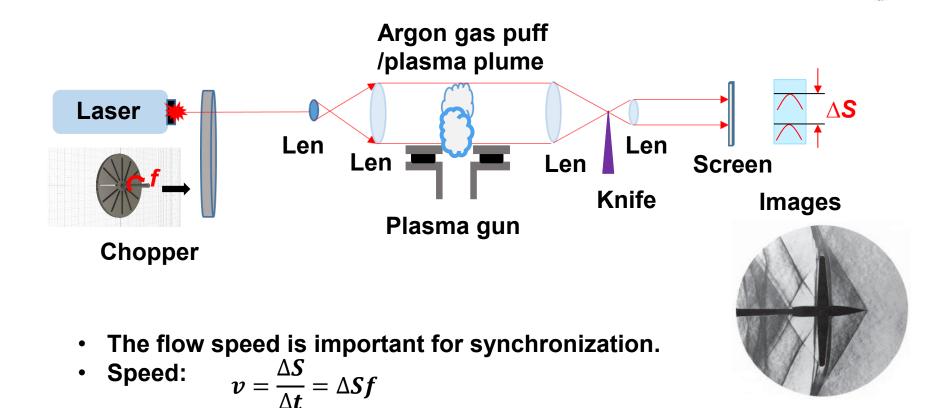
$$a_0 = 5$$
mm
 $P_0 = 2P_g \frac{11604}{300}$ 
 $N_0 = 2.43 \times 10^{19} P_g \text{cm}^{-3}$ 
 $m_{i,\text{Ar}} = 6.67 \times 10^{-23} g$ 





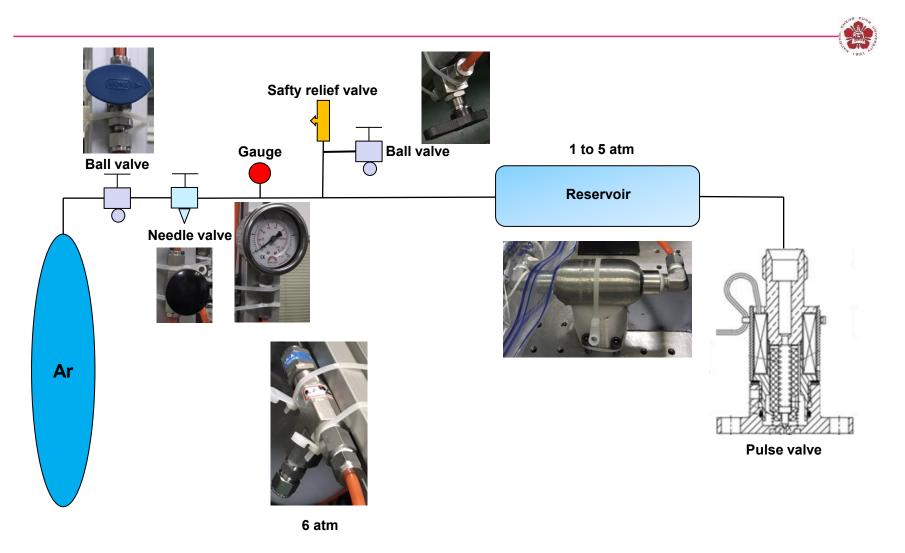
<sup>\*</sup>T. Uchida, etc., Nuclear Fusion, **2**, 70, 1962<sub>332</sub>

# Flow speed of the Argon gas puff/plasma plume will be measured using time-resolved Schlieren system



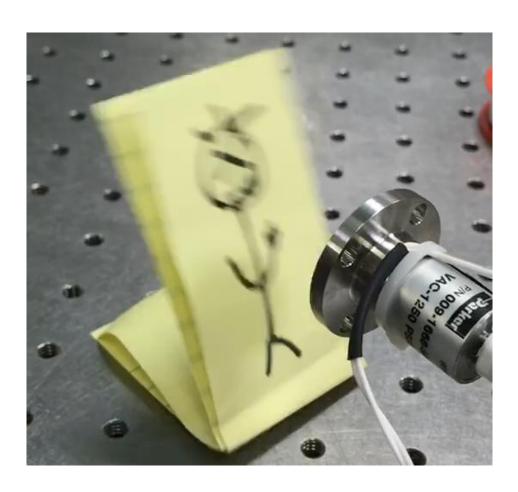
- Sound speed: 300 m/sec For 50 µs, the traveling distance of the plume is 1.5 cm.
- An 20-kHz optical chopper provides 50 µs time separate.

### The gas-puff system in atmosphere has been built for testing

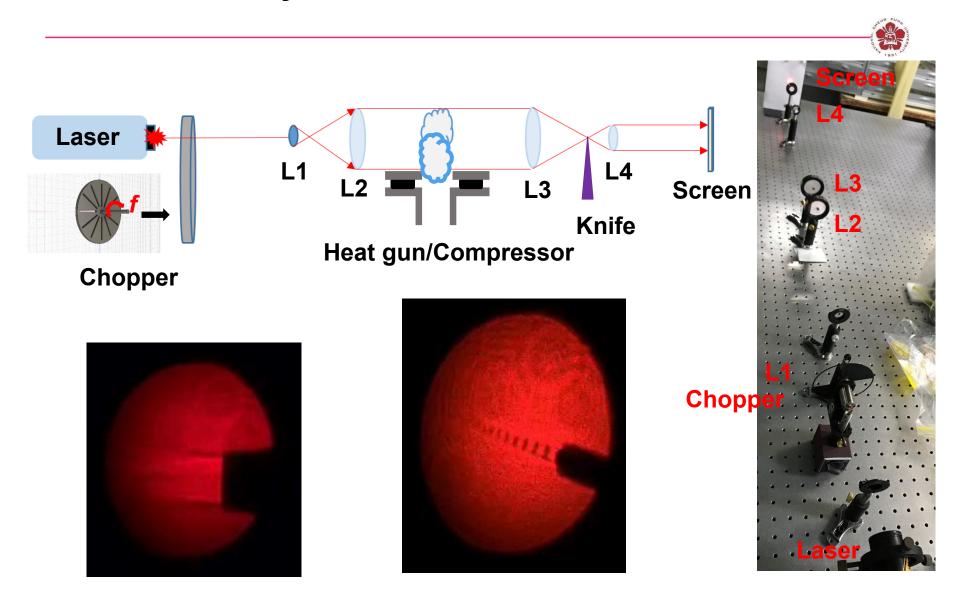


### The gas-puff was capable to push two slides of papers

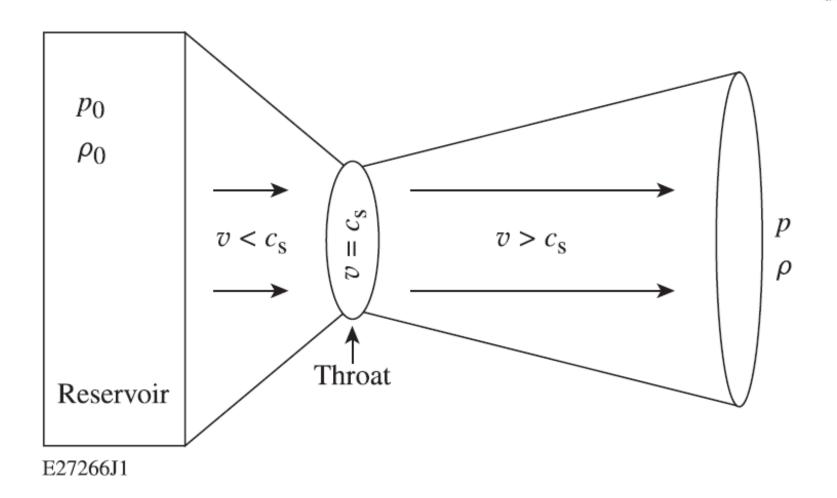




### The Schlieren system has been built

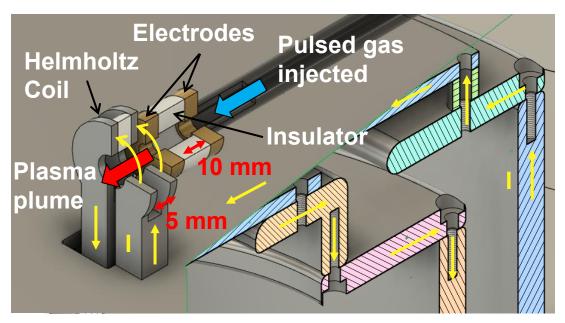


# A converging/diverging nozzle is needed to generate a supersonic gas puff



### **EUV** light characteristics will be measured





- Plasma density, temperature before and after compression will be measured.
- EUV light characteristic will be measured.
  - Intensity
  - Pulse width
  - Spectrum
  - Uniformity
  - ......

#### **Outline**



- Introduction to nuclear fusion
- Magnetic confinement fusion (MCF)
  - Tokamak
  - Stellarator
- Inertial confinement fusion (ICF)
  - Indirection drive ICF
  - Direct drive ICF
- Innovation idea MCF + ICF
- Plasma in space
- Pulsed-power system at NCKU
  - Extreme ultraviolet (EUV) light source
  - Studies of the rotational plasma jets

#### Laboratory astrophysics and space sciences

## Hydrodynamic equations can be written in a dimensionless form



Dimensional form:

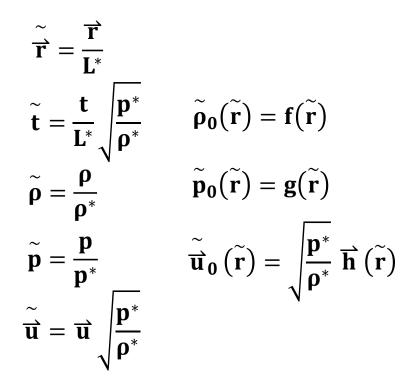
$$\begin{split} \frac{\partial \rho}{\partial t} + \nabla \cdot (\rho \ \overrightarrow{u}) &= 0 \\ \rho \left( \frac{\partial \ \overrightarrow{u}}{\partial t} + \overrightarrow{u} \cdot \nabla \ \overrightarrow{u} \right) &= -\nabla p \\ \frac{\partial p}{\partial t} + \overrightarrow{u} \cdot \nabla p &= -\gamma p \nabla \cdot \overrightarrow{u} \end{split}$$

Dimensionless form:

$$\frac{\frac{\partial \widetilde{\rho}}{\partial \widetilde{t}}}{\frac{\partial \widetilde{v}}{\partial \widetilde{t}}} + \nabla \cdot \left(\widetilde{\widetilde{\rho}} \stackrel{\sim}{\overrightarrow{u}}\right) = 0$$

$$\widetilde{\rho} \left(\frac{\partial \stackrel{\sim}{\overrightarrow{u}}}{\partial \widetilde{t}} + \stackrel{\sim}{\overrightarrow{u}} \cdot \nabla \stackrel{\sim}{\overrightarrow{u}}\right) = -\nabla \widetilde{p}$$

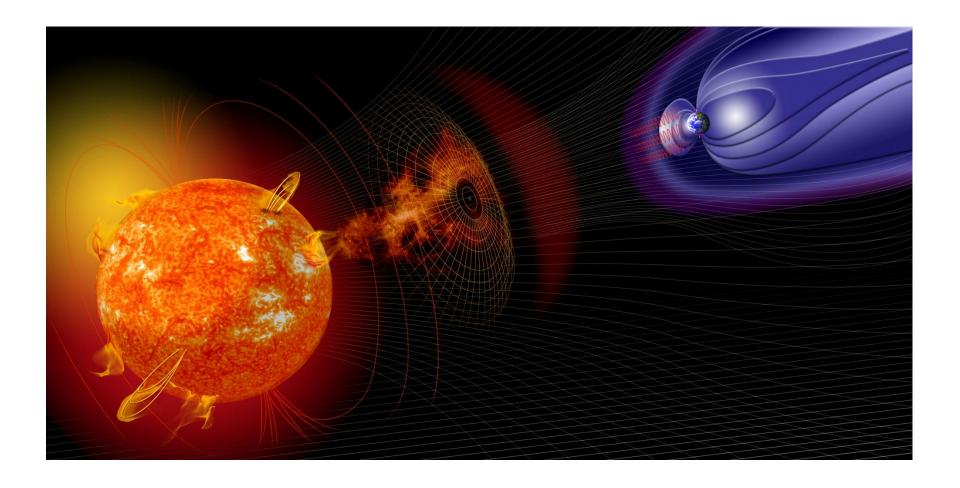
$$\frac{\partial \widetilde{p}}{\partial \widetilde{t}} + \stackrel{\sim}{\overrightarrow{u}} \cdot \nabla \widetilde{p} = -\gamma \widetilde{p} \nabla \cdot \stackrel{\sim}{\overrightarrow{u}}$$



Any two hydrodynamic systems involve identically in a scaled sense if f, g, h, and  $u^*(\rho^*/p^*)^{1/2}$  are the same.

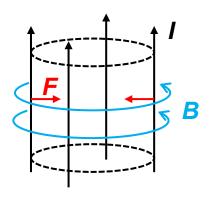
## Solar wind is a supersonic plasma plume coming from the sun

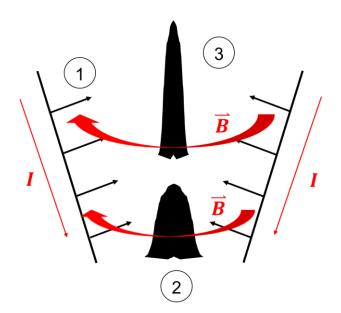




# A plasma jet can be generated by a conical-wire array due to the nonuniform z-pinch effect



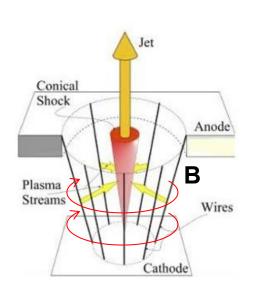


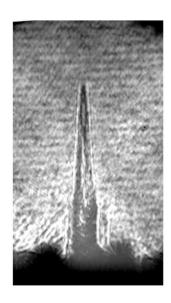


- 1. Wire ablation : corona plasma is generated by wire ablations.
- 2. Precursor: corona plasma is pushed by the  $\vec{J} \times \vec{B}$  force and accumulated on the axis forming a precursor.
- 3. Plasma jet is formed by the nonuniform z-pinch effect due to the radius difference between the top and the bottom of the array.

## Plasma jets generated by conical-wire arrays can be used to simulate the solar wind







**Driver:** 

I<sub>peak</sub>=1 MA T<sub>rise</sub>=240 ns

Jet conditions:  $V \sim 200 \text{ km/s}$  $n_e \sim 10^{19} \text{ cm}^{-3}$ 

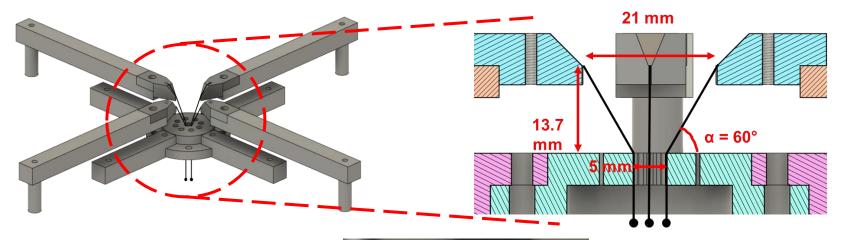
2mm

- A conical-wire array can be used to generate a plasma jet where the flow speed is  $\sim$  200 km/s with Mach number up to 20.
- The solar wind is a supersonic plasma flow with Mach number  $\sim$  5-10 and the flow speed  $\sim$  400 km/s.

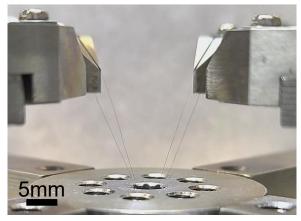
<sup>\*</sup> S. V. Lebedev *et al.* Astrophys. J. 564, 113 (2002)

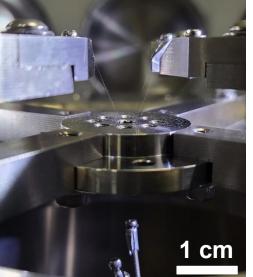
<sup>\*</sup> George K. Parks, Physics of Space Plasmas: An Introduction (Perseus Books (Sd), 1991).

# Our conical-wire array consists of 4 tungsten wires with an inclination angle of 30° with respect to the axis







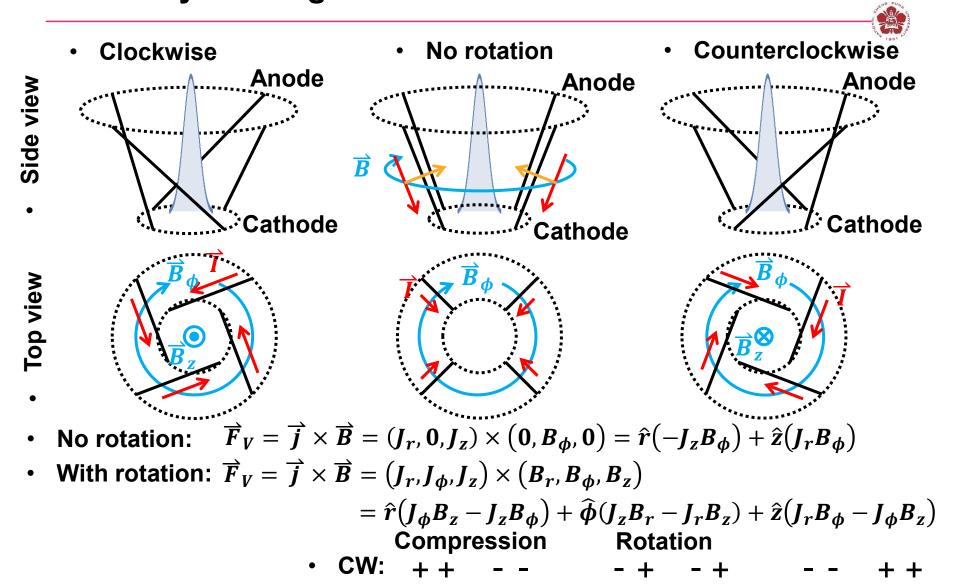


Material : Tungsten

Number of wires: 4

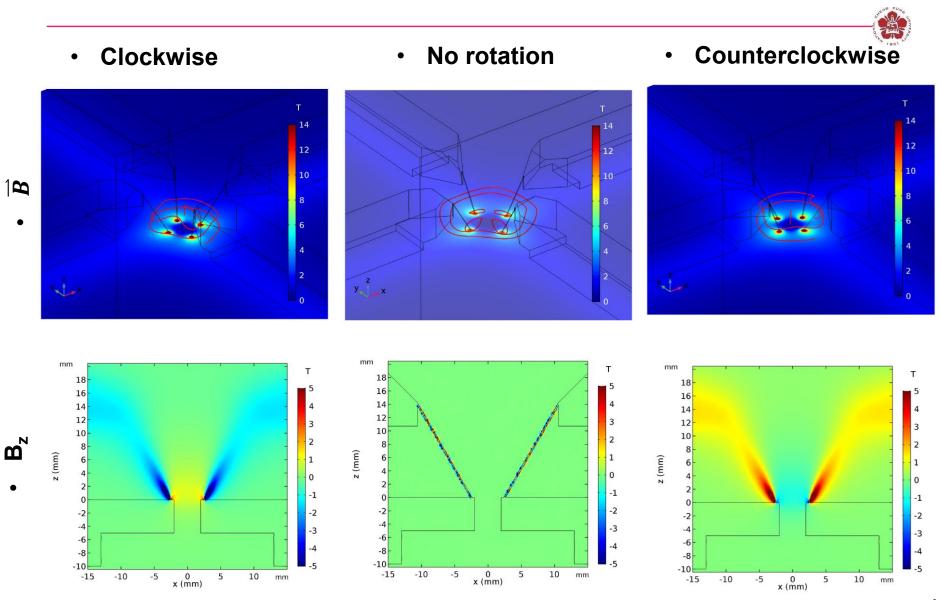
Diameter: 0.02 mm

### The rotational plasma jet produced by a twisted-conicalwire array is being studied



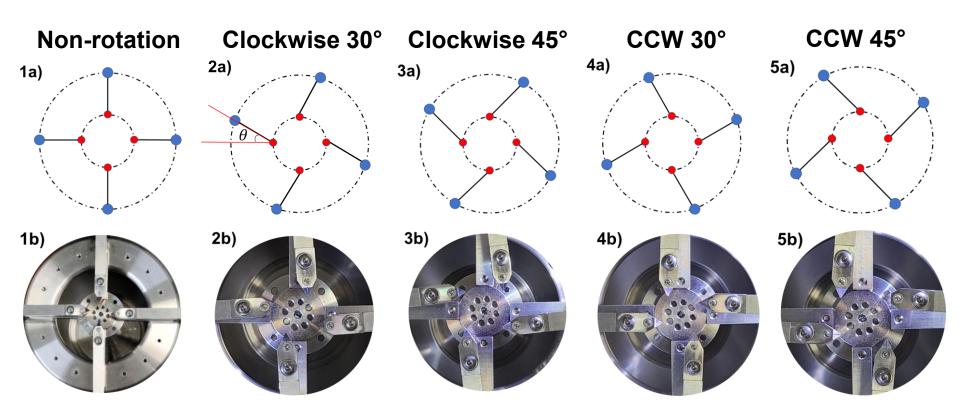
CCW:

### Bz is generated when the coil is twisted



## Conical-wire arrays were twisted with different angles and in different directions

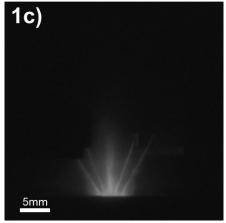


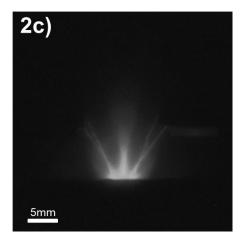


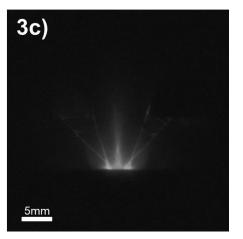
The brightness of the generated plasma jets depend on the twisted angle of the conical-wire array

• Non-rotation
• Clockwise 30°
• Clockwise 45°





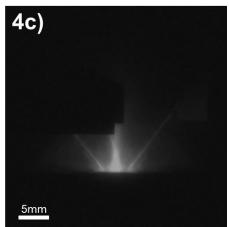




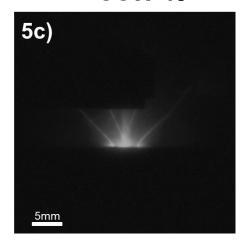
 The view of the plasma jet was blocked



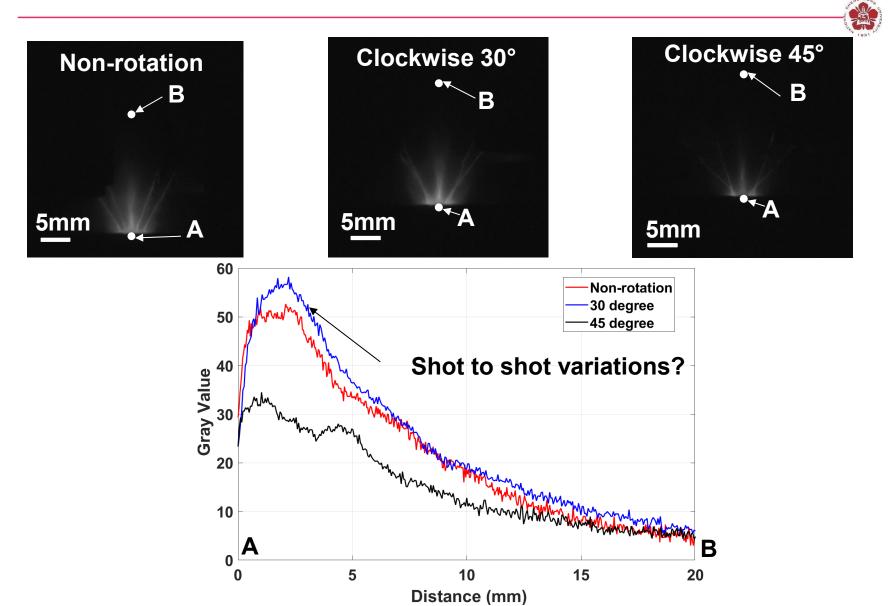




CCW 45°



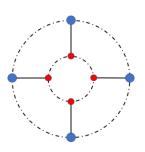
# The plasma jet with the twisted angle of 30° was the brightest

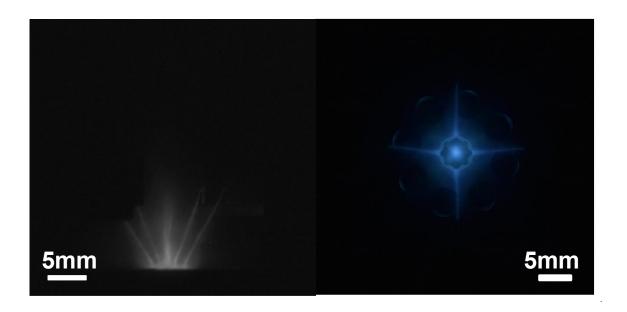


### The plasma jet is a bright spot from the top view



#### Non-rotation

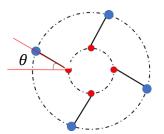


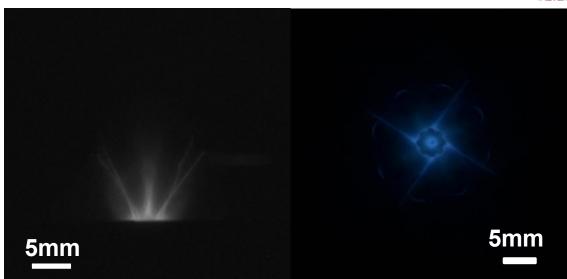


### Hollow plasma jets were generated when the conicalwire arrays were twisted

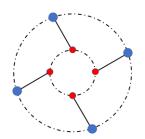


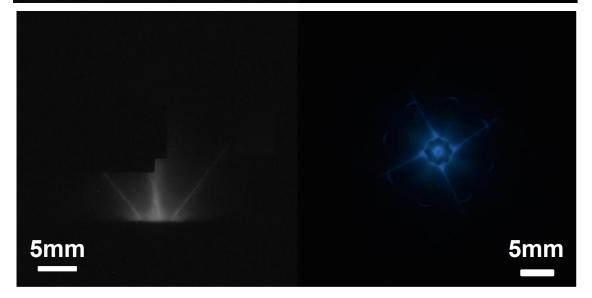
Clockwise 30 °



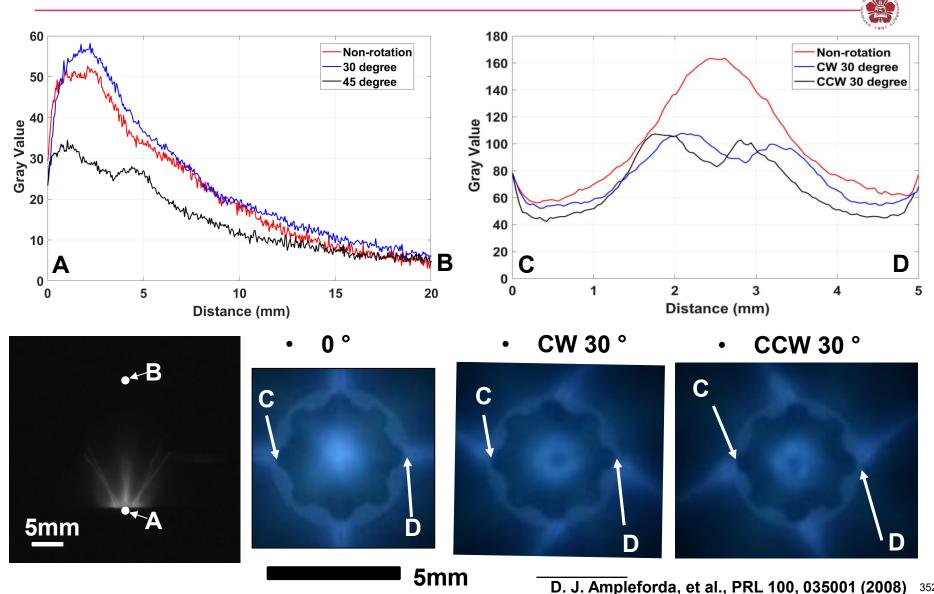


Counter clockwise 30 °



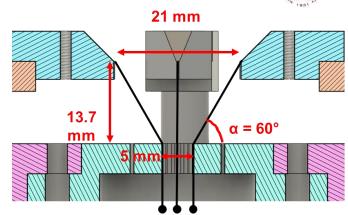


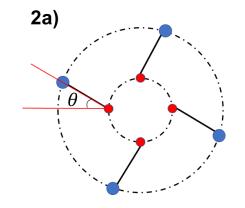
## The hollow region at the center was due to angular momentum conservation of the in-coming plasma flow



## Time-integrated images were not enough to capture the whole stories

- The angular momentum is conserved: larger initial angular momentum may lead to less compression.
- <u>Compression</u>: the magnetic field in the  $\phi$  direction provides the  $\vec{J} \times \vec{B}$  force to compress the plasma jet.
- Heat conduction suppression: the magnetic field in the z-direction may inhibit the thermal conduction losses. The temperature of the plasma jet may be higher leading to a brighter emission.
- Radiation: depends on temperature and density.

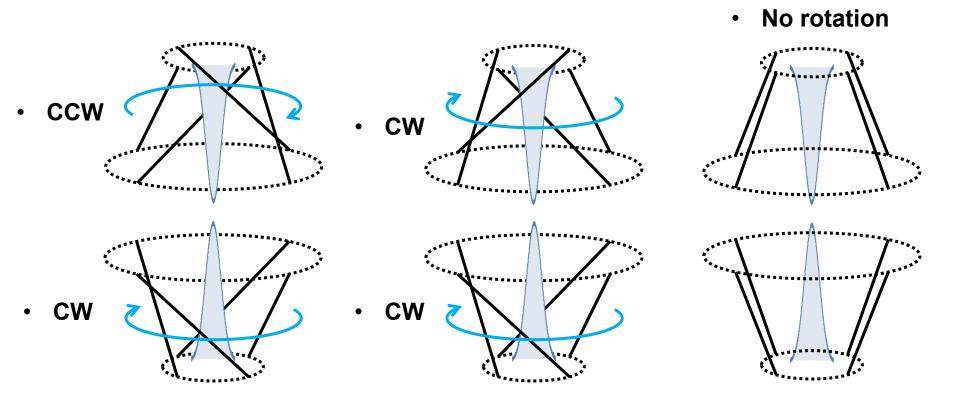




 The time-resolved densities, temperatures, and magnetic fields of the plasma jets need to be measured.

## Can the angular momentum be cancelled out through collisions?





#### **Neutral beam source**



- Neutral beam injection for heating plasma in Tokamak
  - Jure Maglica, Seminar at University in Ljubljana
  - lan G. Brown, The Physics and Technology of Ion Sources
- Electric propulsion (plasma thrusters)
  - D. M. Goebel and I. Katz, Fundamentals of Electric Propulsion: Ion and Hall Thrusters

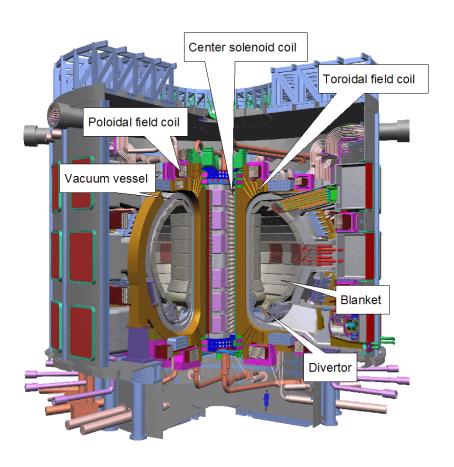
#### **Neutral beam source**

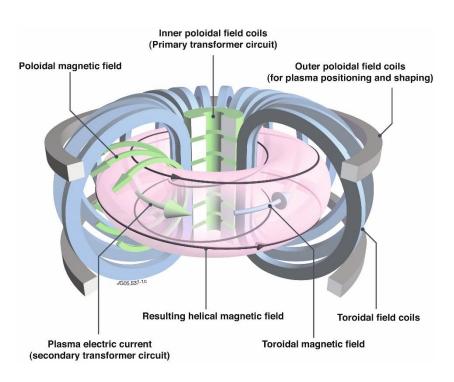


- Neutral beam injection for heating plasma in Tokamak
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  - lan G. Brown, The Physics and Technology of Ion Sources
- Electric propulsion (plasma thrusters)
  - D. M. Goebel and I. Katz, Fundamentals of Electric Propulsion: Ion and Hall Thrusters

# Hot plasma is confined by the magnetic field in magnetic confinement fusion

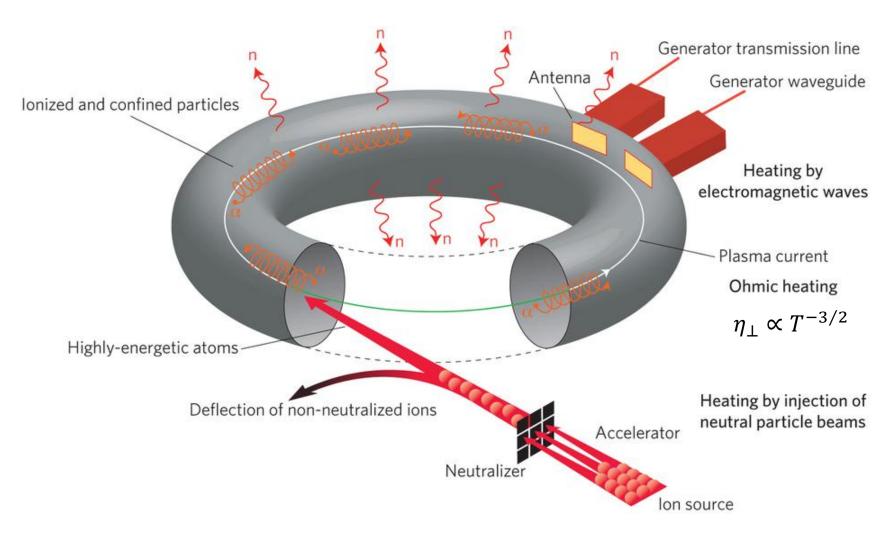






## Neutral beam injector is one of the main heat mechanisms in MCF





## Varies way of heating a MCF device

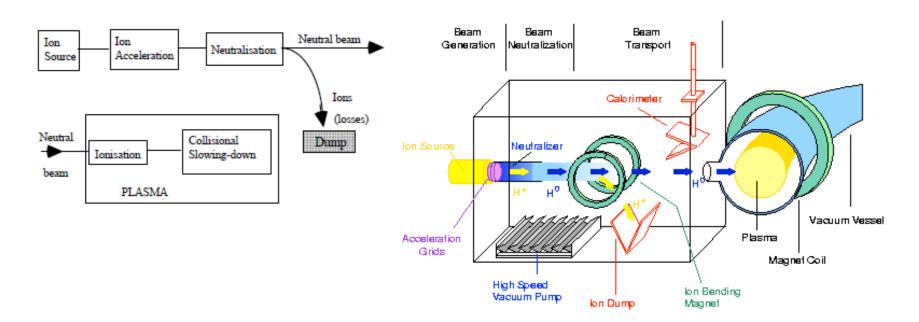


S	ystem	Frequency/ energy	Maximum power coupled to plasma	Overall system efficiency	Development/ demonstration required	Remarks
ECRF	Demonstrated in tokamaks	28–157 GHz	2.8 MW, 0.2 s	30-40%	Power sources and windows, off-axis CD	Provides off-axis CD
Eciti	ITER needs	$150170~\mathrm{GHz}$	50  MW, SS	30 40/0		
ICRF	Demonstrated in tokamaks	$25120~\mathrm{MHz}$	22 MW, 3 s (L-mode); 16.5 MW, 3 s (H-mode)	50–60%	ELM tolerant system	Provides ion heating and smaller ELMs
Total	ITER needs	40–75 MHz	50 MW, SS	30 3070		
LHRF	Demonstrated in tokamaks	1.3–8 GHz	2.5 MW, 120 s; 10 MW, 0.5 s	45–55%	Launcher, coupling to H-mode	Provides off-axis CD
Litter	ITER needs	$5~\mathrm{GHz}$	50  MW, SS	49 99/0		
+ve ion	Demonstrated in tokamaks	$80140~\mathrm{keV}$	40 MW, 2 s; 20 MW, 8 s	3545%	None	Not applicable
NBI	ITER needs	None	None			
-ve ion	Demonstrated in tokamaks	$0.35~\mathrm{MeV}$	$5.2 \mathrm{MW}, \mathrm{D}^-, 0.8 \mathrm{s}$ (from 2 sources)			
ve ion	ITER needs	$1~{ m MeV}$	50 MW, SS	~37%	System, tests on tokamak, plasma CD	provides rotation

<sup>&#</sup>x27;S S' indicates steady state

### Neutral particles heat the plasma via coulomb collisions

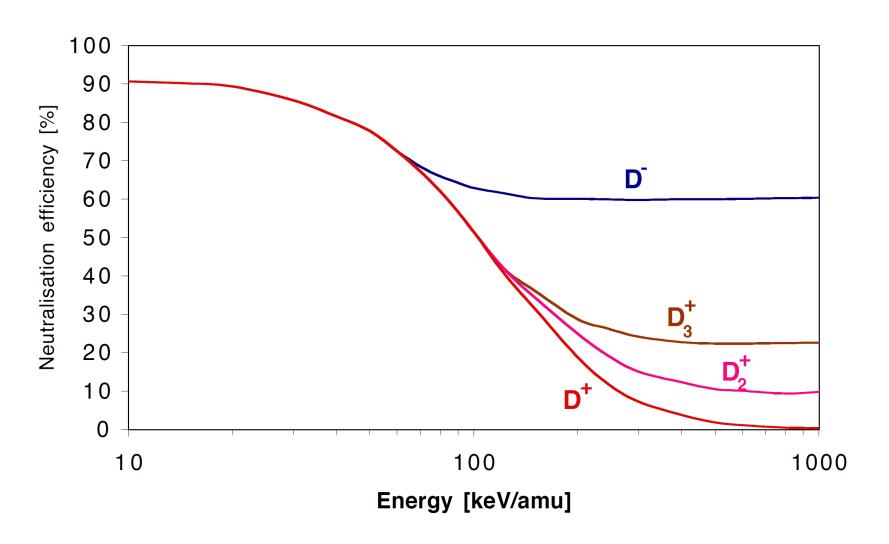




- 1. create energetic (fast) neutral ions
- 2. ionize the neutral particles
- 3. heat the plasma (electrons and ions) via Coulomb collisions

# Negative ion source is preferred due to higher neutralization efficiency

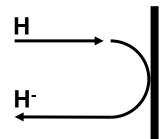




# There are two ways to make negative ions – surface and volume production



- Surface production, depends on :
  - Work function Φ
  - Electron affinity level, 0.75 eV for H<sup>-</sup>



- Perpendicular velocity
- Work function can be reduced by covering the metal surface with cesium

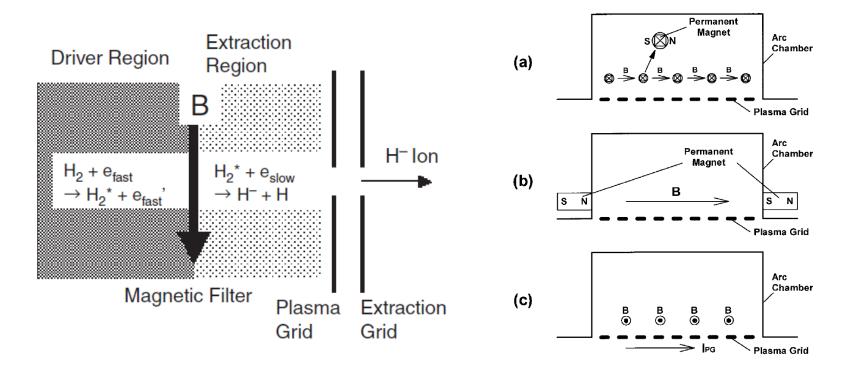
$$H + e^- \rightarrow H^-$$
  
 $H^+ + 2e^- \rightarrow H^-$ 

Volume production:

$$H_2 + e_{\textit{fast}}(>20 \text{ eV}) \rightarrow H_2^*(\text{excited state}) + e_{\textit{fast}},$$
  $H_2^*(\text{excited state}) + e_{\textit{slow}}(\approx 1 \text{ eV}) \rightarrow H^- + H.$ 

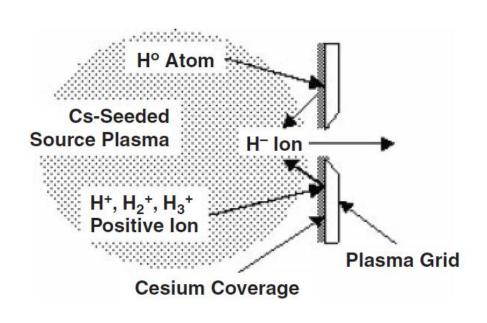
# Two-chamber method of negative ions in volume production with a magnetic filter

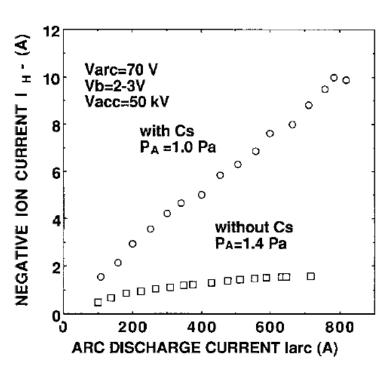




### Adding cesium increases negative ion current

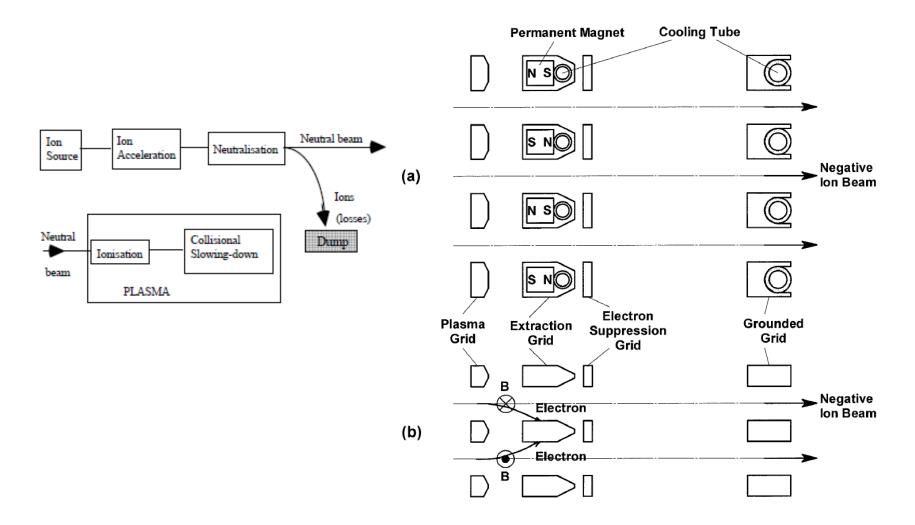






# Electrons need to be filtered out since they are extracted together with negative ions

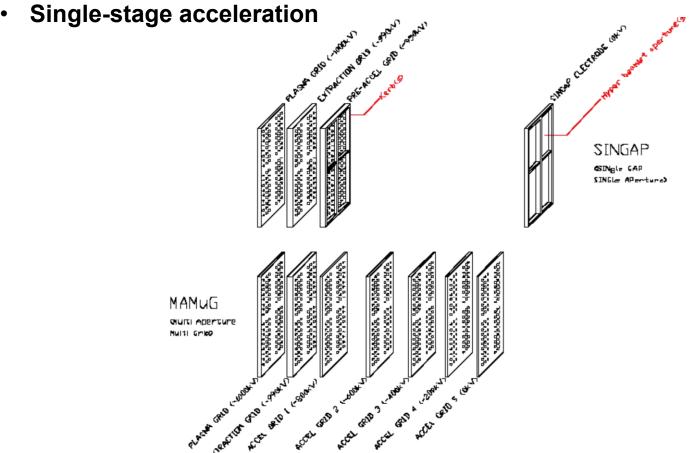




### **Acceleration**



Multi-stage acceleration

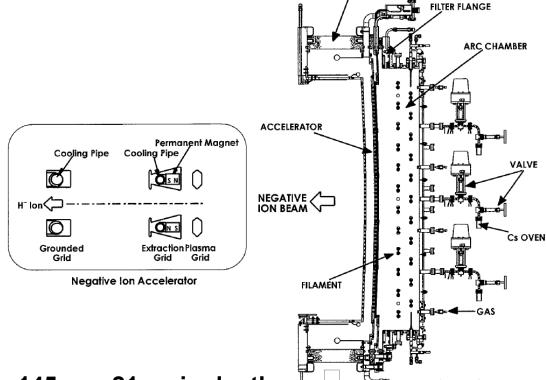


The ITER neutral beam system: status of the project and review of the main technological issues, presented by V. Antoni

# **NBI** system of the LHD fusion machine







INSULATOR

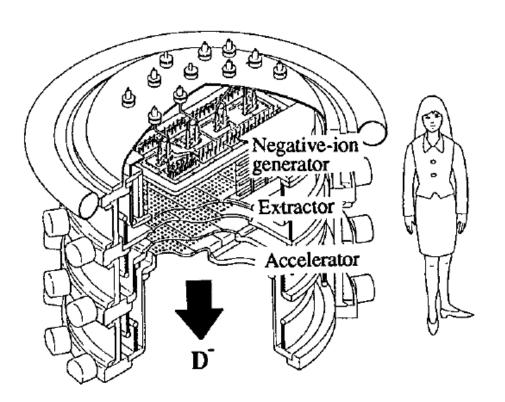
- 180 keV and 30 A
- Arc chamber: 35 cm x 145 cm, 21cm in depth
- Single stage accelerator

20 cm

# JT60U NBI system



- JT-60 (Japan-Torus) is a tokamak in Japan.
- 550 keV, 22A
- 2m in diameter and 1.7 m in height
- 3-stage accelerator



### **Neutralization**



### Gas neutralization

Collisions between fast negative ions and atoms

$$H^- + H_2 \longrightarrow H + H_2 + e^-$$

Fast ions can lose another electron after neutralized

$$H + H_2 \rightarrow H^+ + H_2 + e^-$$

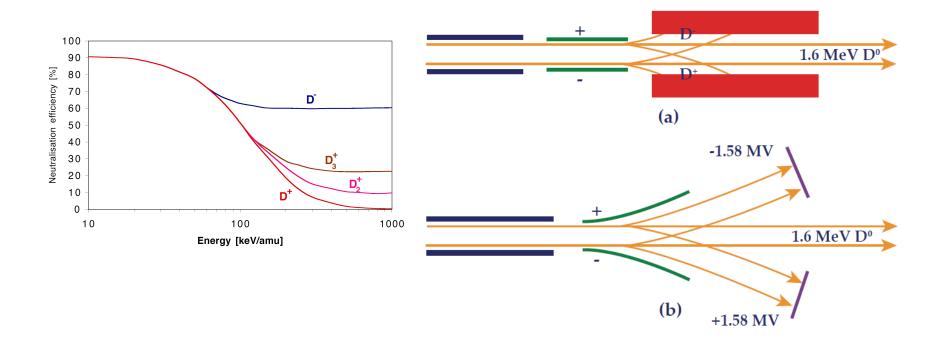
- Plasma neutralization
  - Collisions with charged particles in plasma

$$H^{-} + X(e, Ar, H^{+}, H_{2}^{+}) \longrightarrow H + X + e^{-}$$

- The efficiencies reach up to 85% for fully ionized hydrogen plasma

# Beam dump

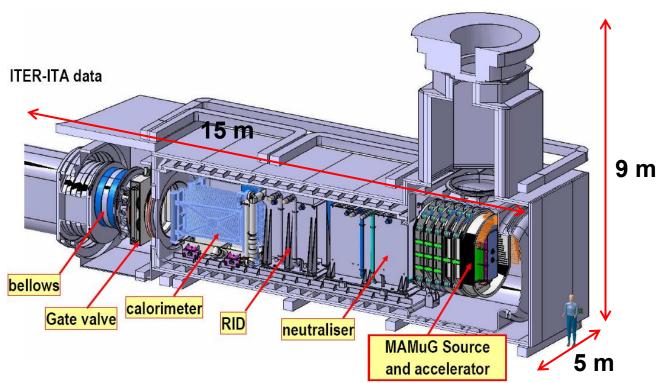




### **NBI for ITER**



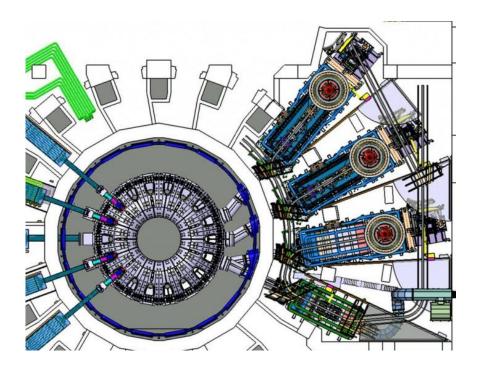
- beam components (Ion Source, Accelerator, Neutralizer, Residual Ion Dump and Calorimeter)
- other components (cryo-pump, vessels, fast shutter, duct, magnetic shielding, and residual magnetic field compensating coils)



The ITER neutral beam system: status of the project and review of the main technological issues, presented by V. Antoni

# **Neutral beam penetration**





- Parallel direction
  - Longest path through the densest part of the plasma
  - Harder to be built
- Perpendicular direction
  - Path is short
  - Larger perpendicular energies leads to larger losses
  - Easier to be built

### **Neutral beam source**



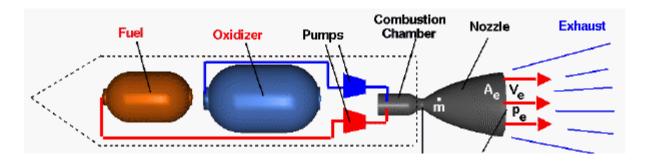
- Neutral beam injection for heating plasma in Tokamak
  - Jure Maglica, Seminar at University in Ljubljana
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- Electric propulsion (plasma thrusters)
  - D. M. Goebel and I. Katz, Fundamentals of Electric Propulsion: Ion and Hall Thrusters

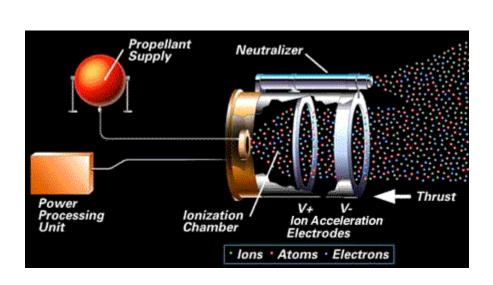
### Comparison between liquid rockets and ion thrusters



### Liquid rockests

- u~4500 m/s
- Isp~450 s
- Energy ~ 100GJ
- Power ~ 300MW
- Thrust ~ 2x10<sup>6</sup> N
- Ion thrusters
  - u~30000 m/s
  - Isp~3000 s
  - Energy ~ 1000GJ
  - Power ~ 1kW
  - Thrust ~ 0.1 N





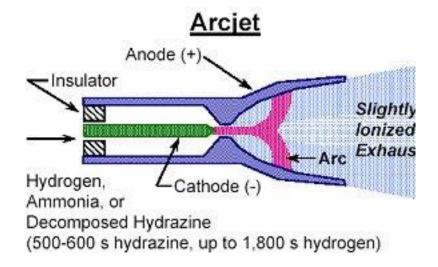
### **Electric thruster types - electrothermal**



### Resistojet

# Resistojet AC or DC Power Hot Gas Exhaust Hydrogen, Ammonia, or Decomposed Hydrazine 300 s (hydrazine) 900 s (hydrogen)

### Arcjet

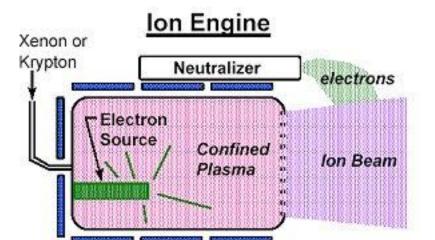


# **Electric thruster types - electrostatic**

2,000-10,000 s

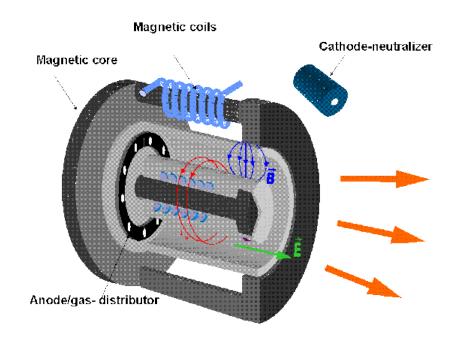


Ion thruster



~Magnets

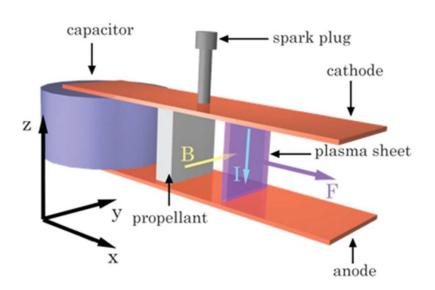
Hall thruster



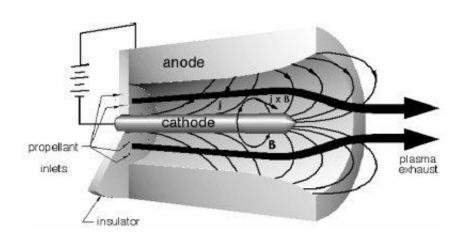
# **Electric thruster types - Electromagnetic**



Pulsed plasma thruster



 Magnetoplasmadynamic thruster (MPD)



# The thrust in an ion engine is transferred by the electrostatic force between the ions and the two grids



$$\frac{dE(x)}{dx} = \frac{\rho(x)}{\varepsilon_0} = \frac{qn_i(x)}{\varepsilon_0}$$

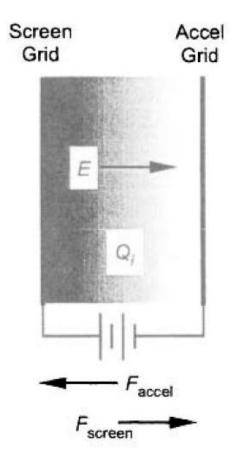
$$E(x) = \frac{q}{\varepsilon_0} \int_0^x n_i(x') dx' + E_{\text{screen}}$$

Gauss's law:  $\sigma = \varepsilon_0 E_{\text{screen}}$ 

$$F_{\text{screen}} = \sigma \frac{(E_{\text{screen}} + 0)}{2} = \frac{1}{2} \varepsilon_0 E_{\text{screen}}^2$$

$$F_{\text{accel}} = -\sigma \frac{(E_{\text{accel}} + 0)}{2} = -\frac{1}{2} \varepsilon_0 E_{\text{accel}}^2$$

$$T = F_{\text{screen}} + F_{\text{accel}} = \frac{1}{2} \varepsilon_0 (E_{\text{screen}}^2 - E_{\text{accel}}^2)$$



$$F_{\text{ion}} = q \int_0^d n_i(x) E(x) dx = \varepsilon_0 \int_0^d \frac{dE}{dx} E dx = \frac{1}{2} \varepsilon_0 (E_{\text{accel}}^2 - E_{\text{screen}}^2)$$

### The rocket equation



Force = 
$$T = M \frac{dv}{dt}$$

$$T = -\frac{d}{dt}(m_p v_{\rm ex}) = -v_{\rm ex} \frac{dm_p}{dt}$$

$$M(t) = m_d + m_p$$

$$\frac{dM}{dt} = \frac{dm_p}{dt}$$

$$M\frac{\mathrm{d}\mathbf{v}}{\mathrm{d}\mathbf{t}} = -\mathbf{v}_{\mathrm{ex}}\frac{\mathrm{d}\mathbf{M}}{\mathrm{d}\mathbf{t}}$$

$$\int_{v_i}^{v_f} d\mathbf{v} = -v_{\text{ex}} \int_{m_d + m_p}^{m_d} \frac{d\mathbf{M}}{\mathbf{M}}$$

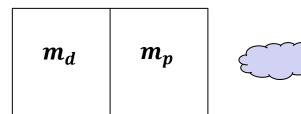
$$v_f - v_i = \Delta v = -v_{\text{ex}} \ln \left( \frac{m_d}{m_d + m_p} \right)$$

$$m_d = (m_d + m_p)e^{-\Delta v/v_{\rm ex}}$$

$$\Delta \mathbf{v} = (\mathbf{Isp} \times \mathbf{g}) \ln \left( \frac{m_d + m_p}{m_d} \right)$$

$$egin{aligned} m{m}_p &= m{m}_d [e^{\Delta \mathbf{v}/v_{\mathrm{ex}}} - \mathbf{1}] \ &= m{m}_d [e^{\Delta \mathbf{v}/(\mathrm{Isp} imes g)} - \mathbf{1}] \end{aligned}$$

M



### Force transfer



$$T = -\frac{d}{dt}(m_p v_{ex}) = -v_{ex} \frac{dm_p}{dt} = m_p v_{ex}$$

$$\dot{m}_p = QM$$

$$P_{\rm jet} = \frac{1}{2} \dot{m}_p v_{\rm ex}^2 = \frac{T^2}{2 \dot{m}_p}$$

$$T = \frac{\mathrm{dm}_p}{\mathrm{dt}} v_{\mathrm{ex}} \approx \dot{m}_i v_i$$

$$v_i = \sqrt{\frac{2qV_b}{M}}$$

$$\dot{m}_i = \frac{I_b M}{q}$$

 $\dot{m}_p = \text{propellant mass flow rate in kg/}s$ 

Q = propellant particle flow rate in particles/s

M = atomic mass in kg

 $\dot{m}_i = \text{ion mass flow rate in kg/}s$  $I_b = \text{ion current}$ 

$$T = \sqrt{\frac{2M}{e}} I_b \sqrt{V_b} \text{ (Nt)}$$

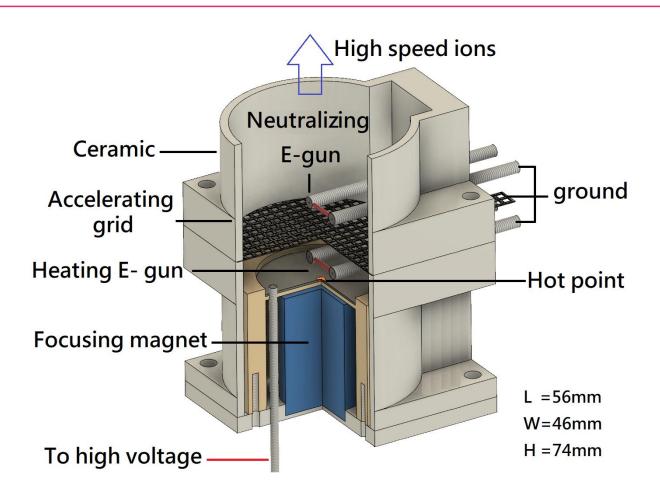
# Ion thruster has the highest specific impulse (Isp)



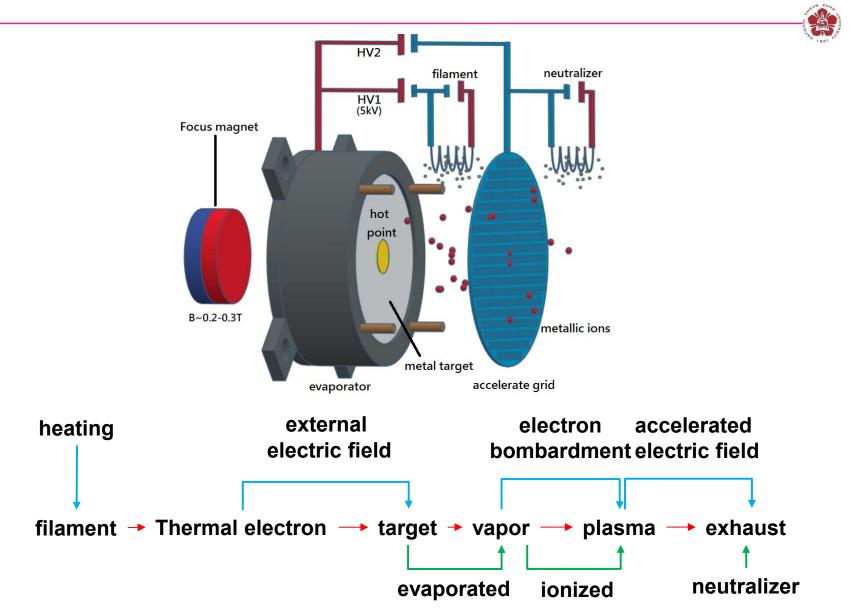
Thruster	Specific Impulse (s)	Input Power (kW)	Efficiency Range (%)	Propellant
Cold gas	50-75		<del></del>	Various
Chemical (monopropellant)	150-225	<del></del>		$N_2H_4$ $H_2O_2$
Chemical (bipropellant)	300-450		_	Various
Resistojet	300	0.5-1	65-90	N <sub>2</sub> H <sub>4</sub> monoprop
Arcjet	500-600	0.9-2.2	25-45	N <sub>2</sub> H <sub>4</sub> monoprop
Ion thruster	2500-3600	0.4-4.3	40-80	Xenon
Hall thrusters	1500-2000	1.5-4.5	35-60	Xenon
PPTs	850-1200	<0.2	7–13	Teflon

# Metallic Ion Thruster Using Magnetron E-Beam Bombardment (MIT-MEB)





# Electrons are used to generate metallic gas, metallic plasma and to neutralize ions

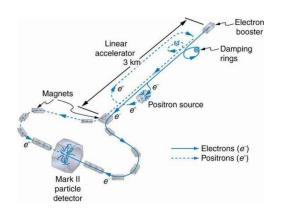


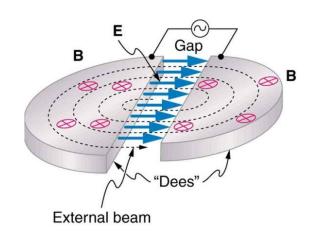
# High energy particle accelerator



- linear particle accelerator (Linac)
- Cyclotron

Synchrotron

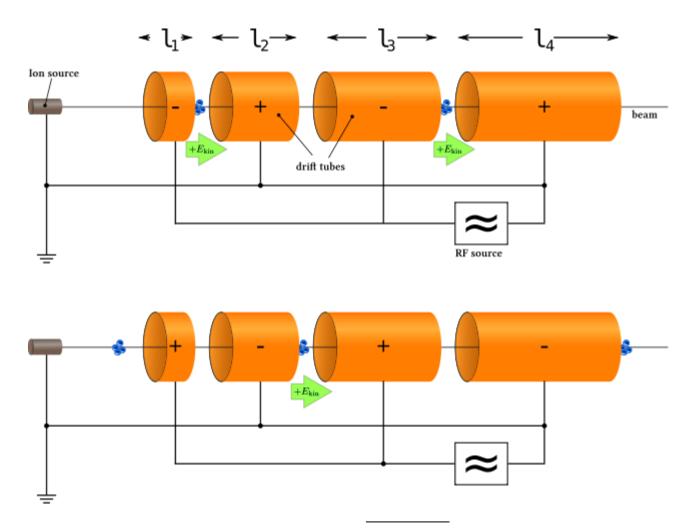






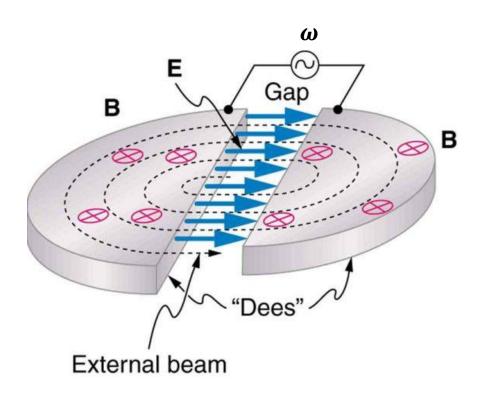
 Reference: Introduction to plasma phenomena and plasma medicine, Y. Nishida and K.-L. Ou

# A linear particle accelerator (linac) accelerates charged particles using a series of oscillating electric potentials along a linear beamline



# Cyclotrons use a magnetic field to cause particles to move in circular orbits





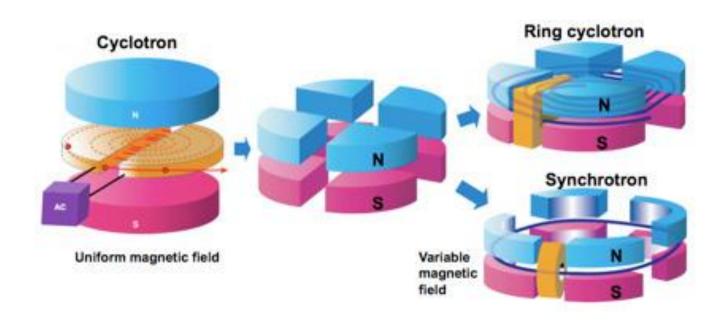
$$\omega_{\rm ce} = \frac{eB}{m_e a}$$

$$r_e = rac{v}{\omega_{
m ce}} = rac{m_e c v}{e B}$$

Cyclotron was invented by Ernest Lawrence who earned the 1939
 Nobel price in physics

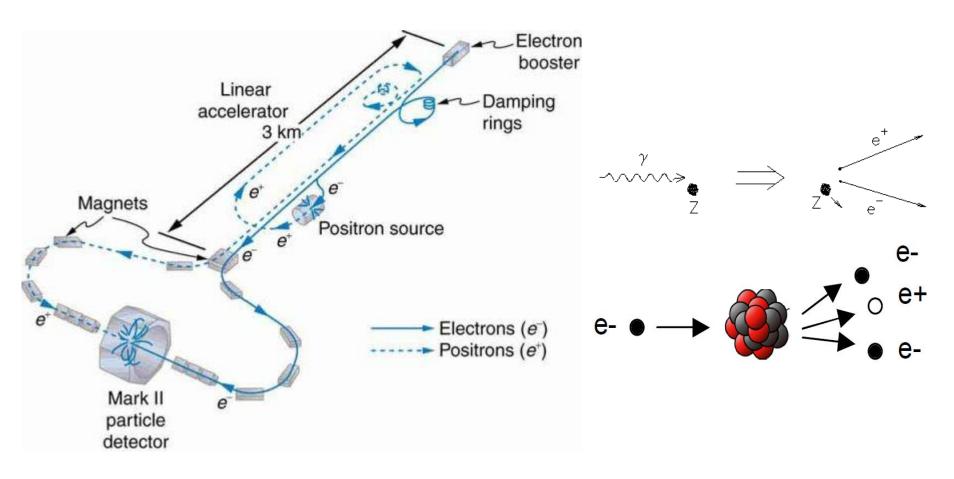
# Synchrotron uses time-dependent guiding magnetic field synchronized to a particle beam





# Stanford linear accelerator center (SLAC) is a 50 GeV electron / positron accelerator





# Large Hadron Collider (LHC) is the world's largest and most powerful particle collider providing 13 TeV protons



# Plasma based accelerators will become 3 orders smaller than the regular microwave based accelerator



- Maximum field strength:
  - Microwave: 100 MV/m
  - Plasma: >10 GV/m, 300 GV/m was achieved using laser wakefield accelerator<sup>1</sup>
- Plasma based high energy accelerators:
  - V<sub>p</sub>xB or surfatron accelerator<sup>2</sup>
  - Plasma wakefield accelerator (PWFA)<sup>3</sup>
  - Plasma beat wave accelerator (PBWA)<sup>4</sup>
  - Laser wakefield accelerator (LWFA)<sup>4</sup>

<sup>&</sup>lt;sup>1</sup>N. A. M. Hafz, *et al.*, Nature Photonics **2**, 571 (2008)

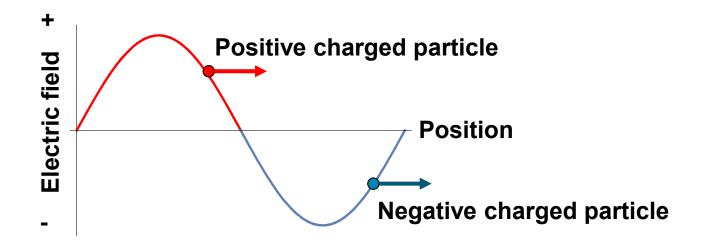
<sup>&</sup>lt;sup>2</sup>T. Katsouleas and J. Dawson, Phys. Rev. Lett. **51**, 392 (1983)

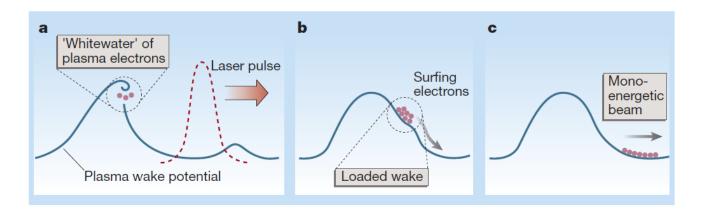
<sup>&</sup>lt;sup>3</sup>P. Chen, et al., Phys. Rev. Lett. **54**, 693 (1985)

<sup>&</sup>lt;sup>4</sup>T. Tajima and J. M. Dawson, Phys. Rev. Lett. **43**, 267 (1979)

# Charged particles can be accelerated in the wave electric field







### Who will catch the wave?





# The surfer glides in a direction not parallel to the wave direction to be in phase to the wave propagation



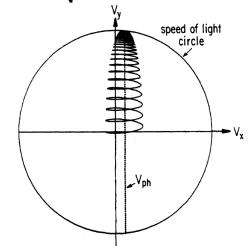


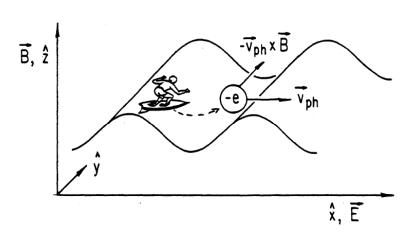
# Electrons may be accelerated to speed of light using V<sub>p</sub>xB acceleration (Surfatron)



$$x_1 = x - v_{\text{ph}}t$$
  $\frac{d}{dt}(\gamma v_{\chi}) = 0$   
 $v_{\chi} \rightarrow v_{\text{ph}}$ 

$$v_y = -rac{\omega_c v_{
m ph} t}{\gamma_{
m ph} \sqrt{1 + rac{\omega_c^2 t^2 v_{
m ph}^2}{c^2}}$$





Plane wave electric field and uniform magnetic field:

$$\vec{E} = E_0 \sin(kx - \omega t)\hat{x}$$

$$\vec{B} = B\hat{z}$$

$$\frac{d}{dt}(\gamma v_x) = \frac{qE_0}{m} \sin(kx - \omega t) + \omega_c v_y$$

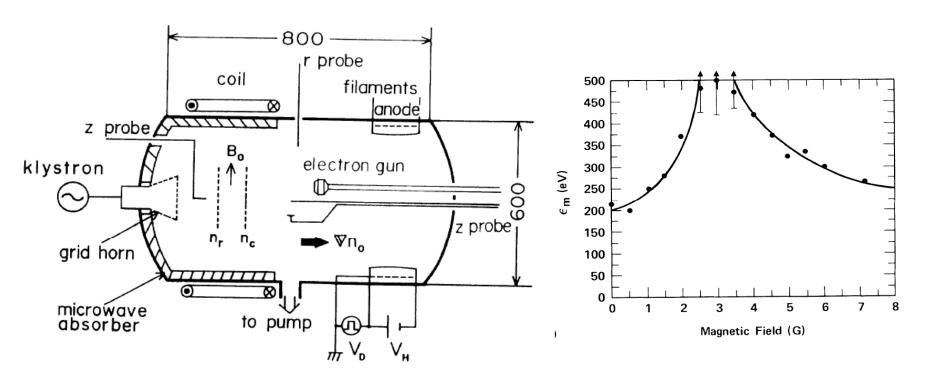
$$\frac{d}{dt}(\gamma v_y) = -\omega_c v_x$$

$$\gamma = \frac{1}{1 - \frac{v_x^2 + v_y^2}{c^2}}$$

- T. Katsouleas, et al., PRL 51, 392 (1983)
- T. Katsouleas, et al., IEEE TNS. **NS-30**, 3241 (1983)

# Experimental results of V<sub>p</sub>xB acceleration (Surfatron)



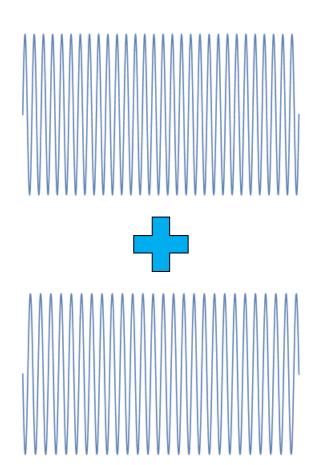


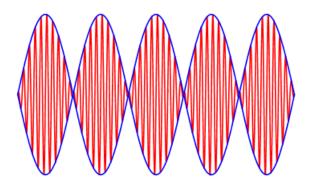
- $n_0 \sim 1-30 \times 10^{17} \text{ m}^{-3}$
- T<sub>e</sub> ~ 2-5 eV

- T<sub>i</sub> ~ 0.1-0.2 eV
- Microwave frequency: 3-10 GHz

### Plasma beat wave accelerator







$$sin(x_1) + sin(x_2) = 2 sin\left(\frac{x_1 + x_2}{2}\right) cos\left(\frac{x_1 - x_2}{2}\right)$$

### A plasma wave is driven by the laser beat wave



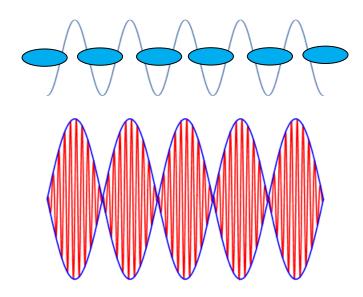
$$\omega_0 = \omega_2 - \omega_1$$

$$k_0 = k_2 - k_1$$

$$v_{\rm ph} = v_g = c \sqrt{1 - \frac{{\omega_p}^2}{{\omega_0}^2}}$$

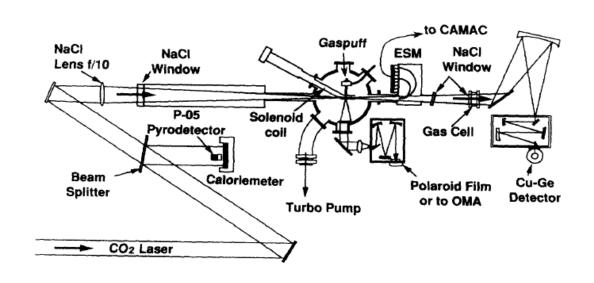
$$F = -e\nabla \phi_p = -\nabla \frac{e^2 E^{(1)} \cdot E^{(2)*}}{m\omega_1\omega_2}$$

#### Plasma wave



### Electrons were accelerated to over 20 MeV using plasma beat wave accelerator



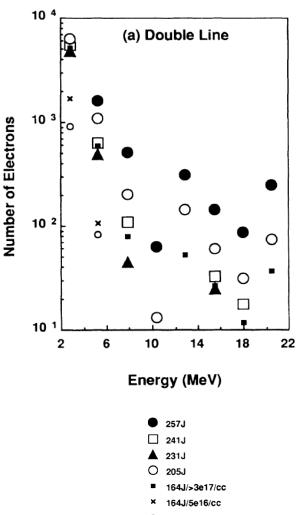




Intensity:  $2x10^{13} \sim 2x10^{14} \text{ W/cm}^2$ 

Injected E-beam: 0.1~1 MeV

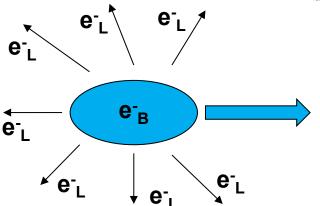
 $n_0 = 3x10^{16} \sim 7x10^{17} \text{ cm}^{-3}$ 

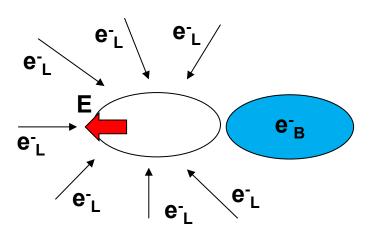


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### Plasma wakefield accelerator employs two beams

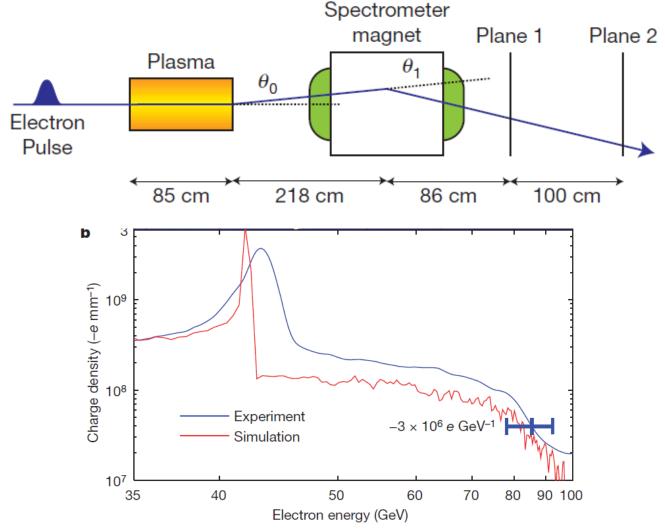
- When a bunch of electrons enter the plasma, they expel local electrons.
- When the bunch of electrons leave the plasma, the local electrons try to return but oscillate around their original locations and generate a wake field behind the bunch.
- The longitudinal field of the wake can accelerate the particles in the back.
- Key components:
  - Drive bunch: excite wakefield
  - Test bunch: beam that is accelerated to high energy





# Energy doubling of 42 GeV electrons in a metre-scale plasma wakefield accelerator





### Dream beam – the dawn of compact particle accelerators





# Ponderomotive force expelled electrons away from the higher electric field region



$$m_s\ddot{x}=q_sE=q_sE_0(x)\cos\omega t$$
  $x=x_0+x_1$  where  $x_0=\overline{x}$   $m_s(\ddot{x}_0+\ddot{x}_1)=q_s\left(E_0+x_1rac{\mathrm{d}E_0}{\mathrm{d}x}
ight)\cos\omega t$ 

Take time average:

$$m_s \ddot{x}_0 = q_s \frac{dE_0}{dx} \bigg|_{x_0} \overline{x_1 \cos \omega t}$$
•  $\ddot{x}_1 \gg \ddot{x}_0$  ,  $E_0 >> x_1 \frac{dE_0}{dx}$ 
 $m_s \ddot{x}_1 = q_s E_0 \cos \omega t$ 

$$x_1 = -\frac{q_s E_0}{m_s \omega^2} \cos \omega t$$

$$\ddot{x}_0 = -\frac{q_s^2 E_0}{2m_s^2 \omega^2} \frac{dE_0}{dx}$$

$$\frac{dE_0}{dx} = 0 \qquad \frac{dE_0}{dx} > 0$$
Weak Strong

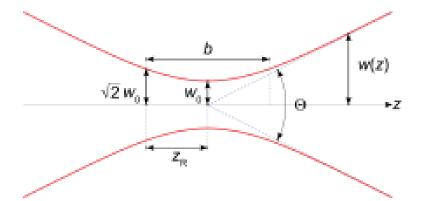
$$F_p = m_s \ddot{x}_0 = -\frac{q_s^2}{4m_s \omega^2} \frac{d}{dx} (E_0^2)$$

### Laser is used to create a bunch in laser wakefield accelerator



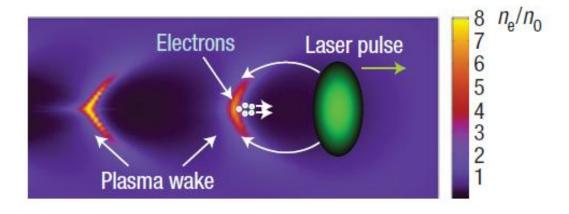
$$I(r,z) = \frac{2P}{\pi w^{2}(z)} \exp \left[-\frac{2r^{2}}{w^{2}(z)}\right]$$

- Waist:  $w(z) = w_0 \sqrt{1 + \frac{z^2}{{z_R}^2}}$
- Rayleigh length:  $z_R = \frac{\pi w_0^2}{\lambda_L}$



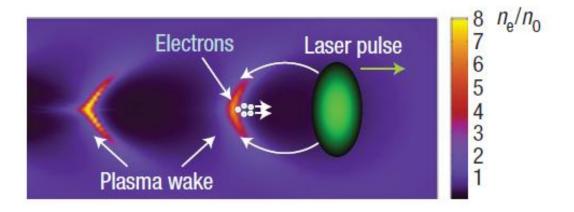
### **Bubble/blow-out regime**

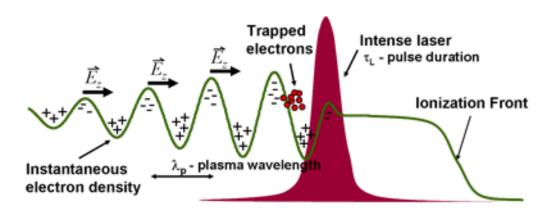




### A plasma wake is generated by a short pulse laser



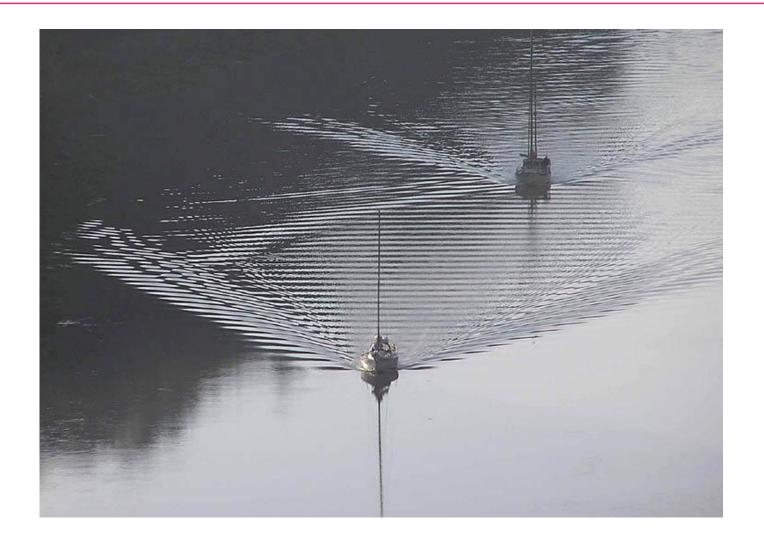




V. Malka, *et al.*, Nature Physics **4**, 447 (2008) http://cuos.engin.umich.edu/researchgroups/hfs/research/laser-wakefield-acceleration/

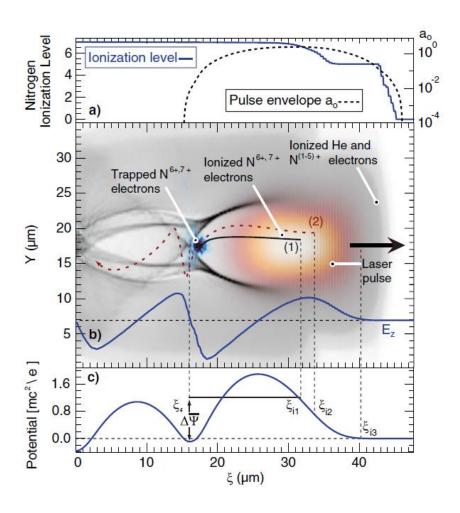
## The wakefield generated by a short pulse laser is very similar to the wave behind a boat





### **Ionization injection**

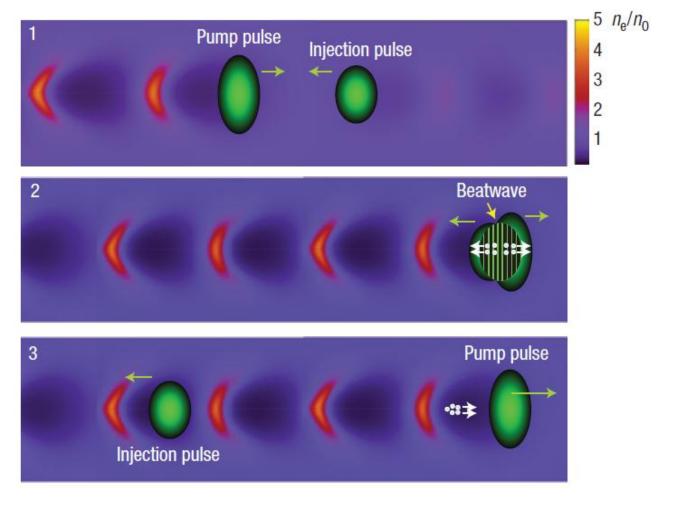




- Large relative energy spread
- Energy required to trap electrons is reduced so that electron beams with large charge can be produced in a moderate laser energy

### **Colliding laser pulses injection**





# Few femtosecond, few kiloampere electron bunch is produced by a laser-plasma accelerator



